



Visibility Report

APRIL 2026

S.NO	Date	Publication	Headline	Page No	Link	AVE	Quote By
INDUSTRY STORY							
PRINT							
1	1st May,2026	The Hindu Business Line	Smartphone prices face year-long spike amid memory chip shortfall, say experts	12	N/A	868670	Mr.Ashok Chandak,President IESA
INDUSTRY STORY							

ONLINE

1	1st May,2026	The Hindu Business Line	Smartphone prices face year-long spike amid memory chip shortfall, say experts	N/A	Link		Mr.Ashok Chandak,President IESA
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EXCLUSIVE INTERACTION**NEW AGE**

1	30th April,2026	Forbes India/ News18	The global landscape is shifting from capital-intensive competition to a battle for talent and knowledge.	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
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INDUSTRY STORY**PRINT**

1	30th April,2026	Business Standard	Electronics makers to cut output by 10-20% amid memory chip squeeze	1 & 9	N/A		Mr.Ashok Chandak,President IESA
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PANEL DISCUSSION**NEW AGE**

1	29th April,2026	Money Control	Future of Work Summit: Global Talent War? Why Geopolitics Is Shaping Jobs	N/A	Link		Mr.Ashok Chandak,President IESA
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PANEL DISCUSSION**ONLINE**

1	29th April,2026	Money Control	Talent is the new geopolitical currency': Why India may win the next global race for skills	N/A	Link		Mr.Ashok Chandak,President IESA
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STANDALONE INDUSTRY STORY**ONLINE**

1	23rd April,2026	Inc42	Can IndieSemiC Win China's 20-Cent Chip Challenge To India?	N/A	Link		Mr.Ashok Chandak,President IESA
STANDALONE INDUSTRY STORY							
PRINT							
1	16th April,2026	Financial Express	From design to silicon IP – The complex path of owning intellectual property	09	N/A		Mr.Ashok Chandak,President IESA and SEMI
STANDALONE INDUSTRY STORY							
ONLINE							
1	16th April,2026	Financial Express	From design to silicon IP – The complex path of owning intellectual property	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
EXCLUSIVE STORY							
PRINT							
1	13th April,2026	Dempa	From Policy to Execution Poised to Soar to a \$100 Billion Industry by 2030	1	N/A		Mr.Ashok Chandak,President IESA
EXCLUSIVE STORY							
ONLINE							
1	8th April,2026	AEI	India Executes Semiconductor Policy Into Full-Stack Growth	N/A	Link	125000	Mr.Ashok Chandak,President IESA and SEMI
INDUSTRY STORY							
ONLINE							
1	6th April,2026	Money Control	From ISM 1.0 to 2.0: How India plans to scale its semiconductor ecosystem		Link		Mr.Ashok Chandak,President IESA and SEMI

EXCLUSIVE STORY							
RADIO							
1	2nd April,2026	Akashvani	Government's Commitment to Strengthen Semiconductor Ecosystem		Link		Mr.Ashok Chandak,President IESA

S.NO	Date	Publication	Headline	Page No	Link	AVE	Quote By
IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging							
Print - Guwahati							
1	24th April,2026	Dainik Batori Kakot	Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging	06	N/A		Mr.Ashok Chandak,President IESA and SEMI
2	24th April,2026	Pratah Khabar	India's Big Leap in the Semiconductor Sector of 3DGS Semicon in Odisha Advanced packaging unit launched	02	N/A		Mr.Ashok Chandak,President IESA and SEMI
3	23rd April,2026	The Assam Post	IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging	09	N/A		Mr.Ashok Chandak,President IESA and SEMI
4	21st April,2026	Purvanchal Prahari	Advanced Semiconductor Packaging India's big leap in the region	06	N/A		Mr.Ashok Chandak,President IESA and SEMI
5	21st April,2026	The North East Times	IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging	02	N/A		Mr.Ashok Chandak,President IESA and SEMI
6	21st April,2026	The Meghalaya Guardian	IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging	08	N/A		Mr.Ashok Chandak,President IESA and SEMI
7	20th April,2026	The Hills Times	3DGS facility signals semiconductor leap	02	N/A		Mr.Ashok Chandak,President IESA and SEMI

IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging

Print - Bhubaneswar

1	20th April,2026	Samaya	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	10	N/A	79200	Mr.Ashok Chandak,President IESA and SEMI
2	20th April,2026	Political and Business Daily	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	04	N/A	76800	Mr.Ashok Chandak,President IESA and SEMI
3	20th April,2026	Darshan	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	05	N/A	51200	Mr.Ashok Chandak,President IESA and SEMI
4	20th April,2026	Indian Era	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	07	N/A	48000	Mr.Ashok Chandak,President IESA and SEMI
5	20th April,2026	Azad Sipahi	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	12	N/A	60000	Mr.Ashok Chandak,President IESA and SEMI
6	20th April,2026	Agami Orissa	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	03	N/A	23500	Mr.Ashok Chandak,President IESA and SEMI
7	20th April,2026	Amruta Dunia	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	14	N/A	32800	Mr.Ashok Chandak,President IESA and SEMI
8	20th April,2026	Dharitri	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	16	N/A	27700	Mr.Ashok Chandak,President IESA and SEMI
9	20th April,2026	Biswabani	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	05	N/A	30500	Mr.Ashok Chandak,President IESA and SEMI
10	20th April,2026	Kalinga Mail	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	08	N/A	28700	Mr.Ashok Chandak,President IESA and SEMI
11	20th April,2026	Ukal Mail	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	11	N/A	40000	Mr.Ashok Chandak,President IESA and SEMI
12	20th	Odisha	IESA Hails 3DGS Ground breaking as	07	N/A	33900	Mr.Ashok

	April,2026	Khabar	India's Big Leap in Advanced Semiconductor Packaging				Chandak,President IESA and SEMI
13	20th April,2026	Orissa Times	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	06	N/A	38800	Mr.Ashok Chandak,President IESA and SEMI
14	20th April,2026	Pratidin	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	13	N/A	37700	Mr.Ashok Chandak,President IESA and SEMI
15	20th April,2026	Swatantra Barta	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	08	N/A	29200	Mr.Ashok Chandak,President IESA and SEMI
16	20th April,2026	Utkal Samaja	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	07	N/A	31500	Mr.Ashok Chandak,President IESA and SEMI
17	20th April,2026	Lokakatha	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging	03	N/A	24500	Mr.Ashok Chandak,President IESA and SEMI

IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging

Print - Bangalore

1	24th April,2026	Vishwavani	3DGS Semicon unit in Odisha	04	N/A	21000	Mr.Ashok Chandak,President IESA and SEMI
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IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging

Online

1	20th April ,2026	Fortune India	India advances in chip value chain with 3DGS facility; semiconductor market expected to hit \$103 billion by 2030		Link		Mr.Ashok Chandak,President IESA and SEMI
2	20th April ,2026	Times Tech	IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging		Link		Mr.Ashok Chandak,President IESA and SEMI
3	19th April,2026	DQ India	IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging		Link		Mr.Ashok Chandak,President IESA and SEMI

IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging

Online Bangalore

1	22th April,2026	Vicharavisthara	3DGS's new unit inaugurated in Odisha: A major boost to India's semiconductor packaging sector		Link		Mr.Ashok Chandak,President IESA and SEMI
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QUOTE -The launch of India's first Quantum Test and Reference Facilities in Amaravati under the Quantum Valley							
PRINT - Guwahati							
1	22 nd April,2026	Sentinel	World Quantum Day: India has moved from being a technology adopter to leading the way in technology.	08	N/A		Mr.Ashok Chandak,President IESA and SEMI
2	21st April,2026	Purvanchal Prahari	The success of the quantum revolution will depend primarily on semiconductors	06	N/A		Mr.Ashok Chandak,President IESA and SEMI
3	21st April,2026	Assam Post	World Quantum Day 2026 marks a defining step in India's Journey towards deep - tech leadership	09	N/A		Mr.Ashok Chandak,President IESA and SEMI
4	20th April ,2026	The North East Times	World Quantum Day 2026 marks a defining step in India's Journey towards deep - tech leadership	05	N/A		Mr.Ashok Chandak,President IESA and SEMI
5	20th April ,2026	The Hills Times	India steps up quantum leadership	02	N/A		Mr.Ashok Chandak,President IESA and SEMI
6	20th April ,2026	The Meghalaya Guardian	World Quantum Day 2026 marks a defining step in India's Journey towards deep - tech leadership	07	N/A		Mr.Ashok Chandak,President IESA and SEMI
7	20th April ,2026	Dainik Batori Kakot	World Quantum Day 2026 celebrated	06	N/A		Mr.Ashok Chandak,President IESA and SEMI

QUOTE -The launch of India's first Quantum Test and Reference Facilities in Amaravati under the Quantum Valley**PRINT - Mumbai**

1	21st April,2026	Punya Nagari	India takes a step forward in the quantum revolution	11			Mr.Ashok Chandak,President IESA and SEMI
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QUOTE -The launch of India's first Quantum Test and Reference Facilities in Amaravati under the Quantum Valley**PRINT - Bengaluru**

1	23rd April,2026	Vartha Bharthi	400 billion dollar electronics market by 2030'	3	N/A	22000	Mr.Ashok Chandak,President IESA and SEMI
2	20th April,2026	Sanje express	India's first quantum test in Amaravati under 'Quantum Valley' initiative	2	N/A	12000	Mr.Ashok Chandak,President IESA and SEMI
3	20th April,2026	Vishwavani	Importance of semiconductor role	3	N/A	19000	Mr.Ashok Chandak,President IESA and SEMI
4	17th April,2026	Dinasuder	India's first quantum testing camp in Amaravati	3	N/A	14300	Mr.Ashok Chandak,President IESA and SEMI
5	17th April,2026	Udayakala	World Quantum Day 2026 marks a significant step in India's journey from technology adoption to technology leadership	3	N/A	13200	Mr.Ashok Chandak,President IESA and SEMI
6	17th April,2026	Sanjesamya	World Quantum Day 2026	3	N/A	10000	Mr.Ashok Chandak,President IESA and SEMI
7	17th April,2026	Arambha	World Quantum Day 2026: A significant step in the journey towards technological leadership	03	N/A	7000	Mr.Ashok Chandak,President IESA and SEMI
8	17th April,2026	Eenadu	Amaravati''s breakthrough on Quantum is amazing	9	N/A	19100	Mr.Ashok Chandak,President IESA and SEMI

QUOTE -The launch of India's first Quantum Test and Reference Facilities in Amaravati under the Quantum Valley

PRINT - Bhubaneswar

1	17th April,2026	Odisha Bhaskar	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	16	N/A	29800	Mr.Ashok Chandak,President IESA and SEMI
2	17th April,2026	Biswabani	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	5	N/A	31000	Mr.Ashok Chandak,President IESA and SEMI
3	17th April,2026	Odisha Khabar	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	8	N/A	27500	Mr.Ashok Chandak,President IESA and SEMI
4	17th April,2026	Lokakatha	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	7	N/A	25500	Mr.Ashok Chandak,President IESA and SEMI
5	16th April,2026	Agami Orissa	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	4	N/A	25000	Mr.Ashok Chandak,President IESA and SEMI

6	16th April,2026	Desbarta	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	6	N/A	27000	Mr.Ashok Chandak,President IESA and SEMI
7	15th April,2026	Dharitri	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	17	N/A	35000	Mr.Ashok Chandak,President IESA and SEMI
8	15th April,2026	Kalinga Mail	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	7	N/A	32000	Mr.Ashok Chandak,President IESA and SEMI
9	15th April,2026	Orissa Times	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	6	N/A	30000	Mr.Ashok Chandak,President IESA and SEMI
10	15th April,2026	Sakala Sathi	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	8	N/A	23000	Mr.Ashok Chandak,President IESA and SEMI
11	15th April,2026	Samaya	India must become a Quantum Nation— anchored in trusted supply	14	N/A	40000	Mr.Ashok Chandak,President IESA and SEMI

			chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India				
12	15th April,2026	Utkal Samaja	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	8	N/A	33000	Mr.Ashok Chandak,President IESA and SEMI
13	15th April,2026	Sakala	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	15	N/A	40000	Mr.Ashok Chandak,President IESA and SEMI
14	15th April,2026	Swatantra Barta	India must become a Quantum Nation— anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India	9	N/A	27800	Mr.Ashok Chandak,President IESA and SEMI

QUOTE -The launch of India's first Quantum Test and Reference Facilities in Amaravati under the Quantum Valley

PRINT - Gujarat

1	15th April	Divya Gujarat	Ashok Chandak: World Quantum Day 2026 is leading India towards a "Quantum Nation"	03	N/A		Mr.Ashok Chandak,President IESA and SEMI
2	15th April	Satellite samachar	Ashok Chandak: World Quantum Day 2026 marks the beginning of a new era of India's technology leadership	03	N/A		Mr.Ashok Chandak,President IESA and SEMI
3	15th April	Gujarat Pranam	Ashok Chandak: World	02	N/A		Mr.Ashok

			Quantum Day 2026 is leading India towards a “Quantum Nation.”				Chandak,President IESA and SEMI
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QUOTE -The launch of India’s first Quantum Test and Reference Facilities in Amaravati under the Quantum Valley

Online Bengaluru

1	17th April,2026	Businessnewsthisweek	India Electronics and Semiconductor Association Highlights India’s Quantum Push on World Quantum Day 2026	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
2	17th April ,2026	BusinessNews Profit	India Electronics and Semiconductor Association Highlights India’s Quantum Push on World Quantum Day 2026	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
3	17th April,2026	Businesshour9	India Electronics and Semiconductor Association Highlights India’s Quantum Push on World Quantum Day 2026	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
4	17th April,2026	StartupBusinesstories	India Electronics and Semiconductor Association Highlights India’s Quantum Push on World Quantum Day 2026	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
5	17th April,2026	Business News Byte	India Electronics and Semiconductor Association Highlights India’s Quantum Push on World Quantum Day 2026	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI

6	16th April,2026	Vicharavisthara	World Quantum Day 2026: India's bold step towards technology leadership	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
7	17th April,2026	Businesshour9	India Electronics and Semiconductor Association Highlights India's Quantum Push on World Quantum Day 2026	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI

S.NO	Date	Publication	Headline	Page No	Link	AVE	Quote By
QUOTE IESA - Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision							
Print - Guhawati							
1	4th April,2026	Sentinel	ECMS Vision for India Is a Game Changer: Ashok Chandak	08	N/A		Mr, Ashok Chandak , President IESA
2	2nd April,2026	Dainik Batori Kakot	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	06	N/A		Mr, Ashok Chandak , President IESA
3	1st April,2026	The North East Times	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	05	N/A		Mr, Ashok Chandak , President IESA
4	1st April,2026	The Assam Post	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	09	N/A		Mr, Ashok Chandak , President IESA
5	1st April,2026	The Meghalaya Guardian	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	07	N/A		Mr, Ashok Chandak , President IESA
6	1st April,2026	Purvanchal Prahari	ECMS Vision for India Is a Game Changer: Ashok Chandak	06	N/A		Mr, Ashok Chandak , President IESA
QUOTE IESA - Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision							

Print - Lucknow

1	1st April,2026	Avadhnama	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	12	N/A	Mr, Ashok Chandak , President IESA
2	1st April,2026	Lokmitra	ECMS Vision for India Is a Game Changer: Ashok Chandak	09	N/A	Mr, Ashok Chandak , President IESA
3	1st April,2026	Ayodhya Times	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	06	N/A	Mr, Ashok Chandak , President IESA
4	1st April,2026	Jansandesh Times	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	11	N/A	Mr, Ashok Chandak , President IESA
5	1st April,2026	Aaj	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	05	N/A	Mr, Ashok Chandak , President IESA
6	1st April,2026	Niyadheesh	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	03	N/A	Mr, Ashok Chandak , President IESA
7	1st April,2026	Navsatta	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	03	N/A	Mr, Ashok Chandak , President IESA
8	1st April,2026	Rashtriya Khabar	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	06	N/A	Mr, Ashok Chandak , President IESA
9	1st April,2026	Prabhatbhedi	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	04	N/A	Mr, Ashok Chandak , President IESA
10	1st April,2026	Pioneer	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	11	N/A	Mr, Ashok Chandak , President IESA
11	1st April,2026	Readers Messengers	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	03	N/A	Mr, Ashok Chandak , President IESA
12	1st April,2026	United Bharat	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	3	N/A	Mr, Ashok Chandak , President IESA
13	1st April,2026	Voice Of lucknow	Design efficiency and quality excellence: Very important for	14	N/A	Mr, Ashok Chandak ,

			enhancing India's ECMS vision				President IESA
14	1st April,2026	Shaha Times	Design efficiency and quality excellence: Very important for enhancing India's ECMS vision	04	N/A		Mr, Ashok Chandak , President IESA
QUOTE IESA - Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision							
Print - Bhubaneswar							
1	1st April,2026	Amruta Dunia	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	13	N/A	35000	Mr, Ashok Chandak , President IESA
2	1st April,2026	Biswabani	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	05	N/A	36000	Mr, Ashok Chandak , President IESA
3	1st April,2026	Desbarta	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	06	N/A	24800	Mr, Ashok Chandak , President IESA
4	1st April,2026	Agami Orissa	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	04	N/A	25400	Mr, Ashok Chandak , President IESA
5	1st April,2026	Dharitri	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	18	N/A	39000	Mr, Ashok Chandak , President IESA
6	1st April,2026	Kalinga Mail	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	09	N/A	34800	Mr, Ashok Chandak , President IESA
7	1st April,2026	Manthan	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President,	10	N/A	23900	Mr, Ashok Chandak , President IESA

			IESA				
8	1st April,2026	Odisha Khabar	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	14	N/A	28000	Mr, Ashok Chandak , President IESA
9	1st April,2026	Orissa Times	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	06	N/A	25500	Mr, Ashok Chandak , President IESA
10	1st April,2026	Pratidin	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	12	N/A	32000	Mr, Ashok Chandak , President IESA
11	1st April,2026	Samaya	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	16	N/A	45000	Mr, Ashok Chandak , President IESA
12	1st April,2026	Sakala Sathi	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	07	N/A	20000	Mr, Ashok Chandak , President IESA
13	1st April,2026	Utkal Mail	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	11	N/A	38000	Mr, Ashok Chandak , President IESA
14	1st April,2026	Sakala	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	15	N/A	40000	Mr, Ashok Chandak , President IESA
15	1st April,2026	Utkal Samaja	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	08	N/A	32000	Mr, Ashok Chandak , President IESA
16	1st April,2026	Swatantra Barta	Design Competency and Quality Excellence: Critical to	07	N/A	30000	Mr, Ashok Chandak ,

			Scaling India's ECMS Vision- Ashok Chandak, President, IESA				President IESA
QUOTE IESA - Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision							
Print -Punjab							
1	3rd April,2026	Yugmarg	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	09	N/A		Mr, Ashok Chandak , President IESA
2	2nd April,2026	News Hunt	Crucial for Expanding India's ECMS Vision: Ashok Chandak, President, IESA	03	N/A		Mr, Ashok Chandak , President IESA
3	1st April,2026	Anant Gyan	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	13	N/A		Mr, Ashok Chandak , President IESA
4	1st April,2026	Aaj Samaj	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	03	N/A		Mr, Ashok Chandak , President IESA
5	1st April,2026	Hariyana News	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	03	N/A		Mr, Ashok Chandak , President IESA
6	1st April,2026	BPN Times	Extremely Important for Expanding India's ECMS Vision — Ashok Chandak, President, IESA	05	N/A		Mr, Ashok Chandak , President IESA
7	1st April,2026	Democratic Front	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA	02	N/A		Mr, Ashok Chandak , President IESA

8	1st April,2026	Punjab Headlines	Very important to expand India's ECMS vision - Ashok Chandak, President, IESA	06	N/A		Mr, Ashok Chandak , President IESA
9	1st April,2026	Punjab Times	Design Competency and Quality Excellence: Critical to Scaling India's ECMS	06	N/A		Mr, Ashok Chandak , President IESA

QUOTE IESA - Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision

Print - Bengaluru

1	5th April,2026	Tamil Sudar	Design Prowess and Quality Excellence : Essential for Expanding the ECMS Vision	03	N/A		Mr, Ashok Chandak , President IESA
2	4th April,2026	Malai Thamizhagam	Essential to expanding India's ECM vision	04	N/A		Mr, Ashok Chandak , President IESA
3	4th April,2026	News Today	Design Excellence and Quality Excellence: Essential for Expanding the ECMS Vision!	03	N/A		Mr, Ashok Chandak , President IESA
4	3rd April,2026	Southern Mail	Essential to expand India's ECMS vision; IESA President Ashok Chandak, statement	02	N/A		Mr, Ashok Chandak , President IESA
5	3rd April,2026	Evening Tamilnadu	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision	03	N/A		Mr, Ashok Chandak , President IESA
6	3rd April ,2026	Trinity Mirror	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision	03	N/A		Mr, Ashok Chandak , President IESA
7	3rd April 2026	Dinakural	Essential to expand India's ECMS vision; IESA President Ashok Chandak, statement	05	N/A		Mr, Ashok Chandak , President IESA
8	3rd April 2026	Southern Mail	Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision	02	N/A		Mr, Ashok Chandak , President IESA

QUOTE IESA - Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision

Online - Bengaluru

1	3rd	Corpwhizz	Design And Quality To Power	N/A	Link		Mr, Ashok
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	April,2026		India's ECMS-Led Electronics Growth: IESA – Corpwhizz				Chandak , President IESA
QUOTE IESA - Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision							
Online - National							
1	30th March,2026	Punjab Kesari	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
2	30th March,2026	Bollywood Country	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
3	30th March,2026	Lokmattimes	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
4	30th March,2026	SME Times	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
5	30th March,2026	The Hawk	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
6	30th March,2026	Ten News	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
7	30th March,2026	The New Kerala	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
8	30th March,2026	Prolerala	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
9	30th March,2026	DQ India	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
10	30th March,2026	Newsgram	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
11	30th March,2026	Social News	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA

12	30th March,2026	Globalbiznewsroom	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
13	30th March,2026	Mediaprismcreative	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
14	30th March,2026	Businessnewschronicle	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA
15	30th March,2026	Businessnewsforprofit	Industry hails centres push on design quality as ecms gains pace	N/A	Link		Mr, Ashok Chandak , President IESA

S.NO	Date	Publication	Headline	Page No	Link	AVE	Quote By
IESA Hails Kaynes Semicon Inauguration							
Print - Bhubaneswar							
1	2nd April,2026	Amrut Dunia	Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	12	N/A	27000	Mr.Ashok Chandak,President IESA and SEMI
2	2nd April,2026	Orissa Times	Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	06	N/A	35500	Mr.Ashok Chandak,President IESA and SEMI
3	2nd April,2026	Dharitri	India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	18	N/A	31000	Mr.Ashok Chandak,President IESA and SEMI
4	2nd April,2026	Biswabani	Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	05	N/A	32000	Mr.Ashok Chandak,President IESA and SEMI
5	2nd	Kalinga Mail	Ashok Chandak, President, IESA	09	N/A	36000	Mr.Ashok

	April,2026		and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey				Chandak,Pre sident IESA and SEMI
6	2nd April,2026	Manthan	Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	04	N/A	28000	Mr.Ashok Chandak,Pre sident IESA and SEMI
7	2nd April,2026	Swatantra Barta	Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	10	N/A	37500	Mr.Ashok Chandak,Pre sident IESA and SEMI
8	2nd April,2026	Odisha Khabar	Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	03	N/A	38000	Mr.Ashok Chandak,Pre sident IESA and SEMI
9	2nd April,2026	Samaya	Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	15	N/A	30000	Mr.Ashok Chandak,Pre sident IESA and SEMI
10	2nd April,2026	Pratidin	Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	11	N/A	24000	Mr.Ashok Chandak,Pre sident IESA and SEMI
11	2nd April,2026	Utkal Samaja	Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	12	N/A	33000	Mr.Ashok Chandak,Pre sident IESA and SEMI
12	2nd April,2026	Sakala	Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's	16	N/A	31800	Mr.Ashok Chandak,Pre sident IESA and SEMI

			Semiconductor Execution Journey				
13	2nd April,2026	Utkal Mail	Ashok Chandak, President, IESA and SEMI India- IESA Hails Keynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	13	N/A	32000	Mr.Ashok Chandak,President IESA and SEMI

IESA Hails Keynes Semicon Inauguration

Print - Guwahati

1	5th April,2026	Sentinel	IESA calls the inaugural Keynes Semicon a milestone in India's semiconductor implementation journey	08	N/A		Mr.Ashok Chandak,President IESA and SEMI
2	3rd April,2026	The Hills Times	IESA hails Keynes Semicon facility as milestone in India's semiconductor push	02	N/A		Mr.Ashok Chandak,President IESA and SEMI
3	2nd April,2026	The North East Times	IESA hails Keynes Semicon inauguration as landmark in India's semiconductor execution journey	02	N/A		Mr.Ashok Chandak,President IESA and SEMI
4	2nd April,2026	The Meghalaya Guardian	IESA hails Keynes Semicon inauguration as landmark in India's semiconductor execution journey	08	N/A		Mr.Ashok Chandak,President IESA and SEMI
5	2nd April,2026	The Assam Post	IESA hails Keynes Semicon inauguration as landmark in India's semiconductor execution journey	09	N/A		Mr.Ashok Chandak,President IESA and SEMI
6	2nd April,2026	Dainik Batori	Keynes Chemicon's inaugural address at IESA	06	N/A		Mr.Ashok Chandak,President IESA and SEMI
7	1st April,2026	Purvanchal Prahari	IESA opens Cannes Semicon Described as a symbol of India's progress	06	N/A		Mr.Ashok Chandak,President IESA and SEMI

IESA Hails Kaynes Semicon Inauguration**Print - Bengaluru**

1	4th April,2026	Vishwavani	Kaynes Semicon Milestone for Semiconductor	03	N/A	14200	Mr.Ashok Chandak,Pre sident IESA and SEMI
2	4th April,2026	Echara Vani	IESA hails inauguration of Keynes Semicon as a milestone in India's semiconductor implementation journey	02	N/A		Mr.Ashok Chandak,Pre sident IESA and SEMI
3	3rd April,2026	Sanje express	Keynes Semicon inauguration a milestone in India's semiconductor implementation journey: IESA	03	N/A	1400	Mr.Ashok Chandak,Pre sident IESA and SEMI
4	4th April,2026	Kalabandu	IESA hails inauguration of Keynes Semicon as a milestone in India's semiconductor implementation journey	03	N/A	11000	Mr.Ashok Chandak,Pre sident IESA and SEMI
5	4th April,2026	Suvarna Times of Karnataka	Kaynes Semicon inaugurates India's semiconductor implementation journey	02	N/A	19000	Mr.Ashok Chandak,Pre sident IESA and SEMI
6	4th April,2026	Sanjemitra	IESA hails inauguration of Keynes Semicon as a milestone in India's semiconductor implementation journey	04	N/A	10000	Mr.Ashok Chandak,Pre sident IESA and SEMI

IESA Hails Kaynes Semicon Inauguration**Online - Bengaluru**

1	2nd April,2026	Vicharavisthara	Inauguration of Cannes Semicon a major milestone in India's semiconductor journey: IESA	N/A	Link		Mr.Ashok Chandak,Pre sident IESA and SEMI
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IESA Hails Kaynes Semicon Inauguration**Online - National**

1	31st March,2026	Businessnewsthis week	IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
2	31st March,2026	Hellokotpad	IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
3	31st March,2026	Businessnews matters	IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
4	31st March,2026	Meidexpress24	IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
5	31st March,2026	Businessnewsfor profit	IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
6	31st March,2026	CXO Today	IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
7	31st March,2026	Electronicsbuzz	IESA Celebrates Kaynes Semicon Inauguration as Milestone in India's Semiconductor Journey		Link		Mr.Ashok Chandak,President IESA and SEMI
8	31st March,2026	Timestech	IESA Celebrates Kaynes Semicon Inauguration as Milestone in India's Semiconductor Journey	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI
9	31st March,2026	BusinessToday	PM Modi inaugurates Rs 3,300 crore Kaynes semiconductor plant in Gujarat	N/A	Link		Mr.Ashok Chandak,President IESA and SEMI

10	31st March,2026	DqIndia	IESA Celebrates Kaynes Semicon Inauguration as Milestone in India's Semiconductor Journey	N/A	Link		Mr.Ashok Chandak,Pre sident IESA and SEMI
11	31st March,2026	Digital Terminal	IESA Highlights Kaynes Semicon Plant as Key Step Toward Scalable Semiconductor Manufacturing in India	N/A	Link		Mr.Ashok Chandak,Pre sident IESA and SEMI
12	31st March,2026	Outlook Business	PM Modi Inaugurates India's Second Semiconductor Plant, Kaynes Semicon Begins Operations	N/A	Link		Mr.Ashok Chandak,Pre sident IESA and SEMI

INDUSTRY STORY
PRINT

Date	1st May
Publication	Hindu Business Line
Quote By	Ashok Chandak

Smartphone prices face year-long spike amid memory chip shortfall, say experts

PRICE ESCALATION. Component cost inflation impacting affordability and extending replacement cycles

S Ronendra Singh
New Delhi

The Indian smartphone market is entering into one of its most challenging phases in recent years, with shipments projected to decline 10-13 per cent in calendar year (CY) 2026 — marking the steepest contraction since 2022, due to sustained component cost inflation, led by a sharp surge in memory prices, industry veterans have said.

The shortage is materially impacting affordability and extending replacement cycles, they said, adding that the price escalation is expected to continue for the next one year and hit low-end mobile phones the most.

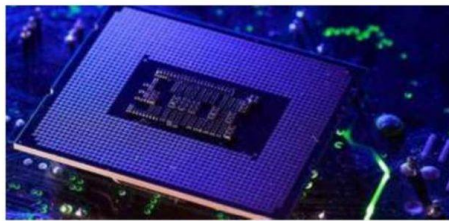
IMPORT DUTY

Experts said the government can also do nothing about it because import duty is already zero for such items and they cannot force any global company to supply more into the country.

“Driven by strong artificial intelligence (AI) demand and superior margins, memory manufacturers are increasingly allocating capacity toward high-bandwidth memory (HBM), tightening supply for conventional dynamic random access memory (DRAM) and NAND (memory chips that retain data without power)... We are already seeing this reflect in pricing trends — DRAM prices have firmed up sharply and are expected to remain elevated, while HBM continues to command a significant premium due to constrained supply,” Ashok Chandak, President, India Electronics and Semiconductor Association (IESA), told *businessline*.

CAPACITY TIGHTNESS

In the near term, capacity tightness is likely to persist through 2026, particularly in advanced nodes and packaging, with gradual easing expected only as new investments come online over the next two-three years, he said.



SUPPLY SQUEEZE. In the near term, capacity tightness is likely to persist through 2026

“As a result, the memory market is clearly bifurcating — HBM is seeing premium, AI-led demand, while conventional memory is becoming tighter and more expensive. This is beginning to impact entry-level consumer devices, where OEMs are recalibrating configurations and pricing. Importantly, this is leading to production optimisation rather than production cuts. OEMs and EMS players are actively adjusting product mix, sourcing strategies and cost structures, with no widespread reduction in manu-

facturing,” Chandak added.

Similarly, Pankaj Mohindroo, Chairman, India Cellular & Electronics Association (ICEA), said that the global memory industry is undergoing a structural reconfiguration, with production capacity increasingly gravitating towards AI and data centre applications.

“For the Indian mobile phone market, this is likely to weigh on near-term volumes, particularly in the entry and mid-tier segments, as the cost impact moves through the supply chain. That said, as supply dynam-

ics normalise and manufacturing efficiencies improve, we remain confident in the sector’s resilience and long-term growth trajectory,” Mohindroo told *businessline*.

According to CyberMedia Research (CMR), with memory now accounting for 20-25 per cent of the bill of materials, average smartphone prices are expected to rise by around 25 per cent, placing disproportionate pressure on entry-level and value-for-money segments.

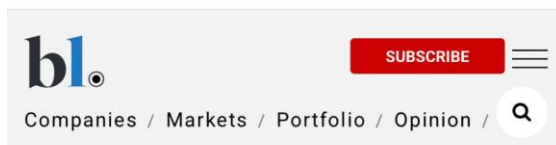
PROTECTING MARGINS

“These segments are bearing the brunt of the slowdown, as brands increasingly pivot toward premium-led growth and tighter portfolio execution to protect margins. At the same time, this environment creates a strategic opening for players with strong supply chain capabilities and agile cost management to compete effectively in the value segment,” Prabhu Ram, Vice-President of the Industry Research Group, CMR, said.

INDUSTRY STORY
ONLINE

Date	1st May
Publication	The Hindu Business Line
Link	https://www.thehindubusinessline.com/news/memory-chip-shortage-to-impact-smartphone-prices-for-next-1-year-industry-experts/article70925030.ece

thehindubusinessline.com



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Capacity tightness

In the near term, capacity tightness is likely to persist through 2026, particularly in advanced nodes and packaging, with gradual easing expected only as new investments come online over the next two-three years, he said.

“As a result, the memory market is clearly bifurcating — HBM is seeing premium, AI-led demand, while conventional memory is becoming tighter and more expensive. This is beginning to impact entry-level consumer devices, where OEMs are recalibrating configurations and pricing. Importantly, this is leading to production optimisation rather than production cuts. OEMs and EMS players are actively adjusting product mix, sourcing strategies and cost structures, with no widespread reduction in manufacturing,” Chandak added.

CONTINUE READING AFTER THIS AD



**EXCLUSIVE INTERACTION
NEW AGE**

Date	30th April
Publication	Forbes India / News 18
Quote By	Ashok Chandak



INDUSTRY STORY
PRINT

Date	30th April
Publication	Business Standard
Quote By	Ashok Chandak

Electronics makers to cut output by 10-20% amid memory chip squeeze

GULVEEN AULAKH
New Delhi, 29 April

A shortage in the supply of memory chips used in electronics manufacturing is forcing original equipment manufacturers (OEMs) and electronics manufacturing services (EMS) firms in India to recalibrate production, with some players cutting output by 10-20 per cent for the remainder of the year.

The shortage is affecting the production of smartphones, televisions, servers, set-top boxes and routers, as manufacturers grapple with both rising costs and tightening availability of memory components.

"Most consumer electronics

MEMORY CHIP PRICES HAVE SURGED 4-5 TIMES IN THE PAST FEW QUARTERS, PROMPTING REDUCED PRODUCTION OF ENTRY-LEVEL DEVICES



categories are being impacted. Mobile phones will be hit the hardest, followed by personal computers, servers and set-top boxes. Other consumer electronics such as TVs, and even automotive-grade memory availability, are also facing shortages," said Tarun Pathak, research director at Counterpoint Research. "Overall, production estimates will decline by 10-15 per cent in volumes across consumer

electronics categories, with manufacturing taking an equivalent hit," he added.

Memory chip prices have surged four to five times over the past few quarters, prompting several manufacturers to reduce production of entry-level devices and redirect capacity towards premium products with higher average selling prices (ASP) in an attempt to protect margins.

"Rather than implementing outright production stops, OEMs are responding through a 'survival of the premium' strategy, using configuration adjustments, tighter cost controls and price increases to offset shrinking margins," said Ashok Chandak, president of the Indian Electronics and Semiconductor Association (IESA).

Turn to Page 9

Electronics makers to cut output by 10-20%

"This shift is forcing a market recalibration where low-margin models are being quietly phased out or production cuts are being implemented, leaving consumers to either pay an 'AI tax' for new hardware or extend the life-cycle of their current devices to a record-breaking four or five years," he said.

Chandak added that the entry-level consumer electronics market was facing acute pressure as memory costs now account for nearly 25 per cent of the total bill of materials, effectively squeezing the viability of low-end smartphones and sub-\$500 laptops.

Mahendra Nabata, managing director of telecom equipment maker HFCL, said: "Memory availability is impacting all telecom and IT products. Since we make our routers fully in-house, we're arranging alternate supplies from multiple OEMs for memory components. For now, we have secured availability for the next six to eight months."

Industry executives said the disruption is unlikely to ease soon. Global memory manufacturers are increasingly prioritising production of high-bandwidth memory (HBM) chips used in artificial intelligence workloads, reducing capacity for conventional DRAM and NAND memory chips and tightening supply further. HBM chips command gross margins of more than 60 per cent, making them significantly more lucrative for manufacturers than traditional memory products, according to industry insiders.

Analysts expect supply constraints and production cuts to persist through 2026 and 2027, with normalisation in memory

supplies unlikely before 2027. "This situation is not going away before the end of 2027 or early 2028. We do not see any respite from rising memory prices. OEMs manufacturing phones, PCs, servers and set-top boxes will be hit the hardest. In most of these categories, price hikes over the coming quarters could be around 30-25 per cent," Pathak said.

Market watchers said companies such as Apple and Samsung Electronics were expected to face fewer disruptions than smaller players because of their dedicated supply chains, long-term supplier contracts and stronger ability to absorb higher input costs or pass them on to consumers.

A Noida-based executive whose manufacturing operations have been directly affected by the shortage said the share of memory in the bill of materials had jumped from 7-10 per cent to nearly 35 per cent within the past four to six months, with little indication of relief through the rest of the year. That, the executive said, leaves manufacturers with little choice but to pass on higher costs to brands, which will ultimately translate into higher prices for consumers.

"Production is being reduced by at least 20 per cent across product lines whenever memory is used because the issue is no longer just pricing, but availability. Memory producers are locking in orders months in advance, but pricing is still being revised month to month. Earlier the concern was rising prices; now the challenge is simply ensuring memory is available for production," the executive said, requesting anonymity.

A senior executive at a

major EMS player in Delhi NCR said companies heavily exposed to IT hardware manufacturing would face greater disruption than diversified manufacturers. "Those making phones, laptops and servers will be under pressure to secure supplies. But companies with exposure to automotive, industrial and medical equipment manufacturing may see a more limited impact," the executive said.

Another senior executive at a leading EMS company in India said the industry was monitoring the situation closely. "It is a challenge. We have secured supplies for now, but we are watching develop-

ments carefully in case the situation escalates and begins to affect production cycles," he said, declining to be named.

Despite the anticipated decline in output volumes, executives said revenues may remain relatively protected as manufacturers prioritise memory allocation for higher-priced products. "Production volumes may decline, but the value generated by OEMs could remain intact. Memory chips will increasingly be prioritised for premium devices rather than low-cost or entry-level products," said Pankaj Mohindroo, chairman of the Indian Cellular and Electronics Association.

**PANEL DISCUSSION
ONLINE**

Date	29th April
Publication	Money control
Link	Future of Work Summit: Global Talent War? Why Geopolitics Is Shaping Jobs - YouTube



The image shows a YouTube video player interface. The video content features a man in a dark suit and blue tie speaking into a microphone. The background is a blue-lit stage with a network-like graphic. A logo for 'MINDOURE FUTURE OF WORK' is visible in the top right corner of the video frame. A dark blue banner at the bottom of the video frame contains the text 'Globalisation Of Work Enters A New Era'. Below the video frame, the video title 'Future of Work Summit: Global Talent War? Why Geopolitics Is Shaping Jobs' is displayed. The channel name 'moneycontrol' with a verified badge and '2.27M subscribers' is shown, along with a 'Subscribe' button. Interaction buttons for 'Like' (1), 'Dislike', 'Share', 'Save', 'Download', and a menu icon are also present.

**PANEL DISCUSSION
ONLINE**

Date	29th April
Publication	Money control
Link	https://www.moneycontrol.com/technology/talent-is-the-new-geopolitical-currency-why-india-may-win-the-next-global-race-for-skills-article-13903361.html

"Talent is the new geopolitical currency... supply chain resilience is now moving towards talent chain resilience," said Ashok Chandak, president of the Indian Electronics and Semiconductor Association, capturing the broader shift underway.

The idea that Indian professionals will simply return home en masse is, at best, premature.

"It's easier said than done," said Chandru Iyer, Deputy High Commissioner for Karnataka, pointing to lifestyle expectations, family considerations, and work culture differences that complicate relocation decisions.

The semiconductor gap

In electronics and semiconductors, the talent story is more nuanced.

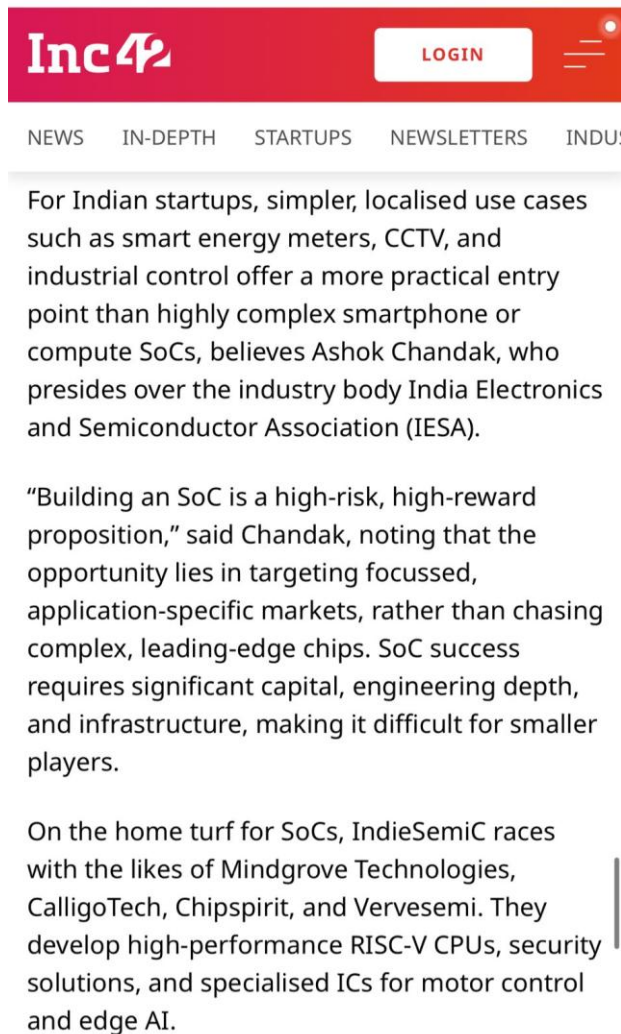
India already commands nearly 20 per cent of the global chip design talent pool, Chandak of IESA said. But manufacturing has long been a weak spot.

That gap is now being addressed through a wave of new projects. The model is straightforward: train talent abroad, bring it back, and build domestic capability through a "train-the-trainer" approach. "In a couple of years, we will see a major difference," Chandak said.



INDUSTRY STORY
ONLINE

Date	29th April
Publication	Inc 42
Link	https://inc42.com/startups/can-indiesemic-win-chinas-20-cent-chip-challenge-to-india/



The image shows a screenshot of a webpage header and the beginning of an article. The header is a red bar with the 'Inc42' logo on the left, a 'LOGIN' button in the center, and a hamburger menu icon on the right. Below the header is a navigation menu with links for 'NEWS', 'IN-DEPTH', 'STARTUPS', 'NEWSLETTERS', and 'INDUS'. The main text of the article discusses the challenges and opportunities for Indian startups in the SoC market, quoting Ashok Chandak, president of India Electronics and Semiconductor Association (IESA). The text mentions that simpler, localized use cases like smart energy meters and CCTV are more practical than complex smartphones or compute SoCs. It also notes that building a SoC is a high-risk, high-reward proposition and that IndieSemiC is competing with companies like Mindgrove Technologies, CalligoTech, Chipspirit, and Vervesemi.

Inc42 LOGIN

NEWS IN-DEPTH STARTUPS NEWSLETTERS INDUS

For Indian startups, simpler, localised use cases such as smart energy meters, CCTV, and industrial control offer a more practical entry point than highly complex smartphone or compute SoCs, believes Ashok Chandak, who presides over the industry body India Electronics and Semiconductor Association (IESA).

“Building an SoC is a high-risk, high-reward proposition,” said Chandak, noting that the opportunity lies in targeting focussed, application-specific markets, rather than chasing complex, leading-edge chips. SoC success requires significant capital, engineering depth, and infrastructure, making it difficult for smaller players.

On the home turf for SoCs, IndieSemiC races with the likes of Mindgrove Technologies, CalligoTech, Chipspirit, and Vervesemi. They develop high-performance RISC-V CPUs, security solutions, and specialised ICs for motor control and edge AI.

INDUSTRY STORY
PRINT

Date	16th April
Publication	Financial Express
Quote By	Ashok Chandak

From design to silicon IP

OWNING INTELLECTUAL PROPERTY IS KEY – BUT THE PATH IS LONG AND COMPLEX

SIDHAR CHOWDHARY

FOR DECADES, INDIA has been building capabilities in engineering services and chip design. Global majors such as Qualcomm and Intel have large R&D centres in Bangalore. The global semiconductor industry is now shifting its focus to India, with India engineers contributing to some of the world's most advanced chips. Yet, the ownership of these designs – the patents, architecture, and design rights – largely remains with the global majors.

This is the challenge IP owners face. While India has innovation but lacks the infrastructure to support intellectual property (IP) ownership. The building a domestic market, enabling more firms to own semiconductor value chains is left unattended, along with the strategic leverage it brings.

GROWTH DYNAMICS

IP ownership determines when firm value and influence is in the ecosystem. Manufacturing makes 5-10% of value, design and IP 20-30%, while the remainder is command over 50%.

ASHOK CHANDAK, Director, Lead, Design, India, Intel

India has good design talent, but much of it is channelled into short-term services revenue.

availability of system level architects and strategic academic institutions to collaborate.

Building IP is inherently capital intensive and uncertain. It requires either investment product think and a willingness to take risks, or risk and a willingness to take risks. Building this gap will need not just policy support, but a cultural shift in how innovation is funded and pursued.

Design will equally attract the India to new semiconductor IP market build a strong domestic market. Ashok Chandak, co-founder of IIC and IIC, founder, says that India now has the scale to design products for local markets, but lacks a sufficient number of system level architects and engineers. The industry needs to build a sufficient number of system level architects and engineers. The industry needs to build a sufficient number of system level architects and engineers.



ANIL KHOTLA, Director, Lead, Design, India, Intel

The domestic market is now large enough to enable the design of India-specific products at scale.

Scaling care the smart way

ACROSS HEALTHCARE SYSTEMS

globally, the convergence of digitalisation and automation is shifting from digitisation to intelligence. AI is no longer used for representation or isolated pilot programmes. It is increasingly becoming the operating backbone of modern healthcare delivery. Globally, healthcare organisations are moving toward AI-enabled transformation, where data is continuously translated into action. In fact, AI's value is being realised in concentrated areas.

Administrative efficiency: AI-enabled auto-coding of claims and automated patient registration reduce routine manual workload, allowing staff to focus more on patient-facing care.

Operational optimisation: AI-driven OT scheduling, bed allocation, and predictive inventory management are reducing wait times and reducing clinical waste.

Clinical augmentation: AI-enabled screening for early-stage cancer, and virtual scribe help reduce cognitive burden by prioritising high-risk cases and reducing routine care. Collectively, these interventions demonstrate that the value of AI in healthcare lies in augmenting human capability and not by displacing it. Also, patient-centricity is driving widespread adoption of AI-enabled services across the entire care journey. First, the adoption of AI-enabled services is being driven by a patient's medical condition and history. The clinical decision support is driven by the patient's condition, symptoms, and history.

TECH BYTES

Smart gear for safer workites

ITF INTERNATIONAL has developed a new line of smart workites. The smart workites are designed to be used in high-risk environments. They are designed to be used in high-risk environments. They are designed to be used in high-risk environments.

Consulting teams get a cockpit boost

TECH MASTERS is adopting SAP S/4HANA for its consulting teams. The adoption of SAP S/4HANA will help the consulting teams to manage their projects more effectively. The adoption of SAP S/4HANA will help the consulting teams to manage their projects more effectively.

Google rolls out AI tailored for users

GOOGLE HAS ROLLED OUT AI TAILORING for its search engine. The AI tailoring is designed to provide more relevant search results to users. The AI tailoring is designed to provide more relevant search results to users.

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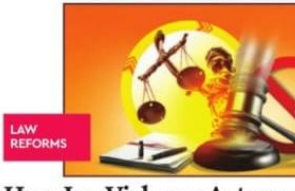
Google rolls out AI tailored for users

GOOGLE HAS ROLLED OUT AI TAILORING for its search engine. The AI tailoring is designed to provide more relevant search results to users. The AI tailoring is designed to provide more relevant search results to users.

Explainer

What is the Jan Vishwas Act?

THE JAN VISHWAS (AMENDMENT OF PROVISIONS) ACT, 2026 AMENDS THE PROVISIONS OF THE JAN VISHWAS ACT, 2016. THE ACT AMENDS THE PROVISIONS OF THE JAN VISHWAS ACT, 2016. THE ACT AMENDS THE PROVISIONS OF THE JAN VISHWAS ACT, 2016.



How Jan Vishwas Act promotes compliance over punishment

The Jan Vishwas (Amendment of Provisions) Act, 2026 changes the legal landscape by replacing jail terms and stiff fines for technical lapses & minor offences with lighter civil penalties. The shift away from excessive criminalisation will help create an enabling business environment, writes **Mahesh Jigata**.

How it builds on its 2023 namesake

THE ACT BUILDS ON THE JAN VISHWAS (AMENDMENT OF PROVISIONS) ACT, 2023. THE ACT BUILDS ON THE JAN VISHWAS (AMENDMENT OF PROVISIONS) ACT, 2023. THE ACT BUILDS ON THE JAN VISHWAS (AMENDMENT OF PROVISIONS) ACT, 2023.

Proportionate punishment

KEY FEATURES INCLUDE replacement of imprisonment with monetary penalties or warnings, gradual enforcement mechanism, including a one-year grace period for first-time offenders, and a reduction of fines and penalties in proportion to the nature of the offence. For first-time offenders, the Act provides for a one-year grace period for first-time offenders. The Act provides for a one-year grace period for first-time offenders.

Laws amended by this new Act

AMONG THE ACTS AMENDED ARE Reserve Bank of India Act, Life Insurance Corporation Act, Pension Fund Regulatory and Development Authority Act, Drug and Cosmetics Act, Food Safety and Standards Act, Chemicals Act, Motor Vehicle Act, New Delhi Municipal Council Act, Water Pollution Control Act, and the Information Act.

Key impact of decriminalised offences

- Regulatory reform:** The Act balances regulatory enforcement with a lenient approach.
- Investor confidence:** Reducing business regulations helps boost investor confidence and supports economic growth.
- Economic growth:** Minimising compliance burdens encourages economic growth, job creation, and employment.

How were the laws to be amended chosen?

MANY INDIAN LEGISLATIONS have not been amended in the last 50-60 years. The Jan Vishwas Act aims to amend these laws to create a more enabling business environment. The Jan Vishwas Act aims to amend these laws to create a more enabling business environment.

How were offences graded?

ONE OPTION WAS a division of any offence which is insignificant or redundant as per the assessment. The other was to replace imprisonment and fine with a civil penalty for the offence which was considered to be appropriate to be adjudicated through civil and not criminal proceedings. This step helps to create a more enabling business environment. The Jan Vishwas Act aims to amend these laws to create a more enabling business environment.

INDUSTRY STORY
ONLINE

Date	16th April
Publication	Financial Express
Link	https://www.financialexpress.com/life/technology/from-design-to-silicon-ip/4208609/

From design to silicon IP – The complex path of owning intellectual property

OWNING INTELLECTUAL PROPERTY IS KEY-BUT THE PATH IS LONG AND COMPLEX

Written by [Sudhir Chowdhary](#)

Updated: April 16, 2026 07:21 IST



Can India Reclaim the Richest Part of the

Can India Reclaim the Richest Part of the

For decades, India has built formidable strength in engineering services and chip design. Global majors – from Qualcomm to Intel – operate large R&D centres in Bengaluru, Hyderabad, and Noida. Indian engineers contribute to some of the world's most advanced chips. Yet, the ownership of those designs – the patents, architectures, and licensing rights – largely resides outside the country.

This is the imbalance that IT minister Ashwini Vaishnaw has repeatedly highlighted: India powers innovation, but does not always profit from it. Design services without intellectual property (IP) ownership are akin to leaving the most valuable part of the value chain on the table. In the semiconductor industry, IP ownership ultimately determines where long-term value, strategic leverage, and ecosystem resilience lie.

ALSO READ

[Entry-level hiring diversifies as AI roles gain ground](#)

To address this, the government has begun shifting its focus. Its push into semiconductor manufacturing – backed by initiatives such as the Design Linked Incentive (DLI) scheme – is aimed at promoting indigenous IP and moving beyond assembly-led participation. Yet beneath this policy momentum lies a more structural question: can India truly move from participation to ownership in the global semiconductor value chain?

The challenge is not one of talent. India has a vast pool of highly skilled engineers. The issue lies in how that talent is deployed. Much of it continues to be channelled into services-led models that prioritise predictable, short-term revenues over long-gestation innovation. "India must move beyond this comfort zone toward long-term wealth creation through product innovation, semiconductor IP, and India-owned brands," says Ashok Chandak, president of IESA and SEMI India.

EXCLUSIVE INTERVIEW
PRINT

Date	13th April
Publication	Dempa Digital
Quote By	Ashok Chandak

4/13/26, 1:09 PM 【IESAチャンダック会長に聞く】インド半導体、「政策」から実行へ 2030年に1000億ドル産業に飛躍 | 電波新聞デジタル

2026 Global Threat Report

MENU
電波新聞 SEMI DIGITAL

国際・総合 | 半導体 | 設備 | 産学連携 | 有料会員限定

2026.04.13

【IESAチャンダック会長に聞く】インド半導体、「政策」から実行へ 2030年に1000億ドル産業に飛躍



A・チャンダック会長

半導体産業の育成に向け、2021年12月に国家プロジェクト「インド半導体ミッション (ISM)」を打ち出したインド。半導体の一次消費地から、世界的な半導体・ディスプレイの製造拠点を転換を進めている。26年からは次の段階「ISM2.0」に入り、装置・材料・設計・サプライチェーンまでを包含するフルスタック型の政策へ移行する。30年には半導体だけで1000億ドル規模を目指す。インド電子・半導体産業協会 (IESA) 会長/SEMI India代表のアシーク・チャンダック氏に、現状と展望を聞いた。

市場拡大とサプライチェーン参画

— 急速にインドの半導体産業が進展しています。

チャンダック会長 確かに進展は速く、外国企業はインドを重要な投資先として捉えている。州政府も中央政府の政策に協力的になってきた。中央政府は次の段階としてスケールアップと実行を掲げており、関心は国内市場だけでなく、世界のサプライチェーンの一員になることへ移っている。

— 一年前にIESAが示した市場予測では、30年に半導体が電子産業の25%を占めています。

チャンダック会長 25年に610億ドルの市場規模が、30年には1030億ドルに拡大するとみている。需要をけん引してきたのは携帯端末で、23年は全体の49%を占めた。今後も高機能化に伴い需要は続く、ただし成長を持続させるには、製造と設計の両面で長期戦略と財政支援、国際協力、設計支援 (DfL)、サプライチェーン拡大、人材育成が不可欠だ。

設計に強み、弱点補完へ新組織

— 新部門「IDSPS」を設置した狙いは。

チャンダック会長 長期戦略を担う組織が必要との声を受け、設計・半導体・パッケージング・システムの4分野を統合した。インドは設計に強みがある一方、R&D (研究開発) や製造技術、パッケージングに課題がある。弱点を補い、成長を加速させる役割を担う。

— ISM1.0の成果は。

チャンダック会長 総額7600億ルピー、当時で約100億ドルの予算で推進した。中央政府で10件、州政府で4～5件のプロジェクトが承認されている。ファブ誘致が主めば、OSAT企業やインフラ、物流など関連産業が広がり、波及効果は大きい。



マイクロソンの組立工場を訪問したモディ首相 (中央)

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ISM ロゴマーク

— ISM1.0の成果は。

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https://dempa-digital.com/article/id712995 1/7

**EXCLUSIVE INTERVIEW
ONLINE**

Date	08th April
Publication	AEI
Link	https://aei.dempa.net/archives/34841 .

India Executes Semiconductor Policy Into Full-Stack Growth

In this exclusive interview, IESA and SEMI India President Ashok Chandak explains how policy momentum is translating into manufacturing reality, capital efficiency, and long-term ecosystem competitiveness—and why global chipmakers are starting to take India seriously now.

For many decades, India's role in the global semiconductor industry was anchored in its powerhouse engineering talent and design capabilities. Today, that role is deliberately evolving with the rise of domestic semiconductor fabs.

India is no longer positioning itself solely as a design hub or a large consumption market. Instead, it is undertaking a decisive transition towards a full-stack electronics and semiconductor ecosystem, carving its own relevance in global manufacturing and supply chains.

Thanks to sound government initiatives, such as the India Semiconductor Mission (ISM), Production Linked Incentives (PLI), and the Electronic Component Manufacturing Scheme (ECMS), India is now translating these policies into actual fabs, OSATs, components manufacturing facilities, and other infrastructure. The country's roadmap now emphasizes high volume semiconductor nodes, packaging, and other value addition activities while further leveraging its advanced capabilities in design, R&D, and IP creation.

**INDUSTRY STORY
ONLINE**

Date	08th April
Publication	Money Control
Link	https://www.moneycontrol.com/news/business/from-ism-1-0-to-2-0-how-india-plans-to-scale-its-semiconductor-ecosystem-13877750.html

Ashok Chandak, president of IESA and SEMI India, told Moneycontrol, "India's immediate focus should remain on commercially relevant nodes like 28nm and specialty technologies. At the same time, selective investments in advanced nodes will be important to stay aligned with future technology roadmaps." ISM 2.0 is likely to support advanced node readiness through strategic partnerships, R&D collaborations and pilot initiatives, ensuring alignment with long-term technological evolution without overextending near-term execution, he said.

The big picture



ISM 1.0 laid the foundation by moving India into execution mode and establishing a credible semiconductor ecosystem. ISM 2.0 is expected to scale and deepen this base, expanding into materials, equipment, design, and supply chains while strengthening India's global competitiveness.

"India is not chasing semiconductors as a short-term opportunity – this is a long-term nation-building effort. ISM 2.0 is expected to be about scale, depth, and global competitiveness," Chandak said.

Date	6th April
Publication	Akashvani
Link	https://www.youtube.com/watch?v=eZlOwFxnPA



Government's Commitment to Strengthen Semiconductor Ecosystem | 2 April 2026

IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging
PRINT - GUWAHATI

Date	24th April
Publication	Dainik Batori Kakot
Quote By	Ashok Chandak

আইইএছএ এ ডিজিএছৰ অগ্ৰগামী পদক্ষেপক ছেমিকণ্ডাক্টৰ পেকেজিঙত বহুৎ সামঞ্জস্য বুলি অভিহিত

গুৱাহাটী, ২৩ এপ্ৰিলঃ কেন্দ্ৰীয় মন্ত্ৰী অশ্বিনী বৈষ্ণৱ আৰু উৰিষ্যাৰ মুখ্যমন্ত্ৰী মোহন চৰণ মাজীৰ দ্বাৰা উদ্বোধন হোৱা ডিজিএচ চেমিকনৰ উন্নত পেকেজিং সুবিধাক ভাৰতৰ ইলেকট্ৰনিক্স আৰু ছেমিকণ্ডাক্টৰ এছ'চিয়েচনে স্বাগতম জনাই ইয়াক ছেমিকণ্ডাক্টৰ ক্ষেত্ৰত ভাৰতৰ উদ্দেশ্যৰ পৰা বাস্তৱ কৰণলৈ হোৱা যাত্ৰাৰ এক শক্তিশালী প্ৰদৰ্শনী বুলি চিহ্নিত কৰিছে। তি প্লাছ চলিউচনৰ হেটেৰ'জেনিয়াছ ইণ্টিগ্ৰেচন পেকেজিং ছলিউচন ইউনিটটোৱে উন্নত পেকেজিঙত এক গুৰুত্বপূৰ্ণ ক্ষমতা বৃদ্ধি সূচায়-বিশ্বজুৰি উন্নত প্ৰচেছ নোডসমূহৰ বাবে যিখন ক্ষেত্ৰ অতি গুৰুত্বপূৰ্ণ। আইইএছএ আৰু এছইএম আইইগুয়াৰ সভাপতি অশোক চাণ্ডাকে কয় যে, 'ছেমিকণ্ডাক্টৰৰ মূল্য শৃংখল শক্তিশালী কৰা, যোগান শৃংখল স্থিতি স্থাপকতা বৃদ্ধি কৰা, চিপলেট আৰু উন্নত পেকেজিঙত নতুনত্ব সমৰ্থন কৰা এই ব্যৱস্থাতোৱে ভাৰতক ছেমিকণ্ডাক্টৰৰ অংশগ্ৰহণৰ পৰা ছেমিকণ্ডাক্টৰৰ মূল্য আহৰণৰ দিশলৈ আগুৱাই লৈ যাব পাৰিব, আৰু পৰবৰ্তী প্ৰজন্মৰ ছেমিকণ্ডাক্টৰ প্ৰণালী একত্ৰীকৰণৰ দিশত ভাৰতৰ যাত্ৰা ত্বৰান্বিত কৰিব। ডিজাইন আৰু ইঞ্জিনিয়াৰিংৰ পৰা আৰম্ভ কৰি পেকেজিং আৰু প্ৰডাক্ট বাণিজ্যিকীকৰণৰ দিশত এক গুৰুত্বপূৰ্ণ উদ্যোগিক অংশীদাৰ হিচাপে ডিজিএছ চেমিকনৰ এই সফলতাই ভাৰতৰ

ছেমিকণ্ডাক্টৰ পৰিবেশৰ গভীৰতা আৰু পৰিপক্বতা বৃদ্ধি হোৱাটো প্ৰকাশ কৰে। এইটোও সূচায় যে, ভাৰত ডিজাইন নেতৃত্বৰ পৰা ছেমিকণ্ডাক্টৰৰ মূল্য শৃংখলৰ অন্তৰ্গত জটিল পণ্যসমূহৰ উৎপাদনৰ দিশত আগবাঢ়িছে। শেহ তীয়া ছেমিকণ্ডাক্টৰ পৰিকল্পনাসমূহৰ উদ্বোধনৰ পাছত এই বছৰত আৰু বহুতো পৰিকল্পনা আৰম্ভ কৰা হৈছে, যিটো মাইলষ্ট'নৰে মেইটী, আইএছএম আৰু সক্ৰিয় ৰাজ্য চৰকাৰসমূহৰ দ্বাৰা আগবঢ়োৱা শক্তিশালী নীতি সমন্বয় আৰু কাৰ্যকৰী গতিৰ প্ৰমাণ দিছে। শ্ৰীচাণ্ডাকে মন্তব্য কৰে যে, 'ভাৰতে বহুৎ পৰিসৰত ছেমিকণ্ডাক্টৰ কাৰ্য সম্পাদনৰ দিশত দ্ৰুতগতিত আগবাঢ়িছে বুলি বিশ্বজুৰি বিনিয়োগকাৰীসকলক এক স্পষ্ট সংকেত প্ৰেৰণ কৰিছে। যিটো সময়ত ভাৰতে ২০৩০ চনৰ ভিতৰত ৪০০ বিলিয়ন ডলাৰৰ ইলেকট্ৰনিক্স বজাৰ আৰু ১০৩ বিলিয়ন ডলাৰৰ ছেমিকণ্ডাক্টৰ বজাৰৰ দিশত আগবাঢ়িছে, সেই একেটা সময়তে ডিজিএছৰ দৰে উন্নয়নসমূহে দেখুৱাইছে যে মূল্য শৃংখলৰ সকলো দিশত দেশখনে গুৰুত্বপূৰ্ণ ক্ষমতা গঢ়ি তুলিছে। উৰিষ্যা এটা ছেমিকণ্ডাক্টৰ হাব হিচাপে বিকশিত হোৱা টোৱে মেক ইন ইণ্ডিয়াৰ দৃষ্টিভংগীক অধিক শক্তিশালী কৰিছে আৰু ভাৰতক বিশ্ব ছেমিকণ্ডাক্টৰৰ মানচিত্ৰত এক বিশ্বাসযোগ্য আৰু প্ৰতিযোগিতামূলক খেলুৱৈ হিচাপে প্ৰতিষ্ঠা কৰিছে।

Date	24th April
Publication	Pratah Khabar
Quote By	Ashok Chandak

सेमीकंडक्टर क्षेत्र में भारत की बड़ी छलांग ओडिशा में 3डीजीएस सेमीकॉन की उन्नत पैकेजिंग यूनिट शुरू

भुवनेश्वर, 23 अप्रैल। भारत ने उन्नत सेमीकंडक्टर पैकेजिंग में बड़ी छलांग लगाई है। केंद्रीय मंत्री अश्विनी वैष्णव और मुख्यमंत्री मोहन चरण माझी ने ओडिशा में 3डीजीएस सेमीकॉन की उन्नत पैकेजिंग सुविधा का उद्घाटन किया। आईईएसए ने इसे 'इरादे से अमल' की दिशा में बड़ी उपलब्धि बताया। 3डी ग्लास सॉल्यूशंस की यह हेटेरोजेनियस इंटीग्रेशन पैकेजिंग यूनिट चिपलेट और एडवांस्ड पैकेजिंग इनोवेशन को बढ़ावा देगी। आईईएसए अध्यक्ष अशोक चांडक ने कहा कि इससे भारत सेमीकंडक्टर सहभागिता से वैल्यू चेन की ओर बढ़ेगा। यह डिजाइन से लेकर पैकेजिंग और प्रोडक्ट कमर्शियलाइजेशन तक भारत के ईकोसिस्टम की परिपक्वता दिखाता है। भारत 2030 तक 400 अरब डॉलर के इलेक्ट्रॉनिक्स और 103 अरब डॉलर के सेमीकंडक्टर बाजार का लक्ष्य लेकर चल रहा है। ओडिशा का सेमीकंडक्टर हब के रूप में उभरना मेक इन इंडिया को मजबूती देगा।

Date	23rd April
Publication	The Assam Post
Quote By	Ashok Chandak

IESA hails 3DGS groundbreaking as India's big leap in advanced semiconductor packaging

Guwahati: The India Electronics and Semiconductor Association (IESA) welcomes the inauguration of 3DGS Semicon's advanced packaging facility in Odisha by Hon'ble Union Minister Shri Ashwini Vaishnaw and Hon'ble Chief Minister Shri Mohan Charan Majhi, calling it a strong demonstration of India's shift from intent to execution in semiconductors. The Heterogeneous Integration Packaging Solutions unit of 3D Glass Solutions marks a significant capability leap in advanced packaging—an area increasingly seen globally as critical as advanced process nodes. It can help India move from semiconductor participation to semiconductor value capture by strengthening the semiconductor value chain, enhancing supply chain resilience, supporting chiplet and advanced packaging innovation, and advancing India's journey toward next-generation semiconductor system integration, said Ashok Chandak, President, IESA and SEMI India. As a valued Industry player, 3DGS Semicon's achievement reflects the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialization. It signals that India is progressing beyond design leadership toward manufacturing sophisticated semiconductor products within the value chain. Following recent semiconductor project inaugurations and with additional projects expected this year, this milestone underscores the strong policy alignment and execution momentum driven by MeitY, ISM, and proactive state governments. It sends a clear signal to global investors that India is accelerating toward sustained, large-scale semiconductor execution, commented, Mr. Chandak. As India advances toward a \$400 billion electronics market and a \$103 billion semiconductor market by 2030, developments such as 3DGS demonstrate that the country is building critical capabilities across the value chain. Odisha's emergence as a semiconductor hub further strengthens the Make in India vision and positions India as a credible and competitive player in the global

semiconductor landscape. The India Electronics and Semiconductor Association (IESA) continues to play a pivotal role in shaping the growth trajectory of the country's fast-evolving electronics and semiconductor ecosystem, acting as a bridge between industry, government, academia, and global stakeholders to advance India's ambitions in high-tech manufacturing and design. As a premier industry body, IESA consistently works to strengthen the domestic ESDM sector by advocating enabling policies, encouraging investments, and supporting innovation-driven initiatives that enhance India's competitiveness in critical areas such as chip design, embedded systems, electronics manufacturing, display technology, automotive electronics, and emerging technologies including AI, IoT, and quantum computing. The association frequently collaborates with central and state governments to push for infrastructure development, talent skilling, and R&D support, recognizing that an integrated ecosystem is vital for India's semiconductor self-reliance. Its programs and reports provide strategic insights to industry players while fostering global partnerships aimed at attracting supply-chain players to set up operations in India. IESA also conducts flagship events, industry dialogues, and startup-focused initiatives to nurture innovation, connect entrepreneurs with investors, and showcase India's expanding capabilities on international platforms. Through these sustained efforts, the association has contributed significantly to creating an enabling environment for the semiconductor and electronics sector, particularly at a time when global supply-chain realignments and rising digital adoption are generating unprecedented opportunities for India. With a strong focus on accelerating local manufacturing, enhancing design leadership, and building future-ready talent, IESA remains committed to supporting India's aspiration to emerge as a trusted global hub for electronics and semiconductor innovation, investment, and production.

Date	21st April
Publication	Purvanchal Prahari
Quote By	Ashok Chandak

उन्नत सेमीकंडक्टर पैकेजिंग के क्षेत्र में भारत की बड़ी छलांग

नई दिल्ली : इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन (आईईएसए) ने केंद्रीय मंत्री अश्विनी वैष्णव और मुख्यमंत्री मोहन चरण माझी द्वारा ओडिशा में 3डीजीएस सेमीकॉन की उन्नत पैकेजिंग सुविधा के उद्घाटन का स्वागत किया है। उन्होंने इसे सेमीकंडक्टर उद्योग में इरादे से अमल की दिशा में भारत की महत्वपूर्ण उपलब्धि बताया है। 3डी ग्लास सॉल्यूशंस की हेटेरोजेनियस इंटीग्रेशन पैकेजिंग सॉल्यूशंस यूनिट एडवांस्ड पैकेजिंग में क्षमता के लिहाज से एक बड़ी छलांग है - यह एक ऐसा क्षेत्र है

जिसे दुनिया भर में एडवांस्ड प्रोसेस नोड्स जितना ही जरूरी माना जा रहा है। आईईएसए और सेमी इंडिया के प्रेसिडेंट अशोक चांडक ने कहा कि यह सेमीकंडक्टर वैल्यू चेन को मजबूत करके, सप्लाय चेन की मजबूती बढ़ाकर, चिपलेट और एडवांस्ड पैकेजिंग इनोवेशन को सहयोग करके और नेक्स्ट-जेनरेशन के सेमीकंडक्टर सिस्टम इंटीग्रेशन की ओर भारत के सफर को आगे बढ़ाकर भारत को सेमीकंडक्टर सहभागिता से सेमीकंडक्टर वैल्यू कैप्चर की ओर ले जाने में मदद कर सकता है।

Date	21st April
Publication	The North East Times
Quote By	Ashok Chandak

IESA hails 3DGS groundbreaking as India's big leap in advanced semiconductor packaging

NEW DELHI, APR 20: The India Electronics and Semiconductor Association (IESA) welcomes the inauguration of 3DGS Semicon's advanced packaging facility in Odisha by Union Minister Ashwini Vaishnaw and Chief Minister Mohan Charan Majhi, calling it a strong demonstration of India's shift from intent to execution in semiconductors.

The Heterogeneous Integration Packaging Solutions unit of 3D Glass Solutions marks a significant capability leap in advanced packaging—an area increasingly seen globally as critical as advanced process nodes. It can help India move from semiconductor participation to semiconductor value capture by strengthening the semiconductor value chain, enhancing supply chain resilience, supporting chiplet and advanced packaging innovation, and advancing India's journey toward next-generation semiconductor system integration, said Ashok Chandak, President, IESA and SEMI India.

As a valued Industry player, 3DGS Semicon's achievement reflects the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialization. It signals that India is progressing beyond design leadership toward manufacturing sophisticated semiconductor products within the value chain. Following recent semiconductor project inaugurations and with additional projects expected this year, this milestone underscores the strong policy alignment and execution momentum driven by MeitY, ISM, and proactive state governments. It sends a clear signal to global investors that India is accelerating toward sustained, large-scale semiconductor execution, commented, Chandak. As India advances toward a \$400 billion electronics market and a \$103 billion semiconductor market by 2030, developments such as 3DGS demonstrate that the country is building critical capabilities across the value chain.

Date	21st April
Publication	The Meghalaya Guardian
Quote By	Ashok Chandak

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Date	20th April
Publication	The Hills Times
Quote By	Ashok Chandak

3DGS facility signals semiconductor leap

HT Bureau

GUWAHATI, April 19: The India Electronics and Semiconductor Association has welcomed the inauguration of 3DGS Semicon's advanced semiconductor packaging facility in Odisha, describing it as a major step in India's transition from intent to execution in the semiconductor sector. The facility was inaugurated by Union Minister Ashwini Vaishnaw and Odisha Chief Minister Mohan Charan Majhi, marking a significant milestone in building domestic capabilities in advanced packaging technologies.

According to IESA, the Heterogeneous Integration

Packaging Solutions unit represents a crucial leap in an area that is increasingly considered as critical as semiconductor fabrication itself. The facility is expected to strengthen India's semiconductor value chain, improve supply chain resilience, and support innovation in chiplet-based architectures and next-generation system integration. Ashok Chandak, President of IESA and SEMI India, said the development reflects the growing maturity of India's semiconductor ecosystem, which is now expanding beyond design and engineering into packaging and product commercialisation.

**IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging
PRINT - BHUBANESWAR**

Date	20th April
Publication	Samaya
Quote By	Ashok Chandak

ଆଇଇଏସ୍ ପକ୍ଷରୁ ଗାଡ଼ିଜିଏସ୍‌ର ଶିଳାନିର୍ମାଣକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା

ଭୁବନେଶ୍ୱର, (ସବୁ୍ୟ): ଭାରତ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଏବଂ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସ୍) ମାନନୀୟ କେନ୍ଦ୍ର ମନ୍ତ୍ରୀ ଅଶ୍ୱିନୀ ବୈଷ୍ଣବ ଏବଂ ମାନନୀୟ ମୁଖ୍ୟମନ୍ତ୍ରୀ ମୋହନ ଚରଣ ମାଝୀଙ୍କ ଦ୍ୱାରା ଓଡ଼ିଶାରେ ଗାଡ଼ିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ଟର ଉନ୍ନତ ପ୍ୟାକେଜିଂ ସୁବିଧାର ଉଦଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟରରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁୟନ ଆଡ଼କୁ ଭାରତର ପରିବର୍ତ୍ତନର ଏକ ଦୃଢ଼ ପ୍ରଦର୍ଶନ ବୋଲି ଅଭିହିତ କରୁଛି। ଗାଡ଼ି ଗ୍ଲୋବ୍ ସଲ୍ୟୁସନ୍‌ର ହେଟେରୋଜେନିୟସ୍ ଇଂଟିଗ୍ରେସନ୍ ପ୍ୟାକେଜିଂ ସଲ୍ୟୁସନ୍ ଯୁନିଟ୍ ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କ୍ଷମତା ଭାବରେ ଚିହ୍ନିତ କରେ - ଏକ କ୍ଷେତ୍ର ଯାହା ବିଶ୍ୱ ସ୍ତରରେ ଉନ୍ନତ ପ୍ରକ୍ରିୟା ନୋଡ୍ ପରି ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଭାବରେ ଦେଖାଯାଉଛି। ଏହା ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ ଶୃଙ୍ଖଳକୁ ସୁଦୃଢ଼ କରି, ଯୋଗାଣ ଶୃଙ୍ଖଳ ସ୍ଥିରତା ବୃଦ୍ଧି କରି, ଚିପଲେଟ୍ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ନବସୃଜନକୁ ସମର୍ଥନ କରି ଏବଂ ପରବର୍ତ୍ତୀ ପିଢ଼ିର

ସେମିକଣ୍ଡକ୍ଟର ସିଷ୍ଟମ ସମନ୍ୱୟ ଆଡ଼କୁ ଭାରତର ଯାତ୍ରାକୁ ଆଗେଇ ନେଇ ଭାରତକୁ ସେମିକଣ୍ଡକ୍ଟର ଅଂଶଗ୍ରହଣରୁ ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ କ୍ୟାପଚରକୁ ସ୍ଥାନାନ୍ତର କରିବାରେ ସାହାଯ୍ୟ କରିପାରିବ ବୋଲି ଆଇଇଏସ୍ ସେମି ଇଣ୍ଡିଆର ସଭାପତି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି।

ଏକ ମୂଲ୍ୟବାନ ଶିକ୍ଷା ଖେଳାଳି ଭାବରେ, ଗାଡ଼ିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ଟର ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ଡିଜାଇନ୍ ଏବଂ ଇଞ୍ଜିନିୟରିଂ ଠାରୁ ପ୍ୟାକେଜିଂ ଏବଂ ଉତ୍ପାଦ ବାଣିଜ୍ୟାକରଣ ପର୍ଯ୍ୟନ୍ତ ବୃଦ୍ଧି ପ୍ରାପ୍ତ ହେବା ଗଭୀରତା ଏବଂ ପରିପକ୍ୱତାକୁ ପ୍ରତିଫଳିତ କରେ। ଏହା ସଙ୍କେତ ଦିଏ ଯେ ଭାରତ ମୂଲ୍ୟ ଶୃଙ୍ଖଳ ମଧ୍ୟରେ ଅତ୍ୟାଧୁନିକ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦ ନିର୍ମାଣ ଦିଗରେ ଡିଜାଇନ୍ ନେତୃତ୍ୱଠାରୁ ଆଗକୁ ବଢ଼ୁଛି। ସମ୍ପ୍ରତି ଅର୍ଦ୍ଧ ସେମିକଣ୍ଡକ୍ଟର ପ୍ରକଳ୍ପ ଉଦଘାଟନ ଏବଂ ଏହି ବର୍ଷ ଆଶା କରାଯାଉଥିବା ଅତିରିକ୍ତ ପ୍ରକଳ୍ପ ପରେ, ଏହି

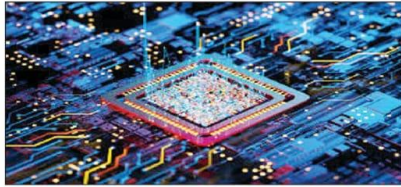
ମାଇଲଖୁଣ୍ଟ ଗରସଗ୍ରଣ, ଓଝଗ ଏବଂ ସକ୍ରିୟ ରାଜ୍ୟ ସରକାରଙ୍କ ଦ୍ୱାରା ପରିଚାଳିତ ଦୃଢ଼ ନୀତି ସମନ୍ୱୟ ଏବଂ କାର୍ଯ୍ୟାନୁୟନ ଗତିକୁ ଗୁରୁତ୍ୱାରୋପ କରେ। ଏହା ବିଶ୍ୱ ନିବେଶକମାନଙ୍କୁ ଏକ ସ୍ପଷ୍ଟ ସଙ୍କେତ ପଠାଏ ଯେ ଭାରତ ନିରନ୍ତର, ବଡ଼ ପରିମାଣର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁୟନ ଦିଗରେ ସ୍ୱରାଜିତ ହେଉଛି, ଶ୍ରୀ ଚଣ୍ଡକ ମନ୍ତ୍ରବ୍ୟ ଦେଇଛନ୍ତି। ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଆଡ଼କୁ ଅଗ୍ରସର ହେଉଥିବାରୁ, ଗାଡ଼ିଜିଏସ୍ ଭଳି ବିକାଶ ଦର୍ଶାଉଛି ଯେ ଦେଶ ମୂଲ୍ୟ ଶୃଙ୍ଖଳରେ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କ୍ଷମତା ନିର୍ମାଣ କରୁଛି। ଏକ ସେମିକଣ୍ଡକ୍ଟର ହବ୍ ଭାବରେ ଓଡ଼ିଶାର ଉଦୟ ମେକ୍ ଇନ୍ ଇଣ୍ଡିଆ ଦୃଷ୍ଟିକୋଣକୁ ଆହୁରି ମଜବୁତ କରେ ଏବଂ ବିଶ୍ୱ ଅର୍ଦ୍ଧ ସେମିକଣ୍ଡକ୍ଟର ଭୁବନେଶ୍ୱରରେ ଭାରତକୁ ଏକ ବିଶ୍ୱସନୀୟ ଏବଂ ପ୍ରତିଯୋଗିତାମୂଳକ ଖେଳାଳି ଭାବରେ ସ୍ଥାନିତ କରେ।

Date	20th April
Publication	Political and Business Daily
Quote By	Ashok Chandak

Page 4
20 Apr 2024
www.pbdodisha.in

the
political and business daily
www.pbdodisha.in

IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging



BHUBANESWAR: The India Electronics and Semiconductor Association (IESA) welcomes the inauguration of 3DGS Semicon's advanced packaging facility in Odisha by Union Minister Ashwini Vaishnaw and Chief Minister Mohan Charan

Majhi, calling it a strong demonstration of India's shift from intent to execution in semiconductors. The Heterogeneous Integration Packaging Solutions unit of 3D Glass Solutions marks a significant capability leap in advanced packaging—an

area increasingly seen globally as critical as advanced process nodes. It can help India move from semiconductor participation to semiconductor value capture by strengthening the semiconductor value chain, enhancing supply chain resilience, supporting chiplet and advanced packaging innovation, and advancing India's journey toward next-generation semiconductor system integration, said Ashok Chandak,

President, IESA and SEMI India. As a valued Industry player, 3DGS Semicon's achievement reflects the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialization. It signals that India is progressing beyond design leadership toward manufacturing sophisticated semiconductor products within the value

chain. Following recent semiconductor project inaugurations and with additional projects expected this year, this milestone underscores the strong policy alignment and execution momentum driven by MeitY, ISM, and proactive state governments. It sends a clear signal to global investors that India is accelerating toward sustained, large-scale semiconductor execution, commented Mr. Chandak.

As India advances toward a \$400 billion electronics market and a \$103 billion semiconductor market by 2030, developments such as 3DGS demonstrate that the country is building critical capabilities across the value chain. Odisha's emergence as a semiconductor hub further strengthens the Make in India vision and positions India as a credible and competitive player in the global semiconductor landscape.

Date	20th April
Publication	Darshan
Quote By	Ashok Chandak

ଆଇଇଏସ ପକ୍ଷରୁ ଗାଡ଼ିଜିଏସ୍‌ର ଶିଳାନ୍ୟାସକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା

ଭୁବନେଶ୍ୱର: ଭାରତ ଇଲେକ୍ଟ୍ରୋନିକ୍ ଏବଂ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସ) ମାନ୍ୟତା ଦେଇ ମହା ଶ୍ରୀ ଅଶ୍ୱିନୀ ବୈଷ୍ଣବ ଏବଂ ମାନ୍ୟତା ପ୍ରାପ୍ତ ଶ୍ରୀ ମୋହନ ଚରଣ ମାଝୀଙ୍କ ଦ୍ୱାରା ଓଡ଼ିଶାରେ ଗାଡ଼ିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ଟର ଉନ୍ନତ ପ୍ୟାକେଜିଂ ସୁବିଧାର ଉଦଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟରରେ ଉଦ୍ଦେଶ୍ୟରୁ ନିର୍ଦ୍ଧାରିତ ଆଡ଼କୁ ଭାରତର ପରିବର୍ତ୍ତନ ଏକ ବୃଦ୍ଧ ପଦକ୍ଷେପ ଭାବରେ ଅଭିହିତ କରୁଛି । ଗାଡ଼ି ଶ୍ରୀମତୀ ସଲ୍ୟୁସନ୍ସର ହେଡ଼ଓଫିସର ଇନ୍ ଇଣ୍ଡିଆ ଇଂଡିଗ୍ରେସନ୍ ପ୍ୟାକେଜିଂ ସଲ୍ୟୁସନ୍ସ ଯୁନିଟ୍ ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କ୍ଷମତା ଭାବରେ ଚିହ୍ନିତ କରେ - ଏକ କ୍ଷେତ୍ର ଯାହା ବିଶ୍ୱ ସ୍ତରରେ

ଉନ୍ନତ ପ୍ରକ୍ରିୟା ନୋଡ୍ ପରି ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଭାବରେ ଦେଖାଯାଇଛି । ଏହା ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ ଶୁଖିଳୁଥିବା ସୁଦୃଢ଼ କରି, ଯୋଗ୍ୟ ଶୁଖିଳୁଥିବା ବୃଦ୍ଧି କରି, ତିପ୍ପଲେଟ୍ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ନବସୃଜନକୁ ସମର୍ଥନ କରି ଏବଂ ପରବର୍ତ୍ତୀ ପିଢ଼ିର ସେମିକଣ୍ଡକ୍ଟର ସିଷ୍ଟମ ସମନ୍ୱୟ ଆଡ଼କୁ ଭାରତର ଯାତ୍ରାକୁ ଆଗେଇ ନେଇ ଭାରତରୁ ସେମିକଣ୍ଡକ୍ଟର ଅଂଶଗୁଡ଼ିକରୁ ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ ନ୍ୟାପତନକୁ ସ୍ଥାନାନ୍ତର କରିବାରେ ସାହାଯ୍ୟ କରିପାରିବ ବୋଲି ଆଇଇଏସ ସେମିକଣ୍ଡକ୍ଟର ସଭାପତି ଅଶୋକ ଚାଣ୍ଡକ୍ କହିଛନ୍ତି । ଏକ ମୂଲ୍ୟବାନ ଶିଳ୍ପ ଖେଳାଳି ଭାବରେ, ଗାଡ଼ିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ଟର ସମ୍ପର୍କରେ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇନୋଭେସନ୍ ଡିଭିଜନ୍

ଏବଂ ଇଉନିୟମିଂ ଠାରୁ ପ୍ୟାକେଜିଂ ଏବଂ ଉତ୍ପାଦ ବାଣିଜ୍ୟାଦିର ପର୍ଯ୍ୟନ୍ତ ବୃଦ୍ଧି ପାଇଥିବା ଗଭୀରତା ଏବଂ ପରିପତ୍ତୀକୁ ପ୍ରତିଫଳିତ କରେ । ଏହା ସମ୍ବଳିତ ବିଏ ସେ ଭାରତ ମୂଲ୍ୟ ଶୁଖିଳୁ ମଧ୍ୟରେ ଅତ୍ୟାଧୁନିକ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦ ନିର୍ମାଣ ବିଶେଷରେ ଡିଜାଇନ୍ ନେତୃତ୍ୱରେ ଆଗକୁ ବଢ଼ୁଛି । ସମ୍ପ୍ରତି ଅର୍ଦ୍ଧ ସେମିକଣ୍ଡକ୍ଟର ପ୍ରକଳ୍ପ ଉତ୍ପାଦନ ଏବଂ ଏହି ବର୍ଷ ଆଶା କରାଯାଉଥିବା ଅତିରିକ୍ତ ପ୍ରକଳ୍ପ ପରେ, ଏହି ମାଲଭାଗ୍ୟ ଗରବଞ୍ଚଣ, ଓଝର ଏବଂ ସକ୍ରିୟ ରାଜ୍ୟ ସରକାରଙ୍କ ଦ୍ୱାରା ପରିଚାଳିତ ବୃଦ୍ଧ ନୀତି ସମନ୍ୱୟ ଏବଂ ନିର୍ଦ୍ଧାରିତ ଗତିରୁ ଗୁରୁତ୍ୱରୋପ କରେ । ଏହା ବିଶ୍ୱ ନିବେଶନମାନଙ୍କୁ ଏକ ସ୍ୱଳ୍ପ ସମ୍ବଳିତ ପଠାଏ ଯେ ଭାରତ ନିଗତର, ବଡ଼

ପରିମାଣର ସେମିକଣ୍ଡକ୍ଟର ନିର୍ମାଣ ବିଶେଷରେ ଦୂରାନ୍ୱିତ ହେଉଛି, ଶ୍ରୀ ଚଣ୍ଡକ ମଧ୍ୟ ଦେଖିଛନ୍ତି । ୨୦୧୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ ବଜାର ଏବଂ ୧୦୧୧ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଆଡ଼କୁ ଅଗ୍ରସର ହେଉଥିବାରୁ, ଗାଡ଼ିଜିଏସ୍ ଉଚ୍ଚ ବିକାଶ ଦର୍ଶାଇଛି ଯେ ଦେଶ ମୂଲ୍ୟ ଶୁଖିଳୁରେ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କ୍ଷମତା ନିର୍ମାଣ କରୁଛି । ଏକ ସେମିକଣ୍ଡକ୍ଟର ହବ୍ ଭାବରେ ଓଡ଼ିଶାର ଉଦୟ ମେଢ଼ ଇନ୍ ଇଣ୍ଡିଆ ବୃଦ୍ଧିଦୋଷକୁ ଆହୁରି ମଜବୁତ କରେ ଏବଂ ବିଶ୍ୱ ଅର୍ଦ୍ଧ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତରୁ ଏକ ବିଶ୍ୱସନୀୟ ଏବଂ ପ୍ରତିଯୋଗିତାମୁକ୍ତ ଖେଳାଳି ଭାବରେ ସ୍ଥାନିତ କରେ ।

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Date	20th April
Publication	Indian Era
Quote By	Ashok Chandak

IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging

Bhubaneswar, (ENS): The India Electronics and Semiconductor Association (IESA) welcomes the inauguration of 3DGS Semicon's advanced packaging facility in Odisha by Hon'ble Union Minister Shri Ashwini Vaishnaw and Hon'ble Chief Minister Shri Mohan Charan Majhi, calling it a strong demonstration of India's shift from intent to execution in semiconductors.

The Heterogeneous Integration Packaging Solutions unit of 3D Glass Solutions marks a

significant capability leap in advanced packaging—an area increasingly seen globally as critical as advanced process nodes. It can help India move from semiconductor participation to semiconductor value capture by strengthening the semiconductor value chain, enhancing supply chain resilience, supporting chiplet and advanced packaging innovation, and advancing India's journey toward next-generation semiconductor system integration, said Ashok Chandak, President, IESA and SEMI India.



Date	20th April
Publication	Azad Sipahi
Quote By	Ashok Chandak

आइएसए ने 3डीजीएस के शिलान्यास को एडवांस्ड सेमीकंडक्टर पैकेजिंग में भारत की बड़ी छलांग बताया

आजाद सिपाही संवाददाता

भुवनेश्वर। इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन ने ओड़िशा में 3 सेमीकंडक्टर (चिप) से जुड़ी कंपनी/संस्था को एडवांस्ड पैकेजिंग सुविधा के उद्घाटन का स्वागत किया है। यह उद्घाटन केन्द्रीय मंत्री अश्विनी वैष्णव और मुख्यमंत्री मोहन चरण माझी द्वारा किया गया। आइएसए ने इसे सेमीकंडक्टर क्षेत्र में भारत के 'इरादे से क्रियान्वयन' की ओर बढ़ते कदम का एक सशक्त प्रमाण बताया है। 3 सेमीकंडक्टर (चिप) से जुड़ी कंपनी / संस्था की 'हेटेरोजेनस

इंटीग्रेशन पैकेजिंग सॉल्यूशंस' इकाई एडवांस्ड पैकेजिंग के क्षेत्र में क्षमताओं में एक महत्वपूर्ण छलांग की दशार्ती है—यह एक ऐसा क्षेत्र है जिसे अब वैश्विक स्तर पर एडवांस्ड प्रोसेस नोड्स जितना ही महत्वपूर्ण माना जाने लगा है। आइएसए और (विदेशी प्रत्यक्ष निवेश) के अध्यक्ष अशोक चंदक ने कहा कि यह इकाई भारत को सेमीकंडक्टर क्षेत्र में केवल भागीदारी करने से आगे बढ़कर 'सेमीकंडक्टर मूल्य-अर्जन' की ओर बढ़ने में मदद कर सकती है। ऐसा सेमीकंडक्टर मूल्य श्रृंखला को

मजबूत करके, आपूर्ति श्रृंखला की लचीलेपन को बढ़ाकर, चिपलेट और एडवांस्ड पैकेजिंग नवाचारों को समर्थन देकर, और अगली पीढ़ी के सेमीकंडक्टर सिस्टम एकीकरण की दिशा में भारत की यात्रा को आगे बढ़ाकर संभव होगा। एक प्रतिष्ठित उद्योग-जगत की कंपनी के तौर पर, 3 सेमीकंडक्टर (चिप) से जुड़ी कंपनी/ संस्था की यह उपलब्धि भारत के सेमीकंडक्टर इकोसिस्टम को बढ़ती गहराई और परिपक्वता की दशार्ती है—जिसमें डिजाइन और इंजीनियरिंग से लेकर पैकेजिंग और उत्पाद के

व्यावसायिकरण तक के सभी चरण शामिल हैं।

यह इस बात का संकेत है कि भारत अब केवल 'डिजाइन नेतृत्व' तक ही सीमित नहीं है, बल्कि वह मूल्य श्रृंखला के भीतर ही अत्याधुनिक सेमीकंडक्टर उत्पादों के निर्माण की दिशा में भी तेजी से आगे बढ़ रहा है। हाल ही में सेमीकंडक्टर परियोजनाओं के उद्घाटन और इस वर्ष अपेक्षित कुछ अन्य परियोजनाओं को देखते हुए, यह उपलब्धि और सक्रिय राज्य सरकारों द्वारा संचालित सशक्त नीतिगत तालमेल और क्रियान्वयन

की गति को रेखांकित करती है। चंदक ने टिप्पणी करते हुए कहा कि यह वैश्विक निवेशकों को एक स्पष्ट संकेत देता है कि भारत अब सेमीकंडक्टर क्षेत्र में निरंतर और बड़े पैमाने पर क्रियान्वयन की दिशा में तेजी से आगे बढ़ रहा है। जैसे-जैसे भारत 2030 तक \$400 बिलियन के इलेक्ट्रॉनिक्स बाजार और \$103 बिलियन के सेमीकंडक्टर बाजार के लक्ष्य की ओर बढ़ रहा है, बी3 जैसी पहलें यह साबित करती हैं कि देश अब पूरी मूल्य श्रृंखला में महत्वपूर्ण क्षमताओं का निर्माण कर रहा है।

Date	20th April
Publication	Agami Orissa
Quote By	Ashok Chandak

IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging

Bhubaneswar: The India Electronics and Semiconductor Association (IESA) welcomes the inauguration of 3DGS Semicon's advanced packaging facility in Odisha by Hon'ble Union Minister Shri Ashwini Vaishnaw and Hon'ble Chief Minister Shri Mohan Charan Majhi, calling it a strong demonstration of India's shift from intent to execution in semiconductors. The Heterogeneous Integration Packaging Solutions unit of 3D Glass Solutions marks a significant capability leap in advanced packaging-an area increasingly seen globally as critical as advanced process nodes. It can help India move from semiconductor participation to semiconductor value capture by strengthening the semiconductor value chain, enhancing supply chain resilience, supporting chiplet and advanced packaging innovation, and advancing India's journey toward next-generation semiconductor system integration, said Ashok Chandak, President, IESA and SEMI India.

Date	20th April
Publication	Amruta Dunia
Quote By	Ashok Chandak

ଆଇଇଏସ ପକ୍ଷରୁ ଗତିଜିଏସ୍‌ର ଶିଳାନିର୍ମାଣକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା

ଭୁବନେଶ୍ୱର : ଭାରତ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଏବଂ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସ) ମାନନୀୟ କେନ୍ଦ୍ର ମନ୍ତ୍ରୀ ଶ୍ରୀ ଅଶ୍ୱିନୀ ବୈଷ୍ଣବ ଏବଂ ମାନନୀୟ ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ମୋହନ ଚରଣ ମାଝୀଙ୍କ ଦ୍ୱାରା ଓଡ଼ିଶାରେ ଗତିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ଟର ଉନ୍ନତ ପ୍ୟାକେଜିଂ ସୁବିଧାର ଉଦଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟରରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁୟମ ଆଡ଼କୁ ଭାରତର ପରିବର୍ତ୍ତନର ଏକ ଦୃଢ଼ ପ୍ରଦର୍ଶନ ବୋଲି ଅଭିହିତ କରୁଛି । ଗତି ଗ୍ଲାସ୍ ସଲ୍ୟୁସନ୍‌ର ହେଟେରୋଜେନିୟସ୍ ଇଂଟିଗ୍ରେସନ୍ ପ୍ୟାକେଜିଂ ସଲ୍ୟୁସନ୍ ଯୁନିଟ୍, ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କ୍ଷମତା ଭାବରେ ଚିହ୍ନିତ କରେ - ଏକ କ୍ଷେତ୍ର ଯାହା ବିଶ୍ୱ ସ୍ତରରେ ଉନ୍ନତ ପ୍ରକ୍ରିୟା ନୋଡ୍ ପରି ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଭାବରେ ଦେଖାଯାଉଛି । ଏହା ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ ଶୃଙ୍ଖଳକୁ ସୁଦୃଢ଼ କରି, ଯୋଗାଣ ଶୃଙ୍ଖଳ ସ୍ଥିରତା ବୃଦ୍ଧି କରି, ଚିପଲୋଟ୍ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ନବସୃଜନକୁ ସମର୍ଥନ କରି ଏବଂ ପରବର୍ତ୍ତୀ ପିଢ଼ିର ସେମିକଣ୍ଡକ୍ଟର ସିଷ୍ଟମ ସମନ୍ୱୟ ଆଡ଼କୁ ଭାରତର ଯାତ୍ରାକୁ ଆଗେଇ ନେଇ ଭାରତକୁ ସେମିକଣ୍ଡକ୍ଟର ଅଂଶଗ୍ରହଣରୁ ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ କ୍ୟାପଚରକୁ ସ୍ଥାନାନ୍ତର କରିବାରେ ସାହାଯ୍ୟ କରିପାରିବ ବୋଲି ଆଇଇଏସ ସେମି ଇଣ୍ଡିଆର ସଭାପତି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	20th April
Publication	Dharitri
Quote By	Ashok Chandak

**ଆଇଇଏସ ପଞ୍ଜରୀ ପାଠିକିଏକା ଶିଳାମାସକୁ
 ଉନ୍ନତ ସେମିନାରକୁ ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ
 ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା**

ଭୁବନେଶ୍ୱର : ଭାରତ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଏବଂ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍, (ଆଇଇଏସ) ମାନନୀୟ କେନ୍ଦ୍ର ମନ୍ତ୍ରୀ ଶ୍ରୀ ଅଶ୍ୱିନୀ ଦେବିଙ୍କ ଏବଂ ମାନନୀୟ ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ନୋହନ ଚରଣ ମାଝୀଙ୍କ ଦ୍ୱାରା ଚତୁର୍ଥାରେ ପାଠିକିଏକା ସେମିନାରର ଉନ୍ନତ ପ୍ୟାକେଜିଂ ସୁବିଧାର ଉପସ୍ଥାପନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟରରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଆଡ଼କୁ ଭାରତର ପରିବର୍ତ୍ତନର ଏକ ଦୃଢ଼ ପ୍ରଦର୍ଶନ ବୋଲି ଅଭିହିତ କରୁଛି ।

ମାଟି ଗ୍ଲାସ୍ ସଲ୍ୟୁସନ୍ସର ହେଡ଼େକୋର୍ଡିନେଟିଭ୍ ଇଂଜିନିୟର, ପ୍ୟାକେଜିଂ ସଲ୍ୟୁସନ୍ସ ୟୁନିଟ୍, ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଏକ ଉତ୍ତରପୂର୍ଣ୍ଣ ଖମଡ଼ା ଭାବରେ ଚିହ୍ନିତ କରେ - ଏକ କ୍ଷେତ୍ର ଯାହା ବିଶ୍ୱ ଖରରେ ଉନ୍ନତ ପ୍ରକ୍ରିୟା ନୋଟ୍ ପରି ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଭାବରେ ଦେଖାଯାଇଛି । ଏହା ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ କ୍ଷୁଞ୍ଚନକୁ ସୁଦୃଢ଼ କରି, ଯୋଗାଣ କ୍ଷୁଞ୍ଚନ ସ୍ଥିରତା ଦୃଢ଼ କରି, ଚିପଲେଉଟ୍ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ନବସୃଜନକୁ ସମର୍ଥନ କରି ଏବଂ ପରବର୍ତ୍ତୀ ପିଢ଼ିର ସେମିକଣ୍ଡକ୍ଟର ସିଖମ ସମନ୍ୱୟ ଆଡ଼କୁ ଭାରତକୁ ଯାତ୍ରାକୁ ଆଗେଇ ନେଇ ଭାରତକୁ ସେମିକଣ୍ଡକ୍ଟର ଅଂଶଗ୍ରହଣରୁ ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ କମ୍ପ୍ୟାପଚରକୁ ସ୍ଥାନାନ୍ତର କରିବାରେ ସାହାଯ୍ୟ କରିପାରିବ ବୋଲି ଆଇଇଏସ ସେମି ଇଣ୍ଡିଆର ସଭାପତି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	20th April
Publication	Biswabani
Quote By	Ashok Chandak

IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging

Bhubaneswar: The India Electronics and Semiconductor Association (IESA) welcomes the inauguration of 3DGS Semicon's advanced packaging facility in Odisha by Hon'ble Union Minister Shri Ashwini Vaishnaw and Hon'ble Chief Minister Shri Mohan Charan Majhi, calling it a strong demonstration of India's shift from intent to execution in semiconductors. The Heterogeneous Integration Packaging Solutions unit of 3D Glass Solutions marks a significant capability leap in advanced packaging-an area increasingly seen globally as critical as advanced process nodes. It can help India move from semiconductor participation to semiconductor value capture by strengthening the semiconductor value chain, enhancing supply chain resilience, supporting chiplet and advanced packaging innovation, and advancing India's journey toward next-generation semiconductor system integration, said Ashok Chandak, President, IESA and SEMI India.

Date	20th April
Publication	Kalinga Mail
Quote By	Ashok Chandak

ଆଇଇଏସ ପକ୍ଷରୁ ଗତିଜିଏସ୍ ଶିଳାନିଧିକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା

ଭୁବନେଶ୍ୱର : ଭାରତ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଏବଂ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସ) ମାନନୀୟ କେନ୍ଦ୍ର ମନ୍ତ୍ରୀ ଶ୍ରୀ ଅଶ୍ୱିନୀ ବୈଷ୍ଣବ ଏବଂ ମାନନୀୟ ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ମୋହନ ଚରଣ ମାଝୀଙ୍କ ଦ୍ୱାରା ଓଡ଼ିଶାରେ ଗତିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ଟର ଉନ୍ନତ ପ୍ୟାକେଜିଂ ସୁବିଧାର ଉଦଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟରରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଆଡ଼କୁ ଭାରତର ପରିବର୍ତ୍ତନର ଏକ ଦୃଢ଼ ପ୍ରଦର୍ଶନ ବୋଲି ଅଭିହିତ କରୁଛି । ଗତି ଗ୍ଲୋସ୍ ସଲ୍ୟୁସନ୍ସର ହେଡ଼େଚରୋଜେନିୟସ୍ ଇଂଚିଗ୍ରେସନ୍ ପ୍ୟାକେଜିଂ ସଲ୍ୟୁସନ୍ସ ୟୁନିଟ୍, ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କ୍ଷମତା ଭାବରେ ଚିହ୍ନିତ କରେ - ଏକ କ୍ଷେତ୍ର ଯାହା ବିଶ୍ୱ ସ୍ତରରେ ଉନ୍ନତ ପ୍ରକ୍ରିୟା ନୋଡ୍ ପରି ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଭାବରେ ଦେଖାଯାଉଛି । ଏହା ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ ଶୃଙ୍ଖଳକୁ ସୁଦୃଢ଼ କରି, ଯୋଗାଣ ଶୃଙ୍ଖଳ ସ୍ଥିରତା ବୃଦ୍ଧି କରି, ଟିପଲେଟ୍ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ନବସୃଜନକୁ ସମର୍ଥନ କରି ଏବଂ ପରବର୍ତ୍ତୀ ପିଢ଼ିର ସେମିକଣ୍ଡକ୍ଟର ସିଷ୍ଟମ ସମନ୍ୱୟ ଆଡ଼କୁ ଭାରତର ଯାତ୍ରାକୁ ଆଗେଇ ନେଇ ଭାରତକୁ ସେମିକଣ୍ଡକ୍ଟର ଅଂଶଗ୍ରହଣରୁ ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ କ୍ୟାପଚରକୁ ସ୍ଥାନାନ୍ତର କରିବାରେ ସାହାଯ୍ୟ କରିପାରିବ ବୋଲି ଆଇଇଏସ ସେମି ଇଣ୍ଡିଆର ସଭାପତି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	20th April
Publication	Ukal Mail
Quote By	Ashok Chandak

ଆଇଇଏସ ପକ୍ଷରୁ ଗାନ୍ଧିଜୀଙ୍କର ଶିଳାମାୟାକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା

ଭୁବନେଶ୍ୱର : ଭାରତୀୟ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂ ପ୍ରତିଷ୍ଠାପନ ହେତୁ ଭାରତୀୟ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂ ଉନ୍ନତ ହେବାର ସମ୍ଭାବନା ରହିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଉପକ୍ରମ ଭାବରେ ବିବେଚନା କରାଯାଇପାରେ - ଏହା ଶେଷରେ ଭାରତୀୟ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଏକ ପ୍ରମୁଖ ପଦକ୍ଷେପ ଭାବରେ ପରିଗଣିତ ହେବ। ଗାନ୍ଧିଜୀଙ୍କର ଶିଳାମାୟାକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା କରାଯାଉଛି ।

ଭାରତୀୟ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂ ଉନ୍ନତ ହେବାର ସମ୍ଭାବନା ରହିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଉପକ୍ରମ ଭାବରେ ବିବେଚନା କରାଯାଇପାରେ - ଏହା ଶେଷରେ ଭାରତୀୟ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଏକ ପ୍ରମୁଖ ପଦକ୍ଷେପ ଭାବରେ ପରିଗଣିତ ହେବ। ଗାନ୍ଧିଜୀଙ୍କର ଶିଳାମାୟାକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା କରାଯାଉଛି ।

Date	20th April
Publication	Odisha Khabar
Quote By	Ashok Chandak

ଆଇଇଏସ ପକ୍ଷରୁ ଗତିଜିଏସ୍ ଶିଳାମ୍ୟାସକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ତର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା

ଭୁବନେଶ୍ୱର : ଭାରତ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଏବଂ ସେମିକଣ୍ଡକ୍ତର ଆସୋସିଏସନ୍ (ଆଇଇଏସ) ମାନନୀୟ କେନ୍ଦ୍ର ମନ୍ତ୍ରୀ ଶ୍ରୀ ଅଶ୍ୱିନୀ ବୈଷ୍ଣବ ଏବଂ ମାନନୀୟ ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ମୋହନ ଚରଣ ମାଝୀଙ୍କ ଦ୍ୱାରା ଓଡ଼ିଶାରେ ଗତିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ତର ଉନ୍ନତ ପ୍ୟାକେଜିଂ ସୁବିଧାର ଉଦଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ତରରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁୟନ ଆଡ଼କୁ ଭାରତର ପରିବର୍ତ୍ତନର ଏକ ଦୃଢ଼ ପ୍ରଦର୍ଶନ ବୋଲି ଅଭିହିତ କରୁଛି । ଗତି ଗ୍ଲୋସ୍ ସଲ୍ୟୁସନ୍ସର ହେଡ଼େରୋଜେନିୟସ୍ ଇଂଟିଗ୍ରେସନ୍ ପ୍ୟାକେଜିଂ ସଲ୍ୟୁସନ୍ସ ୟୁନିଟ୍ ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କ୍ଷମତା ଭାବରେ ଚିହ୍ନିତ କରେ - ଏକ କ୍ଷେତ୍ର ଯାହା ବିଶ୍ୱ ସ୍ତରରେ ଉନ୍ନତ ପ୍ରକ୍ରିୟା ନୋଡ୍ ପରି ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଭାବରେ ଦେଖାଯାଉଛି । ଏହା ସେମିକଣ୍ଡକ୍ତର ମୂଲ୍ୟ ଶୃଙ୍ଖଳକୁ ସୁଦୃଢ଼ କରି, ଯୋଗାଣ ଶୃଙ୍ଖଳ ସ୍ଥିରତା ବୃଦ୍ଧି କରି, ଟିପଲେଟ୍ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ନବସୃଜନକୁ ସମର୍ଥନ କରି ଏବଂ ପରବର୍ତ୍ତୀ ପିଢ଼ିର ସେମିକଣ୍ଡକ୍ତର ସିଷ୍ଟମ ସମନ୍ୱୟ ଆଡ଼କୁ ଭାରତର ଯାତ୍ରାକୁ ଆଗେଇ ନେଇ ଭାରତକୁ ସେମିକଣ୍ଡକ୍ତର ଅଂଶଗ୍ରହଣରୁ ସେମିକଣ୍ଡକ୍ତର ମୂଲ୍ୟ କ୍ୟାପଚରକୁ ସ୍ଥାନାନ୍ତର କରିବାରେ ସାହାଯ୍ୟ କରିପାରିବ ବୋଲି ଆଇଇଏସ ସେମି ଇଣ୍ଡିଆର ସଭାପତି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	20th April
Publication	Orissa Times
Quote By	Ashok Chandak

IESA Hails 3DGS Ground breaking as India's Big Leap in Advanced Semiconductor Packaging

Bhubaneswar: The India Electronics and Semiconductor Association (IESA) welcomes the inauguration of 3DGS Semicon's advanced packaging facility in Odisha by Hon'ble Union Minister Shri Ashwini Vaishnaw and Hon'ble Chief Minister Shri Mohan Charan Majhi, calling it a strong demonstration of

India's shift from intent to execution in semiconductors. The Heterogeneous Integration Packaging Solutions unit of 3D Glass Solutions marks a significant capability leap in advanced packaging-an area increasingly seen globally as critical as advanced process nodes. It can help India move from semiconductor

participation to semiconductor value capture by strengthening the semiconductor value chain, enhancing supply chain resilience, supporting chiplet and advanced packaging innovation, and advancing India's journey toward next-generation semiconductor system integration, said Ashok Chandak, President, IESA and SEMI India.

Date	20th April
Publication	Pratidin
Quote By	Ashok Chandak

ଆଇଇଏସ ପକ୍ଷରୁ ଗତିଜିଏସ୍ ଶିଳାନାମାକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ତର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା

ଭୁବନେଶ୍ୱର : ଭାରତ ଇଲେକ୍ଟ୍ରୋନିକ୍ ଏବଂ ସେମିକଣ୍ଡକ୍ତର ଆସୋସିଏସନ୍ (ଆଇଇଏସ) ମାନନୀୟ କେନ୍ଦ୍ର ମନ୍ତ୍ରୀ ଶ୍ରୀ ଅଶ୍ୱିନୀ ବୈଷ୍ଣବ ଏବଂ ମାନନୀୟ ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ମୋହନ ଚରଣ ମାଝୀଙ୍କ ଦ୍ୱାରା ଓଡ଼ିଶାରେ ଗତିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ତର ଉନ୍ନତ ପ୍ୟାକେଜିଂ ସୁବିଧାର ଉଦଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ

ସେମିକଣ୍ଡକ୍ତରରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁୟମନ ଆଡ଼କୁ ଭାରତର ପରିବର୍ତ୍ତନର ଏକ ଦୃଢ଼ ପ୍ରଦର୍ଶନ ବୋଲି ଅଭିହିତ କରୁଛି। ଗତି ଗ୍ଲାସ୍ ସଲ୍ୟୁସନ୍ସର ହେଡ଼େଡ଼ୋକ୍ୱେଟିୟମ୍, ଇଂଡିଗ୍ରେସନ୍ ପ୍ୟାକେଜିଂ ସଲ୍ୟୁସନ୍ସ ୟୁନିଟ୍, ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କ୍ଷମତା ଭାବରେ ଚିହ୍ନିତ କରେ - ଏକ କ୍ଷେତ୍ର

ଯାହା ବିଶ୍ୱ ସ୍ତରରେ ଉନ୍ନତ ପ୍ରକ୍ରିୟା ନେତୃ ପରି ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଭାବରେ ଦେଖାଯାଉଛି। ଏହା ସେମିକଣ୍ଡକ୍ତର ମୂଲ୍ୟ ଶୃଙ୍ଖଳକୁ ସୁଦୃଢ଼ କରି, ଯୋଗାଣ ଶୃଙ୍ଖଳ ସୁରତା ଦୃଢ଼ କରି, ଚିପଲୋଟ୍ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ନବସୃଜନକୁ ସମର୍ଥନ କରି ଏବଂ ପରବର୍ତ୍ତୀ ପିଢ଼ିର ସେମିକଣ୍ଡକ୍ତର ସିଷମ ସମନ୍ୱୟ ଆଡ଼କୁ

ଭାରତର ଯାତ୍ରାକୁ ଆଗେଇ ନେଇ ଭାରତକୁ ସେମିକଣ୍ଡକ୍ତର ଅଂଶରୁ ହେଉ ସେମିକଣ୍ଡକ୍ତର ମୂଲ୍ୟ କ୍ୟାପଚରକୁ ସ୍ଥାନାନ୍ତର କରିବାରେ ସାହାଯ୍ୟ କରିପାରିବ ବୋଲି ଆଇଇଏସ ସେମିକଣ୍ଡକ୍ତରର ସଭାପତି ଅଶୋକ ଚାଣକ କହିଛନ୍ତି।

Date	20th April
Publication	Swatantra Barta
Quote By	Ashok Chandak

ଆଇଇଏସ ପକ୍ଷରୁ ଗାଡ଼ିଜିଏସ୍‌ର ଶିଳାନାମାସକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା

ଭୁବନେଶ୍ୱର : ଭାରତ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଏବଂ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସ) ମାନନୀୟ କେନ୍ଦ୍ର ମନ୍ତ୍ରୀ ଶ୍ରୀ ଅଶ୍ୱିନୀ ଦେବେ ଏବଂ ମାନନୀୟ ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ନେତ୍ରଜି ପଟ୍ଟନାୟକଙ୍କ ଦ୍ୱାରା ଓଡ଼ିଶାରେ ଗାଡ଼ିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ଟର ଉନ୍ନତ ପ୍ୟାକେଜିଂ ସୁବିଧାର ଉଦଘାଟନକୁ

ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟରରେ ଉଦ୍ୟୋଗ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଆଡ଼କୁ ଭାରତର ପରିବର୍ତ୍ତନର ଏକ ଦୃଢ଼ ପ୍ରଦର୍ଶନ ବୋଲି ଅଭିହିତ କରୁଛି । ଗାଡ଼ି ଗ୍ଲ୍ୟାସ୍ ସଲ୍ୟୁସନ୍‌ର ହେଟେରେ । କେନିୟସ୍ ଇଂଡିସ୍ଟ୍ରିସ୍ ପ୍ୟାକେଜିଂ ସଲ୍ୟୁସନ୍ ଯୁନିଟ୍, ଉନ୍ନତ

ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କ୍ଷମତା ଭାବରେ ଚିହ୍ନିତ କରେ - ଏକ କ୍ଷେତ୍ର ଯାହା ବିଶ୍ୱ ସ୍ତରରେ ଉନ୍ନତ ପ୍ରତିଯା ନୋଟ୍ ପରି ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଭାବରେ ଦେଖାଯାଉଛି । ଏହା ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ ଶୃଙ୍ଖଳକୁ ସୁଦୃଢ଼ କରି, ଯୋଗ୍ୟ ଶୃଙ୍ଖଳ ସ୍ଥିରତା ଦୃଷ୍ଟି କରି, ଟିପ୍ପରେ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ନବସୃଜନକୁ ସମର୍ଥନ

କରି ଏବଂ ପରବର୍ତ୍ତୀ ପିଢ଼ିର ସେମିକଣ୍ଡକ୍ଟର ବିକାଶ ସମନ୍ୱୟ ଆଡ଼କୁ ଭାରତର ଯାତ୍ରାକୁ ଆଗେଇ ନେଇ ଭାରତକୁ ସେମିକଣ୍ଡକ୍ଟର ଅଂଶସୂଚକରୁ ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ କ୍ୟାପଚରକୁ ସ୍ଥାନାନ୍ତର କରିବାରେ ସାହାଯ୍ୟ କରିପାରିବ ବୋଲି ଆଇଇଏସ ସେମିକଣ୍ଡକ୍ଟର ସଭାପତି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	20th April
Publication	Utkal Samaja
Quote By	Ashok Chandak

**ଆଇଇଏସ ପକ୍ଷରୁ ଗତିଜିଏସ୍‌ର
 ଶିଳାମ୍ୟାସକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ତର
 ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼
 ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା**

ଭୁବନେଶ୍ୱର : ଭାରତ
 ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଏବଂ
 ସେମିକଣ୍ଡକ୍ତର ଆସୋସିଏସନ୍
 (ଆଇଇଏସ) ମାନନୀୟ କେନ୍ଦ୍ର
 ମନ୍ତ୍ରୀ ଶ୍ରୀ ଅଶ୍ୱିନୀ ଦେବିଙ୍କ ଏବଂ
 ମାନନୀୟ ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ମୋହନ
 ଚରଣ ମାଝୀଙ୍କ ଦ୍ୱାରା ଓଡ଼ିଶାରେ
 ଗତିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ତର ଉନ୍ନତ
 ପ୍ୟାକେଜିଂ ସୁବିଧାର ଉଦଘାଟନକୁ
 ସ୍ୱାଗତ କରିଛି, ଏହାକୁ
 ସେମିକଣ୍ଡକ୍ତରରେ ଉଦ୍ୟୋଗରୁ
 କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଆଡ଼କୁ ଭାରତର
 ପରିବର୍ତ୍ତନର ଏକ ବୃହତ୍ ପ୍ରଦର୍ଶନ
 ବୋଲି ଅଭିହିତ କରୁଛି । ଗତି ଗ୍ଲୋବ୍
 ସଲ୍ୟୁସନ୍ସର ହେଡ଼େଓରୋକେନିୟସ୍
 ଇଂଟିଗ୍ରେସନ୍ ପ୍ୟାକେଜିଂ
 ସଲ୍ୟୁସନ୍ସ ୟୁନିଟ୍, ଉନ୍ନତ
 ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ
 କ୍ଷମତା ଭାବରେ ଚିହ୍ନିତ କରେ -
 ଏକ କ୍ଷେତ୍ର ଯାହା ବିଶ୍ୱ ସ୍ତରରେ
 ଉନ୍ନତ ପ୍ରକ୍ରିୟା ନୋଡ୍ ପରି
 ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଭାବରେ ଦେଖାଯାଉଛି ।
 ଏହା ସେମିକଣ୍ଡକ୍ତର ମୂଲ୍ୟ
 ଶୃଙ୍ଖଳକୁ ସୁଦୃଢ଼ କରି, ଯୋଗାଣ
 ଶୃଙ୍ଖଳ ସ୍ଥିରତା ବୃଦ୍ଧି କରି,
 ଚିପଲେଉଟ୍ ଏବଂ ଉନ୍ନତ
 ପ୍ୟାକେଜିଂ ନବସୃଜନକୁ ସମର୍ଥନ
 କରି ଏବଂ ପରବର୍ତ୍ତୀ ପିଢ଼ିର
 ସେମିକଣ୍ଡକ୍ତର ସିଷ୍ଟମ ସମନ୍ୱୟ
 ଆଡ଼କୁ ଭାରତର ଯାତ୍ରାକୁ ଆଗେଇ
 ନେଇ ଭାରତକୁ ସେମିକଣ୍ଡକ୍ତର
 ଅଂଶଗ୍ରହଣରୁ ସେମିକଣ୍ଡକ୍ତର ମୂଲ୍ୟ
 କ୍ୟାପଚରକୁ ସ୍ଥାନାନ୍ତର କରିବାରେ
 ସାହାଯ୍ୟ କରିପାରିବ ବୋଲି
 ଆଇଇଏସ ସେମି ଇଣ୍ଡିଆର
 ସଭାପତି ଅଶୋକ ଚାଣ୍ଡକ
 କହିଛନ୍ତି ।

Date	20th April
Publication	Lokakatha
Quote By	Ashok Chandak

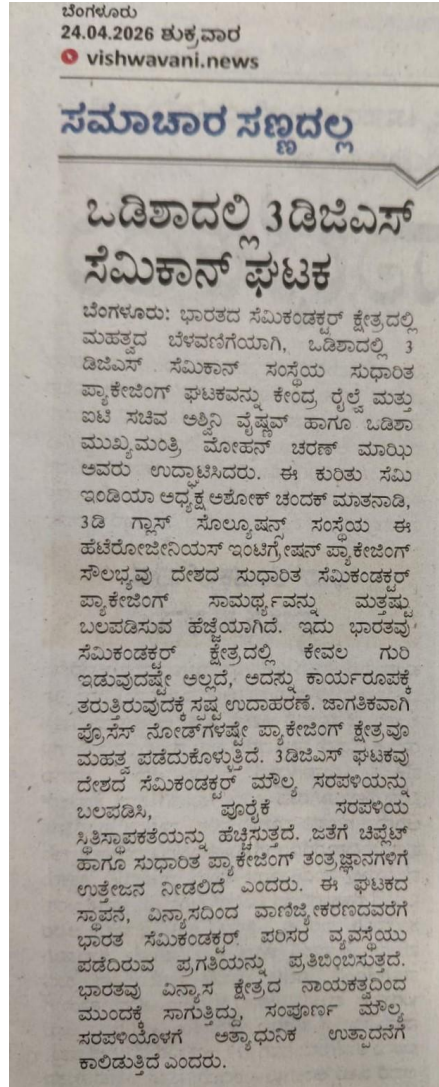
ଆଇଇଏସ ପକ୍ଷରୁ ଗତିଜିଏସ୍ ଶିଳାନାମାସକୁ ଉନ୍ନତ ସେମିକଣ୍ଡକ୍ଟର ପ୍ୟାକେଜିଂରେ ଭାରତର ଏକ ବଡ଼ ପଦକ୍ଷେପ ଭାବରେ ପ୍ରଶଂସା

ଭୁବନେଶ୍ୱର : ଭାରତ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଏବଂ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସ) ମାନନୀୟ କେନ୍ଦ୍ର ମନ୍ତ୍ରୀ ଶ୍ରୀ ଅଶ୍ୱିନୀ ବୈଷ୍ଣବ ଏବଂ ମାନନୀୟ ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ମୋହନ ଚରଣ ମାଝୀଙ୍କ ଦ୍ୱାରା ଓଡ଼ିଶାରେ ଗତିଜିଏସ୍ ସେମିକଣ୍ଡକ୍ଟର ଉନ୍ନତ ପ୍ୟାକେଜିଂ ସୁବିଧାର ଉଦଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟରରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଆଡ଼କୁ ଭାରତର ପରିବର୍ତ୍ତନର ଏକ ବୃଦ୍ଧ ପ୍ରଦର୍ଶନ ବୋଲି ଅଭିହିତ କରୁଛି । ଗତି ଗ୍ଲାସ୍ ସଲ୍ୟୁସନ୍ସର ହେଟେରୋଜେନିୟସ୍ ଇଂଟିଗ୍ରେସନ୍ ପ୍ୟାକେଜିଂ ସଲ୍ୟୁସନ୍ସ ଯୁନିଟ୍ ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କ୍ଷମତା

ଭାବରେ ଚିହ୍ନିତ କରେ - ଏକ କ୍ଷେତ୍ର ଯାହା ବିଶ୍ୱ ସ୍ତରରେ ଉନ୍ନତ ପ୍ରକ୍ରିୟା ନୋଡ୍ ପରି ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ ଭାବରେ ଦେଖାଯାଉଛି । ଏହା ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ ଶୃଙ୍ଖଳକୁ ସୁଦୃଢ଼ କରି, ଯୋଗାଣ ଶୃଙ୍ଖଳ ସ୍ଥିରତା ବୃଦ୍ଧି କରି, ଟିପଲେଟ୍ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ନବସୃଜନକୁ ସମର୍ଥନ କରି ଏବଂ ପରବର୍ତ୍ତୀ ପିଢ଼ିର ସେମିକଣ୍ଡକ୍ଟର ସିଷ୍ଟମ ସମନ୍ୱୟ ଆଡ଼କୁ ଭାରତର ଯାତ୍ରାକୁ ଆଗେଇ ନେଇ ଭାରତକୁ ସେମିକଣ୍ଡକ୍ଟର ଅଂଶଗ୍ରହଣରୁ ସେମିକଣ୍ଡକ୍ଟର ମୂଲ୍ୟ କ୍ୟାପଚରକୁ ସ୍ଥାନାନ୍ତର କରିବାରେ ସାହାଯ୍ୟ କରିପାରିବ ବୋଲି ଆଇଇଏସ ସେମିକଣ୍ଡକ୍ଟରର ସଭାପତି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

**IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging
PRINT - Bangalore**

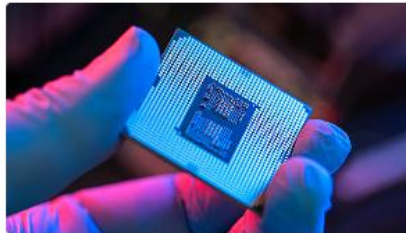
Date	24th April
Publication	Vishwavani
Quote By	Ashok Chandak



**IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging
ONLINE**

Date	20th April
Publication	Fortune India
Link	https://www.fortuneindia.com/technology/india-advances-in-chip-value-cha-in-with-3dgs-facility-semiconductor-market-expected-to-hit-103-billion-by-2030/133145

India leaps advanced packaging push as a turning point in India's shift from design strength to manufacturing depth



AP/WIDEWORLD/GETTY IMAGES/STOCK PHOTO

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The inauguration of 3DGS Semicon's advanced packaging facility in Goa marks a significant step in India's semiconductor journey, with the India Electronics and Semiconductor Association (IESA) calling it a clear sign of movement from policy intent to execution.

3DGS Semicon is the India arm of US-based 3D Glass Solutions, known for its glass-based packaging technologies used in high-frequency and high-performance semiconductor applications. The facility unit is among the early facilities in India focused on heterogeneous integration - an advanced packaging approach that integrates multiple chips into a single system to improve performance and efficiency.



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The facility, inaugurated in the presence of Union Minister Ashwini Vaishnaw and Odisha Chief Minister Mohan Charan Mohi, will manufacture specialised packaging solutions that sit between chip fabrication and final product assembly - an area where India has had limited domestic capacity.

Advanced packaging emerges as key lever

IESA President Ashish Chandra said the unit represents a meaningful capacity addition in advanced packaging, increasingly seen as critical to semiconductor performance and system integrations.

He noted such investments can help India move beyond participation to value capture by strengthening supply chains, enabling chip-set innovations, and supporting next-generation product integrations.




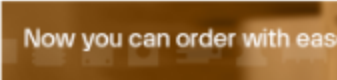
With global players looking beyond traditional node scaling, advanced packaging has become a focal point for enhancing performance and efficiency, making domestic capabilities in this segment particularly relevant.


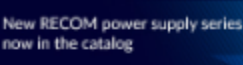

From design base to manufacturing depth

According to Chandra, the development reflects the growing maturity of India's semiconductor ecosystem, historically anchored in design and engineering.

The addition of packaging and product commercialisation capabilities signals a gradual homing-in of the value chain within the country, pointing to progress toward manufacturing more sophisticated semiconductor products.

Date	20th April
Publication	Times Tech
Link	https://timestech.in/iesa-hails-3dgs-groundbreaking-as-indias-big-leap-in-advanced-semiconductor-packaging/








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IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging

By **TimesTech** - April 20, 2020



The [India Electronics and Semiconductor Association \(IESA\)](#) welcomes the inauguration of 3DGS Semicon's advanced packaging facility in Odisha by Hon'ble Union Minister Shri Ashwini Vaishnaw and Hon'ble Chief Minister Shri Mohan Charan Majhi, calling it a strong demonstration of India's shift from intent to execution in semiconductors.

The Heterogeneous Integration Packaging Solutions unit of 3D Glass Solutions marks a significant capability leap in advanced packaging—an area increasingly seen globally as critical as advanced process nodes. It can help India move from [semiconductor](#) participation to semiconductor value capture by strengthening the semiconductor value chain, enhancing supply chain resilience, supporting chiplet and advanced packaging innovation, and advancing India's journey toward [next-generation](#) semiconductor system integration, said Ashok Chandak, President, IESA and SEMI India.

As a valued industry player, 3DGS Semicon's achievement reflects the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialization. It signals that India is progressing beyond design leadership toward manufacturing sophisticated semiconductor products within the value chain.

Following recent semiconductor project inaugurations and with additional projects expected this year, this milestone underscores the strong policy alignment and execution momentum driven by MeitY, ISM, and proactive state governments. It sends a clear signal to global investors that India is accelerating toward sustained, large-scale semiconductor execution, commented Mr. Chandak.

As India advances toward a \$400 billion electronics market and a \$103 billion semiconductor market by 2030, developments such as 3DGS demonstrate that the country is building critical capabilities across the value chain. Odisha's emergence as a semiconductor hub further strengthens the Make in India vision and positions India as a credible and competitive player in the global semiconductor landscape.

Date	19th April
Publication	DQIndia
Link	https://www.dqindia.com/esdm/iesa-hails-3dgs-groundbreaking-as-indias-big-leap-in-advanced-semiconductor-packaging-11745442



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IESA hails 3DGS groundbreaking as India's big leap in advanced semiconductor packaging

Odisha's emergence as a semiconductor hub further strengthens the Make in India vision, and positions India as a credible and competitive player in the global semiconductor landscape.



DQ Bureau
19 Apr 2024 12:00:00

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India Electronics and Semiconductor Association (IESA) has hailed the 3DGS groundbreaking as India's big leap in advanced semiconductor packaging.



Ashok Chandak, President, IESA, and SEMI India, said IESA welcomed the inauguration of 3DGS Semicon's advanced packaging facility in Odisha by Union Minister Ashwini Vaishnaw and Chief Minister Mohan Charan Mahapatra, calling it a strong demonstration of India's shift from intent to execution in semiconductors.

The heterogeneous integration packaging solutions unit of 3D Class Solutions marks a significant capability leap in advanced packaging – an area increasingly seen globally as critical as advanced process nodes.

It can help India move from semiconductor participation to semiconductor value capture by strengthening the semiconductor value chain, enhancing supply chain resilience, supporting chiplet and advanced packaging innovation, and advancing India's journey toward next-generation semiconductor system integration.

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**IESA Hails 3DGS Groundbreaking as India's Big Leap in Advanced Semiconductor Packaging
ONLINE Bangalore**

Date	22nd April
Publication	Vicharavisthara
Link	https://vicharavisthara.com/3dgss-new-unit-inaugurated-in-odisha-a-major-boost-to-indias-semiconductor-packaging-sector/

ಒಡಿಶಾದಲ್ಲಿ 3DGS ನೂತನ ಘಟಕ ಉದ್ಘಾಟನೆ: ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪ್ಯಾಕೇಜಿಂಗ್ ಕ್ಷೇತ್ರಕ್ಕೆ ಮಹತ್ವದ ಉತ್ತೇಜನ

📅 22/04/2024



ಗೌರವಾನ್ವಿತ ಕೇಂದ್ರ ಸಚಿವ ಶ್ರೀ ಅಶ್ವಿನಿ ವೆಂಕಟ್ರಾ ಮತ್ತು ಗೌರವಾನ್ವಿತ ಮುಖ್ಯಮಂತ್ರಿ ಶ್ರೀ ಮೋಹನ್ ಕರ್ಣ್ ಮುಖ್ಯ ಅತಿಥಿಗಳಿದ್ದ 3DGS ಸೆಮಿಕಂಡಕ್ಟರ್ (3DGS Semicon) ಸುಧಾರಣೆ ಪ್ಯಾಕೇಜಿಂಗ್ ಘಟಕದ ಉದ್ಘಾಟನೆಯು ಇಂದು ಇಂಡಿಯಾ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಅಂಡ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಅಸೋಸಿಯೇಷನ್ (IESA) ಸ್ವಾಗತಿಸಿದೆ. ಇದು ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರದಲ್ಲಿ ಭಾರತವು ಕೇವಲ ಗುರಿಯನ್ನು ಹೊಂದಿದೆ, ಅದನ್ನು ಕಾರ್ಯ ರೂಪಕ್ಕೆ ತರುವುದರಲ್ಲಿ ಬಹುಮುಖ್ಯವಾದ ಪ್ರಗತಿಯಾಗಿದೆ ಎಂದು ಐಇಎಸ್‌ಐ ಹೇಳಿದೆ. [Electronics & Electrical](#)

“3D ಗ್ಯಾಲಕ್ಸಿ ಸೀಮೆನ್ಟಾಪ್ಲಾಟ್ ಸಂಸ್ಥೆಯು ಈ ‘ಹಿಟ್‌ಮಾರ್ಕೆಟಿಯಸ್ ಇಂಟೆಗ್ರೇಷನ್ ಪ್ಯಾಕೇಜಿಂಗ್ ಸೀಮೆನ್ಟಾಪ್ಲಾಟ್’ ಘಟಕವು ಸುಧಾರಣೆ ಪ್ಯಾಕೇಜಿಂಗ್ ಸಾಮರ್ಥ್ಯದಲ್ಲಿ ಗಮನಾರ್ಹ ಪ್ರಗತಿ ಸಾಧಿಸಿದೆ ಎಂಬುದನ್ನು ಸೂಚಿಸುತ್ತದೆ. ಈ ಕುರಿತು ಐಇಎಸ್‌ಐ (IESA) ಮತ್ತು ಸೆಮಿ ಇಂಡಿಯಾ (SEMI India) ಅಧ್ಯಕ್ಷರಾದ ಅಶೋಕ್ ಕಂದೋ ಅವರು ಈ ಕೆಳಗಿನಂತೆ ಹೇಳಿದ್ದಾರೆ:

“ಜಾಗತಿಕವಾಗಿ ಸುಧಾರಣೆ ಪ್ಯಾಕೇಜಿಂಗ್ ಸೀಮೆನ್ಟಾಪ್ಲಾಟ್ ಪ್ಯಾಕೇಜಿಂಗ್ ಕ್ಷೇತ್ರವು ನಿರೀಕ್ಷಿಸಲಾಗುತ್ತಿದೆ. ಈ ಘಟಕವು ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮೌಲ್ಯ ಸರಪಳಿಯನ್ನು ಬಹುಮುಖ್ಯವಾದ ಮತ್ತು ಪ್ರೋತ್ಸಾಹಿಸುವ ಘಟಕವನ್ನು ಹೆಚ್ಚಿಸುತ್ತದೆ. ಅಲ್ಲದೆ, ಇದೇನೂ ಅಲ್ಲ ಮತ್ತು ಸುಧಾರಣೆ ಪ್ಯಾಕೇಜಿಂಗ್.

The launch of India's first Quantum Test and Reference Facilities in Amaravati under the Quantum Valley

PRINT GUWAHATI

Date	22nd April
Publication	Sentinel
Quote By	Ashok Chandak

विश्व क्वांटम दिवस : भारत के लिए टेक्नोलॉजी को अपनाने के दौर से निकलकर अब टेक्नोलॉजी के क्षेत्र की कर रहा है अगुवाई

नई दिल्ली, 21 अप्रैल (एजेंसी)। विश्व क्वांटम दिवस 2026, भारत के लिए टेक्नोलॉजी को अपनाने के दौर से निकलकर टेक्नोलॉजी के क्षेत्र की अगुवाई करने तक के सफर में एक अहम पड़ाव है। क्वांटम वैली पहल के तहत अमरावती में भारत के पहले क्वांटम टेस्ट रेफरेंस केंद्र का शुभारंभ किया गया, जिससे इस बात का मजबूत संकेत मिलता है कि भारत अब अगली पीढ़ी की कंप्यूटिंग के क्षेत्र में बुनियादी क्षमताएं खुद विकसित कर रहा है। आंध्र प्रदेश के माननीय मुख्यमंत्री, श्री एन. चंद्रबाबू नायडू की अगुवाई में हासिल की गई यह उपलब्धि इस बात को साबित करती है कि, टेक्नोलॉजी में आत्मनिर्भरता तभी आती है, जब कंप्यूटिंग, सामग्रियों और सिस्टम जैसे बुनियादी संसाधनों का विकास अपने ही देश में किया जाए। क्वांटम क्रांति की सफलता मुख्य रूप से सेमीकंडक्टर्स पर आधारित होगी। क्रायोजेनिक कंट्रोल इलेक्ट्रॉनिक्स और एडवांस्ड चिप डिजाइन से लेकर पैकेजिंग और सटीक मैन्युफैक्चरिंग तक, सेमीकंडक्टर इकोसिस्टम ही बड़े पैमाने पर विकसित किए जाने वाले क्वांटम सिस्टम का मुख्य आधार है। इस अवसर पर आईईएसए के अध्यक्ष, श्री अशोक चांडक ने कहा, डिजाइन के क्षेत्र में भारत की बढ़ती ताकत, फैब्रिकेशन की नई पहल की शुरुआत और राष्ट्रीय क्वांटम मिशन के माध्यम से मिली रफ्तार के साथ, अब हम इस स्थिति में हैं कि क्वांटम हार्डवेयर स्टैक अपने देश में ही तैयार कर सकें। आईईएसए में, हमने स्पष्ट रूप से यह सुनिश्चित करने का लक्ष्य रखा है कि भारत का ईएसडीएम इकोसिस्टम, क्वांटम के क्षेत्र में भारत की महत्वाकांक्षाओं के साथ कदम से कदम मिलाकर आगे बढ़े: यानी भारत में ही क्वांटम श्रेणी के हार्डवेयर की डिजाइनिंग, लैडिंग, पैकेजिंग और टेस्टिंग की जाए।

Date	21st April
Publication	Purvanhal Prahari
Quote By	Ashok Chandak

क्वांटम क्रांति की सफलता मुख्य रूप से सेमीकंडक्टर्स पर आधारित होगी

नई दिल्ली : भारत के लिए टेक्नोलॉजी को अपनाने के दौर से निकलकर टेक्नोलॉजी के क्षेत्र की अगुवाई करने तक के सफर में एक अहम पड़ाव है। क्वांटम वैली पहल के तहत अमरावती में भारत के पहले क्वांटम टेस्ट रेफरेंस केंद्र का शुभारंभ किया गया, जिससे इस बात का मजबूत संकेत मिलता है कि भारत अब अगली पीढ़ी की कंप्यूटिंग के क्षेत्र में बुनियादी क्षमताएं खुद विकसित कर रहा है। आंध्र प्रदेश के मुख्यमंत्री एन. चंद्रबाबू नायडू की अगुवाई में हासिल की गई यह उपलब्धि इस बात को साबित करती है कि टेक्नोलॉजी में आत्मनिर्भरता तभी आती है, जब कंप्यूटिंग, सामग्री और सिस्टम जैसे बुनियादी संसाधनों

का विकास अपने ही देश में किया जाए। क्वांटम क्रांति की सफलता मुख्य रूप से सेमीकंडक्टर्स पर आधारित होगी। क्रायोजेनिक कंट्रोल इलेक्ट्रॉनिक्स और एडवांस्ड चिप डिजाइन से लेकर पैकेजिंग और सटीक मैन्युफैक्चरिंग तक सेमीकंडक्टर इकोसिस्टम ही बड़े पैमाने पर विकसित किए जाने वाले क्वांटम सिस्टम का मुख्य आधार है। इस अवसर पर आईईएसए के अध्यक्ष अशोक चांडक ने कहा कि डिजाइन के क्षेत्र में भारत की बढ़ती ताकत फैब्रिकेशन की नई पहल की शुरुआत और राष्ट्रीय क्वांटम मिशन के माध्यम से मिली रफ्तार के साथ अब हम इस स्थिति में हैं कि क्वांटम हार्डवेयर स्टैक अपने देश में ही तैयार कर सकें।

Date	21st April
Publication	The Assam Post
Quote By	Ashok Chandak

World Quantum Day 2026 marks a defining step in India’s journey toward deep-tech leadership

World Quantum Day 2026 marks a defining step in India’s journey toward deep-tech leadership. The launch of Quantum Test Facilities in Amaravati, led by Hon’ble CM Sri N. Chandrababu Naidu, signals India’s shift from technology adoption to building core capabilities. The quantum revolution will be powered by semiconductors—from chip design to advanced packaging and control systems. At IESA, our focus is to ensure India’s ESDM ecosystem scales alongside quantum ambitions. India must now evolve into a Quantum Nation—built on trusted supply chains, indigenous innovation, and semiconductor-led growth.” Long verition. World Quantum Day 2026 marks a pivotal step in India’s journey from technology adoption to technology leadership. The launch of India’s first Quantum Test and Reference Facilities in Amaravati under the Quantum Valley initiative is a strong signal that India is now building foundational capabilities in next-generation computing. This milestone, led by Hon’ble CM of Andhra Pradesh, Sri N. Chandrababu Naidu, reinforces that technology sovereignty begins with building core infrastructure—compute, materials, and systems—within the country. The quantum revolution will be fundamentally en-

abled by semiconductors. From cryogenic control electronics and advanced chip design to packaging and precision manufacturing, the semiconductor ecosystem is the backbone of scalable quantum systems. With India’s growing strengths in design, emerging fabrication initiatives, and the momentum under the National Quantum Mission, we are uniquely positioned to co-develop the quantum hardware stack domestically , commented Ashok Chandak, president IESA. At IESA, our focus is clear - to ensure that India’s ESDM ecosystem scales in lockstep with quantum ambitions: designing, fabricating, packaging, and testing quantum-class hardware in India. India has already set its sights on scaling quantum capabilities significantly over the next few years. This requires deep integration of semiconductor innovation, advanced materials, and system engineering. IESA has championed India as a Product Nation, a Production Nation, and a Skills Nation. Today, we add a fourth dimension - India must become a Quantum Nation - anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech.” Ashok Chandak, added.

Ashok Chandak,
President, IESA and SEMI India

Date	20th April
Publication	The North East Times
Quote By	Ashok Chandak

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By Ashok Chandak, President, IESA and SEMI India

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Date	20th April
Publication	The Hills Times
Quote By	Ashok Chandak

India steps up quantum leadership push

Quantum Valley launch signals shift to deep-tech capabilities

HT Bureau

GUWAHATI, April 17: India marked World Quantum Day 2026 with a significant stride towards technological leadership, highlighted by the launch of the country's first Quantum Test and Reference Facilities in Amaravati under the Quantum Valley initiative.

The milestone, led by Andhra Pradesh Chief Minister N. Chandrababu Naidu, reflects India's transition from a technology adopter to a builder of foundational capabilities in next-generation computing.

The initiative focuses on strengthening core infrastructure such as compute systems, advanced materials, and integrated technologies within the country.

Commenting on the development, Ashok Chandak, President of the India Electronics and Semiconductor Association, emphasised that semiconductors will play a central role in enabling the quantum revolution.

He noted that components such as cryogenic control electronics, advanced chip design, packaging, and precision manufacturing form the backbone of scalable quantum systems.

He further stated that India's growing strengths in semiconductor design, emerging fabrication initiatives, and the momentum under the National Quantum Mission position the country to co-develop quantum hardware domestically.

IESA highlighted the need for India's Electronics System Design and Manufacturing (ESDM) ecosystem to evolve in tandem with quantum ambitions, encompassing design, fabrication, testing, and packaging of quantum-class hardware within the country.

The initiative aligns with India's broader goal of scaling quantum capabilities through deeper integration of semiconductor innovation, advanced materials, and system engineering.

Chandak added that India must expand its vision beyond being a product, production, and skills nation to becoming a "Quantum Nation," driven by indigenous innovation, trusted supply chains, and leadership in deep technology.

The development signals India's growing intent to establish itself as a global player in quantum computing and emerging technologies.

Date	20th April
Publication	The Meghalaya Guardian
Quote By	Ashok Chandak

World Quantum Day 2026 marks a defining step in India's journey toward deep-tech leadership

By Ashok Chandak, President, IESA and SEMI India

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Date	20th April
Publication	Dainik Batori Kakot
Quote By	Ashok Chandak

বিশ্ব কোৱান্টাম দিৱস ২০২৬ পালন

গুৱাহাটী, ১৬ এপ্ৰিলঃ বিশ্ব কোৱান্টাম দিৱস ২০২৬য়ে ভাৰতৰ প্ৰযুক্তি গ্ৰহণৰ পৰা প্ৰযুক্তিৰ নেতৃত্বতলৈ, এই যাত্ৰাটোক এটা গুৰুত্বপূৰ্ণ পদক্ষেপ হিচাপে চিহ্নিত কৰিছে। অমৰাৱতীত কোৱান্টাম ভেলী উদ্যোগৰ অন্তৰ্গত ভাৰতৰ প্ৰথম কোৱান্টাম পৰীক্ষা আৰু উল্লেখযোগ্য সুবিধাসমূহৰ উদ্বোধনে ভাৰতে যে এতিয়া পৰৱৰ্তী প্ৰজন্মৰ কম্পিউটিং ক্ষেত্ৰত মৌলিক সক্ষমতা গঢ়ি তুলিছে, তাৰেই এক শক্তিশালী বাৰ্তা প্ৰেৰণ কৰিছে। অন্ধ্ৰপ্ৰদেশৰ মুখ্যমন্ত্ৰী এন চন্দ্ৰবাবু নাইডুৰ নেতৃত্বত লাভ কৰা এই উল্লেখযোগ্য সফলতাই এইটো পুনৰ সুদৃঢ় কৰে যে, দেশৰ ভিতৰত গঢ়ি তোলা মূলভিত্তিক আন্তঃগঠন-কম্পিউট, উপাদান আৰু প্ৰণালীৰ পৰাই প্ৰযুক্তিগত সাৰ্বভৌমত্ব আৰম্ভ হয়। ক্ৰয়াজেটিক কণ্ট্ৰল ইলেকট্ৰনিক্স, উন্নত চিপ ডিজাইন, পেকেজিং আৰু সূক্ষ্ম উপাদানৰ পৰা আৰম্ভ কৰি চেমিকণ্ডাক্টৰ পৰিবেশ ব্যৱস্থাই স্কেলযোগ্য কোৱান্টাম প্ৰণালীৰ মেৰুদণ্ড হৈ ৰ'ব। আইইএছএৰ সভাপতি অশোক চান্দকে কয় যে, ভাৰতৰ ডিজাইন, উদীয়মান ফেব্ৰিকেচন উদ্যোগসমূহৰ ক্ষেত্ৰত বৰ্ধিত শক্তি আৰু

নেচনেল কোৱান্টাম মিছনৰ অধীনত পোৱা গতিৰ সৈতে আমি দেশীয়ভাৱে কোৱান্টাম হাৰ্ডৱেৰৰ ষ্টেক সহ-উন্নয়নৰ বাবে এক অনন্য অৱস্থাত আছো। আইইএছএত আমাৰ লক্ষ্য স্পষ্ট-ভাৰততেই কোৱান্টাম-শ্ৰেণীৰ হাৰ্ডৱেৰ ডিজাইন, ফেব্ৰিকেট, পেকেজ আৰু পৰীক্ষা কৰা, ভাৰতৰ ই এছ দি এম পৰিবেশ ব্যৱস্থাই কোৱান্টাম প্ৰযুক্তিৰ দিশত বৃহৎ লক্ষ্যৰ সৈতে একেলগে বিকাশ লাভ কৰাটো নিশ্চিত কৰা। ভাৰতে আগন্তুক কেই বছৰমানত কোৱান্টাম সক্ষমতা উল্লেখযোগ্যভাৱে বৃদ্ধি কৰাৰ লক্ষ্য ইতিমধ্যেই স্থিৰ কৰিছে। আইইএছ এয়ে ভাৰতক এখন উৎপাদনমুখী ৰাষ্ট্ৰ, উৎপাদন-ভিত্তিক ৰাষ্ট্ৰ আৰু দক্ষতা-ভিত্তিক ৰাষ্ট্ৰ হিচাপে বিজয়ী কৰিছে। অশোক চান্দকে লগতে কয় যে, আজি আমি এটা চতুৰ্থ মাত্ৰা যোগ কৰিছো-বিশ্বাসযোগ্য যোগান শৃংখল, খলুৱা উদ্ভাৱন, আৰু গভীৰ প্ৰযুক্তিত বিশ্বব্যাপী নেতৃত্বৰ ওপৰত ভিত্তি কৰি ভাৰত এখন কোৱান্টাম ৰাষ্ট্ৰ হ'ব লাগিব।'

**The launch of India's first Quantum Test and Reference Facilities in Amaravati
under the Quantum Valley**

PRINT Mumbai

Date	21st April
Publication	Puniya Nagari
Quote By	Ashok Chandak

पुण्य नगरी

क्वांटम क्रांतीत भारताचे एक पाऊल पुढे

■ मुंबई : जागतिक क्वांटम दिन २०२६ हा तंत्रज्ञानाचा अवलंब करण्यापासून ते तंत्रज्ञानाच्या नेतृत्वापर्यंतच्या भारताच्या प्रवासातील एक महत्त्वपूर्ण पाऊल आहे. क्वांटम व्हॅली उपक्रमांतर्गत आंध्र प्रदेशातील अमरावती येथे भारताच्या पहिल्या क्वांटम चाचणी आणि संदर्भ सुविधा (रेफरन्स फॅसिलिटी)चा शुभारंभ हा एक मजबूत संकेत आहे की भारत आता पुढील पिढीच्या संगणनामध्ये पायाभूत क्षमता निर्माण करत आहे,

असे मत आयईएसए आणि सेमी इंडियाचे अध्यक्ष अशोक चांडक यांनी व्यक्त केले.

क्वांटम क्रांती मूलभूतपणे सेमीकंडक्टरद्वारे सक्षम केली जाईल. क्रायोजेनिक कंट्रोल इलेक्ट्रॉनिक्स आणि प्रगत चिप डिझाइनपासून ते पॅकेजिंग आणि अचूक उत्पादनापर्यंत, सेमीकंडक्टर इकोसिस्टम हा स्केलेबल क्वांटम प्रणालींचा कणा आहे. रचना क्षेत्रातील भारताची वाढती ताकद,

उदयोन्मुख निर्मिती उपक्रम आणि राष्ट्रीय क्वांटम अभियानातर्गत गतीमुळे आम्ही देशांतर्गत क्वांटम हार्डवेअर स्टॅकचा सह-विकास करण्यासाठी अद्वितीय स्थितीत आहोत. पुढील काही वर्षांत भारताने क्वांटम क्षमता लक्षणीय प्रमाणात वाढवण्यावर आधीच लक्ष केंद्रित केले आहे. यासाठी सेमीकंडक्टर नवकल्पना, प्रगत साहित्य आणि प्रणाली अभियांत्रिकीचे सखोल एकात्रीकरण आवश्यक आहे.

**The launch of India's first Quantum Test and Reference Facilities in Amaravati
under the Quantum Valley**

PRINT Bangalore

Date	20th April
Publication	Sanje Express
Quote By	Ashok Chandak

'ಕ್ವಾಂಟಮ್ ವ್ಯಾಲಿ' ಉಪಕ್ರಮದ ಅಡಿಯಲ್ಲಿ ಅಮರಾವತಿಯಲ್ಲಿ ಭಾರತದ ಮೊದಲ ಕ್ವಾಂಟಮ್ ಪರೀಕ್ಷೆ

ಸಂಜೆ ಎಕ್ಸ್‌ಪ್ರೆಸ್ ಸುದ್ದಿ, ಬೆಂಗಳೂರು, ಏ.18- ವಿಶ್ವ ಕ್ವಾಂಟಮ್ ದಿನ 2026 ಭಾರತದ ತಂತ್ರಜ್ಞಾನ ಮತ್ತು ಪಡೆಯುವ ಹಂತದಿಂದ ತಂತ್ರಜ್ಞಾನದ ನಾಯಕತ್ವದ ಕಡೆಗಿನ ಪ್ರಯೋಗದಲ್ಲಿ ಒಂದು ಮಹತ್ವದ ಹೆಜ್ಜೆಯಾಗಿದೆ. 'ಕ್ವಾಂಟಮ್ ವ್ಯಾಲಿ' ಉಪಕ್ರಮದ ಅಡಿಯಲ್ಲಿ ಅಮರಾವತಿಯಲ್ಲಿ ಭಾರತದ ಮೊದಲ ಕ್ವಾಂಟಮ್ ಪರೀಕ್ಷೆ ಮತ್ತು ಉಲ್ಲೇಖ ಸೌಲಭ್ಯಗಳ ಉದ್ಘಾಟನೆಯು, ಮುಂದಿನ ತೀಳಿಗಿಯ ಕಂಪ್ಯೂಟಿಂಗ್‌ನಲ್ಲಿ ಭಾರತವು ಈಗ ಮೂಲಭೂತ ಸಾಮರ್ಥ್ಯಗಳನ್ನು ನಿರ್ಮಿಸುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಬಲವಾದ ಸಂಕೇತವಾಗಿದೆ. ಅಂದ್ರಪ್ರದೇಶದ ಗೌರವಾನ್ವಿತ ಮುಖ್ಯಮಂತ್ರಿ ಶ್ರೀ ಎನ್. ಚಂದ್ರಬಾಬು ನಾಯ್ಡು ಅವರ ನೇತೃತ್ವದ ಈ ಮೈಲಿಗಲ್ಲು, ತಂತ್ರಜ್ಞಾನದ ಸಾರ್ವಭೌಮತ್ವವು ದೇಶದೊಳಗೇ ಕಂಪ್ಯೂಟಿಂಗ್, ಸಾಮಗ್ರಿಗಳು ಮತ್ತು ವ್ಯವಸ್ಥೆಗಳಂತಹ ಪ್ರಮುಖ

ಮೂಲಸೌಕರ್ಯಗಳನ್ನು ನಿರ್ಮಿಸುವುದರೊಂದಿಗೆ ಪ್ರಾರಂಭವಾಗುತ್ತದೆ ಎಂಬುದನ್ನು ಪುನರುಚ್ಚರಿಸುತ್ತದೆ. "ಕ್ವಾಂಟಮ್ ಕ್ವಾಂಟಿಯು ಮೂಲಭೂತವಾಗಿ ಸೆಮಿಕಂಡಕ್ಟರ್‌ಗಳಿಂದ ಸಶಕ್ತಗೊಳ್ಳಲಿದೆ. ಕ್ರೋನೋಜೆನಿಕ್ ನಿಯಂತ್ರಣ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸುಧಾರಿತ ಜಿಜ್ಞಾಸನದಿಂದ ಹಿಡಿದು ಪ್ಯಾಕೇಜಿಂಗ್ ಮತ್ತು ನಿಖರ ಉತ್ಪಾದನೆಯವರೆಗೆ, ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯು ಸ್ವೇಲೆಬಲ್ ಕ್ವಾಂಟಮ್ ವ್ಯವಸ್ಥೆಗಳ ಬೆನ್ನೆಲುಬಾಗಿದೆ. ವಿನ್ಯಾಸದಲ್ಲಿ ಭಾರತದ ಬೆಳೆಯುತ್ತಿರುವ ಸಾಮರ್ಥ್ಯಗಳು, ಉದಯೋನ್ಮುಖ ಫ್ಯಾಬ್ರಿಕೇಶನ್ ಉಪಕ್ರಮಗಳು ಮತ್ತು ರಾಷ್ಟ್ರೀಯ ಕ್ವಾಂಟಮ್ ಮಿಷನ್ ಅಡಿಯಲ್ಲಿನ ವೇಗವು, ಕ್ವಾಂಟಮ್ ಹಾರ್ಡ್‌ವೇರ್ ಸ್ಟಾಕ್ ಅನ್ನು ದೇಶೀಯವಾಗಿ ಅಭಿವೃದ್ಧಿಪಡಿಸಲು



ನಮಗೆ ವಿಶಿಷ್ಟ ಸ್ಥಾನವನ್ನು ಒದಗಿಸಿವೆ." ಎಂದು IESA ಅಧ್ಯಕ್ಷ ಆಶೋಕ್ ಚಂದರ್ ಕಾಮಂಟ್ ಮಾಡಿದ್ದಾರೆ. IESA ನಲ್ಲಿ ನಮ್ಮ ಉದ್ದೇಶ ಸ್ಪಷ್ಟವಾಗಿದೆ ಭಾರತದ ESDM ಪರಿಸರ ವ್ಯವಸ್ಥೆಯು ಕ್ವಾಂಟಮ್ ಮಹತ್ವಾಕಾಂಕ್ಷಿಗಳೊಂದಿಗೆ ಸಮಬಲವಾಗಿ ಬೆಳೆಯುವುದನ್ನು ಖಚಿತಪಡಿಸಿಕೊಳ್ಳುವುದು: ಅಂದರೆ ಭಾರತದಲ್ಲಿಯೇ ಕ್ವಾಂಟಮ್-ದರ್ಜೆಯ ಹಾರ್ಡ್‌ವೇರ್ ಅನ್ನು ವಿನ್ಯಾಸಗೊಳಿಸುವುದು, ತಯಾರಿಸುವುದು, ಪ್ಯಾಕೇಜಿಂಗ್ ಮಾಡುವುದು ಮತ್ತು ಪರೀಕ್ಷಿಸುವುದು. ಮುಂದಿನ ಕೆಲವು ವರ್ಷಗಳಲ್ಲಿ ಕ್ವಾಂಟಮ್ ಸಾಮರ್ಥ್ಯಗಳನ್ನು ಗಣನೀಯವಾಗಿ ವಿಸ್ತರಿಸಲು ಭಾರತ ಈಗಾಗಲೇ ಗುರಿ ಹೊಂದಿದ್ದ, ಇದಕ್ಕೆ ಸೆಮಿಕಂಡಕ್ಟರ್ ಅವಿಷ್ಕಾರ, ಸುಧಾರಿತ ಸಾಮಗ್ರಿಗಳು ಮತ್ತು ಸಿಸ್ಟಮ್ ಎಂಜಿನಿಯರಿಂಗ್‌ನ ಆಳವಾದ ಏಕೀಕರಣದ ಅಗತ್ಯವಿದೆ.

Date	20th April
Publication	Vishwavani
Quote By	Ashok Chandak

ಸೆಮಿಕಂಡಕ್ಟರ್ ಪಾತ್ರ ಮಹತ್ವ

ಬೆಂಗಳೂರು: ವಿಶ್ವ ಕ್ವಾಂಟಮ್ ದಿನ 2026 ಅಂಗವಾಗಿ ಭಾರತವು ತಂತ್ರಜ್ಞಾನ ಮತ್ತು ಪಡೆಯುವ ಹಂತದಿಂದ ತಂತ್ರಜ್ಞಾನ ನಾಯಕತ್ವದತ್ತ ಹೆಜ್ಜೆಯಿಟ್ಟ ಮಹತ್ವದ ಬೆಳವಣಿಗೆ ಕಂಡಿದೆ.



ಕ್ವಾಂಟಮ್ ವ್ಯಾಲಿ ಯೋಜನೆಯಲ್ಲಿ ಆಂಧ್ರ ಪ್ರದೇಶದ ಅಮರಾವತಿಯಲ್ಲಿ ದೇಶದ ಮೊದಲ ಕ್ವಾಂಟಮ್ ಪರೀಕ್ಷೆ ಮತ್ತು ಉಲ್ಲೇಖ ಸೌಲಭ್ಯಗಳನ್ನು ಪ್ರಾರಂಭಿಸಲಾಯಿತು.

ಈ ಕುರಿತು ಐಇಎಸ್‌ಎ ಅಧ್ಯಕ್ಷ ಅಶೋಕ್ ಚಂದಕ್ ಮಾತನಾಡಿ, ಕ್ವಾಂಟಮ್ ತಂತ್ರಜ್ಞಾನ ಅಭಿವೃದ್ಧಿಯಲ್ಲಿ ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರದ ಪಾತ್ರ ಅತ್ಯಂತ ಮಹತ್ವದ್ದಾಗಿದೆ. ಕ್ರಯೋಜೆನಿಕ್ ನಿಯಂತ್ರಣ ಆಯ್ಕೆಗಳು, ಸುಧಾರಿತ ಚಿಪ್ ವಿನ್ಯಾಸ, ಪ್ಯಾಕೇಜಿಂಗ್ ಮತ್ತು ನಿಖರವಾದ ಉತ್ಪಾದನೆಯಂತಹ ಅಂಶಗಳು ಕ್ವಾಂಟಮ್ ವ್ಯವಸ್ಥೆಗಳ ಬೆನ್ನಲು ಬಾಗಿವೆ. ಭಾರತವು ವಿನ್ಯಾಸ ಮತ್ತು ತಯಾರಿಕಾ ಕ್ಷೇತ್ರಗಳಲ್ಲಿ ವೇಗವಾಗಿ ಬೆಳೆಯುತ್ತಿದೆ, ರಾಷ್ಟ್ರೀಯ ಕ್ವಾಂಟಮ್ ಮಿಷನ್ ಮೂಲಕ

ಕ್ವಾಂಟಮ್ ಹಾರ್ಡ್‌ವೇರ್ ಅಭಿವೃದ್ಧಿಗೆ ವಿಶಿಷ್ಟ ಸ್ಥಾನವನ್ನು ಪಡೆಯುತ್ತಿದೆ ಎಂದರು.

ಇಂಡಿಯಾ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಅಸೋಸಿಯೇಷನ್ ಸಂಸ್ಥೆಯ ಉದ್ದೇಶ ಭಾರತದಲ್ಲಿ ಕ್ವಾಂಟಮ್-ದರ್ಜೆಯ ಹಾರ್ಡ್‌ವೇರ್ ವಿನ್ಯಾಸ, ತಯಾರಿ, ಪ್ಯಾಕೇಜಿಂಗ್ ಮತ್ತು ಪರೀಕ್ಷೆ ಉತ್ತೇಜಿಸುವುದು. ಇದರಿಂದ ದೇಶದ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಸಿಸ್ಟಮ್ ಡಿಸೈನ್ ಮ್ಯಾನುಫ್ಯಾಕ್ಚರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆ ಮತ್ತಷ್ಟು ಬಲಿಷ್ಠವಾಗುತ್ತದೆ.

ಮುಂದಿನ ಕೆಲವು ವರ್ಷಗಳಲ್ಲಿ ಕ್ವಾಂಟಮ್ ಸಾಮರ್ಥ್ಯಗಳನ್ನು ಗಣನೀಯವಾಗಿ ವಿಸ್ತರಿಸುವ ಗುರಿಯನ್ನು ಭಾರತ ಹೊಂದಿದ್ದು, ಇದಕ್ಕೆ ಸೆಮಿಕಂಡಕ್ಟರ್ ಆವಿಷ್ಕಾರ, ಸುಧಾರಿತ ಸಾಮಗ್ರಿಗಳು ಮತ್ತು ಸಿಸ್ಟಮ್ ಎಂಜಿನಿಯರಿಂಗ್‌ನ ಸಮಗ್ರ ಏಕೀಕರಣ ಅಗತ್ಯವಿದೆ. ಭಾರತವನ್ನು ಉತ್ಪನ್ನ ರಾಷ್ಟ್ರ, ಉತ್ಪಾದನಾ ರಾಷ್ಟ್ರ ಮತ್ತು ಕೌಶಲ್ಯ ರಾಷ್ಟ್ರವಾಗಿ ರೂಪಿಸುವ ಜತೆಗೆ ಈಗ ಕ್ವಾಂಟಮ್ ರಾಷ್ಟ್ರವಾಗಿಯೂ ಸ್ಥಾಪಿಸುವ ದಿಕ್ಕಿನಲ್ಲಿ ನಾವು ಸಾಗಬಹುದು ಈ ಹೆಜ್ಜೆ ಭಾರತವನ್ನು ಜಾಗತಿಕ ಡಿಫ್-ಟೆಕ್ ಕ್ಷೇತ್ರದಲ್ಲಿ ವಿಶ್ವಾಸಾರ್ಹ ನಾಯಕನನ್ನಾಗಿ ರೂಪಿಸುವ ದಾರಿ ಮಾಡಿಕೊಡಲಿದೆ ಎಂದರು.

Date	17th April
Publication	Dinasudar
Quote By	Ashok Chandak

அமராவதியில் இந்தியாவின் முதல் குவாண்டம் சோதனை முகாம்

பெங்களூர். ஏப்ரல் 16-2026 ஆம் ஆண்டு உலக குவாண்டம் தினம், தொழில் நுட்பத்தை ஏற்றுக்கொள்வதிலிருந்து தொழில் நுட்பத்தை உலகமே தழுவாத நோக்கிய இந்தியாவின் பயணத்தில் ஒரு முக்கிய மைல்கல்லைக் குறிக்கிறது. குவாண்டம் பள்ளத்தாக்கு முன்முயற்சியின் கீழ் அமராவதியில் இந்தியாவின் முதல் குவாண்டம் சோதனை மற்றும் குறிப்பு வசதிகள் தொடங்கப்பட்டது, அடுத்த தலைமுறை கணினித் துறையில் இந்தியா இப்போது அடித்தளத் திறன்களைக் கட்டமைத்து வருகிறது என்பதற்கான ஒரு வலுவான சமிக்ஞையாகும். ஆந்திரப் பிரதேசத்தின் முதலமைச்சர் என். சந்திரபாபு நாயுடு தலைமையிலான இந்த மைல்கல், தொழில் நுட்ப இறையாண்மை என்பது கணினி, பொருட்கள் மற்றும் அமைப்புகள் போன்ற முக்கிய உள்கட்டமைப்புகளை நாட்டிற்குள்ளேயே உருவாக்குவதில் இருந்து தொடங்குகிறது என்பதை வலுப்படுத்துகிறது. குவாண்டம் புரட்சியானது அடிப்படையில் குறைக்கடத்திகளால் சாத்தியமாக்கப்படும். கிரையோஜனிக் கட்டுப்பாடு மின்னணுவியல் மற்றும் மேம்பட்ட சிப் வடிவமைப்பு முதல் பேக்கேஜிங் மற்றும் துல்லியமான உற்பத்தி வரை, குறைக்கடத்தி குழுவமைப்பு என்பது அளவிடக்கூடிய குவாண்டம் அமைப்புகளின் முதுகெலும்பாகும். வடிவமைப்பில் இந்தியாவின் வளர்ந்து வரும் பலம், வளர்ந்து வரும் உற்பத்தி முயற்சிகள் மற்றும் தேசிய குவாண்டம் திட்டத்தின் கீழ் உள்ள உத்வேகம் ஆகியவற்றைக் கொண்டு, குவாண்டம் வன்பொருள் அடுக்கை உள்நாட்டிலேயே இணைந்து உருவாக்க நாம் தனித்துவமான நிலையில் இருக்கிறோம் என்று தலைவர் அசோக் சந்தக் கருத்து தெரிவித்தார். ஐ.டி.எஸ்.ஏ. எங்களின் கவனம் தெளிவாக உள்ளது— இந்தியாவின் குழுவமைப்பு, குவாண்டம் இலக்குகளுக்கு இணையாக விரிவடைவதை உறுதி செய்வதே அது. குவாண்டம் தரத்திலான வன்பொருட்களை இந்தியாவிலேயே வடிவமைத்தல், உருவாக்குதல், பேக்கேஜிங் செய்தல் மற்றும் சோதித்தல். அடுத்த சில ஆண்டுகளில் குவாண்டம் திறன்களைக் கணிசமாக விரிவுபடுத்துவதை இந்தியா ஏற்கனவே இலக்காகக் கொண்டுள்ளது என்று கூறினார்.



குறைக்கடத்தி குழுவமைப்பு என்பது அளவிடக்கூடிய குவாண்டம் அமைப்புகளின் முதுகெலும்பாகும். வடிவமைப்பில் இந்தியாவின் வளர்ந்து வரும் பலம், வளர்ந்து வரும் உற்பத்தி முயற்சிகள் மற்றும் தேசிய குவாண்டம் திட்டத்தின் கீழ் உள்ள உத்வேகம் ஆகியவற்றைக் கொண்டு, குவாண்டம் வன்பொருள் அடுக்கை உள்நாட்டிலேயே இணைந்து உருவாக்க நாம்

Date	17th April
Publication	Udayakala
Quote By	Ashok Chandak

ವಿಶ್ವ ಕಾಂಟಮ್ ದಿನ 2026 ಭಾರತದ ತಂತ್ರಜ್ಞಾನ ದತ್ತ ಪಡೆಯುವ ಹಂತದಿಂದ ತಂತ್ರಜ್ಞಾನದ ನಾಯಕತ್ವದ ಕಡೆಗಿನ ಪ್ರಯಾಣದಲ್ಲಿ ಮಹತ್ವದ ಹೆಜ್ಜೆ

ಉದಯಕಾಲ ನ್ಯೂಸ್, ಬೆಂಗಳೂರು:

ಆಂಧ್ರಪ್ರದೇಶದ ಗೌರವಾನ್ವಿತ ಮುಖ್ಯಮಂತ್ರಿ ಶ್ರೀ ಎನ್. ಚಂದ್ರಬಾಬು ನಾಯ್ಡು ಅವರ ನೇತೃತ್ವದ ಈ ಮೈಲಿಗಲ್ಲು, ತಂತ್ರಜ್ಞಾನದ ಸಾರ್ವಭೌಮತ್ವವು ದೇಶದೊಳಗೇ ಕಂಪ್ಯೂಟ್, ಸಾಮಗ್ರಿಗಳು ಮತ್ತು ವ್ಯವಸ್ಥೆಗಳಂತಹ ಪ್ರಮುಖ ಮೂಲಸೌಕರ್ಯಗಳನ್ನು ನಿರ್ಮಿಸುವುದರೊಂದಿಗೆ ಪ್ರಾರಂಭವಾಗುತ್ತದೆ ಎಂಬುದನ್ನು ಪುನರುಚ್ಚರಿಸುತ್ತದೆ.

ಕ್ವಾಂಟಮ್ ಕ್ರಾಂತಿಯು ಮೂಲಭೂತವಾಗಿ ಸೆಮಿಕಂಡಕ್ಟರ್‌ಗಳಿಂದ ಸಶಕ್ತಗೊಳ್ಳಲಿದೆ. ಕ್ರಿಯೋಜೆನಿಕ್ ನಿಯಂತ್ರಣ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸುಧಾರಿತ ಚಿಪ್ ವಿನ್ಯಾಸದಿಂದ ಹಿಡಿದು ಪ್ರಾಕೇಜಿಂಗ್ ಮತ್ತು ನಿಖರ ಉತ್ಪಾದನೆಯವರೆಗೆ, ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯು ಸ್ಕೇಲೆಬಲ್ ಕ್ವಾಂಟಮ್ ವ್ಯವಸ್ಥೆಗಳ ಬೆನ್ನೆಲುಬಾಗಿದೆ.

ವಿನ್ಯಾಸದಲ್ಲಿ ಭಾರತದ ಬೆಳೆಯುತ್ತಿರುವ ಸಾಮರ್ಥ್ಯಗಳು, ಉದಯೋನ್ಮುಖ ಫ್ಯಾಬ್ರಿಕೇಶನ್ ಉಪಕರಣಗಳು ಮತ್ತು ರಾಷ್ಟ್ರೀಯ ಕ್ವಾಂಟಮ್ ಮಿಷನ್ ಅಡಿಯಲ್ಲಿನ ವೇಗವು, ಕ್ವಾಂಟಮ್ ಹಾರ್ಡ್‌ವೇರ್ ಸ್ಟಾಕ್ ಅನ್ನು ದೇಶೀಯವಾಗಿ ಅಭಿವೃದ್ಧಿಪಡಿಸಲು ನಮಗೆ ವಿಶಿಷ್ಟ ಸ್ಥಾನವನ್ನು ಒದಗಿಸಿವೆ, ಎಂದು IESA ಅಧ್ಯಕ್ಷ ಅಶೋಕ್ ಚಂದಕ್ ಕಾಮೆಂಟ್ ಮಾಡಿದ್ದಾರೆ.



IESA ನಲ್ಲಿ ನಮ್ಮ ಉದ್ದೇಶ ಸ್ಪಷ್ಟವಾಗಿದೆ ಭಾರತದ IESA ಪರಿಸರ ವ್ಯವಸ್ಥೆಯು ಕ್ವಾಂಟಮ್ ವು ಹತ್ತಾ ಕಾಂಕ್ಷೆಗಳೊಂದಿಗೆ ಸಮಬಲವಾಗಿ ಬೆಳೆಯುವುದನ್ನು ಖಚಿತಪಡಿಸಿಕೊಳ್ಳುವುದು: ಅಂದರೆ ಭಾರತದಲ್ಲಿಯೇ ಕ್ವಾಂಟಮ್ -ದರ್ಜೆಯ ಹಾರ್ಡ್‌ವೇರ್ ಅನ್ನು ವಿನ್ಯಾಸಗೊಳಿಸುವುದು,

ತಯಾರಿಸುವುದು, ಪ್ರಾಕೇಜಿಂಗ್ ಮಾಡುವುದು ಮತ್ತು ಪರೀಕ್ಷಿಸುವುದು. ಮುಂದಿನ ಕೆಲವು ವರ್ಷಗಳಲ್ಲಿ ಕ್ವಾಂಟಮ್ ಸಾಮರ್ಥ್ಯಗಳನ್ನು ಗಣನೀಯವಾಗಿ ವಿಸ್ತರಿಸಲು ಭಾರತ ಈಗಾಗಲೇ ಗುರಿ ಹೊಂದಿದೆ. ಇದಕ್ಕೆ ಸೆಮಿಕಂಡಕ್ಟರ್ ಆವಿಷ್ಕಾರ, ಸುಧಾರಿತ ಸಾಮಗ್ರಿಗಳು ಮತ್ತು ಸಿಸ್ಟಮ್ ಎಂಜಿನಿಯರಿಂಗ್‌ನ ಆಳವಾದ ಏಕೀಕರಣದ ಅಗತ್ಯವಿದೆ.

IESA ಭಾರತವನ್ನು ಉತ್ಕೃಷ್ಟ ರಾಷ್ಟ್ರ ಉತ್ಪಾದನಾ ರಾಷ್ಟ್ರ ಮತ್ತು ಕೌಶಲ್ಯ ರಾಷ್ಟ್ರ ಎಂದು ಪ್ರತಿಪಾದಿಸಿದೆ. ಇಂದು ನಾವು ಇದಕ್ಕೆ ನಾಲ್ಕನೇ ಆಯಾಮವನ್ನು ಸೇರಿಸುತ್ತಿದ್ದೇವೆ ಭಾರತವು 'ಕ್ವಾಂಟಮ್ ರಾಷ್ಟ್ರ' ಅಗಬೇಕು ಇದು ವಿಶ್ವಸಾರ್ವ ಪೂರೈಕೆ ಸರಪಳಿಗಳು, ಸ್ಪದೇಶಿ ಆವಿಷ್ಕಾರ ಮತ್ತು ಡೀಪ್-ಟೆಕ್‌ನಲ್ಲಿ ಜಾಗತಿಕ ನಾಯಕತ್ವದಲ್ಲಿ ನೆಲೆಗೊಂಡಿರಬೇಕು, ಎಂದು ಅಶೋಕ್ ಚಂದಕ್ ಅವರು ಮಾತು ಮುಕ್ತಾಯಗೊಳಿಸಿದರು.

Date	17th April
Publication	Sanjesamya
Quote By	Ashok Chandak

ವಿಶ್ವ ಕಾಂಟಮ್ ದಿನ 2026 ಭಾರತದ ತಂತ್ರಜ್ಞಾನ ದತ್ತ ಪಡೆಯುವ ಹಂತದಿಂದ ತಂತ್ರಜ್ಞಾನದ ನಾಯಕತ್ವದ ಕಡೆಗಿನ ಪ್ರಯಾಣದಲ್ಲಿ ಮಹತ್ವದ ಹೆಜ್ಜೆ

ಉದಯಕಾಲ ನ್ಯೂಸ್, ಬೆಂಗಳೂರು:

ಅಂಧ್ರಪ್ರದೇಶದ ಗೌರವಾನ್ವಿತ ಮುಖ್ಯಮಂತ್ರಿ ಶ್ರೀ ಎನ್. ಚಂದ್ರಬಾಬು ನಾಯ್ಡು ಅವರ ನೇತೃತ್ವದ ಈ ಮೈಲಿಗಲ್ಲು, ತಂತ್ರಜ್ಞಾನದ ಸಾರ್ವಭೌಮತ್ವವು ದೇಶದೊಳಗೇ ಕಂಪ್ಯೂಟ್, ಸಾಮಗ್ರಿಗಳು ಮತ್ತು ವ್ಯವಸ್ಥೆಗಳಂತಹ ಪ್ರಮುಖ ಮೂಲಸೌಕರ್ಯಗಳನ್ನು ನಿರ್ಮಿಸುವುದರೊಂದಿಗೆ ಪ್ರಾರಂಭವಾಗುತ್ತದೆ ಎಂಬುದನ್ನು ಪುನರುಚ್ಚರಿಸುತ್ತದೆ.

ಕ್ವಾಂಟಮ್ ಕ್ರಾಂತಿಯು ಮೂಲಭೂತವಾಗಿ ಸೆಮಿಕಂಡಕ್ಟರ್‌ಗಳಿಂದ ಸಶಕ್ತಗೊಳ್ಳಲಿದೆ. ಕ್ರಿಯೋಜೆನಿಕ್ ನಿಯಂತ್ರಣ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸುಧಾರಿತ ಚಿಪ್ ವಿನ್ಯಾಸದಿಂದ ಹಿಡಿದು ಪ್ರಾಕೇಜಿಂಗ್ ಮತ್ತು ನಿಖರ ಉತ್ಪಾದನೆಯವರೆಗೆ, ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯು ಸ್ಕೇಲೆಬಲ್ ಕ್ವಾಂಟಮ್ ವ್ಯವಸ್ಥೆಗಳ ಬೆನ್ನೆಲುಬಾಗಿದೆ.

ವಿನ್ಯಾಸದಲ್ಲಿ ಭಾರತದ ಬೆಳೆಯುತ್ತಿರುವ ಸಾಮರ್ಥ್ಯಗಳು, ಉದಯೋನ್ಮುಖ ಫ್ಯಾಬ್ರಿಕೇಶನ್ ಉಪಕರಣಗಳು ಮತ್ತು ರಾಷ್ಟ್ರೀಯ ಕ್ವಾಂಟಮ್ ಮಿಷನ್ ಅಡಿಯಲ್ಲಿನ ವೇಗವು, ಕ್ವಾಂಟಮ್ ಹಾರ್ಡ್‌ವೇರ್ ಸ್ಟಾಕ್ ಅನ್ನು ದೇಶೀಯವಾಗಿ ಅಭಿವೃದ್ಧಿಪಡಿಸಲು ನಮಗೆ ವಿಶಿಷ್ಟ ಸ್ಥಾನವನ್ನು ಒದಗಿಸಿವೆ, ಎಂದು IESA ಅಧ್ಯಕ್ಷ ಅಶೋಕ್ ಚಂದಕ್ ಕಾಮೆಂಟ್ ಮಾಡಿದ್ದಾರೆ.



IESA ನಲ್ಲಿ ನಮ್ಮ ಉದ್ದೇಶ ಸ್ಪಷ್ಟವಾಗಿದೆ ಭಾರತದ IESA ಪರಿಸರ ವ್ಯವಸ್ಥೆಯು ಕ್ವಾಂಟಮ್ ವು ಹೆಚ್ಚು ಕಾಂಪ್ಲೆಕ್ಸ್‌ಗೊಂದಿಗೆ ಸಮಬಲವಾಗಿ ಬೆಳೆಯುವುದನ್ನು ಖಚಿತಪಡಿಸಿಕೊಳ್ಳುವುದು: ಅಂದರೆ ಭಾರತದಲ್ಲಿಯೇ ಕ್ವಾಂಟಮ್ -ದರ್ಜೆಯ ಹಾರ್ಡ್‌ವೇರ್ ಅನ್ನು ವಿನ್ಯಾಸಗೊಳಿಸುವುದು,

ತಯಾರಿಸುವುದು, ಪ್ರಾಕೇಜಿಂಗ್ ಮಾಡುವುದು ಮತ್ತು ಪರೀಕ್ಷಿಸುವುದು. ಮುಂದಿನ ಕೆಲವು ವರ್ಷಗಳಲ್ಲಿ ಕ್ವಾಂಟಮ್ ಸಾಮರ್ಥ್ಯಗಳನ್ನು ಗಣನೀಯವಾಗಿ ವಿಸ್ತರಿಸಲು ಭಾರತ ಈಗಾಗಲೇ ಗುರಿ ಹೊಂದಿದೆ. ಇದಕ್ಕೆ ಸೆಮಿಕಂಡಕ್ಟರ್ ಆವಿಷ್ಕಾರ, ಸುಧಾರಿತ ಸಾಮಗ್ರಿಗಳು ಮತ್ತು ಸಿಸ್ಟಮ್ ಎಂಜಿನಿಯರಿಂಗ್‌ನ ಆಳವಾದ ಏಕೀಕರಣದ ಅಗತ್ಯವಿದೆ.

IESA ಭಾರತವನ್ನು ಉತ್ಕೃಷ್ಟ ರಾಷ್ಟ್ರ ಉತ್ಪಾದನಾ ರಾಷ್ಟ್ರ ಮತ್ತು ಕೌಶಲ್ಯ ರಾಷ್ಟ್ರ ಎಂದು ಪ್ರತಿಪಾದಿಸಿದೆ. ಇಂದು ನಾವು ಇದಕ್ಕೆ ನಾಲ್ಕನೇ ಆಯಾಮವನ್ನು ಸೇರಿಸುತ್ತಿದ್ದೇವೆ ಭಾರತವು 'ಕ್ವಾಂಟಮ್ ರಾಷ್ಟ್ರ' ಅಗಬೇಕು ಇದು ವಿಶ್ವಸಾರ್ವ ಪೂರೈಕೆ ಸರಪಳಿಗಳು, ಸ್ಪದೇಶಿ ಆವಿಷ್ಕಾರ ಮತ್ತು ಡೀಪ್-ಟೆಕ್‌ನಲ್ಲಿ ಜಾಗತಿಕ ನಾಯಕತ್ವದಲ್ಲಿ ನೆಲೆಗೊಂಡಿರಬೇಕು, ಎಂದು ಅಶೋಕ್ ಚಂದಕ್ ಅವರು ಮಾತು ಮುಕ್ತಾಯಗೊಳಿಸಿದರು.

Date	17th April
Publication	Aramba
Quote By	Ashok Chandak

ವಿಶ್ವ ಕ್ವಾಂಟಮ್ ದಿನ 2026

ಬೆಂಗಳೂರು: ಆಂಧ್ರಪ್ರದೇಶದ ಗೌರವಾನ್ವಿತ ಮುಖ್ಯಮಂತ್ರಿ ಶ್ರೀ ಎನ್. ಚಂದ್ರಬಾಬು ನಾಯ್ಡು ಅವರ ನೇತೃತ್ವದ ಈ ಮೈಲಿಗಲ್ಲು, ತಂತ್ರಜ್ಞಾನದ ಸಾರ್ವಭೌಮತ್ವವು ದೇಶದೊಳಗೇ ಕಂಪ್ಯೂಟರ್, ಸಾಮಗ್ರಿಗಳು ಮತ್ತು ವ್ಯವಸ್ಥೆಗಳಂತಹ ಪ್ರಮುಖ ಮೂಲಸೌಕರ್ಯಗಳನ್ನು ನಿರ್ಮಿಸುವುದರೊಂದಿಗೆ ಪ್ರಾರಂಭವಾಗುತ್ತದೆ ಎಂಬುದನ್ನು ಪುನರುಚ್ಚರಿಸುತ್ತದೆ.



"ಕ್ವಾಂಟಮ್ ಕ್ವಾಂಟಿಯು ಮೂಲಭೂತವಾಗಿ ಸೆಮಿಕಂಡಕ್ಟರ್‌ಗಳಿಂದ ಸಶಕ್ತಗೊಳ್ಳಲಿದೆ. ಕ್ರೋಮೋಜೆನಿಕ್ ನಿಯಂತ್ರಣ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸುಧಾರಿತ ಚಿಪ್ ವಿನ್ಯಾಸದಿಂದ ಹಿಡಿದು ಪ್ಯಾಕೇಜಿಂಗ್ ಮತ್ತು ನಿಖರ ಉತ್ಪಾದನೆಯವರೆಗೆ, ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯು ಸ್ಕೇಲೆಬಲ್ ಕ್ವಾಂಟಮ್ ವ್ಯವಸ್ಥೆಗಳ ಬೆನ್ನೆಲುಬಾಗಿದೆ. ವಿನ್ಯಾಸದಲ್ಲಿ

ಭಾರತದ ಬೆಳೆಯುತ್ತಿರುವ ಸಾಮರ್ಥ್ಯಗಳು, ಉದಯೋನ್ಮುಖ ಫ್ಯಾಬ್ರಿಕೇಶನ್ ಉಪಕ್ರಮಗಳು ಮತ್ತು ರಾಷ್ಟ್ರೀಯ ಕ್ವಾಂಟಮ್ ಮಿಷನ್ ಅಡಿಯಲ್ಲಿನ ವೇಗವು, ಕ್ವಾಂಟಮ್ ಹಾರ್ಡ್‌ವೇರ್ ಸ್ಟಾಕ್ ಅನ್ನು ದೇಶೀಯವಾಗಿ ಅಭಿವೃದ್ಧಿಪಡಿಸಲು ನಮಗೆ ವಿಶಿಷ್ಟ ಸ್ಥಾನವನ್ನು ಒದಗಿಸಿವೆ." ಎಂದು IESA ಅಧ್ಯಕ್ಷ ಅಶೋಕ್ ಚಂದಕ್ ಕಾಮೆಂಟ್ ಮಾಡಿದ್ದಾರೆ.

IESA ನಲ್ಲಿ ನಮ್ಮ ಉದ್ದೇಶ ಸ್ಪಷ್ಟವಾಗಿದೆ ಭಾರತದ ESDM ಪರಿಸರ ವ್ಯವಸ್ಥೆಯು ಕ್ವಾಂಟಮ್ ಮಹತ್ವಾಕಾಂಕ್ಷಿಗಳೊಂದಿಗೆ ಸಮಬಲವಾಗಿ ಬೆಳೆಯುವುದನ್ನು ಖಚಿತಪಡಿಸಿಕೊಳ್ಳುವುದು: ಅಂದರೆ ಭಾರತದಲ್ಲಿಯೇ ಕ್ವಾಂಟಮ್-ದರ್ಜೆಯ ಹಾರ್ಡ್‌ವೇರ್ ಅನ್ನು ವಿನ್ಯಾಸಗೊಳಿಸುವುದು, ತಯಾರಿಸುವುದು, ಪ್ಯಾಕೇಜಿಂಗ್ ಮಾಡುವುದು ಮತ್ತು ಪರೀಕ್ಷಿಸುವುದು.

Date	17th April
Publication	Eanadu
Quote By	Ashok Chandak

ವಿಶ್ವ ಕ್ವಾಂಟಮ್ ದಿನ 2026: ತಂತ್ರಜ್ಞಾನದ ನಾಯಕತ್ವದ ಕಡೆಗಿನ ಪ್ರಯಾಣದಲ್ಲಿ ಒಂದು ಮಹತ್ವದ ಹೆಜ್ಜೆ

ಬೆಂಗಳೂರು: 'ಕ್ವಾಂಟಮ್ ವಾಲ್ಡ್' ಉಪಕ್ರಮದ ಅಡಿಯಲ್ಲಿ ಅಮರಾವತಿಯಲ್ಲಿ ಭಾರತದ ಮೊದಲ ಕ್ವಾಂಟಮ್ ಪರಿಷ್ಕೆ ಮತ್ತು ಉಲ್ಲೇಖಿ ಸೌಲಭ್ಯಗಳ ಉದ್ಘಾಟನೆಯು, ಮುಂದಿನ ಪೀಳಿಗೆಯ ಕಂಪ್ಯೂಟಿಂಗ್‌ನಲ್ಲಿ ಭಾರತವು ಈಗ ಮೂಲಭೂತ ಸಾಮರ್ಥ್ಯಗಳನ್ನು ನಿರ್ಮಿಸುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಬಲವಾದ ಸಂಕೇತವಾಗಿದೆ. ಅಂದ್ರಪ್ರದೇಶದ ಗೌರವಾನ್ವಿತ ಮುಖ್ಯಮಂತ್ರಿ ಶ್ರೀ ಎನ್. ಚಂದ್ರಬಾಬು ನಾಯ್ಡು ಅವರ ನೇತೃತ್ವದ ಈ ಮೈಲಿಗಲ್ಲು, ತಂತ್ರಜ್ಞಾನದ ಸಾರ್ವಭೌಮತ್ವವು ದೇಶದೊಳಗೇ ಕಂಪ್ಯೂಟಿಂಗ್, ಸಾಮಗ್ರಿಗಳು ಮತ್ತು ವ್ಯವಸ್ಥೆಗಳಂತಹ ಪ್ರಮುಖ ಮೂಲಸೌಕರ್ಯಗಳನ್ನು ನಿರ್ಮಿಸುವುದರೊಂದಿಗೆ ಪ್ರಾರಂಭವಾಗುತ್ತದೆ ಎಂಬುದನ್ನು ಪುನರುಚ್ಚರಿಸುತ್ತದೆ. "ಕ್ವಾಂಟಮ್ ಕ್ರಾಂತಿಯು ಮೂಲಭೂತವಾಗಿ ಸೆಮಿಕಂಡಕ್ಟರ್‌ಗಳಿಂದ ಸಶಕ್ತಗೊಳ್ಳಲಿದೆ. ಕ್ರಯೋಜೆನಿಕ್ ನಿಯಂತ್ರಣ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸುಧಾರಿತ ಚಿಪ್ ವಿನ್ಯಾಸದಿಂದ ಹಿಡಿದು ಪ್ರಾಕೀಜಿಂಗ್ ಮತ್ತು ನಿಖರ

ಉತ್ಪಾದನೆಯವರೆಗೆ, ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯು ಸ್ಟೇಲೆಬಲ್ ಕ್ವಾಂಟಮ್ ವ್ಯವಸ್ಥೆಗಳ ಬೆನ್ನೆಲುಬಾಗಿದೆ. ವಿನ್ಯಾಸದಲ್ಲಿ ಭಾರತದ ಬೆಳೆಯುತ್ತಿರುವ ಸಾಮರ್ಥ್ಯಗಳು, ಉದಯೋನ್ಮುಖ ಫ್ಯಾಬ್ರಿಕೇಶನ್ ಉಪಕ್ರಮಗಳು ಮತ್ತು ರಾಷ್ಟ್ರೀಯ ಕ್ವಾಂಟಮ್ ಮಿಷನ್ ಅಡಿಯಲ್ಲಿನ ವೇಗವು, ಕ್ವಾಂಟಮ್ ಹಾರ್ಡ್‌ವೇರ್ ಸ್ಟಾಕ್ ಅನ್ನು ದೇಶೀಯವಾಗಿ ಅಭಿವೃದ್ಧಿಪಡಿಸಲು ನಮಗೆ ವಿಶಿಷ್ಟ ಸ್ಥಾನವನ್ನು ಒದಗಿಸಿವೆ," ಎಂದು ಬೆಂಗಳೂರು ಅಧ್ಯಕ್ಷ ಅಶೋಕ್ ಚಂದಕ್ ಕಾಮೆಂಟ್ ಮಾಡಿದ್ದಾರೆ. IESA ನಲ್ಲಿ ನಮ್ಮ ಉದ್ದೇಶ ಸ್ಪಷ್ಟವಾಗಿದೆ ಭಾರತದ ESDM ಪರಿಸರ ವ್ಯವಸ್ಥೆಯು ಕ್ವಾಂಟಮ್ ಮಹತ್ವಾಕಾಂಕ್ಷಿಗಳೊಂದಿಗೆ ಸಮಬಲವಾಗಿ ಬೆಳೆಯುವುದನ್ನು ಖಚಿತಪಡಿಸಿಕೊಳ್ಳುವುದು: ಅಂದರೆ ಭಾರತದಲ್ಲಿಯೇ ಕ್ವಾಂಟಮ್-ದರ್ಜೆಯ ಹಾರ್ಡ್‌ವೇರ್ ಅನ್ನು ವಿನ್ಯಾಸಗೊಳಿಸುವುದು, ತಯಾರಿಸುವುದು,



ಪ್ರಾಕೀಜಿಂಗ್ ಮಾಡುವುದು ಮತ್ತು ಪರಿಷ್ಕಿಸುವುದು. ಮುಂದಿನ ಕೆಲವು ವರ್ಷಗಳಲ್ಲಿ ಕ್ವಾಂಟಮ್ ಸಾಮರ್ಥ್ಯಗಳನ್ನು ಗಣನೀಯವಾಗಿ ವಿಸ್ತರಿಸಲು ಭಾರತ ಈಗಾಗಲೇ ಗುರಿ ಹೂಂದಿದ್ದೆ. ಇದಕ್ಕೆ ಸೆಮಿಕಂಡಕ್ಟರ್ ಆವಿಷ್ಕಾರ, ಸುಧಾರಿತ ಸಾಮಗ್ರಿಗಳು ಮತ್ತು ಸಿಸ್ಟಮ್ ಎಂಜಿನಿಯರಿಂಗ್‌ನ ಅಳವಡದ ಏಕೀಕರಣದ ಅಗತ್ಯವಿದೆ. "IESA ಭಾರತವನ್ನು ಉತ್ಕೃಷ್ಟ ರಾಷ್ಟ್ರ ಉತ್ಪಾದನಾ ರಾಷ್ಟ್ರ ಮತ್ತು ಕೌಶಲ್ಯ ರಾಷ್ಟ್ರ ಎಂದು ಪ್ರತಿಪಾದಿಸಿದೆ. ಇಂದು ನಾವು ಇದಕ್ಕೆ ನಾಲ್ಕನೇ ಆಯಾಮವನ್ನು ಸೇರಿಸುತ್ತಿದ್ದೇವೆ ಭಾರತವು 'ಕ್ವಾಂಟಮ್ ರಾಷ್ಟ್ರ' ಆಗಬೇಕು ಇದು ವಿಶ್ವಸಾರ್ಹ ಪೂರೈಕೆ ಸರಪಳಿಗಳು, ಸ್ವದೇಶಿ ಆವಿಷ್ಕಾರ ಮತ್ತು ಡಿಎಸ್-ಟೆಕ್‌ನಲ್ಲಿ ಜಾಗತಿಕ ನಾಯಕತ್ವದಲ್ಲಿ ನೆಲೆಗೊಂಡಿರಬೇಕು," ಎಂದು ಅಶೋಕ್ ಚಂದಕ್ ಅವರು ಮಾತು ಮುಕ್ತಾಯಗೊಳಿಸಿದರು.

**The launch of India's first Quantum Test and Reference Facilities in Amaravati
under the Quantum Valley**

PRINT Bhubaneswar

Date	17th April
Publication	Odisha Bhaskar
Quote By	Ashok Chandak

ଭାରତକୁ ବିଶ୍ୱସ୍ତ ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସ୍ୱଦେଶୀ ନବସୃଜନ ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ବିଶ୍ୱ ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ ଏକ କ୍ୱାଟର୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡ଼ିବ : ଅଶୋକ ଚାଣ୍ଡକ

ଭୁବନେଶ୍ୱର : ବିଶ୍ୱ କ୍ୱାଟର୍ ଦିବସ ୨୦୨୬ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିମୁଖେ ଯାତ୍ରାରେ ଏକ ନିର୍ଦ୍ଦିଷ୍ଟ ପଦକ୍ଷେପ। ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟର୍ ପରୀକ୍ଷଣ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଗ୍ରହଣରୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସଙ୍କେତ ଦେଇଛନ୍ତି। ଆନ୍ତ ପ୍ରଦେଶର ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଲଗୁଟ, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଓଫି - କମ୍ପ୍ୟୁଟର, ସାମଗ୍ରୀ ଏବଂ ସିଷ୍ଟମ - ନିର୍ମାଣ ସହିତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମିକ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛନ୍ତି। କ୍ୱାଟର୍ ବିପ୍ଳବ ସେମିକଣ୍ଡକ୍ଟର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଚିପ୍ ଡିଜାଇନ୍ ଠାରୁ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ। ଆଇଇଏସଏରେ, ଆମର ଧ୍ୟାନ କ୍ୱାଟର୍ ମହତ୍ୱାକାଂକ୍ଷା ସହିତ ଭାରତର ଇସ୍ପତିଏମ ଇକୋସିଷ୍ଟମ୍ ସ୍କେଲ୍ ସୁନିଶ୍ଚିତ କରିବ। ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ଚାମ୍ପିଅନ୍ କରିଛି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି।

Date	17th April
Publication	Biswabani
Quote By	Ashok Chandak

India must become a Quantum Nation-anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak, President , IESA and SEMI India

Bhubaneswar: World Quantum Day 2026 marks a defining step in India's journey toward deep-tech leadership. The launch of Quantum Test Facilities in Amaravati, led by Hon'ble CM Sri N. Chandrababu Naidu, signals India's shift from technology adoption to building core capabilities. This milestone, led by Hon'ble CM of Andhra Pradesh, Sri N. Chandrababu Naidu, reinforces that technology sovereignty begins with building core infrastructure-compute, materials, and systems-within the country. The quantum revolution will be powered by semiconductors-from chip design to advanced packaging and control systems. At IESA, our focus is to ensure India's ESDM ecosystem scales alongside quantum ambitions. IESA has championed India as a Product Nation, a Production Nation, and a Skills Nation. Today, we add a fourth dimension said Ashok Chandak

Date	17th April
Publication	Odisha Khabar
Quote By	Ashok Chandak

ଭାରତକୁ ବିଶ୍ୱସ୍ତ ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସ୍ୱଦେଶୀ ନବସୃଜନ ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ବିଶ୍ୱ ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ ଏକ କ୍ୱାଟମ୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡ଼ିବ : ଅଶୋକ ଚାଣ୍ଡକ

ଭୁବନେଶ୍ୱର : ବିଶ୍ୱ କ୍ୱାଟମ୍ ଦିବସ ୨୦୨୬ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିମୁଖେ ଯାତ୍ରାରେ ଏକ ନିର୍ଦ୍ଦିଷ୍ଟ ପଦକ୍ଷେପ । ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟମ୍ ପରୀକ୍ଷଣ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଗ୍ରହଣରୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସଙ୍କେତ ଦେଇଛନ୍ତି । ଆନ୍ତ ପ୍ରଦେଶର ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଇଲଷ୍ଟ୍ପ, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଓମି - କମ୍ପ୍ୟୁଟ୍, ସାମଗ୍ରୀ ଏବଂ ସିଷ୍ଟମ - ନିର୍ମାଣ ସହିତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମିକ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛନ୍ତି । କ୍ୱାଟମ୍ ବିପ୍ଳବ ସେମିକଣ୍ଡକ୍ଟର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଚିପ୍ ଡିଜାଇନ୍, ଠାରୁ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ । ଆଇଇଏସଏରେ, ଆମର ଧ୍ୟାନ କ୍ୱାଟମ୍ ମହତ୍ୱାକାଂକ୍ଷା ସହିତ ଭାରତର ଇଏସଡିଏମ ଇକୋସିଷ୍ଟମ୍ ସ୍କେଲ୍ ସୁନିଶ୍ଚିତ କରିବ । ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ଚାମ୍ପିଅନ୍ କରିଛି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	17th April
Publication	Lokakatha
Quote By	Ashok Chandak

ଭାରତକୁ ବିଶ୍ୱସ୍ତ ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସ୍ୱଦେଶୀ ନବସୃଜନ ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ବିଶ୍ୱ ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ ଏକ କ୍ୱାଟମ୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡ଼ିବ : ଅଶୋକ ଚାଣ୍ଡକ

ଭୁବନେଶ୍ୱର : ବିଶ୍ୱ କ୍ୱାଟମ୍ ଦିବସ ୨୦୨୬ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିମୁଖେ ଯାତ୍ରାରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ। ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟମ୍ ପରାକ୍ଷଣ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଗ୍ରହଣରୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସଙ୍କେତ

ଦେଇଛନ୍ତି । ଆଜ୍ଞା ପ୍ରଦେଶର ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଲକ୍ଷୁଟ, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଓମି - କମ୍ପ୍ୟୁଟର, ସାମଗ୍ରୀ ଏବଂ ସିଂକ୍ସମ - ନିର୍ମାଣ ସହିତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମରୁ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛନ୍ତି । କ୍ୱାଟମ୍ ବିପ୍ଲବ ସେମିକଣ୍ଡକ୍ଟର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଚିପ୍ ଡିଜାଇନ୍, ଠାରୁ ଉନ୍ନତ

ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ । ଆଇଇଏସଏରେ, ଆମର ଧ୍ୟାନ କ୍ୱାଟମ୍ ମହତ୍ୱାକାଂକ୍ଷା ସହିତ ଭାରତର ଇସ୍ପତିଏମ ଇକୋସିଷ୍ଟମ୍ ଷ୍ଟେଲ୍ ସୁନିଶ୍ଚିତ କରିବ । ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ଚାମ୍ପିଅନ୍ କରିଛି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	15th April
Publication	Agami Orissa
Quote By	Ashok Chandak

India must become a Quantum Nation-anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech- Ashok Chandak

Bhubaneswar: World Quantum Day 2026 marks a defining step in India's journey toward deep-tech leadership. The launch of Quantum Test Facilities in Amaravati, led by Hon'ble CM Sri N. Chandrababu Naidu, signals India's shift from technology adoption to building core capabilities. This milestone, led by Hon'ble CM of Andhra Pradesh, Sri N. Chandrababu Naidu, reinforces that technology sovereignty begins with building core infrastructure-compute, materials, and systems-within the country. The quantum revolution will be powered by semiconductors-from chip design to advanced packaging and control systems. At IESA, our focus is to ensure India's ESDM ecosystem scales alongside quantum ambitions. IESA has championed India as a Product Nation, a Production Nation, and a Skills Nation. Today, we add a fourth dimension said Ashok Chandak.

Date	15th April
Publication	Desbarta
Quote By	Ashok Chandak

ଭାରତକୁ ବିଶ୍ୱସ୍ତ ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସ୍ୱଦେଶୀ ନବସୃଜନ ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ବିଶ୍ୱ ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ ଏକ କ୍ୱାଟର୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡ଼ିବ - ଅଶୋକ ଚାଣ୍ଡକ, ସଭାପତି, ଆଇଇଏସଏ ଏବଂ ସେମି ଇଣ୍ଡିଆ

ଭୁବନେଶ୍ୱର: ବିଶ୍ୱ କ୍ୱାଟର୍ ଦିବସ ୨୦୨୬ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିମୁଖେ ଯାତ୍ରାରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ । ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟର୍ ପରୀକ୍ଷଣ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଗ୍ରହଣରୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସଙ୍କେତ ଦେଇଛନ୍ତି । ଆନ୍ତ୍ର ପ୍ରଦେଶର ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଇଲଷ୍ଟୁଟ୍, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଓମି - କମ୍ପ୍ୟୁଟ୍, ସାମଗ୍ରୀ ଏବଂ ସିଷ୍ଟମ - ନିର୍ମାଣ ସହିତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମିତ୍ୱ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛନ୍ତି । କ୍ୱାଟର୍ ବିପ୍ଳବ ସେମିକଣ୍ଡକ୍ଟର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଟିପ୍ ଡିଜାଇନ୍, ଠାରୁ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ । ଆଇଇଏସଏରେ, ଆମର ଧ୍ୟାନ କ୍ୱାଟର୍ ମହତ୍ୱାକାଂକ୍ଷା ସହିତ ଭାରତର ଇଏସଡିଏମ ଇକୋସିଷ୍ଟମ୍ ସ୍କେଲ୍ ସୁନିଶ୍ଚିତ କରିବ । ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ଚାମ୍ପିଅନ୍ କରିଛି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	15th April
Publication	Dharitri
Quote By	Ashok Chandak

**ଭାରତକୁ ବିଶ୍ୱସ୍ତ ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସ୍ୱଦେଶୀ ନବସୃଜନ ଏବଂ
ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ବିଶ୍ୱ ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ ଏକ କ୍ୱାଟମ୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡ଼ିବ
- ଅଶୋକ ଚାଣ୍ଡକ, ସଭାପତି, ଆଇଇଏସଏ ଏବଂ ସେମି ଇଣ୍ଡିଆ**

ଭୁବନେଶ୍ୱର: ବିଶ୍ୱ କ୍ୱାଟମ୍ ଦିବସ ୨୦୨୬ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିମୁଖେ ଯାତ୍ରାରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ । ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାରୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟମ୍ ପରୀକ୍ଷଣ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଗ୍ରହଣରୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସଙ୍କେତ ଦେଇଛନ୍ତି । ଆନ୍ତ ପ୍ରଦେଶର ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାରୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଇଲ୍‌ଷ୍ଟୁଟ୍, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଓମି - କମ୍ପ୍ୟୁଟ୍, ସାମଗ୍ରୀ ଏବଂ ସିଷମ - ନିର୍ମାଣ ସହିତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମିତ୍ୱ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛନ୍ତି । କ୍ୱାଟମ୍ ବିପ୍ଳବ ସେମିକଣ୍ଡକ୍ଟର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଟିପ୍ ଡିଜାଇନ୍ ଠାରୁ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ । ଆଇଇଏସଏରେ, ଆମର ଧ୍ୟାନ କ୍ୱାଟମ୍ ମହତ୍ୱାକାଂକ୍ଷା ସହିତ ଭାରତର ଇଏସଡିଏମ ଇକୋସିଷ୍ଟମ୍ ସ୍କେଲ୍ ସୁନିଶ୍ଚିତ କରିବ । ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ଚାମ୍ପିଅନ୍ କରିଛି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	15th April
Publication	Kalinga Mail
Quote By	Ashok Chandak

କାଳିଙ୍ଗ ସମ୍ବାଦ ୫୧ ଏମ୍.ସି. ବନ୍ଦୁର, ବ୍ୟବହାର ପାଇଁ ନଷ୍ଟ ନେଇଛି ।

କଳିଙ୍ଗ ସମ୍ବାଦ କର୍ମଚାରୀ ଉପସ୍ଥାପନା କମିଟିର ଅଧିକାରୀଙ୍କ ଦ୍ୱାରା ପଠାଯାଇଥିଲା ।

କାଳିଙ୍ଗ
ସମ୍ବାଦ
କର୍ମଚାରୀ
ଉପସ୍ଥାପନା
କମିଟିର
ଅଧିକାରୀ
ଙ୍କ ଦ୍ୱାରା
ପଠାଯାଇ
ଥିଲା ।

ଭାରତକୁ ବିଶ୍ୱସ୍ତ ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସ୍ୱଦେଶୀ ନବସୃଜନ ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ବିଶ୍ୱ ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ ଏକ କ୍ୱାଟମ୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡ଼ିବ - ଅଶୋକ ଚାଣ୍ଡକ

ଭୁବନେଶ୍ୱର: ବିଶ୍ୱ କ୍ୱାଟମ୍ ଦିବସ ୨୦୨୬ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିମୁଖେ ଯାତ୍ରାରେ ଏକ ନିର୍ଦ୍ଦିଷ୍ଟ ପଦକ୍ଷେପ । ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟମ୍ ପରାମର୍ଶ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା

ଗ୍ରହଣକୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସକ୍ଷେପ ଦେଇଛନ୍ତି । ଆଜି ପ୍ରଦେଶର ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଲକ୍ଷ୍ମୀଟ, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଓମି - କମ୍ପ୍ୟୁଟର, ସାମଗ୍ରୀ ଏବଂ ସିଷମ - ନିର୍ମାଣ

ସହିତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମିକ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛି । କ୍ୱାଟମ୍ ବିପ୍ଳବ ସୈମିକଶକ୍ତିର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଚିପ୍ ଡିଜାଇନ୍, ଠାରୁ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ । ଆଇଇଏସଏରେ, ଆମର ଧ୍ୟାନ କ୍ୱାଟମ୍ ମହତ୍ୱାକାଂକ୍ଷା ସହିତ

ଭାରତର ଇସ୍ପତିଏମ୍ ଇକୋସିଷ୍ଟମ୍ ସେଲ୍ ସୁନିଶ୍ଚିତ କରିବ । ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ତାମ୍ପିଅନ୍ କରିଛି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡ଼ୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	15th April
Publication	Orissa Times
Quote By	Ashok Chandak

**India must become a Quantum Nation-anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech-
Ashok Chandak, President , IESA and SEMI India**

Bhubaneswar: World Quantum Day 2026 marks a defining step in India's journey toward deep-tech leadership. The launch of Quantum Test Facilities in Amaravati, led by Hon'ble CM Sri N. Chandrababu Naidu, signals India's shift from technology adoption to building core capabilities. This milestone, led by Hon'ble CM of Andhra Pradesh, Sri N. Chandrababu Naidu, reinforces that technology sovereignty begins with building core infrastructure-compute, materials, and systems-within the country. The quantum revolution will be powered by semiconductors-from chip design to advanced packaging and control systems. At IESA, our focus is to ensure India's ESDM ecosystem scales alongside quantum ambitions. IESA has championed India as a Product Nation, a Production Nation, and a Skills Nation. Today, we add a fourth dimension said Ashok Chandak.

Date	15th April
Publication	Sakala Sathi
Quote By	Ashok Chandak

ଭାରତକୁ ବିଶ୍ୱସ୍ତ ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସ୍ୱଦେଶୀ ନବସୃଜନ ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ

ବିଶ୍ୱ ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ ଏକ କ୍ୱାଟର୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡିବ - ଅଶୋକ ଚାଣ୍ଡକ

ଭୁବନେଶ୍ୱର: ବିଶ୍ୱ କ୍ୱାଟର୍ ଦିବସ ୨୦୨୬ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିଯୁକ୍ତେ ଯାତ୍ରାରେ ଏକ ନିର୍ଦ୍ଦିଷ୍ଟ ପଦକ୍ଷେପ। ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟର୍ ପରୀକ୍ଷଣ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଗ୍ରହଣରୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସଙ୍କେତ ଦେଇଛନ୍ତି। ଆନ୍ତର୍ଜାତୀୟ ପ୍ରଦେଶର ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଲଲ୍ୟୁଟ, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଓମି - କମ୍ପ୍ୟୁଟର, ସାମଗ୍ରୀ ଏବଂ ସିଷ୍ଟମ - ନିର୍ମାଣ ସହିତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମିକ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛନ୍ତି। କ୍ୱାଟର୍ ବିପ୍ଳବ ସେମିକଣ୍ଡକ୍ଟର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଚିପ୍ ଡିଜାଇନ୍, ଠାରୁ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ। ଆଇଇଏସଏରେ, ଆମର ଧ୍ୟାନ କ୍ୱାଟର୍ ମହତ୍ତ୍ୱାକାଂକ୍ଷା ସହିତ ଭାରତର ଲକ୍ଷ୍ୟସାଧନ ଲକୋସିଷ୍ଟମ୍ ସ୍କେଲ୍ ସୁନିଶ୍ଚିତ କରିବ। ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ଚାମ୍ପିଅନ୍ କରିଛନ୍ତି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି।

Date	15th April
Publication	Samaya
Quote By	Ashok Chandak

ଭାରତକୁ ବିଶ୍ୱସ୍ତ ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସୁଦେଶୀ ନବସୃଜନ ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ବିଶ୍ୱ ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ
 ଏକ କ୍ୱାଟର୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡ଼ିବ - ଅଶୋକ ଚାଣ୍ଡକ, ସଭାପତି, ଆଇଇଏସଏ ଏବଂ ସେମି ଇଣ୍ଡିଆ

ଭୁବନେଶ୍ୱର: ବିଶ୍ୱ କ୍ୱାଟର୍ ଦିବସ ୨୦୨୨ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିମୁଖେ ଯାତ୍ରାରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ । ମାନବବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟର୍ ପରୀକ୍ଷଣ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଗ୍ରହଣରୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସଙ୍କେତ ଦେଇଛନ୍ତି । ଆନ୍ତ ପ୍ରଦେଶର ମାନବବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଇଲଖୁଂଚ, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଓମି - କମ୍ପ୍ୟୁଟ୍, ସାମଗ୍ରୀ ଏବଂ ସିଷ୍ଟମ - ନିର୍ମାଣ ସହିତ

ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମତ୍ୱ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛି । କ୍ୱାଟର୍ ବିପ୍ଳବ ସେମିକଣ୍ଡକ୍ଟର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଚିପ୍ ଡିଜାଇନ୍, ଠାରୁ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ । ଆଇଇଏସଏରେ, ଆମର ଧ୍ୟାନ କ୍ୱାଟର୍ ମହତ୍ୱାକାଂକ୍ଷା ସହିତ ଭାରତର ଇଏସଡିଏମ ଇକୋସିଷ୍ଟମ୍ ସ୍କେଲ୍ ସୁନିଶ୍ଚିତ କରିବ । ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ଚାମ୍ପିଅନ୍ କରିଛି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	15th April
Publication	Utkal Samaja
Quote By	Ashok Chandak

ଭାରତକୁ ବିଶ୍ୱସ୍ତ ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସ୍ୱଦେଶୀ ନବସୃଜନ ଏବଂ
 ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ବିଶ୍ୱ ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ ଏକ କ୍ୱାଟର୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡ଼ିବ
 - ଅଶୋକ ଚାଣ୍ଡକ, ସଭାପତି, ଆଇଇଏସଏ ଏବଂ ସେମି ଇଣ୍ଡିଆ

ଭୁବନେଶ୍ୱର: ବିଶ୍ୱ କ୍ୱାଟର୍ ଦିବସ ୨୦୨୨ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିମୁଖେ ଯାତ୍ରାରେ ଏକ ନିର୍ଦ୍ଦିଷ୍ଟ ପଦକ୍ଷେପ। ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟର୍ ପରୀକ୍ଷଣ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଗ୍ରହଣରୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସଙ୍କେତ ଦେଇଛନ୍ତି। ଆନ୍ତ ପ୍ରଦେଶର ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଇଲ୍‌ଷ୍ଟୁଟ୍, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଭୁମି - କମ୍ପ୍ୟୁଟ୍, ସାମଗ୍ରୀ ଏବଂ ସିଷ୍ଟମ - ନିର୍ମାଣ ସହିତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମିକ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛନ୍ତି। କ୍ୱାଟର୍ ବିପ୍ଲବ ସେମିକଣ୍ଡକ୍ଟର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଚିପ୍ ଡିଜାଇନ୍ ଠାରୁ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ। ଆଇଇଏସଏରେ, ଆମର ଧାନ କ୍ୱାଟର୍ ମହତ୍ୱାକାଂକ୍ଷୀ ସହିତ ଭାରତର ଇସପତିଏମ ଇକୋସିଷ୍ଟମ୍ ସେଲ୍ ସୁନିଶ୍ଚିତ କରିବ। ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ଚାମ୍ପିଅନ୍ କରିଛି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି।

Date	15th April
Publication	Sakala
Quote By	Ashok Chandak

ଭାରତକୁ ବିଶ୍ୱସ୍ତ ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସ୍ୱଦେଶୀ ନବସୃଜନ ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ବିଶ୍ୱ

ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ ଏକ କ୍ୱାଟର୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡ଼ିବ : ଅଶୋକ ଚାଣ୍ଡକ

ଭୁବନେଶ୍ୱର: ବିଶ୍ୱ କ୍ୱାଟର୍ ଦିବସ ୨୦୨୧ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିମୁଖେ ଯାତ୍ରାରେ ଏକ ନିର୍ଦ୍ଦିଷ୍ଟ ପଦକ୍ଷେପ । ମାନବବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟର୍ ପରୀକ୍ଷଣ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଗ୍ରହଣରୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସଙ୍କେତ ଦେଇଛନ୍ତି । ଆନ୍ତ ପ୍ରଦେଶର ମାନବବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଇଲଷ୍ଟ୍ପ, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଓମି - କମ୍ପ୍ୟୁଟ୍, ସାମଗ୍ରୀ ଏବଂ ସିଷ୍ଟମ - ନିର୍ମାଣ ସହିତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମିକ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛନ୍ତି । କ୍ୱାଟର୍ ବିପ୍ଳବ ସେମିକଣ୍ଡକ୍ଟର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଚିପ୍ ଡିଜାଇନ୍ ଠାରୁ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ । ଆଇଇଏସଏରେ, ଆମର ଧ୍ୟାନ କ୍ୱାଟର୍ ମହତ୍ୱାକାଂକ୍ଷା ସହିତ ଭାରତର ଇସସଡିଏମ ଇକୋସିଷ୍ଟମ୍ ସ୍କେଲ୍ ସୁନିଶ୍ଚିତ କରିବ । ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ଚାମ୍ପିଅନ୍ କରିଛି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି ।

Date	15th April
Publication	Swatantra Barta
Quote By	Ashok Chandak

ଭାରତକୁ ବିଶ୍ୱସ୍ତ୍ର ଯୋଗାଣ ଶୃଙ୍ଖଳ, ସ୍ୱଦେଶୀ ନବସୃଜନ ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ବିଶ୍ୱ ନେତୃତ୍ୱ କ୍ଷେତ୍ରରେ ଏକ କ୍ୱାଟର୍ ରାଷ୍ଟ୍ର ହେବାକୁ ପଡ଼ିବ - ଅଶୋକ ଚାଣ୍ଡକ

ଭୁବନେଶ୍ୱର: ବିଶ୍ୱ କ୍ୱାଟର୍ ଦିବସ ୨୦୨୬ ଭାରତର ଗଭୀର ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନେତୃତ୍ୱ ଅଭିମୁଖେ ଯାତ୍ରାରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ। ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଅମରାବତୀରେ କ୍ୱାଟର୍ ପରୀକ୍ଷଣ ସୁବିଧାର ଶୁଭାରମ୍ଭ, ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଗ୍ରହଣରୁ ମୂଳ କ୍ଷମତା ନିର୍ମାଣ ଦିଗରେ ଭାରତର ପରିବର୍ତ୍ତନକୁ ସଙ୍କେତ ଦେଇଛନ୍ତି। ଆନ୍ତ ପ୍ରଦେଶର ମାନ୍ୟବର ମୁଖ୍ୟମନ୍ତ୍ରୀ ଶ୍ରୀ ଏନ. ଚନ୍ଦ୍ରବାବୁ ନାଇଡୁଙ୍କ ନେତୃତ୍ୱରେ ଏହି ମାଇଲଷ୍ଟ୍ପ, ଦେଶ ମଧ୍ୟରେ ମୁଖ୍ୟ ଭିଡିଓ - କମ୍ପ୍ୟୁଟର, ସାମଗ୍ରୀ ଏବଂ ସିଷ୍ଟମ - ନିର୍ମାଣ ସହିତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ସାର୍ବଭୌମିକ ଆରମ୍ଭ ହେବ ବୋଲି ଦୃଢ଼ କରିଛନ୍ତି। କ୍ୱାଟର୍ ବିପ୍ଳବ ସେମିକଣ୍ଡକ୍ଟର ଦ୍ୱାରା ପରିଚାଳିତ ହେବ - ଚିପ୍ ଡିଜାଇନ୍ ଠାରୁ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ନିୟନ୍ତ୍ରଣ ପ୍ରଣାଳୀ ପର୍ଯ୍ୟନ୍ତ। ଆଇଇଏସଏରେ, ଆମର ଧ୍ୟାନ କ୍ୱାଟର୍ ମହତ୍ୱକାଂକ୍ଷୀ ସହିତ ଭାରତର ଇସ୍ତଫିଦାନ ଇକୋସିଷ୍ଟମ୍ ସ୍କେଲ୍ ସୁନିଶ୍ଚିତ କରିବ। ଆଇଇଏସଏ ଭାରତକୁ ଏକ ଉତ୍ପାଦ ରାଷ୍ଟ୍ର, ଏକ ଉତ୍ପାଦନ ରାଷ୍ଟ୍ର ଏବଂ ଏକ ଦକ୍ଷତା ରାଷ୍ଟ୍ର ଭାବରେ ଚାମ୍ପିଆନ୍ କରିଛି ଏବଂ ଆଜି, ଆମେ ଏକ ଚତୁର୍ଥ ଦିଗ ଯୋଡୁଛୁ ବୋଲି ଅଶୋକ ଚାଣ୍ଡକ କହିଛନ୍ତି।

**The launch of India's first Quantum Test and Reference Facilities in Amaravati
under the Quantum Valley**

PRINT Gujarat

Date	15th April
Publication	Divya Gujarat
Quote By	Ashok Chandak

અશોક ચાંડક: વર્લ્ડ ક્વાન્ટમ ડે ૨૦૨૬ ભારતને “ક્વાન્ટમ નેશન” તરફ દોરી રહ્યું છે

વર્લ્ડ ક્વાન્ટમ ડે ૨૦૨૬ ભારતના ડીપ-ટેક નેતૃત્વ તરફના પ્રવાસમાં એક મહત્વપૂર્ણ પગલું સાબિત થાય છે. અમરાવતીમાં ક્વાન્ટમ ટેસ્ટ ફેસિલિટીઝનું લોન્ચ, માનનીય મુખ્યમંત્રી શ્રી એન. ચંદ્રબાબુ નાયડુના નેતૃત્વ હેઠળ, ભારત હવે ટેકનોલોજી અપનાવવાથી આગળ વધી પોતાની મૂળભૂત ક્ષમતાઓ નિર્માણ કરી રહ્યું છે તેવો મજબૂત સંકેત આપે છે. ક્વાન્ટમ ક્રાંતિનો આધાર સેમિકન્ડક્ટર્સ

રહેશે—ચિપ ડિઝાઇનથી લઈને એડવાન્સ્ડ પેકેજિંગ અને કન્ટ્રોલ સિસ્ટમ્સ સુધી. IESA ખાતે અમારો ફોકસ એ સુનિશ્ચિત કરવાનો છે કે ભારતનું ESDM ઈકોસિસ્ટમ ક્વાન્ટમ ક્ષેત્રની મહત્વાકાંક્ષાઓ સાથે સમકક્ષ રીતે વિકસે.

હવે ભારતે “ક્વાન્ટમ નેશન” બનવા તરફ આગળ વધવું પડશે—વિશ્વસનીય સપ્લાય ચેઇન, સ્થાનિક નવીનતા અને સેમિકન્ડક્ટર આધારિત વિકાસ પર આધારિત.

Date	15th April
Publication	Satellite samachar
Quote By	Ashok Chandak

અશોક ચાંડક: વર્લ્ડ ક્વાન્ટમ ડે ૨૦૨૬ ભારતના ટેકનોલોજી નેતૃત્વના નવા યુગની શરૂઆત

વર્લ્ડ ક્વાન્ટમ ડે ૨૦૨૬ ભારતના ટેકનોલોજી અપનાવવાથી લઈને ટેકનોલોજી નેતૃત્વ સુધીના પ્રવાસમાં એક મહત્વપૂર્ણ મંચ દર્શાવે છે. અમરાવતીમાં ઊદ્ઘોલન ફેસ્ટિવલ પહેલ હેઠળ ભારતની પ્રથમ ઊદ્ઘોલન પ્લેટફોર્મ અને **Reference Facilities**નું લોન્ચ એ સ્પષ્ટ સંકેત છે કે ભારત હવે આગામી પેઢીની કમ્પ્યુટિંગ માટે મૂળભૂત ક્ષમતાઓ વિકસાવી રહ્યું છે.

આ મહત્વપૂર્ણ પહેલ, આંધ્ર પ્રદેશના માનનીય મુખ્યમંત્રી શ્રી એન. ચંદ્રબાબુ નાયડુના નેતૃત્વ હેઠળ, આ વાતને મજબૂત બનાવે છે કે ટેકનોલોજીકલ સ્વરાજ્ય માટે દેશની અંદર જ કોર ઇન્ફ્રાસ્ટ્રક્ચર—કમ્પ્યુટિંગ, મટિરિયલ્સ અને સિસ્ટમ્સ—નિર્માણ કરવું અનિવાર્ય છે.

ક્વાન્ટમ ક્રાંતિનો મૂળ આધાર સેમિકન્ડક્ટર્સ પર રહેશે. કાયોજેનિક કન્ટ્રોલ ઇલેક્ટ્રોનિક્સથી લઈને એડવાન્સ્ડ ચિપ ડિઝાઇન, પેકેજિંગ અને પ્રિસિઝન મેન્યુફેક્ચરિંગ સુધી, સેમિકન્ડક્ટર ઇકોસિસ્ટમ સ્કેલેબલ ક્વાન્ટમ સિસ્ટમ્સનો આધારસ્તંભ છે. ડિઝાઇનમાં ભારતની વધતી શક્તિ, ઉભરતા ફેબ્રિકેશન પ્રયાસો અને નેશનલ ક્વાન્ટમ મિશન હેઠળ મળતી ગતિ સાથે, આપણે દેશની અંદર જ ક્વાન્ટમ હાર્ડવેર સ્ટેક સહ-વિકસાવવા માટે અનોખી સ્થિતિમાં છીએ,” એમ IESAના પ્રેસિડન્ટ અશોક ચાંડકે જણાવ્યું.

IESA ખાતે અમારો સ્પષ્ટ ફોકસ છે—ભારતનું ઈજીટ્સ ઇકોસિસ્ટમ ક્વાન્ટમ મહત્વાકાંક્ષાઓ સાથે સમન્વયમાં વિકસે: ભારતમાં જ ક્વાન્ટમ-ક્લાસ

હાર્ડવેરનું ડિઝાઇન, ફેબ્રિકેશન, પેકેજિંગ અને ટેસ્ટિંગ કરવામાં આવે.

ભારતે આગામી થોડા વર્ષોમાં ક્વાન્ટમ ક્ષમતાઓને મોટા પાયે વિકસાવવાનું લક્ષ્ય નક્કી કર્યું છે. આ માટે સેમિકન્ડક્ટર નવીનતા, એડવાન્સ્ડ મટિરિયલ્સ અને સિસ્ટમ એન્જિનિયરિંગ વચ્ચે ઘનિષ્ઠ સંકલન જરૂરી છે.

IESAએ ભારતને **Product Nation, Production Nation** અને **Skills Nation** તરીકે આગળ ધપાવ્યું છે. આજે અમે ચોથું પરિમાણ ઉમેરીએ છીએ—ભારતે **“Quantum Nation”** બનવું જોઈએ, જે વિશ્વસનીય સપ્લાય ચેઇન, સ્થાનિક નવીનતા અને ડીપ-ટેક ક્ષેત્રમાં વૈશ્વિક નેતૃત્વ પર આધારિત હોય,” એમ અશોક ચાંડકે ઉમેર્યું.

Date	15th April
Publication	Gujarat Pranam
Quote By	Ashok Chandak

અશોક ચાંડક: વર્લ્ડ ક્વાન્ટમ ડે ૨૦૨૬ ભારતને “ક્વાન્ટમ નેશન” તરફ દોરી રહ્યું છે

વર્લ્ડ ક્વાન્ટમ ડે ૨૦૨૬ ભારતના ડીપ-ટેક નેતૃત્વ તરફના પ્રવાસમાં એક મહત્વપૂર્ણ પગલું સાબિત થાય છે. અમરાવતીમાં ક્વાન્ટમ ટેસ્ટ ફેસિલિટીઝનું લોન્ચ, માનનીય મુખ્યમંત્રી શ્રી એન. ચંદ્રબાબુ નાયડુના નેતૃત્વ હેઠળ, ભારત હવે ટેકનોલોજી અપનાવવાથી આગળ વધી પોતાની મૂળભૂત ક્ષમતાઓ નિર્માણ કરી રહ્યું છે તેવો મજબૂત સંકેત આપે છે.

ક્વાન્ટમ ક્રાંતિનો આધાર સેમિકન્ડક્ટર્સ રહેશે—ચિપ

ડિઝાઇનથી લઈને એડવાન્સ્ડ પેકેજિંગ અને કન્ટ્રોલ સિસ્ટમ્સ સુધી. IESA ખાતે અમારો ફોકસ એ સુનિશ્ચિત કરવાનો છે કે ભારતનું ઈજીટ્સ ઈકોસિસ્ટમ ક્વાન્ટમ ક્ષેત્રની મહત્વાકાંક્ષાઓ સાથે સમકક્ષ રીતે વિકસે.

હવે ભારતે “ક્વાન્ટમ નેશન” બનવા તરફ આગળ વધવું પડશે—વિશ્વસનીય સપ્લાય ચેઇન, સ્થાનિક નવીનતા અને સેમિકન્ડક્ટર આધારિત વિકાસ પર આધારિત.

**The launch of India's first Quantum Test and Reference Facilities in Amaravati
under the Quantum Valley**

ONLINE Bangalore

Date	17th April
Publication	Businessthisweek
Link	India Electronics and Semiconductor Association Highlights India's Quantum Push on World Quantum Day 2026 Business News This Week

India Electronics and Semiconductor Association Highlights India's Quantum Push on World Quantum Day 2026

April 17, 2026 · Neel Achary · Business · 0



April 17: On the occasion of World Quantum Day 2026, the India Electronics and Semiconductor Association (IESA) underscored a significant milestone in India's transition from a technology adopter to a global technology leader. The launch of India's first Quantum Test and Reference Facilities in Amaravati, under the Quantum Valley initiative, marks a critical step in building foundational capabilities in next-generation computing.



The initiative, led by the Hon'ble Chief Minister of Andhra Pradesh, N. Chandrababu Naidu, reflects a strong commitment to advancing technology sovereignty by developing core infrastructure—including compute, materials, and systems—within the country.

Commenting on the development, Ashok Chandak, President of IESA, emphasized the pivotal role of semiconductors in enabling the quantum revolution. He noted that critical components such as cryogenic control electronics, advanced chip design, packaging, and precision manufacturing form the backbone of scalable quantum systems. With India's growing strengths in semiconductor design, emerging fabrication initiatives, and the momentum generated by the National Quantum Mission, the country is well-positioned to co-develop quantum hardware domestically.

IESA reiterated its focus on ensuring that India's Electronics System Design and Manufacturing (ESDM) ecosystem evolves in tandem with the nation's quantum ambitions spanning design, fabrication, packaging, and testing of quantum-class hardware within India.

As India accelerates efforts to scale quantum capabilities in the coming years, the integration of semiconductor innovation, advanced materials, and system engineering will be critical. IESA highlighted its long-standing vision of positioning India as a Product Nation, Production Nation, and Skills Nation, and called for the addition of a fourth dimension transforming India into a Quantum Nation.

Anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech, India's quantum journey is poised to unlock new frontiers in science, technology, and economic growth.

Date	17th April
Publication	Business Hour 9
Link	<u>India Electronics and Semiconductor Association Highlights India's Quantum Push on World Quantum Day 2026 – businesshour9.com</u>

India Electronics and Semiconductor Association Highlights India's Quantum Push on World Quantum Day 2026

April 17, 2026 • admin

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Date	17th April
Publication	Business NewsByte
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Date	15th April
Publication	Startupbusinessstories
Link	India Electronics and Semiconductor Association Highlights India's Quantum Push on World Quantum Day 2026 - startup business stories

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Date	17th April
Publication	Vicharavisthara
Link	ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪಯಣದಲ್ಲಿ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಉದ್ಘಾಟನೆ ಮಹತ್ವದ ಮೈಲಿಗಲ್ಲು: ಐಇಎಸ್‌ಎ - ವಿಚಾರ ವಿಸ್ತಾರ

ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪಯಣದಲ್ಲಿ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಉದ್ಘಾಟನೆ ಮಹತ್ವದ ಮೈಲಿಗಲ್ಲು: ಐಇಎಸ್‌ಎ



ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಉದ್ಘಾಟನೆ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಪಯಣದ ಬಗ್ಗೆ ಐಇಎಸ್‌ಎ ವಿಚಾರ ವಿಸ್ತಾರ.

ಐಇಎಸ್‌ಎ ವಿಚಾರ ವಿಸ್ತಾರದ ಉದ್ದೇಶವು, ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪಯಣದ ಬಗ್ಗೆ ಐಇಎಸ್‌ಎ ವಿಚಾರ ವಿಸ್ತಾರವನ್ನು ಪ್ರಚಾರಿಸುವುದು ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಪಯಣದ ಬಗ್ಗೆ ಐಇಎಸ್‌ಎ ವಿಚಾರ ವಿಸ್ತಾರವನ್ನು ಪ್ರಚಾರಿಸುವುದು.

ಐಇಎಸ್‌ಎ ವಿಚಾರ ವಿಸ್ತಾರದ ಉದ್ದೇಶವು, ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪಯಣದ ಬಗ್ಗೆ ಐಇಎಸ್‌ಎ ವಿಚಾರ ವಿಸ್ತಾರವನ್ನು ಪ್ರಚಾರಿಸುವುದು ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಪಯಣದ ಬಗ್ಗೆ ಐಇಎಸ್‌ಎ ವಿಚಾರ ವಿಸ್ತಾರವನ್ನು ಪ್ರಚಾರಿಸುವುದು.

₹3,300 ಕೋಟಿ ಮೊದಲ ಬಾರಿಗೆ ನಿರ್ಮಿಸಲಾಗುವ ಉದ್ಯಮ

ಐಇಎಸ್‌ಎ ವಿಚಾರ ವಿಸ್ತಾರದ ಉದ್ದೇಶವು, ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪಯಣದ ಬಗ್ಗೆ ಐಇಎಸ್‌ಎ ವಿಚಾರ ವಿಸ್ತಾರವನ್ನು ಪ್ರಚಾರಿಸುವುದು ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಪಯಣದ ಬಗ್ಗೆ ಐಇಎಸ್‌ಎ ವಿಚಾರ ವಿಸ್ತಾರವನ್ನು ಪ್ರಚಾರಿಸುವುದು.

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Date	17th April
Publication	Business Hour 9
Link	India Electronics and Semiconductor Association Highlights India's Quantum Push on World Quantum Day 2026 – busineshour9.com

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April 17: On the occasion of World Quantum Day 2026, the India Electronics and Semiconductor Association (IESA) underscored a significant milestone in India's transition from a technology adopter to a global technology leader. The launch of India's first Quantum Test and Refinement Facilities in Amaravati, under the Quantum Valley Initiative, marks a critical step in building foundational capabilities in next-generation computing.



The initiative, led by the Hon'ble Chief Minister of Andhra Pradesh, N. Chandrababu Naidu, reflects a strong commitment to advancing technology sovereignty by developing core infrastructures—including compute, materials, and systems—within the country.

Commenting on the development, Ashok Chandak, President of IESA, emphasized the pivotal role of semiconductors in enabling the quantum revolution. He noted that critical components such as ergonomic control electronics, advanced chip design, packaging, and precision manufacturing form the backbone of scalable quantum systems. With India's growing strengths in semiconductor design, emerging fabrication initiatives, and the momentum generated by the National Quantum Mission, the country is well-positioned to co-develop quantum hardware domestically.

IESA reiterated its focus on ensuring that India's Electronics System Design and Manufacturing (ESDM) ecosystem evolves in tandem with the nation's quantum ambitions spanning design, fabrication, packaging, and testing of quantum-class hardware within India.

As India accelerates efforts to scale quantum capabilities in the coming years, the integration of semiconductor innovation, advanced materials, and system engineering will be critical. IESA highlighted its long-standing vision of positioning India as a Product Nation, Production Nation, and Skills Nation, and called for the addition of a fourth dimension transforming India into a Quantum Nation.

Anchored in trusted supply chains, indigenous innovation, and global leadership in deep-tech, India's quantum journey is poised to unlock new frontiers in science, technology, and economic growth.

**Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision
Print GUWAHATI**

Date	04th April
Publication	Sentinel
Quote By	Ashok Chandak

भारत के लिए ईसीएमएस विजन है गेम चेंजर : अशोक चांडक

मुंबई, 3 अप्रैल (आईएनएस)। ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैनुफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। आईईएसए के प्रेसीडेंट अशोक चांडक ने कहा कि लिथियम आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरीयां 16 प्रोडक्ट सैगमेंटों में हैं, और ये 8 राज्यों में फैले हुए हैं, जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। आईईएसए, इलेक्ट्रॉनिक्स और सूचना प्रौद्योगिकी मंत्रालय को उसके अग्रसक्रिय दृष्टिकोण और फास्ट ट्रेक अप्रूवल के लिए बधाई देता है, जिससे ईकोसिस्टम डैवलपमेंट में काफी तेजी आई है। जैसे-जैसे 2026 आकार लेने लगा है, भारत ने एक भरोसेमंद, निवेश योग्य ईएसडीएम डेस्टिनेशन के तौर पर दुनिया का भरोसा जीता है। ईसीएमएस एक गेम चेंजर है क्योंकि एक मजबूत ईकोसिस्टम के लिए सिर्फ सेमीकंडक्टर ही नहीं, बल्कि कम्पोनेंट, मटीरियल और इलेक्ट्रॉनिक्स वैल्यू एडिशन की भी जरूरत होती है। माननीय मंत्री जी का निरंतर मार्गदर्शन-खासकर डिजाइन कॉम्पिटेन्सी और सिक्स सिग्मा क्वालिटी को मजबूत करने पर- दीर्घ-कालिक वैश्विक प्रतिस्पर्धात्मकता निर्मित करने हेतु समयोचित एवं महत्वपूर्ण दोनों हैं। आईईएसए इलेक्ट्रॉनिक्स और सेमीकंडक्टर सेक्टर में डिजाइन आधारित मैनुफैक्चरिंग दृष्टिकोण को लगातार बढ़ावा दे रहा है और उसकी वकालत कर रहा है, और हमारे सदस्य भारत में डिजाइन, इनोवेशन और प्रोडक्ट रचना की उन्नति के लिए गहराई से प्रतिबद्ध हैं। अगले चरण में स्केलिंग अप, मजबूत डिजाइन टीम निर्माण, लोकल सोर्सिंग और विश्व स्तरीय गुणवत्ता पर फोकस होना चाहिए।

Date	02nd April
Publication	Dainik Batori Kakot
Quote By	Ashok Chandak

ডিজাইন দক্ষতা আৰু গুণগত উৎকৃষ্টতাঃ ভাৰতৰ ইচিএমএছ দৃষ্টিভংগী বৃদ্ধি কৰাৰ বাবে অতি গুৰুত্বপূৰ্ণ

গুৱাহাটী, ১ এপ্ৰিলঃ ইচিএমএছ
আঁচনিৰ সফলতাই ইলেকট্ৰনিকছ
উৎপাদনত ভাৰতৰ অভিপ্ৰায়ৰ
পৰা কাৰ্যকৰীকৰণলৈ স্পষ্ট
পৰিৱৰ্তনৰ সূচনা কৰিছে।
অনুমোদনসমূহ ১৬টা উৎপাদন
খণ্ডত বিস্তৃত, যেনে লিথিয়াম-
আয়ন কোষ, নমনীয় পিচিবিৰ
পৰা আৰম্ভ কৰি কানেষ্টৰ আৰু
ডিছপ্লে মডিউললৈকে আৰু ৮
খন ৰাজ্যত বিতৰিত হৈছে। এই
বিনিয়োগসমূহে ১৪,০০০ তকৈও
অধিক চাকৰি সৃষ্টি কৰিব বুলি
আশা কৰা হৈছে আৰু ৮৪,৫১৫
কোটিৰ উৎপাদন
চলাব। সাধাৰণতে, ইচিএমএছ

কাৰ্যসূচীত ১২খন ৰাজ্যৰ পৰা ২৩টা উৎপাদন শ্ৰেণীত ৭৫টা আবেদন
দেখা গৈছে। ৫৯,৩৫০ কোটি টকাৰ লক্ষ্য বিনিয়োগৰ বিপৰীতে
অনুমোদন ইতিমধ্যে ৬১,৬৭১ কোটি টকালৈ উপনীত হৈছে।
আঁচনিখনে ৪,৫১,৮৫৮ কোটি টকাৰো অধিক উৎপাদন সক্ষম কৰিব
বুলি আশা কৰা হৈছে, যি সামগ্ৰিক লক্ষ্য ৪,৫৬,৫০০ কোটি টকাৰ
ওচৰ চাপি আহিছে। আনহাতে চাকৰি সৃষ্টি ইতিমধ্যে ৬৫,০০০তকৈ
অধিক হৈছে যিটো প্ৰক্ষেপিত ৯১,৬০০ চাকৰিৰ বিপৰীতে।
আইইএছএই মেইটিওক তেওঁলোকৰ সক্ৰিয় দৃষ্টিভংগী আৰু দ্ৰুতগতিত
অনুমোদনৰ বাবে অভিনন্দন জনাইছে। মন্ত্ৰীৰ অব্যাহত নিৰ্দেশনা,
বিশেষকৈ ডিজাইন দক্ষতা আৰু ছিফ্ট চিগমা গুণগত মানদণ্ড শক্তিশালী
কৰাৰ ওপৰত, দীৰ্ঘম্যাদী বিশ্ব প্ৰতিযোগিতামূলকতা গঢ়ি তোলাৰ
বাবে সময়োপযোগী আৰু অতি গুৰুত্বপূৰ্ণ। আইইএছএই ইলেকট্ৰনিকছ
আৰু ছেমিকণ্ডাক্টৰ খণ্ডত ডিজাইন-নেতৃত্বাধীন উৎপাদন পদ্ধতিৰ
পোষকতা আৰু সমৰ্থন কৰি আহিছে, আৰু আমাৰ সদস্যসকলে
ভাৰতত ডিজাইন, উদ্ভাৱন আৰু উৎপাদন অগ্ৰসৰ কৰাত গভীৰভাৱে
প্ৰতিশ্ৰুতিবদ্ধ হৈ আছে।

Date	1st April
Publication	The North East Times
Quote By	Ashok Chandak

Design competency and quality excellence: Critical to scaling India's ECMS vision

By Ashok Chandak, President, IESA

The success of the ECMS scheme marks India's decisive shift from intent to execution in electronics manufacturing. The approvals span 16 product segments, from lithium-ion cells and flexible PCBs to connectors and display modules, and are spread across 8 states, with Karnataka and Maharashtra leading in project count. These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515 cr highlighting the strong momentum being created under the scheme.

Broadly, the ECMS programme has seen 75 applications across 23 product categories from 12 states, reflecting strong industry participation across the country. Against a target investment of Rs 59,350 cr, approvals have already reached Rs 61,671 cr, demonstrating the industry's strong confidence in the policy framework. The scheme is expected to enable production worth over Rs 4,51,858 cr, moving close to the overall target of Rs 4,56,500 cr, while employment generation has already reached over 65,000 jobs against a projected 91,600 jobs. IESA congratulates MeitY for its proactive approach and fast-tracked approvals, which have significantly accelerated ecosystem development. As 2026 begins to shape, India has earned global trust as a credible, investible ESDM destination. ECMS is a game-changer because a strong ecosystem needs components, materials, and electronics value addition, not just semiconductors. The continued guidance of the Minister, particularly on strengthening design competency and Six Sigma quality, is both timely and critical to building long-term global competitiveness. IESA has been consistently nurturing and advocating a design-led manufacturing approach across the electronics and semiconductor sectors, and our members remain deeply committed to advancing design, innovation, and product creation in India.

Date	1st April
Publication	The Assam Post
Quote By	Ashok Chandak

Design competency and quality excellence: Critical to scaling India's ECMS vision

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Ashok Chandak, President, IESA

Date	1st April
Publication	The Meghalaya Guardian
Quote By	Ashok Chandak

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Date	1st April
Publication	Purvanchal Prahari
Quote By	Ashok Chandak

भारत के ईसीएमएस विजन को आगे बढ़ाने के लिए अहम

नई दिल्ली : ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम-आयन बैटरी और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरीयां 16 प्रोडक्ट सैगमेंटों में हैं, और ये 8 राज्यों में फैले हुए हैं, जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा

नौकरियां पैदा होने और 84,515 करोड़ रुपए का उत्पादन होने की उम्मीद है, जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है। मोटे तौर पर, ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं, जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। रु. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही 61,671 करोड़ तक पहुंच चुकी है, जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है।

**Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision
Print Lucknow**

Date	1st April
Publication	Avadhama
Quote By	Ashok Chandak

डिजिटल सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विज्ञ को आगे बढ़ने के लिए अहम: अशोक चांडक

लखनऊ। अशोक चांडक, प्रेसिडेंट, आईईएसए ने बताया है कि ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम-आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरीयां 16 प्रोडक्ट सैगमेंटों में हैं, और ये 8 राज्यों में फैले हुए हैं, जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है, जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है।

मोटे तौर पर, ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं, जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। ₹. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही ₹. 61,671 करोड़ तक पहुंच चुकी है, जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। इस स्कीम से ₹. 4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है, जो ₹. 4,56,500 करोड़ के सकल लक्ष्य के करीब है, जबकि रोजगार का सृजन पहले ही अनुमानित 91,600 नौकरियों के मुकाबले 65,000 से ज्यादा नौकरियां दे चुका है।

आईईएसए, इलेक्ट्रॉनिक्स और सूचना प्रौद्योगिकी मंत्रालय को उसके अग्रसक्रिय दृष्टिकोण और फास्ट-ट्रैक अप्रूवल के लिए बधाई देता है, जिससे ईकोसिस्टम डैवलपमेंट में काफी तेजी आई है। जैसे-जैसे 2026 आकार लेने लगा है, भारत ने एक भरोसेमंद, निवेश योग्य ईएसडीएम डेस्टिनेशन के तौर पर दुनिया का भरोसा जीता है।

Date	1st April
Publication	Lokmitra
Quote By	Ashok Chandak

भारत के ईसीएमएस विजन को आगे बढ़ाने के लिए अहम: अशोक चांडक

लोकमित्र ब्यूरो

लखनऊ। अशोक चांडक, प्रेसिडेंट, आईईएसए ने बताया है कि ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इग्रेड से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम-आयन सैल और फ्लोक्सिबल पीसीवी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरीयां 16 प्रोडक्ट सैगमेंटों में हैं, और ये 8 राज्यों में फैले हुए हैं, जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है, जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है। मोटे तौर पर, ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं, जो पूरे देश में इंडस्ट्री की मजबूत

भागीदारी को दिखाता है। रु. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही रु. 61,671 करोड़ तक पहुंच चुकी है, जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। इस स्कीम से रु. 4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है, जो रु. 4,56,500 करोड़ के सकल लक्ष्य के करीब है, जबकि रोजगार का सृजन पहले ही अनुमानित 91,600 नौकरियों के मुकाबले 65,000 से ज्यादा नौकरियां दे चुका है। आईईएसए, इलेक्ट्रॉनिक्स और सूचना प्रौद्योगिकी मंत्रालय को उसके अग्रसक्रिय दृष्टिकोण और फास्ट-ट्रैक अप्रूवल के लिए बधाई देता है, जिससे ईकोसिस्टम डैवलपमेंट में काफी तेजी आई है। जैसे-जैसे 2026 आकार लेने लगा है, भारत ने एक भरोसेमंद, निवेश योग्य ईएसडीएम डेस्टिनेशन के तौर पर दुनिया का भरोसा जीता है।

Date	1st April
Publication	Ayodhya Times
Quote By	Ashok Chandak

डिजाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विजन को आगे बढ़ाने के लिए अहम : अशोक चांडक

लखनऊ। अशोक चांडक प्रेसिडेंट ए आईईएसए ने बताया ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैनुफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरीयां 16 प्रोडक्ट सैगमेंटों में हैं और ये 8 राज्यों में फैले हुए हैं जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद

में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है। मोटे तौर पर ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। रु. 59,350 करोड़ के लक्षित निवेश के

मुकाबले, मंजूरी पहले ही रु. 61,671 करोड़ तक पहुंच चुकी है जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। इस स्कीम से रु. 4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है जो रु. 4,56,500 करोड़ के सकल लक्ष्य के करीब है जबकि रोजगार का सृजन पहले ही अनुमानित 91,600 नौकरियों के मुकाबले 65,000 से ज्यादा नौकरियां दे चुका है।

Date	1st April
Publication	Jansandesh Times
Quote By	Ashok Chandak

डिजाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विजन को आगे बढ़ाने के लिए अहम : अशोक चांडक

लखनऊ। अशोक चांडक प्रेसिडेंट ए आईईएसए ने बताया ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम.आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरियां 16 प्रोडक्ट सैगमेंटों में हैं और ये 8 राज्यों में फैले हुए हैं जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है। मोटे तौर पर ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। रु. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही रु. 61,671 करोड़ तक पहुंच चुकी है जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। इस स्कीम से रु. 4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है जो रु. 4,56,500 करोड़ के सकल लक्ष्य के करीब है जबकि रोजगार का सृजन पहले ही अनुमानित 91,600 नौकरियों के मुकाबले 65,000 से ज्यादा नौकरियां दे चुका है।

Date	1st April
Publication	AAJ
Quote By	Ashok Chandak

डिज़ाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विज़न को आगे बढ़ाने के लिए अहम

नई दिल्ली। आईईएसए के अध्यक्ष अशोक चांडक ने आज यहां कहा कि ईसीएमएस स्कीम की सफलता

दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम-आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरियां 16 प्रोडक्ट सैगमेंटों में हैं, और ये 8 राज्यों में फैले हुए हैं, जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है, जो इस स्कीम के तहत

बन रहे मजबूत मोमेंटम को दिखाता है। मोटे तौर पर, ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं, जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। रु. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही रु. 61,671 करोड़ तक पहुंच चुकी है, जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। इस स्कीम से रु. 4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है, जो रु. 4,56,500 करोड़ के सकल लक्ष्य के करीब है।

Date	1st April
Publication	Niyadheesh
Quote By	Ashok Chandak

डिज़ाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विज़न को आगे बढ़ाने के लिए अहम : अशोक चांडक

लखनऊ। अशोक चांडक, में 75 आवेदन आए हैं, जो पूरे देश में इंडस्ट्री की मज़बूत भागीदारी को दिखाता है। ईसीएमएस ने बताया है कि ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स के लक्षित निवेश के मुकाबले, मंजूरी मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल पहले ही रु. 61,671 करोड़ तक की ओर एक निर्णायक परिवर्तन पहुंच चुकी है, जो नीतिगत ढांचे में आया है। लिथियम-आयन सैल और इंडस्ट्री के मज़बूत भरोसे को फ्लेक्सिबल पीसीबी से लेकर दिखाता है। इस स्कीम से रु. कनेक्टर और डिस्प्ले मॉड्यूल तक 4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है, जो मंजूरियां 16 प्रोडक्ट सैगमेंटों में हैं, और ये 8 राज्यों में फैले हुए रु. 4,56,500 करोड़ के सकल हैं, जिसमें कर्नाटक और महाराष्ट्र लक्ष्य के करीब है, जबकि रोज़गार प्रोजेक्ट की तदाद में सबसे आगे का सृजन पहले ही अनुमानित हैं। इन निवेशों से 14,000 से ज्यादा 91,600 नौकरियों के मुकाबले 65,000 नौकरियां पैदा होने और 84,515 से ज्यादा नौकरियां दे चुका है। ईसीएमएस, इलेक्ट्रॉनिक्स और सूचना प्रौद्योगिकी मंत्रालय को उसके अग्रसक्रिय दृष्टिकोण और फास्ट-ट्रैक अप्रूवल के लिए बधाई देता है, जिससे ईकोसिस्टम में 12 राज्यों से 23 उत्पाद श्रेणियों डेवलपमेंट में काफी तेज़ी आई है।

Date	1st April
Publication	Navsatta
Quote By	Ashok Chandak

डिजाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विजन को आगे बढ़ाने के लिए अहम: अशोक चांडक

संवाददाता

लखनऊ, (नवसत्ता)। अशोक चांडक, प्रेसिडेंट, आईईएसए ने बताया है कि ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम-आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरीयां 16 प्रोजेक्ट सैगमेंटों में हैं, और ये 8 राज्यों में फैले हुए हैं, जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है, जो इस स्कीम के तहत बन रहे मजबूत मोमेंट को दिखाता है।

मोटे तौर पर, ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में

75 आवेदन आए हैं, जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। ₹. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही ₹. 61,671 करोड़ तक पहुंच चुकी है, जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। इस स्कीम से ₹.4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है, जो ₹. 4,56,500 करोड़ के सकल लक्ष्य के करीब है, जबकि रोजगार का सृजन पहले ही अनुमानित 91,600 नौकरियों के मुकाबले 65,000 से ज्यादा नौकरियां दे चुका है। आईईएसए, इलेक्ट्रॉनिक्स और सूचना प्रौद्योगिकी मंत्रालय को उसके अग्रसक्रिय दृष्टिकोण और फास्ट-ट्रैक अप्रूवल के लिए बधाई देता है, जिससे ईकोसिस्टम डैवलपमेंट में काफी तेजी आई है। जैसे-जैसे 2026 आकार लेने लगा है, भारत ने एक भरोसेमंद, निवेश योग्य ईएसडीएम

डिस्टिनेशन के तौर पर दुनिया का भरोसा जीता है। ईसीएमएस एक गेम-चेंजर है क्योंकि एक मजबूत ईकोसिस्टम के लिए सिर्फ सेमीकंडक्टर ही नहीं, बल्कि कम्पोनेंट, मटीरियल और इलेक्ट्रॉनिक्स वैल्यू एडिशन की भी जरूरत होती है। मंत्री का निरंतर मार्गदर्शन -खासकर डिजाइन कॉम्पिटेन्सी और सिक्स सिग्मा क्वालिटी को मजबूत करने पर- दीर्घ-कालिक वैश्विक प्रतिस्पर्धात्मकता निर्मित करने हेतु सम्योचित एवं महत्वपूर्ण दोनों है। आईईएसए इलेक्ट्रॉनिक्स और सेमीकंडक्टर सेक्टर में डिजाइन आधारित मैन्युफैक्चरिंग दृष्टिकोण को लगातार बढ़ावा दे रहा है और उसकी कालत कर रहा है, और हमारे सदस्य भारत में डिजाइन, इनोवेशन और प्रोजेक्ट रचना की उन्नति के लिए गहराई से प्रतिबद्ध हैं।

Date	1st April
Publication	Rashtriya Khabar
Quote By	Ashok Chandak

डिजाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विजन को आगे बढ़ाने के लिए अहम : अशोक चांडक

लखनऊ। अशोक चांडक प्रेसिडेंट ए आईईएसए ने बताया ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम.आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरीयां 16 प्रोडक्ट सैगमेंटों में हैं और ये 8 राज्यों में फैले हुए हैं जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां

पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है।

मोटे तौर पर ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। रु. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही रु. 61,671 करोड़ तक पहुंच चुकी है जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है।

Date	1st April
Publication	Prabhatbhedhi
Quote By	Ashok Chandak

डिज़ाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विज़न को आगे बढ़ाने के लिए अहम : अशोक चांडक

प्रभात भेदी नेटवर्क

लखनऊ। अशोक चांडक, प्रेसिडेंट, आईईएसए ने बताया है कि ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम-आयन सेल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरीयां 16 प्रोजेक्ट सैगमेंटों में हैं, और ये 8 राज्यों में फैले हुए हैं, जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है, जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है। मोटे तौर पर, ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं, जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। रु. 59,350 करोड़ के लिखित निवेश के मुकाबले, मंजूरी पहले ही रु. 61,671 करोड़ तक पहुंच चुकी है, जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। इस स्कीम से रु. 4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है, जो रु. 4,56,500 करोड़ के सकल लक्ष्य के करीब है, जबकि रोजगार का सृजन पहले ही अनुमानित 91,600 नौकरियों के मुकाबले 65,000 से ज्यादा नौकरियां दे चुका है। आईईएसए, इलेक्ट्रॉनिक्स और सूचना प्रौद्योगिकी

मंत्रालय को उसके अग्रसक्रिय दृष्टिकोण और फास्ट-ट्रैक अफ़वेल के लिए बधाई देता है, जिससे ईकोसिस्टम डैवलपमेंट में काफी तेजी आई है। जैसे-जैसे 2026 आकार लेने लगा है, भारत ने एक भरोसेमंद, निवेश योग्य ईएसडीएम डेस्टिनेशन के तौर पर दुनिया का भरोसा जीता है। ईसीएमएस एक गेम-चेंजर है क्योंकि एक मजबूत ईकोसिस्टम के लिए सिर्फ सेमीकंडक्टर ही नहीं, बल्कि कम्पोनेंट, मटेरियल और इलेक्ट्रॉनिक्स वैल्यू एडिशन की भी ज़रूरत होती है। माननीय मंत्री जी का निरंतर मार्गदर्शन -खासकर डिज़ाइन कॉम्पिटेन्सी और सिक्स सिग्मा क्वालिटी को मजबूत करने पर- दीर्घ-कालिक वैश्विक प्रतिस्पर्धात्मकता निर्मित करने हेतु समयोचित एवं महत्वपूर्ण दोनों है। आईईएसए इलेक्ट्रॉनिक्स और सेमीकंडक्टर सेक्टर में डिज़ाइन आधारित मैन्युफैक्चरिंग दृष्टिकोण को लगातार बढ़ावा दे रहा है और उसकी वकालत कर रहा है, और हमारे सदस्य भारत में डिज़ाइन, इन्वेस्टमेंट और प्रोजेक्ट रचना की उन्नति के लिए गहराई से प्रतिबद्ध हैं। अगले चरण में स्केलिंग अप, मजबूत डिज़ाइन टीम निर्माण, लोकल सोर्सिंग और विश्व स्तरीय गुणवत्ता पर फोकस होना चाहिए। ओईएम और सिस्टम कंपनियों को डिज़ाइन किए गए और मेड-इन-इंडिया कम्पोनेंट्स को सक्रियता से अपनाना चाहिए क्योंकि डिमांड क्रिएशन, सर्प्लाइ क्रिएशन जितना ही ज़रूरी है, जबकि डिस्ट्रीब्यूटर भारतीय प्रोजेक्ट्स को बिल ऑफ मटेरियल्स में ग्लोबल इंटीग्रेशन में मदद करते हैं।

Date	1st April
Publication	Pioneer
Quote By	Ashok Chandak

डिजाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विजन को आगे बढ़ाने के लिए अहम : अशोक चांडक

लखनऊ। अशोक चांडक प्रेसिडेंट ए आईईएसए ने बताया ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम.आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरीयां 16 प्रोडक्ट सैगमेंटों में हैं और ये 8 राज्यों में फैले हुए हैं जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है। मोटे तौर पर ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। रु. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही रु. 61,671 करोड़ तक पहुंच चुकी है जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। इस स्कीम से रु. 4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है जो रु. 4,56,500 करोड़ के सकल लक्ष्य के करीब है जबकि रोजगार का सृजन पहले ही अनुमानित 91,600 नौकरियों के मुकाबले 65,000 से ज्यादा नौकरियां दे चुका है। आईईएसए इलेक्ट्रॉनिक्स और सूचना प्रौद्योगिकी मंत्रालय को उसके अग्रसक्रिय दृष्टिकोण और फास्ट.ट्रैक अप्रूवल के लिए बधाई देता है जिससे ईकोसिस्टम डैवलपमेंट में काफी तेजी आई है।

Date	1st April
Publication	Readers Messenger
Quote By	Ashok Chandak

डिजाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विज़न को आगे बढ़ाने के लिए अहम : अशोक चांडक

रीडर्स मैसेंजर नेटवर्क

लखनऊ। अशोक चांडक, प्रेसिडेंट, आईईएसए ने बताया है कि ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम-आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्पले मॉड्यूल तक मंजूरीयां 16 प्रोडक्ट सैगमेंटों में हैं, और ये 8 राज्यों में फैले हुए हैं, जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है, जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है। मोटे तौर पर, ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं, जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। ₹. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही ₹. 61,671 करोड़ तक पहुंच चुकी है, जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। इस स्कीम से ₹. 4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है, जो ₹. 4,56,500 करोड़ के सकल लक्ष्य के करीब है, जबकि रोजगार का सृजन पहले ही अनुमानित 91,600 नौकरियों के मुकाबले 65,000 से ज्यादा नौकरियां दे चुका है। आईईएसए, इलेक्ट्रॉनिक्स और सूचना प्रौद्योगिकी

मंत्रालय को उसके अग्रसक्रिय दृष्टिकोण और फास्ट-ट्रैक अफ़वॉल के लिए बधाई देता है, जिससे ईकोसिस्टम डैवलपमेंट में काफी तेज़ी आई है। जैसे-जैसे 2026 आकार लेने लगा है, भारत ने एक भरोसेमंद, निवेश योग्य ईएसडीएम डेस्टिनेशन के तौर पर दुनिया का भरोसा जीता है। ईसीएमएस एक गेम-चेंजर है क्योंकि एक मजबूत ईकोसिस्टम के लिए सिर्फ सेमीकंडक्टर ही नहीं, बल्कि कम्पोनेंट, मटेरियल और इलेक्ट्रॉनिक्स वैल्यू एडिशन की भी ज़रूरत होती है। माननीय मंत्री जी का निरंतर मार्गदर्शन -खासकर डिजाइन कॉम्पिटेन्सी और सिक्स सिग्मा क्वालिटी को मजबूत करने पर- दीर्घ-कालिक वैश्विक प्रतिस्पर्धात्मकता निर्मित करने हेतु समयोचित एवं महत्वपूर्ण दोनों हैं। आईईएसए इलेक्ट्रॉनिक्स और सेमीकंडक्टर सेक्टर में डिजाइन आधारित मैन्युफैक्चरिंग दृष्टिकोण को लगातार बढ़ावा दे रहा है और उसकी क्वालिटी कर रहा है, और हमारे सदस्य भारत में डिजाइन, इन्वेस्टमेंट और प्रोडक्ट रचना की उन्नति के लिए गहराई से प्रतिबद्ध हैं। अगले चरण में स्केलिंग अप, मजबूत डिजाइन टीम निर्माण, लोकल सोर्सिंग और विश्व स्तरीय गुणवत्ता पर फोकस होना चाहिए। ओईएम और सिस्टम कंपनियों को डिजाइन किए गए और मेड-इन-इंडिया कम्पोनेंट्स को सक्रियता से अपनाना चाहिए क्योंकि डिमांड क्रिएशन, सप्लाय क्रिएशन जितना ही ज़रूरी है, जबकि डिस्ट्रीब्यूटर भारतीय प्रोडक्ट्स को बिल ऑफ मटेरियल्स में ग्लोबल इंटिग्रेशन में मदद करते हैं।

Date	1st April
Publication	United Bharat
Quote By	Ashok Chandak

डिजाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस

विज्ञान को आगे बढ़ाने के लिए अहम: अशोक चांडक

लखनऊ । अशोक चांडक, प्रेसिडेंट, आईईएसए ने बताया है कि ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम-आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिम्पले मॉड्यूल तक मंजूरीयां 16 प्रोडक्ट सैगमेंटों में हैं, और ये 8 राज्यों में फैले हुए हैं, जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है, जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है। मोटे तौर पर, ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं, जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। रु. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही रु. 61,671 करोड़ तक पहुंच चुकी है, जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। इस स्कीम से रु. 4,51,858 करोड़ से ज्यादा का उत्पादन होने की उम्मीद है, जो रु. 4,56,500 करोड़ के सकल लक्ष्य के करीब है, जबकि रोजगार का सृजन पहले ही अनुमानित 91,600 नौकरियों के मुकाबले 65,000 से ज्यादा नौकरियां दे चुका है। आईईएसए, इलेक्ट्रॉनिक्स और सूचना प्रौद्योगिकी मंत्रालय को उसके अग्रसक्रिय ट्रिप्लिकोण और फास्ट-ट्रैक अप्रुवल के लिए बधाई देता है, जिससे ईकोसिस्टम डेवलपमेंट में काफी तेजी आई है। जैसे-जैसे 2026 आकार लेने लगा है, भारत ने एक भरोसेमंद, निवेश योग्य ईएसडीएम डेस्टिनेशन के तौर पर दुनिया का भरोसा जीता है। ईसीएमएस एक गेम-चेंजर है क्योंकि एक मजबूत ईकोसिस्टम के लिए सिर्फ सेमीकंडक्टर ही नहीं, बल्कि कम्पोनेंट, मटीरियल और इलेक्ट्रॉनिक्स वैल्यू एडिशन की भी जरूरत होती है।

Date	1st April
Publication	Voice Of Lucknow
Quote By	Ashok Chandak

ईसीएमएस विजन को आगे बढ़ाने के लिए अहम है डिजाइन सामर्थ्य और गुणवत्ता

बंगलुरु। अशोक चांडक, प्रेसिडेंट, आईईएसए ने बताया है कि ईसीएमएस स्कीम की सफलता दशाती है कि भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम-आयन सैल और फ्लोक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरियां 16 प्रोडक्ट सेगमेंटों में हैं, और ये 8 राज्यों में फैले हुए हैं, जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है, जो इस स्कीम के तहत बन रहे मजबूत मोमेंटम को दिखाता है। मोटे तौर पर, ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं।

Date	1st April
Publication	Shah Times
Quote By	Ashok Chandak

डिजाइन सामर्थ्य और गुणवत्ता उत्कृष्टता भारत के ईसीएमएस विजन को आगे बढ़ाने के लिए अहम : अशोक चांडक

लखनऊ। अशोक चांडक प्रेसिडेंट ए आईईएसए ने बताया ईसीएमएस स्कीम की सफलता दर्शाती है कि भारत के इलेक्ट्रॉनिक्स मैनुफैक्चरिंग क्षेत्र में इरादे से अमल की ओर एक निर्णायक परिवर्तन आया है। लिथियम.आयन सैल और फ्लेक्सिबल पीसीबी से लेकर कनेक्टर और डिस्प्ले मॉड्यूल तक मंजूरीयां 16 प्रोडक्ट सैगमेंटों में हैं और ये 8 राज्यों में फैले हुए हैं जिसमें कर्नाटक और महाराष्ट्र प्रोजेक्ट की तदाद में सबसे आगे हैं। इन निवेशों से 14,000 से ज्यादा नौकरियां पैदा होने और 84,515 करोड़ रुपये का उत्पादन होने की उम्मीद है जो इस स्कीम के तहत बन

रहे मजबूत मोमेंटम को दिखाता है।

मोटे तौर पर ईसीएमएस प्रोग्राम में 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन आए हैं जो पूरे देश में इंडस्ट्री की मजबूत भागीदारी को दिखाता है। रु. 59,350 करोड़ के लक्षित निवेश के मुकाबले, मंजूरी पहले ही रु. 61,671 करोड़ तक पहुंच चुकी है जो नीतिगत ढांचे में इंडस्ट्री के मजबूत भरोसे को दिखाता है। आईईएसए इलेक्ट्रॉनिक्स और सूचना प्रौद्योगिकी मंत्रालय को उसके अग्रसक्रिय दृष्टिकोण और फास्ट.ट्रैक अप्रूवल के लिए बधाई देता है जिससे ईकोसिस्टम डैवलपमेंट में काफी तेजी आई है।

**Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision
Print Bhubaneswar**

Date	1st April
Publication	Amrutadunia
Quote By	Ashok Chandak

ଡିଜାଇନ୍ ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ସ୍ଵେଲିଂ କରିବା ପାଇଁ ଗୁରୁତ୍ଵପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଂଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ଵର : ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦାୟକ ପରିବର୍ତ୍ତନକୁ ସୂଚିତ କରେ। ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଥିୟମ-ଆୟନ ସେଲ୍ ଏବଂ ନମନୀୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମତ୍ସ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୬ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକଳ୍ପ ସଂଖ୍ୟାରେ କର୍ଷାତକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି। ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ

ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ। ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିଳ୍ପ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ। ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୬୧,୬୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି। ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପନ୍ନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

Date	1st April
Publication	Desbarta
Quote By	Ashok Chandak

ଡିଜାଇନ୍ ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ସ୍ଫେଲିଂ
କରିବା ପାଇଁ ଗୁରୁତ୍ଵପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଂଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ଵର ୩୧ ମାର୍ଚ୍ଚ ୨୦୨୨ ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁୟନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦାୟକ ପରିବର୍ତ୍ତନକୁ ସୂଚିତ କରେ । ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଥିୟମ-ଆୟନ ସେଲ୍ ଏବଂ ନମନୀୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମଡ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୬ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକୃତ ସଂଖ୍ୟାରେ କର୍ଷାଟକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି । ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ । ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିକ୍ଷ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ । ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୨୧,୨୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି । ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପନ୍ନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

Date	1st April
Publication	Biswabani
Quote By	Ashok Chandak

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA

Bhubaneswar : The success of the ECMS scheme marks India's decisive shift from intent to execution in electronics manufacturing. The approvals span 16 product segments, from lithium-ion cells and flexible PCBs to connectors and display modules, and are spread across 8 states, along with Karnataka and Maharashtra leading in project count. These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515cr highlighting the strong momentum being created under the scheme. the ECMS programme has seen 75 applications across 23 product categories from 12 states, reflecting strong industry participation across the country. Against a target investment of Rs 59,350 cr, approvals have already reached Rs 61,671 cr, demonstrating the industry's strong confidence in the policy framework. The scheme is expected to enable production worth over Rs 4,51,858 cr, moving close to the overall target of Rs 4,56,500 cr, while employment generation has already reached over 65,000 jobs against a projected 91,600 jobs.

Date	1st April
Publication	Agami Orissa
Quote By	Ashok Chandak

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA

Bhubaneswar 31st March 2026: The success of the ECMS scheme marks India's decisive shift from intent to execution in electronics manufacturing. The approvals span 16 product segments, from lithium-ion cells and flexible PCBs to connectors and display modules, and are spread across 8 states, along with Karnataka and Maharashtra leading in project count. These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515cr highlighting the strong momentum being created under the scheme. the ECMS programme has seen 75 applications across 23 product categories from 12 states, reflecting strong industry participation across the country. Against a target investment of Rs 59,350 cr, approvals have already reached Rs 61,671 cr, demonstrating the industry's strong confidence in the policy framework. The scheme is expected to enable production worth over Rs 4,51,858 cr, moving close to the overall target of Rs 4,56,500 cr, while employment generation has already reached over 65,000 jobs against a projected 91,600 jobs.

Date	1st April
Publication	Dharitri
Quote By	Ashok Chandak

ଡିଜାଇନ୍ ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ଖୋଲି କରିବା ପାଇଁ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଣ୍ଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ୱର ୩୧ ମାର୍ଚ୍ଚ ୨୦୨୨ ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦାୟକ ପରିବର୍ତ୍ତନକୁ ସୂଚିତ କରେ । ଅନୁମୋଦନଗୁଡ଼ିକ ଲିୟୁୟମ୍-ଆୟନ ସେଲ୍ ଏବଂ ନମନାୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମତ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୬ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକୃତ ସଂଖ୍ୟାରେ କର୍ଷାଚକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି । ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ

କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ । ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିକ୍ଷ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ । ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୬୧,୬୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି । ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପନ୍ନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

Date	1st April
Publication	Kalinga Mail
Quote By	Ashok Chandak

ଡିଜାଇନ୍ ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ସ୍ଵେଲିଂ କରିବା ପାଇଁ ଗୁରୁତ୍ଵପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଂଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ଵର ୩୧ ମାର୍ଚ୍ଚ ୨୦୨୬ ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦାୟକ ପରିବର୍ତ୍ତନକୁ ସୂଚିତ କରେ । ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଅର୍ଯ୍ୟ-ଆୟନ ସେଲ୍ ଏବଂ ନମନାୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମଡ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୨ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକଳ୍ପ ସଂଖ୍ୟାରେ କର୍ଣ୍ଣାଟକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି । ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି

ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ । ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିଳ୍ପ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ । ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୬୧,୬୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି । ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

Date	1st April
Publication	Manthan
Quote By	Ashok Chandak

ଡିଜାଇନ୍ ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା:
ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ସ୍ୱେଲିଂ
କରିବା ପାଇଁ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ,
ପ୍ରେସିଡେଣ୍ଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ୱର : ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁୟନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦାୟକ ପରିବର୍ତ୍ତନକୁ ସୂଚିତ କରେ। ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଥିୟମ-ଆୟନ ସେଲ୍ ଏବଂ ନିମ୍ନମାଧ୍ୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମଡ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୬ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକୃତ ସଂଖ୍ୟାରେ କର୍ଷାଟକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି। ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ। ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିଳ୍ପ ଅଂଶଗୁହଣକୁ ପ୍ରତିଫଳିତ କରେ। ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୬୧,୬୬୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି। ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପନ୍ନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି।

Date	1st April
Publication	Orissa Times
Quote By	Ashok Chandak

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision- Ashok Chandak, President, IESA

Bhubaneswar 31st March 2026: The success of the ECMS scheme marks India's decisive shift from intent to execution in electronics manufacturing. The approvals span 16 product segments, from lithium-ion cells and flexible PCBs to connectors and display modules, and are spread across 8 states, along with Karnataka and Maharashtra leading in project count. These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515cr highlighting the strong momentum being created under the scheme. the ECMS programme has seen 75 applications across 23 product categories from 12 states, reflecting strong industry participation across the country. Against a target investment of Rs 59,350 cr, approvals have already reached Rs 61,671 cr, demonstrating the industry's strong confidence in the policy framework. The scheme is expected to enable production worth over Rs 4,51,858 cr, moving close to the overall target of Rs 4,56,500 cr, while employment generation has already reached over 65,000 jobs against a projected 91,600 jobs.

Date	1st April
Publication	Pratidin
Quote By	Ashok Chandak

ଡିଜାଇନ୍ ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ଝେଲିଂ କରିବା ପାଇଁ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଂଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ୱର : ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦିଷ୍ଟ ପରିବର୍ତ୍ତନକୁ ପୂର୍ଣ୍ଣ କରେ। ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଥିୟମ-ଆୟନ ବେଲ୍ ଏବଂ ନମନାୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ

ମତ୍ସ୍ନୁ ପର୍ଯ୍ୟାନ୍ତ ୧୬ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକୃତ ସଂଖ୍ୟାରେ କର୍ତ୍ତୃତ୍ୱ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି। ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି

ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦ୍ରୁତ ଗତିକୁ ଉଲ୍ଲେଖ କରେ। ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦ୍ରୁତ ଶିଳ୍ପ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ।

୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୬୧,୬୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି। ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ଭାବନା ବୋଲି ଆଶା କରାଯାଉଛି।

Date	1st April
Publication	Odisha Khabar
Quote By	Ashok Chandak

ଡିଜାଇନ୍, ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ସ୍ଫେଲିଂ କରିବା ପାଇଁ ଗୁରୁତ୍ଵପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଂଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ଵର : ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁୟନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦାୟକ ପରିବର୍ତନକୁ ସୂଚିତ କରେ । ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଭୁୟନ-ଆୟନ ସେଲ୍ ଏବଂ ନମନାୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମଡ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୨ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକଳ୍ପ ସଂଖ୍ୟାରେ କର୍ଣ୍ଣାଟକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି । ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ । ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିଳ୍ପ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ । ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୨୧,୨୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି । ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

Date	1st April
Publication	Sakala Sathi
Quote By	Ashok Chandak

ଡିଜାଇନ୍ ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ସ୍ଵେଲିଂ କରିବା ପାଇଁ ଗୁରୁତ୍ଵପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଂଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ଵର ୩୧ ମାର୍ଚ୍ଚ ୨୦୨୨ ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦାୟକ ପରିବର୍ତ୍ତନକୁ ସୂଚିତ କରେ। ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଥିୟମ-ଆୟନ ସେଲ୍ ଏବଂ ନମନାୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମତ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୨ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକଳ୍ପ ସଂଖ୍ୟାରେ କର୍ଣ୍ଣାଟକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି। ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ। ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିଳ୍ପ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ। ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୨୧,୨୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି। ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପନ୍ନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

Date	1st April
Publication	Samaya
Quote By	Ashok Chandak

ଡିଜାଇନ୍ ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ସ୍କେଲିଂ କରିବା ପାଇଁ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଂଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ୱର ୩୧ ମାର୍ଚ୍ଚ ୨୦୨୨ ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦିଷ୍ଟ ପରିବର୍ତ୍ତନକୁ ସୂଚିତ କରେ । ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଥିୟମ-ଆୟନ ସେଲ୍ ଏବଂ ନମନୀୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମଡ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୬ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକୃତ ସଂଖ୍ୟାରେ କର୍ଷାଚକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି । ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ । ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିଳ୍ପ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ । ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୨୧,୨୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି । ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପନ୍ନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

Date	1st April
Publication	sakala
Quote By	Ashok Chandak

ଓଡ଼ିଆର ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ସ୍ଵେଲିଂ

କରିବା ପାଇଁ ଗୁରୁତ୍ଵପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଣ୍ଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ୱର ୩୧ ମାର୍ଚ୍ଚ ୨୦୨୨ ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦିଷ୍ଟ ପରିବର୍ତ୍ତନକୁ ସୂଚିତ କରେ । ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଥିୟମ-ଆୟନ ସେଲ୍ ଏବଂ ନମନୀୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମଡ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୨ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକୃତ ସଂଖ୍ୟାରେ କର୍ଷାଟକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି । ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ । ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିଳ୍ପ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ । ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୨୧,୨୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି । ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

Date	1st April
Publication	Swatantra Barta
Quote By	Ashok Chandak

ଡିଜାଇନ୍, ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ସ୍କେଲିଂ କରିବା ପାଇଁ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ

ଭୁବନେଶ୍ୱର ୩୧ ମାର୍ଚ୍ଚ ୨୦୨୨ ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁୟତ୍ନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦାୟକ ପରିବର୍ତ୍ତନକୁ ସୂଚିତ କରେ । ଅନୁମୋଦନଗୁଡ଼ିକ ଲିୟୁୟନ-ଆୟନ ସେଲ୍ ଏବଂ ନମନୀୟ ପିସିବି ୦ାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମଡ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୨ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକଳ୍ପ ସଂଖ୍ୟାରେ କର୍ତ୍ତାଟକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି । ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ । ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିଳ୍ପ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ । ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୨୧,୨୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି । ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

Date	1st April
Publication	Utkal Samaja
Quote By	Ashok Chandak

ଡିଜାଇନ୍ ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା: ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ସ୍ଵେଲିଂ କରିବା ପାଇଁ ଗୁରୁତ୍ଵପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଣ୍ଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ୱର ୩୧ ମାର୍ଚ୍ଚ ୨୦୨୨ ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦାୟକ ପରିବର୍ତ୍ତନକୁ ସୁଚିତ କରେ । ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଥିୟମ-ଆୟନ ସେଲ୍ ଏବଂ ନିମ୍ନମାଧ୍ୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମଡ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୬ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକଳ୍ପ ସଂଖ୍ୟାରେ କର୍ତ୍ତାଚକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି । ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ । ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିଳ୍ପ ଅଂଶଗ୍ରହଣକୁ ପ୍ରତିଫଳିତ କରେ । ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୨୧,୨୭୧ କୋଟି ଟଙ୍କାରେ ପହଞ୍ଚିଛି । ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

Date	1st April
Publication	Utkal Mail
Quote By	Ashok Chandak

ଡିଜାଇନ୍, ଦକ୍ଷତା ଏବଂ ଗୁଣବତ୍ତା ଉତ୍କର୍ଷତା ଭାରତର ଇସିଏମଏସ୍ ଦୃଷ୍ଟିକୋଣକୁ ଝେଲିଂ କରିବା ପାଇଁ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ-ଅଶୋକ ଚାନ୍ଦକ, ପ୍ରେସିଡେଣ୍ଟ, ଆଇଇଏସଏ

ଭୁବନେଶ୍ୱର : ଇସିଏମଏସ୍ ଯୋଜନାର ସଫଳତା ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ଉଦ୍ଦେଶ୍ୟରୁ କାର୍ଯ୍ୟାନୁୟନ ପାଇଁ ଭାରତର ନିର୍ଦ୍ଦାୟକ ପରିବର୍ତ୍ତନକୁ ସୂଚିତ କରେ। ଅନୁମୋଦନଗୁଡ଼ିକ ଲିଥିୟମ-ଆୟନ ସେଲ୍ ଏବଂ ନମନାୟ ପିସିବି ଠାରୁ ଆରମ୍ଭ କରି ସଂଯୋଗକାରୀ ଏବଂ ପ୍ରଦର୍ଶନ ମତ୍ୟୁଲ୍ ପର୍ଯ୍ୟନ୍ତ ୧୨ଟି ଉତ୍ପାଦ ବିଭାଗକୁ ବିସ୍ତାରିତ କରିଥାଏ, ଏବଂ ୮ଟି

ରାଜ୍ୟରେ ବିସ୍ତାରିତ, ପ୍ରକଳ୍ପ ସଂଖ୍ୟାରେ କର୍ତ୍ତାଚକ ଏବଂ ମହାରାଷ୍ଟ୍ର ଆଗରେ ରହିଛି । ଏହି ନିବେଶଗୁଡ଼ିକ ୧୪,୦୦୦ ରୁ ଅଧିକ ନିଯୁକ୍ତି ସୃଷ୍ଟି କରିବ ଏବଂ ୮୪,୫୧୫ କୋଟି ଟଙ୍କାର ଉତ୍ପାଦନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ଯାହା ଯୋଜନା ଅଧୀନରେ ସୃଷ୍ଟି ହେଉଥିବା ଦୃଢ଼ ଗତିକୁ ଉଲ୍ଲେଖ କରେ। ବିଶେଷ ଭାବରେ, ଇସିଏମଏସ୍ କାର୍ଯ୍ୟକ୍ରମରେ ୧୨ଟି

ରାଜ୍ୟରୁ ୨୩ଟି ଉତ୍ପାଦ ବର୍ଗରେ ୭୫ଟି ଆବେଦନ ଆସିଛି, ଯାହା ସାରା ଦେଶରେ ଦୃଢ଼ ଶିଳ୍ପ ଅଂଶଗୁହଣକୁ ପ୍ରତିଫଳିତ କରେ। ୫୯,୩୫୦ କୋଟି ଟଙ୍କାର ଲକ୍ଷ୍ୟ ନିବେଶ ବିରୁଦ୍ଧରେ, ଅନୁମୋଦନ ପୂର୍ବରୁ ୬୧,୬୭୧ କୋଟି ଟଙ୍କାରେ ପହଂଚିଛି । ଏହି ଯୋଜନା ୪,୫୧,୮୫୮ କୋଟି ଟଙ୍କାରୁ ଅଧିକ ମୂଲ୍ୟର ଉତ୍ପାଦନ ସମ୍ପନ୍ନ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

**Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision
Print Punjab**

Date	3rd April
Publication	Yugmarg
Quote By	Ashok Chandak

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision: Mr Ashok Chandak, President, IESA

CHANDIGARH: Ashok Chandak, President, IESA (India Electronics & Semiconductor Association) has said, "The success of the ECMS scheme marks India's decisive shift from intent to execution in electronics manufacturing. The approvals span 16 product segments, from lithium-ion cells and flexible PCBs to connectors and display modules, and are spread across 8 states, along with Karnataka and Maharashtra leading in project count. These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515cr highlighting the strong momentum being created under the scheme. Broadly, the ECMS programme has seen 75 applications across 23 product categories from 12



states, reflecting strong industry participation across the country. Against a target investment of Rs 59,350 cr, approvals have already reached Rs 61,671 cr, demonstrating the industry's strong confidence in the policy framework. The scheme is expected to enable production worth over Rs 4,51,858 cr, moving close to the overall target of Rs 4,56,500 cr, while employment generation has already reached over 65,000 jobs against a projected 91,600 jobs. IESA congratulated MeitY for its proactive approach and fast-tracked approvals, which have significantly accelerated ecosystem development. As 2026 begins to shape, India has earned global trust as a credible, investible ESDM destination. ECMS is a game-changer because a strong ecosystem needs components, materials, and electronics value addition, not just

semiconductors. The continued guidance of the Hon'ble Minister, particularly on strengthening design competency and Six Sigma quality, is both timely and critical to building long-term global competitiveness. IESA has been consistently nurturing and advocating a design-led manufacturing approach across the electronics and semiconductor sectors, and our members remain deeply committed to advancing design, innovation, and product creation in India. The next phase must focus on scaling up, building strong design teams, local sourcing, and world-class quality. OEMs and system companies must actively adopt Designed and Made-in-India components as demand creation is as critical as supply creation while distributors enable global integration of Indian products into the bill of materials."

Date	2nd April
Publication	News Hunt
Quote By	Ashok Chandak

भारत के ईसीएमएस विज़न को विस्तार देने के लिए अत्यंत महत्वपूर्ण: अशोक चांडक, अध्यक्ष, आईईएसए

चंडीगढ़ (अमरपाल नूरपुरी): आई ई एस ए (इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन) के अध्यक्ष अशोक चांडक ने कहा, ईसीएमएस योजना की सफलता भारत के इलेक्ट्रॉनिक्स निर्माण क्षेत्र में इरादे से क्रियान्वयन की ओर निर्णायक बदलाव को दर्शाती है। स्वीकृतियाँ 16 उत्पाद श्रेणियों में फैली हुई हैं, जिनमें लिथियम-आयन सेल, फ्लेक्सिबल पीसीबी, कनेक्टर्स और डिस्प्ले मॉड्यूल शामिल हैं, और ये 8 राज्यों में वितरित हैं, जिनमें कर्नाटक और महाराष्ट्र परियोजनाओं की संख्या में अग्रणी हैं। इन निवेशों से 14,000 से अधिक रोजगार सृजित होने और रुपये 84,515 रुपये करोड़ के उत्पादन को बढ़ावा मिलने की उम्मीद है, जो इस योजना के तहत बन रही मजबूत गति को दर्शाता है।

सामान्य तौर पर, आई ई एस ए



कार्यक्रम के तहत 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन प्राप्त हुए हैं, जो देशभर में उद्योग की मजबूत भागीदारी को दर्शाता है। 59,350 रुपये करोड़ के लक्षित निवेश के मुकाबले स्वीकृतियाँ पहले ही रुपये 61,671 करोड़ तक पहुंच चुकी हैं, जो इस नीति ढांचे में उद्योग के मजबूत विश्वास को दर्शाती हैं। इस योजना से

4,51,858 करोड़ रुपये से अधिक के उत्पादन को सक्षम बनाने की उम्मीद है, जो कुल लक्ष्य 4,56,500 करोड़ रुपये के करीब है, जबकि रोजगार सृजन पहले ही 65,000 से अधिक तक पहुंच चुका है, जो अनुमानित 91,600 नौकरियों के मुकाबले है। आई ई एस ए ने एम ई आई टी वाई को उनके सक्रिय दृष्टिकोण और तेज़ स्वीकृति प्रक्रिया के लिए बधाई दी, जिसने पारिस्थितिकी तंत्र के विकास को उल्लेखनीय रूप से गति दी है। जैसे-जैसे 2026 आकार ले रहा है, भारत ने एक विश्वसनीय और निवेश योग्य ईएसडीएम गंतव्य के रूप में वैश्विक भरोसा हासिल किया है। ई सी एम एस एक गेम-चेंजर है क्योंकि एक मजबूत पारिस्थितिकी तंत्र के लिए केवल सेमीकंडक्टर ही नहीं, बल्कि कंपोनेंट्स, मटेरियल्स और इलेक्ट्रॉनिक्स वैल्यू एडिशन भी आवश्यक हैं।

Date	1st April
Publication	Anant Gyan
Quote By	Ashok Chandak

डिजाइन क्षमता व गुणवत्ता उत्कृष्टता: भारत के ईसीएमएस विजन को विस्तार देने के लिए अत्यंत महत्वपूर्ण: अशोक

अनंत ज्ञान

चंडीगढ़। आईईएसए (इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन) के अध्यक्ष अशोक चांडक ने कहा कि ईसीएमएस योजना की सफलता भारत के इलेक्ट्रॉनिक्स निर्माण क्षेत्र में निर्णायक बदलाव का प्रतीक है।

योजना के तहत 16 उत्पाद श्रेणियों में स्वीकृतियां दी गई हैं, जिनमें लिथियम-आयन सेल, फ्लेक्सिबल पीसीबी, कनेक्टर्स और डिस्प्ले मॉड्यूल शामिल हैं, और ये 8 राज्यों में वितरित हैं, जिसमें कर्नाटक और महाराष्ट्र अग्रणी हैं। इन निवेशों से 14,000 से अधिक रोजगार सृजित होने और 84,515 करोड़ रुपए के उत्पादन को बढ़ावा मिलने की उम्मीद है। कुल 75 आवेदन प्राप्त हुए हैं, जिनमें 61,671 करोड़ रुपए के स्वीकृत निवेश शामिल हैं, जो लक्ष्य 59,450 करोड़ रुपए से अधिक है। यह उद्योग में नीति और पारिस्थितिकी तंत्र पर मजबूत विश्वास को दर्शाता है। योजना के अंतर्गत कुल उत्पादन 4,51,858 करोड़ रुपए तक पहुंचने की संभावना है, जबकि रोजगार पहले ही



65,000 से अधिक तक पहुंच चुका है। अशोक चांडक ने एमईआईटीवाई के तेज स्वीकृति प्रक्रिया व सक्रिय दृष्टिकोण की सराहना की। उन्होंने कहा कि ईसीएमएस न केवल सेमीकंडक्टर बल्कि कंपोनेंट्स, मटेरियल्स और इलेक्ट्रॉनिक्स मूल्य संवर्द्धन के लिए भी गेम-चेंजर साबित हो रही है। मंत्री

के मार्गदर्शन में डिजाइन क्षमता और सिक्स सिग्मा गुणवत्ता को मजबूत करना दीर्घकालिक वैश्विक प्रतिस्पर्धा के लिए महत्वपूर्ण है।

आईईएसए ने डिजाइन-आधारित विनिर्माण को बढ़ावा देने और भारत में नवाचार व उत्पाद निर्माण को आगे बढ़ाने के लिए प्रतिबद्धता जताई। अगले चरण में विस्तार, मजबूत डिजाइन टीमों का निर्माण, स्थानीय सोर्सिंग और विश्वस्तरीय गुणवत्ता पर ध्यान देने की आवश्यकता है। साथ ही, ओईएम और सिस्टम कंपनियों को 'डिजाइन्ड और मेड-इन-इंडिया' कंपोनेंट्स अपनाने और वितरकों को भारतीय उत्पादों को वैश्विक बिल ऑफ मटेरियल्स में शामिल करने में सक्रिय भूमिका निभाने का आह्वान किया गया है।

Date	1st April
Publication	Aaj SAMAJ
Quote By	Ashok Chandak

डिजाइन क्षमता और गुणवत्ता उत्कृष्टता: भारत के ईसीएमएस विजन को विस्तार देने के लिए अत्यंत महत्वपूर्ण: अशोक चांडक

चंडीगढ़। आई ई एस ए (इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन) के अध्यक्ष अशोक चांडक ने कहा कि ईसीएमएस योजना की सफलता भारत के इलेक्ट्रॉनिक्स निर्माण क्षेत्र में इरादे से क्रियान्वयन की ओर निर्णायक बदलाव को दर्शाती है। स्वीकृतियां 16 उत्पाद श्रेणियों में फैली हुई हैं, जिनमें लिथियम-आयन सेल, फ्लेक्सिबल पीसीबी, कनेक्टर्स और डिस्प्ले मॉड्यूल शामिल हैं, और ये 8 राज्यों में वितरित हैं, जिनमें कर्नाटक और महाराष्ट्र परियोजनाओं की संख्या में अग्रणी हैं। इन निवेशों से 14,000 से अधिक रोजगार सृजित होने और रुपये 84,515 रुपये करोड़ के उत्पादन को बढ़ावा मिलने की उम्मीद है, जो इस योजना के तहत बन रही मजबूत गति को दर्शाता है। सामान्य तौर पर, आई ई एस ए कार्यक्रम के तहत 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन प्राप्त हुए हैं, जो देशभर में उद्योग की मजबूत भागीदारी को दर्शाता है। 59,350 रुपये करोड़ के लक्षित निवेश के मुकाबले स्वीकृतियाँ पहले ही रुपये 61,671 करोड़ तक पहुंच चुकी हैं, जो इस नीति ढांचे में उद्योग के मजबूत विश्वास को दर्शाती हैं। आई ई एस ए ने एम ई आई टी वाई को उनके सक्रिय दृष्टिकोण और तेज स्वीकृति प्रक्रिया के लिए बधाई दी, जिसने पारिस्थितिकी तंत्र के विकास को उल्लेखनीय रूप से गति दी है। जैसे-जैसे 2026 आकार ले रहा है, भारत ने एक विश्वसनीय और निवेश योग्य ईएसडीएम गंतव्य के रूप में वैश्विक भरोसा हासिल किया है। ई सी एम एस एक गेम-चेंजर है क्योंकि एक मजबूत पारिस्थितिकी तंत्र के लिए केवल सेमीकंडक्टर ही नहीं, बल्कि कंपोनेंट्स, मटेरियल्स और इलेक्ट्रॉनिक्स वैल्यू एडिशन भी आवश्यक हैं।



Date	1st April
Publication	Haryana News
Quote By	Ashok Chandak

प्रदेश/आसपास

हरियाणा न्यूज प्लैश

03

हरियाणा न्यूज प्लैश

www.haryananewsflash.com

चंडीगढ़, मंगलवार, 31 मार्च 2026

डिजाइन क्षमता और गुणवत्ता उत्कृष्टता: भारत के ईसीएमएस विजन को विस्तार देने के लिए अत्यंत महत्वपूर्ण अशोक चांडक, अध्यक्ष, आईईएसए

हरियाणा न्यूज प्लैश
चंडीगढ़। आई ई एस ए (इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन) के अध्यक्ष अशोक चांडक ने कहा, ईसीएमएस योजना की सफलता भारत के इलेक्ट्रॉनिक्स निर्माण क्षेत्र में इादे से क्रियान्वयन की ओर निर्माणक बदलाव को दर्शाती है। स्वीकृतियाँ 16 उत्पाद श्रेणियों में फैली हुई हैं, जिनमें लिथियम-आयन सेल, फ्लोबैटरी पीसीबी, कनेक्टर और डिजिटल माइक्रोल शामिल हैं, और ये 8 राज्यों में वितरित हैं, जिनमें कर्नाटक और महाराष्ट्र परियोजनाओं की संख्या में अग्रणी हैं। इन निवेशों से 14,000 से अधिक रोजगार सृजित होने और रुपये 84,515

रुपये करोड़ के उत्पादन को बढ़ावा मिलने की उम्मीद है, जो इस योजना के तहत बन रही मजबूत गति को दर्शाता है। सामान्य तौर पर, आई ई एस ए कार्यक्रम के तहत 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन प्राप्त हुए हैं, जो देशभर में उद्योग की मजबूत भागीदारी को दर्शाता है। 59,350 रुपये करोड़ के लक्षित निवेश के मुकाबले स्वीकृतियाँ पहले ही रुपये 61,671 करोड़ तक पहुंच चुकी हैं, जो इस नीति खांचे में उद्योग के मजबूत विश्वास को दर्शाती हैं। इस योजना से 4,51,858 करोड़ रुपये से अधिक के उत्पादन को सक्षम बनाने की उम्मीद है, जो कुल लक्ष्य 4,56,500 करोड़ रुपये के करीब है, जबकि रोजगार सृजन पहले ही



65,000 से अधिक तक पहुंच चुका है, जो अनुमानित 91,600 नौकरियों के मुकाबले है। आई ई एस ए ने एम ई

को उल्लेखनीय रूप से गति दी है। जैसे-जैसे 2026 आकार ले रहा है, भारत ने एक विश्वसनीय और निवेश योग्य इंसुइएएम गंतव्य के रूप में वैश्विक भरोसा हासिल किया है। ई सी एम एस एक गेम-चेंजर है क्योंकि एक मजबूत पारिस्थितिकी तंत्र के लिए केवल सेमीकंडक्टर ही नहीं, बल्कि कंपोनेंट्स, मटेरियल्स और इलेक्ट्रॉनिक्स वैल्यू एडिशन भी आवश्यक हैं। माननीय मंत्री का निरंतर मार्गदर्शन, विशेष रूप से डिजाइन क्षमता और सिक्स सिग्मा गुणवत्ता को मजबूत करने पर, दीर्घकालिक वैश्विक प्रतिस्पर्धात्मकता बनाने के लिए समर्थित और अत्यंत महत्वपूर्ण है। आई ई एस ए लगातार इलेक्ट्रॉनिक्स और सेमीकंडक्टर क्षेत्रों

में डिजाइन-आधारित विनिर्माण दृष्टिकोण को बढ़ावा देता रहा है, और हमारे सदस्य भारत में डिजाइन, नवाचार और उत्पाद निर्माण को आगे बढ़ाने के लिए गहवाई से प्रतिबद्ध हैं। अगला चरण विस्तार, मजबूत डिजाइन टीमों का निर्माण, स्थानीय सोर्सिंग और विश्वस्तरीय गुणवत्ता पर केंद्रित होना चाहिए। ओ ई एस एस और सिस्टम कंपनियों को सक्रिय रूप से 'डिजाइन्ड और मेड-इन-इंडिया' कंपोनेंट्स को अपनाना चाहिए, क्योंकि मांग का सृजन आपूर्ति के सृजन जितना ही महत्वपूर्ण है, जबकि वितरक भारतीय उत्पादों को वैश्विक बिल ऑफ मटेरियल्स में एकीकृत करने में सक्षम बनते हैं।

Date	1st April
Publication	BPN Times
Quote By	Ashok Chandak

भारत के ईसीएमएस विजन को विस्तार देने के लिए अत्यंत महत्वपूर्ण - अशोक चांडक, अध्यक्ष, आई ई एस ए

अमरपाल नूरपुरी
चंडीगढ़, 31 मार्च 2026: आई ई एस ए (इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन) के अध्यक्ष अशोक चांडक ने कहा, ईसीएमएस योजना की सफलता भारत के इलेक्ट्रॉनिक्स निर्माण क्षेत्र में इरादे से क्रियान्वयन की ओर निर्णायक बदलाव को दर्शाती है। स्वीकृतियाँ 16 उत्पाद श्रेणियों में फैली हुई हैं, जिनमें लिथियम-आयन सेल, फ्लैक्सिबल पीसीबी, कनेक्टर्स और डिस्प्ले मॉड्यूल शामिल हैं, और ये 8 राज्यों में वितरित हैं, जिनमें कर्नाटक और महाराष्ट्र परियोजनाओं की संख्या में अग्रणी हैं। इन निवेशों से 14,000 से अधिक रोजगार



सृजित होने और रुपये 84,515 रुपये करोड़ के उत्पादन को बढ़ावा मिलने की उम्मीद है, जो इस योजना के तहत बन रही मजबूत गति को दर्शाता है।

सामान्य तौर पर, आई ई एस ए कार्यक्रम के तहत 12 राज्यों से 23 उत्पाद श्रेणियों में 75 आवेदन प्राप्त हुए हैं, जो देशभर में उद्योग की मजबूत भागीदारी को दर्शाता है। 59,350 रुपये करोड़ के लक्षित निवेश के मुकाबले स्वीकृतियाँ पहले ही रुपये 61,671 करोड़ तक पहुँच चुकी हैं, जो इस नीति ढाँचे में उद्योग के मजबूत विश्वास को दर्शाती हैं। इस योजना से 4,51,858 करोड़ रुपये से अधिक के उत्पादन को सक्षम बनाने की उम्मीद है, जो कुल लक्ष्य 4,56,500 करोड़ रुपये के करीब है, जबकि रोजगार सृजन पहले ही 65,000 से अधिक तक पहुँच चुका है, जो

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Date	1st April
Publication	Democratic Front
Quote By	Ashok Chandak

डिज़ाइन क्षमता और गुणवत्ता उत्कृष्टता- भारत के ईसीएमएस विज़न को विस्तार देने के लिए अत्यंत महत्वपूर्ण : अशोक चांडक

डेमोक्रेटिक फ्रंट चंडीगढ़. आई ई एस ए (इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन) के अध्यक्ष अशोक चांडक ने कहा, ईसीएमएस योजना की सफलता भारत के इलेक्ट्रॉनिक्स निर्माण क्षेत्र में इरादे से क्रियान्वयन की ओर निर्णायक बदलाव को दर्शाती है। स्वीकृतियाँ 16 उत्पाद श्रेणियों में फैली हुई हैं, जिनमें लिथियम-आयन सेल, फ्लेक्सिबल पीसीबी, कनेक्टर्स और डिस्प्ले मॉड्यूल शामिल हैं, और ये 8 राज्यों में वितरित हैं, जिनमें कर्नाटक और महाराष्ट्र परियोजनाओं की संख्या में अग्रणी हैं। इन निवेशों से 14,000 से अधिक रोजगार सृजित होने और रुपये 84,515 रुपये करोड़ के उत्पादन को बढ़ावा मिलने की उम्मीद है, जो इस योजना के तहत बन रही मजबूत गति को दर्शाता है।

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Date	1st April
Publication	Punjab Headlines
Quote By	Ashok Chandak

ਭਾਰਤ ਦੇ ਈਸੀਐਮਐਸ ਵਿਜ਼ਨ ਨੂੰ ਵਿਸਤਾਰ ਦੇਣ ਲਈ ਬਹੁਤ ਹੀ ਮਹੱਤਵਪੂਰਨ - ਅਸ਼ੋਕ ਚੰਡਕ, ਪ੍ਰਧਾਨ, ਆਈਈਐਸਏ

ਚੰਡੀਗੜ੍ਹ - ਅਮਰਪਾਲ ਨੂਰਪੁਰੀ

ਆਈਈਐਸਏ (ਇੰਡੀਆ ਇਲੈਕਟ੍ਰੋਨਿਕਸ ਐਂਡ ਸੈਮੀਕੰਡਕਟਰ ਐਸੋਸੀਏਸ਼ਨ) ਦੇ ਪ੍ਰਧਾਨ ਅਸ਼ੋਕ ਚੰਡਕ ਨੇ ਕਿਹਾ, “ਈਸੀਐਮਐਸ ਯੋਜਨਾ ਦੀ ਸਫਲਤਾ ਭਾਰਤ ਦੇ ਇਲੈਕਟ੍ਰੋਨਿਕਸ ਮੈਨੂਫੈਕਚਰਿੰਗ ਖੇਤਰ ਵਿੱਚ ਇਰਾਦੇ ਤੋਂ ਕਾਰਜਾਨਵੈਨ ਵੱਲ ਇੱਕ ਨਿਰਣਾਇਕ ਬਦਲਾਅ ਨੂੰ ਦਰਸਾਉਂਦੀ ਹੈ। ਮਨਜ਼ੂਰੀਆਂ 16 ਉਤਪਾਦ ਸ਼੍ਰੇਣੀਆਂ ਵਿੱਚ ਫੈਲੀਆਂ ਹੋਈਆਂ ਹਨ, ਜਿਨ੍ਹਾਂ ਵਿੱਚ ਲਿਥੀਅਮ-ਆਇਅਨ ਸੈਲ, ਫਲੈਕਸਿਬਲ ਪੀਸੀਬੀ, ਕਨੇਕਟਰ ਅਤੇ ਡਿਸਪਲੇ ਮੋਡੀਊਲ ਸ਼ਾਮਲ ਹਨ, ਅਤੇ ਇਹ 8 ਰਾਜਾਂ ਵਿੱਚ ਵੰਡੀਆਂ ਹੋਈਆਂ ਹਨ, ਜਿਨ੍ਹਾਂ ਵਿੱਚ ਕਰਨਾਟਕ ਅਤੇ ਮਹਾਰਾਸ਼ਟਰ ਪ੍ਰੋਜੈਕਟਾਂ ਦੀ ਗਿਣਤੀ ਵਿੱਚ ਅੱਗੇ ਹਨ। ਇਨ੍ਹਾਂ ਨਿਵੇਸ਼ਾਂ ਨਾਲ 14,000 ਤੋਂ ਵੱਧ ਰੋਜ਼ਗਾਰ ਪੈਦਾ ਹੋਣ ਅਤੇ 84,515 ਕਰੋੜ ਰੁਪਏ ਦੇ ਉਤਪਾਦਨ ਨੂੰ ਪ੍ਰੋਤਸਾਹਨ ਮਿਲਣ ਦੀ ਉਮੀਦ ਹੈ, ਜੋ ਇਸ ਯੋਜਨਾ ਦੇ ਤਹਿਤ ਬਣ ਰਹੀ ਮਜ਼ਬੂਤ ਗਤੀ ਨੂੰ ਦਰਸਾਉਂਦਾ ਹੈ।



ਸਮੁੱਚੇ ਤੌਰ 'ਤੇ, ਆਈਈਐਸਏ ਪ੍ਰੋਗਰਾਮ ਤਹਿਤ 12 ਰਾਜਾਂ ਤੋਂ 23 ਉਤਪਾਦ ਸ਼੍ਰੇਣੀਆਂ ਵਿੱਚ 75 ਅਰਜ਼ੀਆਂ ਪ੍ਰਾਪਤ ਹੋਈਆਂ ਹਨ, ਜੋ ਦੇਸ਼ ਭਰ ਵਿੱਚ ਉਦਯੋਗ ਦੀ ਮਜ਼ਬੂਤ ਭਾਗੀਦਾਰੀ ਨੂੰ ਦਰਸਾਉਂਦੀਆਂ ਹਨ। 59,350 ਕਰੋੜ ਰੁਪਏ ਦੇ ਲਕਸ਼ਿਤ ਨਿਵੇਸ਼ ਦੇ ਮੁਕਾਬਲੇ ਮਨਜ਼ੂਰੀਆਂ ਪਹਿਲਾਂ ਹੀ 61,671 ਕਰੋੜ ਰੁਪਏ ਤੱਕ ਪਹੁੰਚ ਚੁੱਕੀਆਂ ਹਨ, ਜੋ ਇਸ ਨੀਤੀ ਢਾਂਚੇ ਵਿੱਚ ਉਦਯੋਗ ਦੇ ਮਜ਼ਬੂਤ ਭਰੋਸੇ ਨੂੰ ਦਰਸਾਉਂਦੀਆਂ ਹਨ। ਇਸ ਯੋਜਨਾ ਨਾਲ 4,51,858 ਕਰੋੜ ਰੁਪਏ ਤੋਂ ਵੱਧ ਦੇ ਉਤਪਾਦਨ ਨੂੰ ਯੋਗ ਬਣਾਉਣ ਦੀ ਉਮੀਦ ਹੈ, ਜੋ ਕੁੱਲ ਲਕਸ਼ 4,56,500 ਕਰੋੜ ਰੁਪਏ ਦੇ ਨੇੜੇ ਹੈ, ਜਦਕਿ ਰੋਜ਼ਗਾਰ ਸਿਰਜਣਾ ਪਹਿਲਾਂ ਹੀ 65,000 ਤੋਂ ਵੱਧ ਹੋ ਚੁੱਕੀ ਹੈ, ਜੋ ਅਨੁਮਾਨਿਤ 91,600 ਨੌਕਰੀਆਂ ਦੇ ਮੁਕਾਬਲੇ ਹੈ। ਆਈਈਐਸਏ ਨੇ ਐਮਈਆਈਟੀਵਾਈ ਨੂੰ ਉਨ੍ਹਾਂ ਦੇ ਸਰਗਰਮ ਰਵੱਈਏ ਅਤੇ ਤੇਜ਼ ਮਨਜ਼ੂਰੀ ਪ੍ਰਕਿਰਿਆ ਲਈ ਵਧਾਈ ਦਿੱਤੀ, ਜਿਸ ਨੇ ਇਕੋਸਿਸਟਮ ਦੇ ਵਿਕਾਸ ਨੂੰ ਖਾਸ ਤੌਰ 'ਤੇ ਤੇਜ਼ ਕੀਤਾ ਹੈ।

Date	1st April
Publication	Punjab Times
Quote By	Ashok Chandak

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision: Mr Ashok Chandak, President, IESA

R Media News

Chandigarh, March 31

Ashok Chandak, President, IESA (India Electronics & Semiconductor Association) has said, "The success of the ECMS scheme marks India's decisive shift from intent to execution in electronics manufacturing. The approvals span 16 product segments, from lithium-ion cells and flexible PCBs to connectors and display modules, and are spread across 8 states, along with Karnataka and Maharashtra leading in project count. These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515cr highlighting the strong momentum being created under the scheme. Broadly, the ECMS programme has seen 75 applications across 23 product categories from 12 states, reflecting strong industry par-



icipation across the country. Against a target investment of Rs 59,350 cr, approvals have already reached Rs 61,671 cr, demonstrating the industry's strong confidence in the policy framework. The scheme is expected to enable production worth over Rs 4,51,858 cr, moving close to the overall target of Rs 4,56,500 cr, while employment generation has already reached over 65,000 jobs against a projected 91,600 jobs. IESA congratulated MeitY for its proactive approach and

fast-tracked approvals, which have significantly accelerated ecosystem development. As 2026 begins to shape, India has earned global trust as a credible, investible ESDM destination. ECMS is a game-changer because a strong ecosystem needs components, materials, and electronics value addition, not just semiconductors. The continued guidance of the Hon'ble Minister, particularly on strengthening design competency and Six Sigma quality, is both timely and critical to building long-term global competitiveness. IESA has been consistently nurturing and advocating a design-led manufacturing approach across the electronics and semiconductor sectors, and our members remain deeply committed to advancing design, innovation, and product creation in India.

**Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision
Print Bangalore**

Date	5th April
Publication	Tamil Sudar
Quote By	Ashok Chandak

வடிவமைப்புத் திறனும் தரச் சிறப்பும்: இசிஎம்எஸ் தொலைநோக்குப் பார்வையை விரிவுபடுத்துவதற்கு இன்றியமையாதவை!

இந்திய மின்னணு மற்றும் குறைக்கடத்தி சங்கத்தின் (IESA) தலைவர் அசோக் சந்தக், "வடிவமைப்புத் திறனும் தரச் சிறப்பும்—இந்தியாவின் ECMS தொலைநோக்குப் பார்வையை விரிவுபடுத்துவதற்கு இன்றியமையாதவை." என தெரிவித்தார்.

மின்னணு உற்பத்தித் துறையில், இந்தியா எடுத்துள்ள தீர்க்கமான மாற்றத்தை ECMS திட்டத்தின் வெற்றி குறிக்கிறது. இந்த ஒப்புதல்கள், லித்தியம்-அயன் செல்கள், PCBகள், மற்றும் மின்னணு இணைப்பிகள் வரை 16 தயாரிப்புப் பிரிவுகளை உள்ளடக்கியுள்ளன. மேலும், இவை 8 மாநிலங்களில் பரவியுள்ளன. இதில் திட்டங்களின் எண்ணிக்கையில் கர்நாடகா மற்றும் மகாராஷ்டிரா முன்னணியில் உள்ளன. இந்த முதலீடுகள் 14,000க்கும் மேற்பட்ட வேலைவாய்ப்புகளை உருவாக்கும் என்றும், ரூ. 84,515 கோடி மதிப்பிலான உற்பத்தியை ஊக்குவிக்கும் என்றும் எதிர்பார்க்கப்படுகிறது. இது, இத்திட்டத்தின் கீழ் உருவாக்கப்படும் வலுவான உத்வே

கத்தை எடுத்துக் காட்டுகிறது.

ECMS திட்டத்தின் கீழ் 12 மாநிலங்களைச் சேர்ந்த 23 தயாரிப்பு வகைகளில் இருந்து 75 விண்ணப்பங்கள் பெறப்பட்டுள்ளன;

இதுநாடு முழுவதும் இத்துறையின் நின் வலுவான பங்கேற்பைப் பிரதிபலிக்கிறது.

ரூ. 59,350 கோடி என்ற இலக்கு முதலீட்டிற்கு எதிராக, ஒப்புதல்கள் ஏற்கனவே ரூ. 61,671 கோடியை எட்டியுள்ளன;

இது இக்கொள்கை கட்டமைப்பின் மீது இத்துறையினர் கொண்டுள்ள வலுவான நம்பிக்கையை வெளிப்படுத்துகிறது. இத்திட்டத்தின் மூலம் ரூ. 4,51,858 கோடிக்கும் அதிகமான மதிப்பிலான உற்பத்தி சாத்தியமாகும் என எதிர்பார்க்கப்படுகிறது; இது ரூ. 4,56,500 கோடி என்ற ஒட்டுமொத்த இலக்கை நெருங்கி வருகிறது. அதேவேளையில், 91,600 வேலைவாய்ப்புகளை



இசிஎம்எஸ் தலைவர் அசோக் சந்தக்

உருவாக்கும் என்ற கணிப்பிற்கு எதிராக, வேலைவாய்ப்பு உருவாக்கும் ஏற்கனவே 65,000க்கும் மேற்பட்ட எண்ணிக்கையை எட்டியுள்ளது.

கற்றுச் சூழல் அமைப்பின் வளர்ச்சியை கணிசமாக முடுக்கிவிட்டது.

அதன் முன்முயற்சி அணுகுமுறை மற்றும் விரைவுபடுத்தப்பட்ட ஒப்புதல்களுக்காக IESA, MeitY இப்பாராட்டுகிறது. 2026 ஆம் ஆண்டு வடிவம் பெறத் தொடங்கும் வேளையில், இந்தியா ஒரு நம்பகமான, முதலீடு செய்யக்கூடிய ESDM இடமாக உலகளாவிய நம்பிக்கையைப் பெற்றுள்ளது. ECMS ஒரு திருப்புமுனையாகும், ஏனெனில் ஒரு வலுவான கற்றுச்சூழல் அமைப்புக்கு குறைக்கடத்திகள் மட்டுமல்ல, கூறுகள், மூலப்பொருட்கள் மற்றும் மின்னணுவியல் மதிப்புக்கூட்டலும் தேவைப்படுகின்றன.

இந்தியா ஒரு நம்பகமான, முதலீடு செய்யக்கூடிய ESDM இடமாக உலகளாவிய நம்பிக்கையைப் பெற்றுள்ளது. ECMS ஒரு திருப்புமுனையாகும், ஏனெனில் ஒரு வலுவான கற்றுச்சூழல் அமைப்புக்கு குறைக்கடத்திகள் மட்டுமல்ல, கூறுகள், மூலப்பொருட்கள் மற்றும் மின்னணுவியல் மதிப்புக்கூட்டலும் தேவைப்படுகின்றன.

Date	4th April
Publication	Malai Thanizhagam
Quote By	Ashok Chandak

இந்தியாவின் ECMS தொலைநோக்குப் பார்வையை விரிவுபடுத்துவதற்கு இன்றியமையாதவை

சென்னை, ஏப், 03: மின்னணு உற்பத்தித் துறையில், இந்தியா எடுத்துள்ள தீர்க்கமான மாற்றத்தை ECMS திட்டத்தின் வெற்றி குறிக்கிறது. இந்த ஒப்புதல்கள், லித்தியம்-அயன் செல்கள், PCB-கள், மற்றும் மின்னணு இணைப்பிகள் வரை 16 தயாரிப்புப் பிரிவுகளை உள்ளடக்கியுள்ளன. மேலும், இவை 8 மாநிலங்களில் பரவியுள்ளன. இதில், திட்டங்களின் எண்ணிக்கையில் கர்நாடகா மற்றும் மகாராஷ்டிரா முன்னணியில் உள்ளன. இந்த முதலீடுகள் 14,000-க்கும் மேற்பட்ட வேலைவாய்ப்புகளை உருவாக்கும் என்றும், ரூ. 84,515 கோடி மதிப்பிலான உற்பத்தியை ஊக்குவிக்கும் என்றும் எதிர்பார்க்கப்படுகிறது. இது, இத்திட்டத்தின் கீழ் உருவாக்கப்படும் வலுவான உத்வேகத்தை எடுத்துக்காட்டுகிறது.

ECMS திட்டத்தின் கீழ் 12 மாநிலங்களைச் சேர்ந்த 23 தயாரிப்பு வகைகளில் இருந்து 75 விண்ணப்பங்கள் பெறப்பட்டுள்ளன; இது நாடு முழுவதும் இத்துறையினரின் வலுவான பங்கேற்பைப் பிரதிபலிக்கிறது. ரூ. 59,350 கோடி என்ற இலக்கு முதலீட்டிற்கு எதிராக, ஒப்புதல்கள் ஏற்கனவே ரூ. 61,671 கோடியை எட்டியுள்ளன; இது இக்கொள்கை கட்டமைப்பின் மீது இத்துறையினர் கொண்டுள்ள வலுவான நம்பிக்கையை

வெளிப்படுத்துகிறது. இத்திட்டத்தின் மூலம் ரூ. 4,51,858 கோடிக்கும் அதிகமான மதிப்பிலான உற்பத்தி சாத்தியமாகும் என எதிர்பார்க்கப்படுகிறது; இது ரூ. 4,56,500 கோடி என்ற ஒட்டுமொத்த இலக்கை நெருங்கி வருகிறது. அதேவேளையில், 91,600 வேலைவாய்ப்புகளை உருவாக்கும் என்ற கணிப்பிற்கு எதிராக, வேலைவாய்ப்பு உருவாக்கம் ஏற்கனவே 65,000-க்கும் மேற்பட்ட எண்ணிக்கையை எட்டியுள்ளது.

Date	4th April
Publication	New Today
Quote By	Ashok Chandak

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision

Ashok Chandak, President, India Electronics and Semiconductor Association (IESA), commented on: Design competency and quality excellence: Critical to scaling India's ECMS vision

The success of the ECMS scheme marks India's decisive shift from intent to execution in electronics manufacturing. The approvals span 16 product segments, from lithium-ion cells and flexible PCBs to connectors and display modules, and are spread across 8 states, along with Karnataka and Maharashtra leading in project count. These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515cr highlighting the strong momentum being created under the scheme.

IESA congratulates MeitY for its proactive approach and fast-tracked approvals, which have significantly accelerated ecosystem development. As 2026 begins to shape, India has earned global trust as a credible, investible ESDM destination. ECMS is a game-changer because a strong ecosystem needs components, materials, and electronics value addition, not just semiconductors.

Date	3rd April
Publication	Southern Mail
Quote By	Ashok Chandak

இந்தியாவின் ECMS தொலைநோக்குப் பார்வையை விரிவுபடுத்துவதற்கு இன்றியமையாதவை

சென்னை, ஏப், 03: மின்னணு உற்பத்தித் துறையில், இந்தியா எடுத்துள்ள தீர்க்கமான மாற்றத்தை ECMS திட்டத்தின் வெற்றி குறிக்கிறது. இந்த ஒப்புதல்கள், லித்தியம்-அயன் செல்கள், PCB-கள், மற்றும் மின்னணு இணைப்பிகள் வரை 16 தயாரிப்புப் பிரிவுகளை உள்ளடக்கியுள்ளன. மேலும், இவை 8 மாநிலங்களில் பரவியுள்ளன. இதில், திட்டங்களின் எண்ணிக்கையில் கர்நாடகா மற்றும் மகாராஷ்டிரா முன்னணியில் உள்ளன. இந்த முதலீடுகள் 14,000-க்கும் மேற்பட்ட வேலைவாய்ப்புகளை உருவாக்கும் என்றும், ரூ. 84,515 கோடி மதிப்பிலான உற்பத்தியை ஊக்குவிக்கும் என்றும் எதிர்பார்க்கப்படுகிறது. இது, இத்திட்டத்தின் கீழ் உருவாக்கப்படும் வலுவான உத்வேகத்தை எடுத்துக்காட்டுகிறது.

ECMS திட்டத்தின் கீழ் 12 மாநிலங்களைச் சேர்ந்த 23 தயாரிப்பு வகைகளில் இருந்து 75 விண்ணப்பங்கள் பெறப்பட்டுள்ளன; இது நாடு முழுவதும் இத்துறையினரின் வலுவான பங்கேற்பைப் பிரதிபலிக்கிறது. ரூ. 59,350 கோடி என்ற இலக்கு முதலீட்டிற்கு எதிராக, ஒப்புதல்கள் ஏற்கனவே ரூ. 61,671 கோடியை எட்டியுள்ளன; இது இக்கொள்கை கட்டமைப்பின் மீது இத்துறையினர் கொண்டுள்ள வலுவான நம்பிக்கையை

வெளிப்படுத்துகிறது. இத்திட்டத்தின் மூலம் ரூ. 4,51,858 கோடிக்கும் அதிகமான மதிப்பிலான உற்பத்தி சாத்தியமாகும் என எதிர்பார்க்கப்படுகிறது; இது ரூ. 4,56,500 கோடி என்ற ஒட்டுமொத்த இலக்கை நெருங்கி வருகிறது. அதேவேளையில், 91,600 வேலைவாய்ப்புகளை உருவாக்கும் என்ற கணிப்பிற்கு எதிராக, வேலைவாய்ப்பு உருவாக்கம் ஏற்கனவே 65,000-க்கும் மேற்பட்ட எண்ணிக்கையை எட்டியுள்ளது.

Date	3rd April
Publication	Evening Tamil Nadu
Quote By	Ashok Chandak

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision

Chennai: Ashok Chandak, President, India Electronics and Semiconductor Association (IESA), commented on: Design competency and quality excellence: Critical to scaling India's ECMS vision

The success of the ECMS scheme marks India's decisive shift from intent to execution in electronics manufacturing. The approvals span 16 product segments, from lithium-ion cells and flexible PCBs to connectors and display modules, and are spread across 8 states, along with Karnataka and Maharashtra leading in project count. These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515cr highlighting the strong momentum being created under the scheme.

Broadly, the ECMS programme has seen 75 applications across 23 product categories from 12 states, reflecting strong industry participation across the country. Against a target investment of Rs 59,350 cr, approvals have already reached Rs 61,671 cr, demonstrating the industry's strong confidence in the policy framework. The scheme is expected to enable production worth over Rs 4,51,858 cr, moving close to the overall target of Rs 4,56,500 cr, while employment generation has already reached over 65,000 jobs against a projected 91,600 jobs.

IESA congratulates MeitY for its proactive approach and fast-tracked approvals, which have significantly accelerated ecosystem development. As 2026 begins to shape, India has earned global trust as a credible, investible ESDM destination. ECMS is a game-changer because a strong ecosystem needs components, materials, and electronics value addition, not just semiconductors.

The continued guidance of the Hon'ble Minister, particularly on strengthening design competency and Six Sigma quality, is both timely and critical to building long-term global competitiveness. IESA has been consistently nurturing and advocating a design-led manufacturing approach across the electronics and semiconductor sectors, and our members remain deeply committed to advancing design, innovation, and product creation in India. The next phase must focus on scaling up, building strong design teams, local sourcing, and world-class quality. OEMs and system companies must actively adopt Designed and Made-in-India components as demand creation is as critical as supply creation while distributors enable global integration of Indian products into the bill of materials.

Date	3rd April
Publication	Trinity Mirror
Quote By	Ashok Chandak

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision

Ashok Chandak, President, India Electronics and Semiconductor Association (IESA), commented on: Design competency and quality excellence: Critical to scaling India's ECMS vision. The success of the ECMS scheme marks India's decisive shift from intent to ex-

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Please find attached the release. Request you to kindly help us publish the news.

Date	3rd April
Publication	Dinakural
Quote By	Ashok Chandak

இந்தியாவின் ECMS தொலைநோக்குப் பார்வையை விரிவுபடுத்துவதற்கு இன்றியமையாதவை; IESA தலைவர் அசோக் சந்தக், அறிக்கை

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வெளிப்படுத்துகிறது. இத்திட்டத்தின் மூலம் ரூ. 4,51,858 கோடிக்கும் அதிகமான மதிப்பிலான உற்பத்தி சாத்தியமாகும் என எதிர்பார்க்கப்படுகிறது; இது ரூ. 4,56,500 கோடி என்ற ஒட்டுமொத்த இலக்கை நெருங்கி வருகிறது. அதேவேளையில், 91,600 வேலைவாய்ப்புகளை உருவாக்கும் என்ற கணிப்பிற்கு எதிராக, வேலைவாய்ப்பு உருவாக்கம் ஏற்கனவே 65,000-க்கும் மேற்பட்ட எண்ணிக்கையை எட்டியுள்ளது.

சுற்றுச்சூழல் அமைப்பின் வளர்ச்சியை கணிசமாக முடுக்கிவிட்ட அதன் முன்முயற்சி அணுகுமுறை மற்றும் விரைவுபடுத்தப்பட்ட ஒப்புதல்களுக்காக IESA, MeitY-ஐப் பாராட்டுகிறது. 2026-ஆம் ஆண்டு வடிவம் பெறத் தொடங்கும் வேளையில், இந்தியா ஒரு நம்பகமான, முதலீடு செய்யக்கூடிய ESDM இடமாக உலகளாவிய நம்பிக்கையைப் பெற்றுள்ளது. ECMS ஒரு திருப்புமுனையாகும், ஏனெனில் ஒரு வலுவான சுற்றுச்சூழல் அமைப்புக்கு குறைக்கடத்திகள் மட்டுமல்ல, கூறுகள், மூலப்பொருட்கள் மற்றும் மின்னணுவியல் மதிப்புக்கூட்டலும் தேவைப்படுகின்றன. என இந்திய மின்னணு மற்றும் குறைக்கடத்தி சங்கத்தின் (IESA) தலைவர் அசோக் சந்தக், தெரிவித்தார்.

Date	3rd April
Publication	SouthernMail
Quote By	Ashok Chandak


Design Competency and Quality Excellence: Critical Scaling India's ECMS Vision

Ashok Chandak, President, India Electronics and Semiconductor Association (IESA), commented on: Design competency and quality excellence: Critical to scaling India's ECMS vision. The success of the ECMS scheme marks India's decisive shift from intent to ex-

ecution in electronics manufacturing. The approvals span 16 product segments, from lithium-ion cells and flexible PCBs to connectors and display modules, and are spread across 8 states, along with Karnataka and Maharashtra leading in project count. These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515cr highlighting the strong momentum being created under the scheme.

**Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision
Online Bangalore**

Date	3rd April
Publication	Coprwhizz
Link	Design And Quality To Power India's ECMS-Led Electronics Growth: IESA – Corpwhizz




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Design And Quality To Power India's ECMS-Led Electronics Growth: IESA

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Ashok Chandak, president of India Electronics and Semiconductor Association (IESA), has emphasised the critical role of design competency and quality excellence in scaling India's Electronics Components Manufacturing Scheme (ECMS) vision.

ECMS signals shift from policy intent to execution

Chandak noted that the success of the ECMS scheme marks a decisive shift in India's electronics manufacturing journey, from policy intent to on-ground execution.

The approvals under the scheme span 16 product segments, including lithium-ion cells, flexible PCBs, connectors, and display modules. These projects are spread across eight states, with Karnataka and Maharashtra emerging as leaders in terms of project count.

The approved investments are expected to generate over 14,000 jobs and drive production worth ₹84,515 crore, reflecting the strong momentum building under the initiative.

Strong industry participation and investment momentum

The ECMS programme has witnessed robust industry participation, with 75 applications across 23 product categories from 12 states.

Against a targeted investment of ₹50,350 crore, approvals have already surpassed expectations at ₹61,671 crore, highlighting strong industry confidence in the policy framework.

The scheme is projected to enable production worth over ₹4,51,858 crore, nearing the overall target of ₹4,56,500 crore. Employment generation has also gained traction, crossing 65,000 jobs against a projected 91,800.

Fast-tracked approvals boost ecosystem development

IESA commended the proactive role of the Ministry of Electronics and Information Technology (MeitY) in accelerating approvals and enabling faster ecosystem development.

With these developments, India is increasingly being recognised as a credible and investible destination in the Electronics System Design and Manufacturing (ESDM) space.

Next phase: scaling, local sourcing and demand creation

Looking ahead, the focus must shift toward scaling operations, building strong design teams, enhancing local sourcing, and ensuring world-class quality standards.

Chandak stressed that OEMs and system companies must actively adopt "Designed and Made-in-India" components, as demand creation is as critical as supply creation. He also highlighted the role of distributors in integrating Indian products into global supply chains and bill of materials.

**Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision
Online NATIONAL**

Date	30th April
Publication	Punjab Kesari
Link	https://english.punjabkesari.com/business/industry-hails-centres-push-on-design-quality-as-ecms-gains-pace/

Industry hails Centre's push on design, quality as ECMS gains pace

By: IANS
On: Monday, March 30, 2020 8:27 PM



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New Delhi, March 30 (IANS) Industry leaders on Monday welcomed the government's strong push on design capability and quality standards under the Electronics Component Manufacturing Scheme (ECMS), calling it critical for scaling India's electronics ambitions.

Industry participants at an event hosted by the India Cellular and Electronics Association (ICEA) to mark the fourth tranche of ECMS approvals said that the ECMS scheme reflects India's shift from policy intent to on-ground execution.

ICEA Chairman Pankaj Mohindroo said the enhanced outlay under ECMS shows the government's commitment to building a robust electronics ecosystem.

He added that reopening the scheme in a calibrated manner would help deepen component manufacturing and boost domestic value addition.

"A calibrated reopening of the scheme will be important to further build critical component capabilities and deepen domestic value addition," Mohindroo stated.

"The next phase of growth must focus on scaling up design capabilities, strengthening local sourcing, and achieving global quality standards," he added.

He stressed that original equipment manufacturers and system companies should actively adopt "Designed and Made in India" components, as demand creation is as important as supply.

Industry leaders also highlighted that India has emerged as a credible and investible destination for electronics system design and manufacturing.

"The ECMS is helping bridge critical gaps in the value chain by enabling component level manufacturing, which is essential for capturing higher value and building resilience," Ashok Chandak, President, IESA said.

"These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515cr highlighting the strong momentum being created under the scheme," he mentioned.

So far, 75 applications across 23 product categories from 12 states have been approved, covering areas such as lithium ion cells, flexible PCBs, connectors, and display modules.

The projects are spread across eight states, with Karnataka and Maharashtra leading in project count.

According to the data shared at the event, approved investments have already crossed Rs 61,000 crore, exceeding the initial target of Rs 59,350 crore.

The scheme is expected to generate production worth over Rs 4.5 lakh crore and create more than 65,000 jobs, moving steadily towards its overall targets.

Date	30th April
Publication	Bollywood Country
Link	https://bollywoodcountry.com/industry-hails-centres-push-on-design-quality-as-ecms-gains-pace--20260330203441

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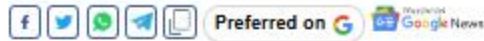
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Date	30th April
Publication	Lokmattimes
Link	https://www.lokmatimes.com/technology/industry-hails-centres-push-on-design-quality-as-ecms-gains-pace-1/#

Industry hails Centre's push pace

By IANS | Updated: March 30, 2026 20:40 IST



New Delhi, March 30 Industry leaders on Monday welcomed the government's strong push on design capability and quality ...



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Date	30th April
Publication	SME Times
Link	https://www.smetimes.in/smetimes/news/top-stories/2026/Mar/30/ecms-gains-pace.html

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- » Sensex, Nifty trade higher in early session on optimism
- » India forex reserves rise to \$703.3 billion amid Asia tensions

Date	30th April
Publication	The Hawk
Link	https://www.thehawk.in/news/science/industry-hails-centres-push-on-design-quality-as-ecms-gains-pace

Home > Science

Science

Industry hails Centre's push on design, quality as ECMS gains pace

Industry Hails Government's Commitment to Robust Electronics Ecosystem under ECMS

Date	30th April
Publication	Ten News
Link	https://tennews.in/industry-hails-centres-push-on-design-quality-as-ecms-gains-pace/

TEN NEWS NETWORK

TECHNOLOGY

Industry Hails Centre's Push On Design, Quality As ECMS Gains Pace

30 Mar 20, 2020



New Delhi, March 30 (IANS) Industry leaders on Monday welcomed the government's strong push on design capability and quality standards under the Electronics Component Manufacturing Scheme (ECMS), calling it critical for scaling India's electronics ambitions.

Industry participants at an event hosted by the India Cellular and Electronics Association (ICEA) to mark the fourth tranche of ECMS approvals said that the ECMS scheme reflects India's shift from policy intent to on-ground execution.

ICEA Chairman Pankaj Mohindroo said the enhanced outlay under ECMS shows the government's commitment to building a robust electronics ecosystem.

He added that reopening the scheme in a calibrated manner would help deepen component manufacturing and boost domestic value addition.

"A calibrated reopening of the scheme will be important to further build critical component capabilities and deepen domestic value addition," Mohindroo stated.

"The next phase of growth must focus on scaling up design capabilities, strengthening local sourcing, and achieving global quality standards," he added.

He stressed that original equipment manufacturers and system companies should actively adopt "Designed and Made-in-India" components, as demand creation is as important as supply.

Industry leaders also highlighted that India has emerged as a credible and investible destination for electronics system design and manufacturing.

"The ECMS is helping bridge critical gaps in the value chain by enabling component-level manufacturing, which is essential for capturing higher value and building resilience," Ashok Chandak, President, IESA said.

"These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515cr highlighting the strong momentum being created under the scheme," he mentioned.

So far, 75 applications across 23 product categories from 12 states have been approved, covering areas such as lithium-ion cells, flexible PCBs, connectors, and display modules.

The projects are spread across eight states, with Karnataka and Maharashtra leading in project count.

According to the data shared at the event, approved investments have already crossed Rs 61,000 crore, exceeding the initial target of Rs 59,350 crore.

The scheme is expected to generate production worth over Rs 4.5 lakh crore and create more than 65,000 jobs, moving steadily towards its overall targets.





-IANS

Date	30th April
Publication	The New Kerala
Link	https://www.newkerala.com/news/a/industry-hails-centres-push-design-quality-as-ecms-428.htm

India's Electronics Push Gains Momentum as ECMS Scheme Drives Component Manufacturing

Industry leaders have welcomed the government's push on design and quality under the Electronics Component Manufacturing Scheme (ECMS), highlighting its shift from policy to execution. The scheme has seen 75 applications approved across 23 product categories, with investments exceeding Rs 61,000 crore. It is expected to generate production worth over Rs 4.5 lakh crore and create more than 65,000 jobs. Leaders stress that scaling design capabilities and adopting "Designed and Made-in-India" components are critical for the next phase of growth.

Key Points: ECMS Scheme Boosts India's Electronics Manufacturing & Design

-  ECMS approvals cross Rs 61,000 crore
-  Focus on design capability & quality standards
-  Expected to generate over 65,000 jobs
-  Scheme covers 23 product categories

 Mar 30, 2026  2 min read

Industry hails Centre's push on design, quality as ECMS gains pace

Industry leaders hail ECMS for scaling electronics, creating jobs, and boosting domestic value addition with over Rs 61,000 crore in approved investments.

Date	30th April
Publication	Prokerala
Link	https://www.prokerala.com/news/articles/a1745280.html

Industry hails Centre's push on design, quality as ECMS gains pace

By IANS | Published on Mon, Mar 30 2026 20:40 IST



NEW DELHI, MARCH 30 : Industry leaders on Monday welcomed the government's strong push on design capability and quality standards under the Electronics Component Manufacturing Scheme (ECMS), calling it critical for scaling India's electronics ambitions.

Industry participants at an event hosted by the India Cellular and Electronics Association (ICEA) to mark the fourth tranche of ECMS approvals said that the ECMS scheme reflects India's shift from policy intent to on-ground execution.

ICEA Chairman Pankaj Mohindroo said the enhanced outlay under ECMS shows the government's commitment to building a robust electronics ecosystem.

He added that reopening the scheme in a calibrated manner would help deepen component manufacturing and boost domestic value addition.

"A calibrated reopening of the scheme will be important to further build critical component capabilities and deepen domestic value addition," Mohindroo stated.

"The next phase of growth must focus on scaling up design capabilities, strengthening local sourcing, and achieving global quality standards," he added.

He stressed that original equipment manufacturers and system companies should actively adopt "Designed and Made-in-India" components, as demand creation is as important as supply.

Industry leaders also highlighted that India has emerged as a credible and investible destination for electronics system design and manufacturing.

"The ECMS is helping bridge critical gaps in the value chain by enabling component-level manufacturing, which is essential for capturing higher value and building resilience," Ashok Chandak, President, IESA said.

Date	30th April
Publication	DQ India
Link	https://www.dqindia.com/esdm/design-competency-and-quality-excellence-critical-to-scaling-indias-ecms-vision-11436445

Design competency and quality excellence: Critical to scaling India's ECMS vision

The approvals span 16 product segments, from lithium-ion cells and flexible PCBs, to connectors and display modules, and are spread across eight states.



Ashok Chandak, President, India Electronics and Semiconductor Association (IESA), commented on: Design competency and quality excellence: Critical to scaling India's ECMS vision



The success of the ECMS scheme marks India's decisive shift from intent to execution in electronics manufacturing. The approvals span 16 product segments, from lithium-ion cells and flexible PCBs to connectors and display modules, and are spread across eight states, along with Karnataka and Maharashtra leading in project count. These investments are expected to generate over 14,000 jobs and drive production worth Rs 84,515 crore, highlighting the strong momentum being created under the scheme.

Broadly, the ECMS program has seen 75 applications across 23 product categories from 12 states, reflecting strong industry participation across the country. Against a target investment of Rs 58,350 crore, approvals have already reached Rs 61,671 crore, demonstrating the industry's strong confidence in the policy framework.

The scheme is expected to enable production worth over Rs 4,51,898 crore, moving close to the overall target of Rs 4,56,500 crore, while employment generation has already reached over 65,000 jobs against a projected 91,600 jobs.



IESA congratulates MeltY for its proactive approach and fast-tracked approvals, which have significantly accelerated ecosystem development. As 2026 begins to shape, India has earned global trust as a credible, investible ESDM destination. ECMS is a game-changer because a strong ecosystem needs components, materials, and electronics value addition, not just semiconductors.

The continued guidance of the Hon'ble Minister, particularly on strengthening design competency and Six Sigma quality, is both timely and critical to building long-term global competitiveness. IESA has been consistently nurturing and advocating a design-led manufacturing approach across the electronics and semiconductor sectors, and our members remain deeply committed to advancing design, innovation, and product creation in India.

The next phase must focus on scaling up, building strong design teams, local sourcing, and world-class quality. OEMs and system companies must actively adopt Designed and Made-in-India components as demand creation is as critical as supply creation while distributors enable global integration of Indian products into the bill of materials.

Date	30th April
Publication	Newsgram
Link	https://www.newsgram.com/amp/story/business/2026/03/30/industry-hails-centres-push-on-design-quality-as-ecms-gains-pace

Industry hails Centre's push on design, quality as ECMS gains pace

IAN S Agency

Updated: 31st Mar, 2026 at 4:51 PM



New Delhi, March 30 (IANS) Industry leaders on Monday welcomed the government's strong push on design capability and quality standards under the Electronics Component Manufacturing Scheme (ECMS), calling it critical for scaling India's electronics ambitions.

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ICEA Chairman Pankaj Mohindroo said the enhanced outlay under ECMS shows the government's commitment to building a robust electronics ecosystem.

He added that reopening the scheme in a calibrated manner would help deepen component manufacturing and boost domestic value addition.

"A calibrated reopening of the scheme will be important to further build critical component capabilities and deepen domestic value addition," Mohindroo stated.

"The next phase of growth must focus on scaling up design capabilities, strengthening local sourcing, and achieving global quality standards," he added.

He stressed that original equipment manufacturers and system companies should actively adopt "Designed and Made-in-India" components, as demand creation is as important as supply.

Industry leaders also highlighted that India has emerged as a credible and investible destination for electronics system design and manufacturing.

"The ECMS is helping bridge critical gaps in the value chain by enabling component-level manufacturing, which is essential for capturing higher value and building resilience," Ashok Chandak, President, IESA said.

Date	30th April
Publication	Social News
Link	https://www.socialnews.xyz/2026/03/30/industry-hails-centres-push-on-design-quality-as-ecms-gains-pace/

Home » General » Business » Industry hails Centre's push on design, quality as ECMS gains pace

Industry hails Centre's push on design, quality as ECMS gains pace

POSTED BY: GOPI MARCH 30, 2026



New Delhi, March 30 (SocialNews.XYZ) Industry leaders on Monday welcomed the government's strong push on design capability and quality standards under the [Electronics](#) Component Manufacturing Scheme (ECMS), calling it critical for scaling India's [electronics](#) ambitions.

[Electronics & Electrical](#)

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Date	30th April
Publication	Globalbiznewsroom
Link	https://globalbiznewsroom.com/business/design-competency-and-quality-excellence-critical-to-scaling-indias-ecms-vision

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision

Business Manasi Praharaj 3/31/2026

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Broadly, the ECMS programme has seen **75 applications across 23 product categories from 12 states,** reflecting strong industry participation across the country. Against a target investment of **Rs 59,350 cr,** approvals have already reached **Rs 61,671 cr,** demonstrating the industry's strong confidence in the policy framework. The scheme is expected to enable production worth over **Rs 4,51,858 cr,** moving close to the overall target of Rs 4,56,500 cr, while employment generation has already reached over **65,000 jobs against a projected 91,600 jobs.**



News

On the Founder's Day Manipal University Jaipur Launches New Industry-Or

IESA congratulates MeitY for its proactive approach and fast-tracked approvals, which have significantly accelerated ecosystem development. As 2026 begins to shape, India has earned global trust as a credible, investible ESDM destination. ECMS is a game-changer because a strong ecosystem needs components, materials, and electronics value addition, not just semiconductors.



Date	30th April
Publication	Mediaprismcreative
Link	https://mediaprismcreative.com/business/design-competency-and-quality-excellence-critical-to-scaling-indias-ecms-vision

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Date	30th April
Publication	Businessnewschronicle
Link	https://businessnewschronicle.com/business/design-competency-and-quality-excellence-critical-to-scaling-indias-ecms-vision

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision

Business Manasi Praharaj 31 Mar 2026

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The continued guidance of the Hon'ble Minister, particularly on strengthening design competency and Six Sigma quality, is both timely and critical to building long-term global competitiveness. IESA has been consistently nurturing and advocating a designed manufacturing approach across the electronics and semiconductor sectors, and our members remain deeply committed to advancing design, innovation, and product creation in India. The next phase must focus on scaling up, building strong design teams, local sourcing, and world-class quality. OEMs and system companies must actively adopt Designed and Made-in-India components as demand creation is as critical as supply creation while distributors enable global integration of Indian products into the bill of materials.



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Date	30th April
Publication	Businessnewsforprofit
Link	https://businessnewsforprofit.com/business/design-competency-and-quality-excellence-critical-to-scaling-indias-ecms-vision/



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BUSINESS

Design Competency and Quality Excellence: Critical to Scaling India's ECMS Vision

By team

MAR 31, 2026

IESA Hails Keynes Semicon Inauguration
PRINT - BHUBANESWAR

Date	2ndApril
Publication	Amrut Dunia
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର ଉଦ୍‌ଘାଟନକୁ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁୟନ ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟବର ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନ୍ ର ଓଏସଏଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଦେଶ୍ୟରୁ ସଫଳ କାର୍ଯ୍ୟାନୁୟନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ ସ୍ୱଷ୍ଟ ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି । ମଲ୍ଟି-ଟିପ୍ପ ଇଂଟେଲିଜେଂଟ ମଡ୍ୟୁଲ୍ (ଏମସିଏମ୍) ର ବାଣିଜ୍ୟିକ ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷ୍ଟମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ସ୍କେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ । ପ୍ରାୟ ଟ.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ ସାନନ୍ଦରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ଡିଜାଇନ୍ ଠାରୁ ଉନ୍ନତ ଆସେମ୍ବଲି, ପରୀକ୍ଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏଟିଏମପି) ରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ ପ୍ରତିନିଧିତ୍ୱ କରେ । ଆଇଇଏସଏ ର ଜଣେ ମୂଲ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନଙ୍କ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉତ୍ତୁଳ କରେ । ଏହି ମାଇଲ୍‌ଷ୍ଟୁଟ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ବହନ କରେ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖିଛି ।

Date	2ndApril
Publication	Orissa Times
Quote By	Ashok Chandak

Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey

Bhubaneswar: The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT facility by the Hon'ble Prime Minister Narendra Modi, terming it a clear demonstration of

India's shift from intent to successful execution in the semiconductor sector. The Kaynes semiconductor facility in Sanand, with an investment of approximately ₹3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and

packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day. This milestone assumes even greater significance as India targets a \$400 billion electronics market and a \$103 billion semiconductor market by 2030.

Date	2ndApril
Publication	Dharitri
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର ଉଦ୍‌ଘାଟନକୁ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁୟନ ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ୍ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟବର ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନର ଓଏସଏଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଦେଶ୍ୟରୁ ସଫଳ କାର୍ଯ୍ୟାନୁୟନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ ସ୍ପଷ୍ଟ ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି। ମିଲି-ଟିପ୍ ଇଂଟେଲିଜେଂସ ମଡ୍ୟୁଲ୍ (ଏମସିଏମ୍) ର ବାଣିଜ୍ୟିକ ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷ୍ଟମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ଷ୍ଟେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ। ପ୍ରାୟ ୯.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ ସାନନ୍ଦରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ଡିଜାଇନ୍ ଠାରୁ ଉନ୍ନତ ଆସେମ୍ବଲି, ପରୀକ୍ଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏଟିଏମପି) ରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ ପ୍ରତିନିଧିତ୍ୱ କରେ। ଆଇଇଏସଏ ର ଜଣେ ମୂଲ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନଙ୍କ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉଜ୍ଜ୍ୱଳ କରେ। ଏହି ମାଲଖୁଂସ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ବହନ କରେ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖିଛି।

Date	2ndApril
Publication	Biswabani
Quote By	Ashok Chandak

Ashok Chandak, President, IESA and SEMI India- IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey

Bhubaneswar: The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT facility by the Hon'ble Prime Minister Narendra Modi, terming it a clear demonstration of India's shift from intent to successful execution in the semiconductor sector. The Kaynes semiconductor facility in Sanand, with an investment of approximately ₹3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day. This milestone assumes even greater significance as India targets a \$400 billion electronics market and a \$103 billion semiconductor market by 2030.

Date	2ndApril
Publication	Kalinga Mail
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର ଉଦ୍‌ଘାଟନକୁ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁୟନ ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ୍ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟବର ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନ୍ ର ଓଏସଏଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଘାଟନ ସଫଳ କାର୍ଯ୍ୟାନୁୟନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ ସ୍ୱଷ୍ଟ ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି। ମିଲି-ଟିପ୍ ଇଂଟେଲିଜେଂଟ ମଡ୍ୟୁଲ୍ (ଏମସିଏମ୍) ର ବାଣିଜ୍ୟିକ ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷ୍ଟମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ସ୍ୱେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ। ପ୍ରାୟ ୫.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ

ସାମୟରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ତିଳାଇନ୍, ଠାରୁ ଉନ୍ନତ ଆସେମ୍ବଲି, ପରୀକ୍ଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏଟିଏମପି) ରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ ପ୍ରତିନିଧିତ୍ୱ କରେ। ଆଇଇଏସଏ ର ଜଣେ ମୂଲ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନ୍‌ଙ୍କ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉତ୍ତୁଳ କରେ। ଏହି ମାଲଲକ୍ଷ୍ମିଂଟ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ବହନ କରେ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖିଛି।

Date	2ndApril
Publication	Manthan
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର ଉଦ୍‌ଘାଟନକୁ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁୟନ ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟବର ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନ୍ ର ଓଏସଏଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଦେଶ୍ୟରୁ ସଫଳ କାର୍ଯ୍ୟାନୁୟନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ ସ୍ପଷ୍ଟ ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି। ମଲ୍ଟି-ଟିପ୍ପି ଇଂଟେଲିଜେଂଟ ମଡ୍ୟୁଲ୍ (ଏମସିଏମ୍) ର

ବାଣିଜ୍ୟିକ ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷ୍ଟମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ସ୍କେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ। ପ୍ରାୟ ୫.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ ସାନନ୍ଦରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ଡିଜାଇନ୍ ଠାରୁ ଉନ୍ନତ ଆସେମ୍ବଲି, ପରୀକ୍ଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏଟିଏମପି) ରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ ପ୍ରତିନିଧିତ୍ୱ କରେ।

ଆଇଇଏସଏ ର ଜଣେ ମୂଲ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନଙ୍କ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉତ୍ତୁଳ କରେ। ଏହି ମାଇଲଷ୍ଟେଜ୍ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ବହନ କରେ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖିଛି।

Date	2ndApril
Publication	Swatantra Barta
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର ଉଦ୍‌ଘାଟନକୁ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟବର ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନ୍ ଓଏସଏଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଘାଟନରୁ ସଫଳ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ ସ୍ୱତନ୍ତ୍ର ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି। ମଲ୍ଟି-ଟିପ୍ପି ଇଂଟେଲିଜେଂଟ ମଡ୍ୟୁଲ୍ (ଏମସିଏମ୍) ର ବାଣିଜ୍ୟିକ ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷ୍ଟମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ସ୍ୱେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ। ପ୍ରାୟ ଟ.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ ସାମୟରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ତିଳାଇନ୍ ଠାରୁ ଉନ୍ନତ ଆସେମ୍‌ଲି, ପରାଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏଟିଏମପି) ରେ ଏକ ନିର୍ଦ୍ଦାୟକ ପଦକ୍ଷେପ ପ୍ରତିନିଧିତ୍ୱ କରେ। ଆଇଇଏସଏ ର ଜଣେ ମୂଲ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନକ୍ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉତ୍ତୁଳ କରେ। ଏହି ମାଇଲଷ୍ଟେଜ୍ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ବହନ କରେ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖିଛି।

Date	2ndApril
Publication	Odisha Khabar
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର ଉଦ୍‌ଘାଟନକୁ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ୍ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟବର ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନ୍ ଓ ଏସଏସଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଦେଶ୍ୟରୁ ସଫଳ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ ଉନ୍ନତ ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି। ମିଳି-ଟିପ୍ପି ଇଂଟେଲିଜେନ୍ସ ମଡ୍ୟୁଲ୍ (ଏମସିଏମ୍) ର ବାଣିଜ୍ୟିକ

ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷ୍ଟମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ସ୍କେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ। ପ୍ରାୟ ୫.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ ସାମୟରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ଡିଜାଇନ୍, ଠାରୁ ଉନ୍ନତ ଆସେମ୍ବଲି, ପରୀକ୍ଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏଟିଏମପି) ରେ ଏକ ନିର୍ଦ୍ଦିଷ୍ଟ ପଦକ୍ଷେପ ପୂର୍ତ୍ତି ନିଧୁତ୍ କରେ।

ଆଇଇଏସଏ ର ଜଣେ ମୁଖ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନଙ୍କ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉତ୍ତୁଳ କରେ। ଏହି ମାଲଖୁଟ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ବହନ କରେ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖୁଛି।

Date	2ndApril
Publication	Samaya
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର
 ଉଦ୍‌ଘାଟନକୁ ଭାରତର
 ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁୟନ
 ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ
 ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟବର ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନ ର ଓଏସଏଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଘାଟନରୁ ସଫଳ କାର୍ଯ୍ୟାନୁୟନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ ସ୍ୱପ୍ନ ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି । ମଲ୍ଲି-ଟିପ୍ପ ଇଂଡେଲିକେଟ ମତ୍ୟୁଲ୍ (ଏମସିଏମ୍) ର ବାଣିଜ୍ୟିକ ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷ୍ଟମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ସ୍କେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ । ପ୍ରାୟ ୯.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ ସାନନ୍ଦରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ଡିଜାଇନ୍, ଠାରୁ ଉନ୍ନତ ଆସେମ୍ବଲି, ପରାକ୍ଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏଟିଏମସି) ରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ ପ୍ରତିନିଧିତ୍ୱ କରେ । ଆଇଇଏସଏ ର ଜଣେ ମୁଖ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନଙ୍କ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉଚ୍ଛ୍ୱଳ କରେ । ଏହି ମାଲଖିଂଟ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ବହନ କରେ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖିଛି ।

Date	2ndApril
Publication	Pratidin
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର ଉଦ୍‌ଘାଟନକୁ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ୍ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟତା ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନ୍ ର ଓଏସଏଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଘାଟନ ସଫଳ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ ଘଣ୍ଟ ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି । ମଲ୍ଟି-ଟିପ୍ ଇଂରେଲିଜେଟ ମଡ୍ୟୁଲ୍ (ଏମସିଏମ୍) ର ବାଣିଜ୍ୟିକ

ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷ୍ଟମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ସ୍କେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ । ପ୍ରାୟ ୯.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ ସାମ୍ବଲରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ଡିକାଭର୍, ଠାରୁ ଉନ୍ନତ ଆସେମ୍ବଲି, ପରୀକ୍ଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏସିଏମପି) ରେ ଏକ ନିର୍ଦ୍ଦିଷ୍ଟ ପଦକ୍ଷେପ ପ୍ରତିନିଧିତ୍ୱ କରେ । ଆଇଇଏସଏ ର ଜଣେ

ମୂଲ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନଙ୍କ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉତ୍ସୁକ କରେ । ଏହି ମାଇକ୍ରୋଟ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ଦେଇ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖିଛି ।

Date	2ndApril
Publication	Utkal Samaja
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର ଉଦ୍‌ଘାଟନକୁ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁୟନ ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟବର ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନ ର ଓଏସଏଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଦେଶ୍ୟରୁ ସଫଳ କାର୍ଯ୍ୟାନୁୟନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ ସ୍ୱଷ୍ଟ ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି । ମିଲି-ଟିପ୍ ଇଂଟେଲିଜେଂସ ମଡ୍ୟୁଲ୍ (ଏମସିଏମ୍) ର ବାଣିଜ୍ୟିକ ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷ୍ଟମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ସ୍କେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ । ପ୍ରାୟ ୯.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ ସାନନ୍ଦରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ତିଜାଇନ୍ ଠାରୁ ଉନ୍ନତ ଆସେମ୍‌ଲି, ପରୀକ୍ଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏଟିଏମପି) ରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ ପ୍ରତିନିଧିତ୍ୱ କରେ । ଆଇଇଏସଏ ର ଜଣେ ମୂଲ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନଙ୍କ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉତ୍ତୁଳ କରେ । ଏହି ମାଇଲଷ୍ଟୁଟ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ବହନ କରେ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖିଛି ।

Date	2ndApril
Publication	Sakala
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର ଉଦ୍‌ଘାଟନକୁ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟବର ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନ ର ଓଏସଏଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଦେଶ୍ୟରୁ ସଫଳ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ ସ୍ପଷ୍ଟ ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି । ମିଲି-ଟିଏ ଇଂଚେଲିଜେଂଟ ମଡ୍ୟୁଲ୍ (ଏମସିଏମ) ର ବାଣିଜ୍ୟିକ ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ସ୍ୱେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ । ପ୍ରାୟ ୪.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ ସାନନ୍ଦରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ତିଜାଜନ୍ ଠାରୁ ଉନ୍ନତ ଆସେମ୍‌ଲି, ପରୀକ୍ଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏଟିଏମପି) ରେ ଏକ ନିର୍ଦ୍ଦାୟକ ପଦକ୍ଷେପ ପ୍ରତିନିଧିତ୍ୱ କରେ । ଆଇଇଏସଏ ର ଜଣେ ମୂଲ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନଙ୍କ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉଚ୍ଛ୍ୱଳ କରେ । ଏହି ମାଇଲ୍‌ଷ୍ଟେଟ୍ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ବଢ଼ନ କରେ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖିଛି ।

Date	2ndApril
Publication	Utkal Mail
Quote By	Ashok Chandak

ଆଇଇଏସଏ କେନ୍ଦ୍ର ସେମିକନର ଉଦ୍‌ଘାଟନକୁ ଭାରତର ସେମିକଣ୍ଡକ୍ଟର କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଯାତ୍ରାରେ ଏକ ଐତିହାସିକ ମୁହୂର୍ତ୍ତ ବୋଲି ଦର୍ଶାଇଛନ୍ତି

ଭୁବନେଶ୍ୱର: ଇଣ୍ଡିଆ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଆଣ୍ଡ ସେମିକଣ୍ଡକ୍ଟର ଆସୋସିଏସନ୍ (ଆଇଇଏସଏ) ମାନ୍ୟବର ପ୍ରଧାନମନ୍ତ୍ରୀ ନରେନ୍ଦ୍ର ମୋଦୀଙ୍କ ଦ୍ୱାରା କେନ୍ଦ୍ର ସେମିକନର ଓଏସଏଟି ସୁବିଧାର ଉଦ୍‌ଘାଟନକୁ ସ୍ୱାଗତ କରିଛି, ଏହାକୁ ସେମିକଣ୍ଡକ୍ଟର କ୍ଷେତ୍ରରେ ଭାରତର ଉଦ୍‌ଘାଟନ ସଫଳ କାର୍ଯ୍ୟାନୁଷ୍ଠାନ ଆଡ଼କୁ ପରିବର୍ତ୍ତନର ଏକ

ସ୍ପଷ୍ଟ ପ୍ରଦର୍ଶନ ବୋଲି କହିଛି । ମଲ୍ଟି-ଟିପ୍ପ ଇଂରେଲିଙ୍ଗେଟ ମଡ୍ୟୁଲ୍ (ଏମସିଏମ୍) ର ବାଣିଜ୍ୟିକ ଶୁଭାରମ୍ଭ ସହିତ, ଏହି ଉଦ୍‌ଘାଟନ ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସିଷମ୍ ଇଂଟିଗ୍ରେସନ୍ ଏବଂ ସେଲେବଲ୍ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନରେ ଭାରତର ବର୍ଦ୍ଧିତ ଶକ୍ତିକୁ ଉଲ୍ଲେଖ କରେ । ପ୍ରାୟ ୯.୩,୩୦୦ କୋଟି ନିବେଶ ସହିତ

ସାମନ୍ତରେ କେନ୍ଦ୍ର ସେମିକଣ୍ଡକ୍ଟର ସୁବିଧା, ତିଳାଜନ୍ ଠାରୁ ଉନ୍ନତ ଆସେମ୍‌ଲି, ପରୀକ୍ଷଣ ଏବଂ ପ୍ୟାକେଜିଂ (ଏଟିଏମପି) ରେ ଏକ ନିର୍ଣ୍ଣାୟକ ପଦକ୍ଷେପ ପ୍ରତିନିଧିତ୍ୱ କରେ । ଆଇଇଏସଏ ର ଜଣେ ମୂଲ୍ୟବାନ ସଦସ୍ୟ ଭାବରେ, କେନ୍ଦ୍ର ସେମିକନକ୍ ସଫଳତା ଭାରତର ସେମିକଣ୍ଡକ୍ଟର

ଇକୋସିଷ୍ଟମର ବର୍ଦ୍ଧିତ ବ୍ୟାପକତା ଏବଂ ପରିପକ୍ୱତାକୁ ଉଚ୍ଛ୍ୱଳ କରେ । ଏହି ମାଇଲଷ୍ଟେଜ୍ ଆହୁରି ଅଧିକ ଗୁରୁତ୍ୱ ଦେଇ କରେ କାରଣ ଭାରତ ୨୦୩୦ ସୁଦ୍ଧା ୪୦୦ ବିଲିୟନ ଡଲାରର ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ବଜାର ଏବଂ ୧୦୩ ବିଲିୟନ ଡଲାରର ସେମିକଣ୍ଡକ୍ଟର ବଜାର ଲକ୍ଷ୍ୟ ରଖିଛି ।

**IESA Hails Keynes Semicon Inauguration
PRINT - GUWAHATI**

Date	5th April
Publication	Sentinel
Quote By	Ashok Chandak

आईईएसए ने केन्स सेमीकॉन उद्घाटन को भारत की सेमीकंडक्टर क्रियान्वयन यात्रा में एक मील का पत्थर बताया

नई दिल्ली, 4 अप्रैल (एजेंसी)। इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन (आईईएसए) ने माननीय प्रधानमंत्री नरेंद्र मोदी द्वारा केन्स सेमीकॉन की ओएसएटी फैसिलिटी के उद्घाटन का स्वागत किया और इसे सेमीकंडक्टर सेक्टर में इरादों से अमल की ओर बदलाव में भारत की प्रगति का प्रतीक बताया। मल्टी-चिप इंटेलिजेंट मॉड्यूल (एमसीएम) के कमर्शियल लॉन्च के साथ यह उद्घाटन, एडवांस्ड पैकेजिंग, सिस्टम इंटीग्रेशन और स्केलेबल सेमीकंडक्टर मैनुफैक्चरिंग में भारत की बढ़ती शक्ति को दर्शाता है। यह जमीनी स्तर पर हो रही ठोस तरक्की को दिखाता है क्योंकि भारत एक मजबूत और विश्व स्तर पर प्रतिस्पर्धी सेमीकंडक्टर ईकोसिस्टम का निर्माण कर रहा है। साणंद में केन्स सेमीकंडक्टर फैसिलिटी, जिसमें लगभग 3,300 करोड़ का निवेश है, डिजाइन से परे एडवांस्ड असेंबली, टैस्टिंग और पैकेजिंग (एटीएमपी) की दिशा में एक अहम कदम है। हर दिन लगभग 60 लाख चिप्स बनाने की संभावित क्षमता के साथ, यह फैसिलिटी घरेलू मैनुफैक्चरिंग सामर्थ्य को बढ़ाएगी, साथ ही स्थानीय अर्थव्यवस्था के विकास को बढ़ावा देगी और सहायक उद्योगों को मजबूत करेगी। आईईएसए के एक अहम सदस्य के तौर पर, केन्स सेमीकॉन की कामयाबी भारत के सेमीकंडक्टर ईकोसिस्टम की बढ़ती गहराई और परिपक्वता को दर्शाती है डिजाइन और इंजीनियरिंग से लेकर पैकेजिंग और प्रोडक्ट कमर्शियलाइजेशन तक। मल्टी-चिप मॉड्यूल का सफल लॉन्च इस बात का पुख्ता संकेत है कि भारत अब न सिर्फ बड़े पैमाने पर बेहतर सेमीकंडक्टर प्रोडक्ट डिजाइन कर रहा है, बल्कि उन्हें मैनुफैक्चर भी कर रहा है। खास बात यह है कि एक ही महीने में दो सेमीकंडक्टर फैसिलिटीज के उद्घाटन हुए हैं तथा इस साल कई और प्रोजेक्ट्स शुरू होने वाले हैं, यह एक मजबूत सेमीकंडक्टर ईकोसिस्टम निर्मित करने के भारत के पक्के इरादे को दिखाता है।

Date	3rd April
Publication	The Hills Times
Quote By	Ashok Chandak

IESA hails Kaynes Semicon facility as milestone in India's semiconductor push

HT Bureau

GUWAHATI, April 2: The India Electronics and Semiconductor Association (IESA) has welcomed the inauguration of Kaynes Semicon's OSAT facility, calling it a significant step in India's transition from policy intent to on-ground execution in the semiconductor sector.

The facility, inaugurated by Prime Minister Narendra Modi, marks a major advancement in India's capabilities in semiconductor assembly, testing and packaging. IESA said the development highlights the country's growing strength in advanced packaging, system integration and scalable manufacturing.

Speaking on the development, Ashok Chandak, President of IESA and SEMI India, described the inauguration as a clear demonstration of India's progress.

He noted that the launch of the

Multi-Chip Intelligent Module (MCM) alongside the facility reflects the country's ability to move beyond chip design to full-scale manufacturing.

The Sanand-based facility, built with an investment of around ₹3,300 crore, is expected to have a production capacity of nearly 60 lakh chips per day. Industry experts say this will significantly enhance domestic manufacturing capability while supporting local economic growth and ancillary industries.

IESA highlighted that the development signals increasing maturity in India's semiconductor ecosystem, spanning design, engineering, packaging and product commercialisation.

The association noted that the rapid rollout of semiconductor projects— including multiple facility inaugurations within a

month—demonstrates strong policy alignment driven by the Ministry of Electronics and Information Technology and the India Semiconductor Mission, along with support from state governments such as Gujarat.

The milestone comes as India targets a \$400 billion electronics market and a \$103 billion semiconductor market by 2030.

IESA said sustained execution across the value chain will be crucial to achieving these goals, adding that such developments position India as a credible player in the global semiconductor landscape.

The transformation of Sanand from an automobile hub into an emerging semiconductor cluster further underlines the momentum of the "Make in India" initiative and the country's push towards building a resilient, end-to-end semiconductor ecosystem.

Date	2nd April
Publication	The North East Times
Quote By	Ashok Chandak

IESA hails Kaynes Semicon inauguration as landmark in India's semiconductor execution journey

By Ashok Chandak, President, IESA and SEMI India

The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT facility by the Prime Minister Narendra Modi, terming it a clear demonstration of India's shift from intent to successful execution in the semiconductor sector.

The inauguration, along with the commercial launch of the Multi-Chip Intelligent Module (MCM), underscores India's growing strength in advanced packaging, system integration, and scalable semiconductor manufacturing. It reflects tangible progress on the ground as India builds a resilient and globally competitive semiconductor ecosystem. The Kaynes semiconductor facility in Sanand, with an investment of approximately Rs.3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day, the facility will significantly boost domestic manufacturing capability while driving local economic development and strengthening ancillary industries.

As a valued member of IESA, Kaynes Semicon's achievement highlights the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialisation. The successful launch of the Multi-Chip Module is a strong indicator that India is now not only designing but also manufacturing sophisticated semiconductor products at scale.

Notably, the inauguration of two semiconductor facilities within a single month, with several more projects slated for rollout this year, reinforces India's unwavering commitment to building a robust semiconductor ecosystem. This rapid pace of execution reflects strong policy alignment and effective coordination led by the Ministry of Electronics and Information Technology (MeitY), the India Semiconductor Mission (ISM), and proactive support from state governments such as Government of Gujarat. It sends a clear signal to global investors and industry stakeholders that India is accelerating from intent to sustained, large-scale execution in the semiconductor sector.

This milestone assumes even greater significance as India targets a \$400 bn electronics market and a \$103 bn semiconductor market by 2030. Achieving these ambitions will require sustained execution across the value chain, and developments such as Kaynes' facility demonstrate that India is firmly on that path.

Strengthening domestic semiconductor capabilities will be critical for supply chain resilience, technological leadership, and the creation of high-quality, skilled jobs. Importantly, India is now converting global supply chain shifts into a strategic advantage by building a comprehensive, end-to-end semiconductor ecosystem.

The transformation of Sanand from an automobile hub into a fast-emerging semiconductor cluster further reinforces the momentum of the Make in India vision and positions India as a credible and competitive player in the global semiconductor landscape."

Date	2nd April
Publication	The Meghalaya Guardian
Quote By	Ashok Chandak

IESA hails Kaynes Semicon inauguration as landmark in India's semiconductor execution journey

By Ashok Chandak, President, IESA and SEMI India

The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT facility by the Prime Minister Narendra Modi, terming it a clear demonstration of India's shift from intent to successful execution in the semiconductor sector.

The inauguration, along with the commercial launch of the Multi-Chip Intelligent Module (MCM), underscores India's growing strength in advanced packaging, system integration, and scalable semiconductor manufacturing. It reflects tangible progress on the ground as India builds a resilient and globally competitive semiconductor ecosystem. The Kaynes semiconductor facility in Sanand, with an investment of approximately Rs.3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day, the facility will significantly boost domestic manufacturing capability while driving local economic development and strengthening ancillary industries.

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The transformation of Sanand from an automobile hub into a fast-emerging semiconductor cluster further reinforces the momentum of the Make in India vision and positions India as a credible and competitive player in the global semiconductor landscape."

Date	2nd April
Publication	The Assam Post
Quote By	Ashok Chandak

IESA hails Kaynes Semicon inauguration as landmark in India's Semiconductor execution journey

The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT facility by the Hon'ble Prime Minister Narendra Modi, terming it a clear demonstration of India's shift from intent to successful execution in the semiconductor sector.

The inauguration, along with the commercial launch of the Multi-Chip Intelligent Module (MCM), underscores India's growing strength in advanced packaging, system integration, and scalable semiconductor manufacturing. It reflects tangible progress on the ground as India builds a resilient and globally competitive semiconductor ecosystem. The Kaynes semiconductor facility in Sanand, with an investment of approximately ₹3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day, the facility will significantly boost domestic manufacturing capability while driving local economic development and strengthening ancillary industries. As a valued member of IESA, Kaynes Semicon's achievement highlights the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialisation. The successful launch of the Multi-Chip Module is a strong indicator that India is now not only designing but also manufacturing sophisticated semiconductor products at scale. Notably, the inauguration of two semiconductor facilities within a single month, with

several more projects slated for rollout this year, reinforces India's unwavering commitment to building a robust semiconductor ecosystem. This rapid pace of execution reflects strong policy alignment and effective coordination led by the Ministry of Electronics and Information Technology (MeitY), the India Semiconductor Mission (ISM), and proactive support from state governments such as Government of Gujarat. It sends a clear signal to global investors and industry stakeholders that India is accelerating from intent to sustained, large-scale execution in the semiconductor sector. This milestone assumes even greater significance as India targets a \$400 billion electronics market and a \$103 billion semiconductor market by 2030. Achieving these ambitions will require sustained execution across the value chain, and developments such as Kaynes' facility demonstrate that India is firmly on that path. Strengthening domestic semiconductor capabilities will be critical for supply chain resilience, technological leadership, and the creation of high-quality, skilled jobs. Importantly, India is now converting global supply chain shifts into a strategic advantage by building a comprehensive, end-to-end semiconductor ecosystem. The transformation of Sanand from an automobile hub into a fast-emerging semiconductor cluster further reinforces the momentum of the Make in India vision and positions India as a credible and competitive player in the global semiconductor landscape."

Ashok Chandak, President, IESA and SEMI India

Date	2nd April
Publication	Dainik Batori
Quote By	Ashok Chandak

আইইএছএ-এ কেইনছ চেমিকনৰ উদ্বোধনক অভিনন্দন

গুৱাহাটী, ১ এপ্রিলঃ ভাৰত ইলেক্ট্ৰনিক্স আৰু চেমিকণ্ডাক্টৰ এছ'চিয়েছনে প্ৰধানমন্ত্ৰী নৰেন্দ্ৰ মোদীৰ দ্বাৰা কেইনছ চেমিকনৰ অ'এচএটি সুবিধাৰ উদ্বোধনক স্বাগতম জনাইছে। এই উদ্বোধনৰ লগতে মাল্টি-চিপ ইণ্টেলিজেণ্ট মডিউলৰ বাণিজ্যিক উন্মোচনে ভাৰতৰ উন্নত পেকেজিং, চিপ্লেট ইণ্টিগ্ৰেচন আৰু বুদ্ধিযোগ্য চেমিকণ্ডাক্টৰ উৎপাদনত ক্ৰমবৰ্ধমান শক্তিৰ ওপৰত আলোকপাত কৰে। ইয়ে বাস্তৱত দৃশ্যমান প্ৰগতি প্ৰতিফলিত কৰে যিহেতু ভাৰতে এটা স্থিতিস্থাপক আৰু বিশ্বব্যাপী প্ৰতিযোগিতামূলক চেমিকণ্ডাক্টৰ ইক'চিপ্লেটম গাঢ়ি তুলিছে। সানন্দত কেইনছ চেমিকণ্ডাক্টৰ সুবিধা, প্ৰায় ৩,৩০০ কোটি টকাৰ বিনিয়োগৰ সৈতে, ডিজাইনৰ পৰা উন্নত একত্ৰীকৰণ, পৰীক্ষণ আৰু পেকেজিংলৈ এটা নিৰ্ণায়ক পদক্ষেপ প্ৰতিনিধিত্ব কৰে। প্ৰতিদিনে প্ৰায় ৬০ লাখ চিপৰ ক্ষমতাৰ সৈতে, এই সুবিধাই দেশীয় উৎপাদন ক্ষমতা বৃদ্ধি কৰিব আৰু স্থানীয় অৰ্থনৈতিক উন্নয়ন চালনা কৰিব লগতে সহায়ক উদ্যোগবোৰক শক্তিশালী কৰিব। আইইএছএৰ এক মূল্যবান সদস্য হিচাপে,

কেইনছ চেমিকনৰ এই সাফল্যই ভাৰতৰ চেমিকণ্ডাক্টৰ ইক'চিপ্লেটম ক্ৰমবৰ্ধমান গভীৰতা আৰু পৰিপক্বতাক প্ৰতিফলিত কৰে য'ত ডিজাইন আৰু ইঞ্জিনিয়াৰিংৰ পৰা পেকেজিং আৰু প্ৰ'ডাক্ট বাণিজ্যিকীকৰণলৈকে আছে। মাল্টি-চিপ মডিউলৰ সফল উন্মোচন এটা শক্তিশালী সূচক যে ভাৰতে এতিয়া কেৱল ডিজাইন নকৰে বৰঞ্চ বৃহৎ পৰ্যায়ত জটিল চেমিকণ্ডাক্টৰ প্ৰ'ডাক্টবোৰ উৎপাদন কৰিছে। উল্লেখযোগ্যভাৱে, এমাহৰ ভিতৰত দুটা চেমিকণ্ডাক্টৰ সুবিধাৰ উদ্বোধন, ইয়াৰ লগতে বছৰটোৰ ভিতৰত আৰু কেইবাটাও প্ৰকল্প বাস্তৱায়ন কৰিবলৈ থকাটোৱে ভাৰতৰ এটা শক্তিশালী চেমিকণ্ডাক্টৰ ইক'চিপ্লেটম গাঢ়ি তোলাৰ অটল প্ৰতিশ্ৰুতিৰ পুনৰ নিশ্চিত কৰে। এই দ্ৰুত কাৰ্যকৰী গতিয়ে ইলেক্ট্ৰনিক্স আৰু তথ্য প্ৰযুক্তি মন্ত্ৰালয়, ভাৰত চেমিকণ্ডাক্টৰ মিছন আৰু গুজৰাট চৰকাৰৰ দৰে ৰাজ্য চৰকাৰসমূহৰ প্ৰক্ৰিয়াগত সমৰ্থনৰ নেতৃত্বত শক্তিশালী নীতি সংৰেখন আৰু ফলপ্ৰসূ সমন্বয় প্ৰতিফলিত কৰে। এই মাইলৰ খুঁটিৰ আৰু অধিক তাৎপৰ্য আছে যিহেতু ভাৰতে ২০৩০ চনৰ ভিতৰত ৪০০ বিলিয়ন ডলাৰ ইলেক্ট্ৰনিক্স বজাৰ আৰু ১০৩ বিলিয়ন ডলাৰ চেমিকণ্ডাক্টৰ বজাৰ লক্ষ্য কৰিছে। গুৰুত্বপূৰ্ণভাৱে, ভাৰতে এতিয়া বিশ্বব্যাপী যোগান শৃংখলৰ পৰিৱৰ্তনসমূহক এটা কৌশলগত সুবিধালৈ ৰূপান্তৰিত কৰিছে-এটা বিস্তৃত, এণ্ড-টু-এণ্ড চেমিকণ্ডাক্টৰ ইক'চিপ্লেটম গাঢ়ি তোলাৰ দ্বাৰা সানন্দক অটোমোবাইল কেন্দ্ৰৰ পৰা এটা দ্ৰুত উদীয়মান চেমিকণ্ডাক্টৰ ক্লাষ্টাৰলৈ ৰূপান্তৰিত কৰাৰ এই পৰিৱৰ্তনে 'মেক ইন ইণ্ডিয়া' দৃষ্টিভংগীৰ গতিবেগক আৰু শক্তিশালী কৰে আৰু ভাৰতক বিশ্ব চেমিকণ্ডাক্টৰ পৰিৱেশত এটা বিশ্বাসযোগ্য আৰু প্ৰতিযোগিতামূলক প্ৰতিযোগী হিচাপে স্থান দিয়ে।

Date	2nd April
Publication	Purvanchal Prahari
Quote By	Ashok Chandak

आईईएसए ने केन्स सेमीकॉन उद्घाटन को भारत की प्रगति का प्रतीक बताया

नई दिल्ली : इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन (आईईएसए) ने प्रधानमंत्री नरेंद्र मोदी द्वारा केन्स सेमीकॉन की ओएसएटी फैसिलिटी के उद्घाटन का स्वागत किया और इसे सेमीकंडक्टर सेक्टर में इरादों से अमल की ओर बदलाव में भारत की प्रगति का प्रतीक बताया। मल्टी-चिप इंटेजिग्रेटेड मॉड्यूल (एमसीएम) के कमर्शियल लांच के साथ यह उद्घाटन, एडवांस्ड पैकेजिंग, सिस्टम इंटीग्रेशन और स्केलेबल सेमीकंडक्टर मैनुफैक्चरिंग में भारत की बढ़ती शक्ति को दर्शाता है। यह जमीनी स्तर पर हो रही ठोस तरक्की को दिखाता है क्योंकि भारत एक मजबूत और विश्व स्तर पर प्रतिस्पर्धी सेमीकंडक्टर ईकोसिस्टम का निर्माण कर रहा है। साणंद में

केन्स सेमीकंडक्टर फैसिलिटी, जिसमें लगभग 3,300 करोड़ का निवेश है, डिजाइन से परे एडवांस्ड असेंबली, टैस्टिंग और पैकेजिंग (एटीएमपी) की दिशा में एक अहम कदम है। हर दिन लगभग 60 लाख चिप्स बनाने की संभावित क्षमता के साथ यह फैसिलिटी घरेलू मैनुफैक्चरिंग सामर्थ्य को बढ़ाएगी, साथ ही स्थानीय अर्थव्यवस्था के विकास को बढ़ावा देगी और सहायक उद्योगों को मजबूत करेगी। आईईएसए के एक अहम सदस्य के तौर पर, केन्स सेमीकॉन की कामयाबी भारत के सेमीकंडक्टर ईकोसिस्टम की बढ़ती गहराई और परिपक्वता को दर्शाती है - डिजाइन और इंजीनियरिंग से लेकर पैकेजिंग और प्रोडक्ट कमर्शियलाइज

**IESA Hails Keynes Semicon Inauguration
PRINT - Bangalore**

Date	4th April
Publication	Vishwavani
Quote By	Ashok Chandak

ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರಕ್ಕೆ ಮೈಲಿಗಲ್ಲು

ಬೆಂಗಳೂರು: ಪ್ರಧಾನಮಂತ್ರಿ ನರೇಂದ್ರ ಮೋದಿ



ಅವರು ಕೇನೆಸ್ ಸೆಮಿಕಾನ್‌ನ
ಓಎಸ್‌ಎಟಿ ಘಟಕವನ್ನು
ಉದ್ಘಾಟಿಸಿರುವುದನ್ನು
ಭಾರತೀಯ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್
ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್
ಅಸೋಸಿಯೇಷನ್ ಸ್ವಾಗತಿ
ಸಿದೆ. ಇದು ಸೆಮಿಕಂಡಕ್ಟರ್

ಕ್ಷೇತ್ರದಲ್ಲಿ ಭಾರತವು ಕೇವಲ ಉದ್ದೇಶವನ್ನು ಹೊಂದಿರು
ವುದಲ್ಲದೆ, ಅದನ್ನು ಯಶಸ್ವಿ ಅನುಷ್ಠಾನಕ್ಕೆ ತರುತ್ತಿದೆ
ಎಂದು ಐಇಎಸ್‌ಎ ಅಧ್ಯಕ್ಷ ಅಶೋಕ್ ಚಂದ್ರನ್
ತಿಳಿಸಿದರು. ಈ ಕುರಿತು ಪತ್ರಿಕಾ ಪ್ರಕಟಣೆಯಲ್ಲಿ
ತಿಳಿಸಿರುವ ಅವರು, ಸುಮಾರು 3,300 ಕೋಟಿ ರು.
ಹೂಡಿಕೆಯಲ್ಲಿ ನಿರ್ಮಿತ ಈ ಘಟಕವು ದಿನಕ್ಕೆ 60 ಲಕ್ಷ
ಚಿಪ್ ಉತ್ಪಾದನೆ ಸಾಮರ್ಥ್ಯ ಹೊಂದಿದ್ದು,
ಅಸೆಂಬಲ್, ಪರಿಕ್ಷೆ ಮತ್ತು ಪ್ಯಾಕೇಜಿಂಗ್ ಕ್ಷೇತ್ರದಲ್ಲಿ
ಭಾರತದ ಶಕ್ತಿಯನ್ನು ಹೆಚ್ಚಿಸುತ್ತದೆ. ಜತೆಗೆ ಮಲಿ-ಚಿಪ್
ಮಾಡ್ಯೂಲ್ ಬಿಡುಗಡೆ ದೇಶವು ವಿನ್ಯಾಸದಷ್ಟೇ ಅಲ್ಲ,
ಉತ್ಪಾದನೆಯಲ್ಲಿ ಸಹ ಮುನ್ನಡೆಯುತ್ತಿದೆ. ಭಾರತವು
2030ರೊಳಗೆ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಹಾಗೂ ಸೆಮಿಕಂಡಕ್ಟರ್
ಮಾರುಕಟ್ಟೆಯಲ್ಲಿ ದೊಡ್ಡ ಗುರಿ ಹೊಂದಿದೆ ಎಂದರು.

Date	4th April
Publication	Echara Vani
Quote By	Ashok Chandak

ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಅನುಷ್ಠಾನದ ಪಯಣದಲ್ಲಿ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಉದ್ಘಾಟನೆಯನ್ನು ಒಂದು ಮೈಲಿಗಲ್ಲು ಎಂದು ಐಇಎಸ್‌ಎ ಶ್ಲಾಘಿಸಿ

ಬೆಂಗಳೂರು: ಗೌರವಾನ್ವಿತ ಪ್ರಧಾನಮಂತ್ರಿ ನರೇಂದ್ರ ಮೋದಿ ಅವರು ಕೇನೆಸ್ ಸೆಮಿಕಾನ್‌ನ ಓಎಸ್‌ಎಟಿ (OSAT) ಘಟಕವನ್ನು ಉದ್ಘಾಟಿಸಿರುವುದನ್ನು ಭಾರತೀಯ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಅಸೋಸಿಯೇಷನ್ (IESA) ಸ್ವಾಗತಿಸಿದೆ. ಇದು ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರದಲ್ಲಿ ಭಾರತವು ಕೇವಲ ಉದ್ದೇಶವನ್ನು ಹೊಂದಿರುವುದಲ್ಲದೆ, ಅದನ್ನು ಯಶಸ್ವಿ ಅನುಷ್ಠಾನಕ್ಕೆ ತರುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಸ್ಪಷ್ಟ ನಿದರ್ಶನ ಎಂದು ಐಇಎಸ್‌ಎ ಬಣ್ಣಿಸಿದೆ.

ಈ ಉದ್ಘಾಟನೆ ಮತ್ತು ಮಲ್ಟಿ-ಚಿಪ್ ಇಂಟಿಗ್ರೇಟೆಡ್ ಮಾಡ್ಯೂಲ್‌ನ (MCM) ವಾಣಿಜ್ಯ ಬಿಡುಗಡೆಯು ಸುಧಾರಿತ ಪ್ಯಾಕೇಜಿಂಗ್, ಸಿಸ್ಟಮ್ ಇಂಟಿಗ್ರೇಷನ್ ಮತ್ತು ಸ್ಕೇಲೆಬಲ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಉತ್ಪಾದನೆಯಲ್ಲಿ ಭಾರತದ ಬೆಳೆಯುತ್ತಿರುವ ಶಕ್ತಿಯನ್ನು ಎತ್ತಿ ತೋರಿಸುತ್ತದೆ. ಭಾರತವು ಸ್ಥಿತಿಶಾಪಕ ಮತ್ತು ಜಾಗತಿಕವಾಗಿ ಸ್ಪರ್ಧಾತ್ಮಕವಾದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು ನಿರ್ಮಿಸುತ್ತಿರುವುದಕ್ಕೆ ಇದು ಸಾಕ್ಷಿಯಾಗಿದೆ. ಸೆನಂದ್‌ನಲ್ಲಿರುವ ಕೇನೆಸ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಘಟಕವು ಸುಮಾರು 3,300 ಕೋಟಿ ಹೂಡಿಕೆಯೊಂದಿಗೆ ನಿರ್ಮಾಣವಾಗಿದ್ದು, ವಿನ್ಯಾಸವನ್ನು ಮೀರಿ ಸುಧಾರಿತ ಅಸೆಂಬ್ಲಿ, ಪರಿಶೀಲನೆ ಮತ್ತು ಪ್ಯಾಕೇಜಿಂಗ್ (ATMP) ಕಡೆಗೆ ಇಟ್ಟ ನಿರ್ಣಾಯಕ ಹೆಜ್ಜೆಯಾಗಿದೆ. ದಿನಕ್ಕೆ ಸುಮಾರು 60 ಲಕ್ಷ ಚಿಪ್‌ಗಳನ್ನು ತಯಾರಿಸುವ ಸಾಮರ್ಥ್ಯ ಹೊಂದಿರುವ ಈ ಸೌಲಭ್ಯವು ದೇಶೀಯ ಉತ್ಪಾದನಾ ಸಾಮರ್ಥ್ಯವನ್ನು ಗಣನೀಯವಾಗಿ ಹೆಚ್ಚಿಸುವುದಲ್ಲದೆ, ಸ್ಥಳೀಯ ಆರ್ಥಿಕ ಅಭಿವೃದ್ಧಿ ಮತ್ತು ಪೂರಕ ಕೈಗಾರಿಕೆಗಳನ್ನು ಬಲಪಡಿಸಲಿದೆ.

ಐಇಎಸ್‌ಎದ ಮೌಲ್ಯಯುತ ಸದಸ್ಯರಾಗಿರುವ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್‌ನ ಈ ಸಾಧನೆಯು ವಿನ್ಯಾಸ ಮತ್ತು ಎಂಜಿನಿಯರಿಂಗ್‌ನಿಂದ ಪ್ಯಾಕೇಜಿಂಗ್

ಮತ್ತು ಉತ್ಪನ್ನಗಳ ವಾಣಿಜ್ಯೀಕರಣದವರೆಗೆ ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯ ಆಳ ಮತ್ತು ಪ್ರೌಢಿಮೆಯನ್ನು ಎತ್ತಿ ತೋರಿಸುತ್ತದೆ. ಮಲ್ಟಿ-ಚಿಪ್ ಮಾಡ್ಯೂಲ್‌ನ ಯಶಸ್ವಿ ಬಿಡುಗಡೆಯು ಭಾರತವು ಈಗ ಕೇವಲ ವಿನ್ಯಾಸ ಮಾಡುವುದು ಮಾತ್ರವಲ್ಲದೆ, ಅತ್ಯಾಧುನಿಕ ಸೆಮಿಕಂಡಕ್ಟರ್ ಉತ್ಪನ್ನಗಳನ್ನು ದೊಡ್ಡ ಪ್ರಮಾಣದಲ್ಲಿ ಉತ್ಪಾದಿಸುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಪ್ರಬಲ ಸಂಕೇತವಾಗಿದೆ.

ಒಂದೇ ತಿಂಗಳ ಅವಧಿಯಲ್ಲಿ ಎರಡು ಸೆಮಿಕಂಡಕ್ಟರ್ ಘಟಕಗಳ ಉದ್ಘಾಟನೆ ಮತ್ತು ಈ ವರ್ಷ ಇನ್ನೂ ಹಲವು ಯೋಜನೆಗಳು ಕಾರ್ಯಗತಗೊಳ್ಳಲು ಸಿದ್ಧವಾಗಿರುವುದು, ಸದೃಢವಾದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು ನಿರ್ಮಿಸುವಲ್ಲಿ ಭಾರತಕ್ಕಿರುವ ಅಚಲ ಬದ್ಧತೆಯನ್ನು ಪುನರುಚ್ಚರಿಸುತ್ತದೆ. ಈ ವೇಗದ ಅನುಷ್ಠಾನವು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಮಾಹಿತಿ ತಂತ್ರಜ್ಞಾನ ಸಚಿವಾಲಯ ಇಂಡಿ-ಮಾ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮಿಷನ್ ನಾಯಕತ್ವದ ಪರಿಣಾಮಕಾರಿ ಸಮನ್ವಯ ಮತ್ತು ಗುಜರಾತ್ ಸರ್ಕಾರದಂತಹ ರಾಜ್ಯ ಸರ್ಕಾರಗಳ ಸಕ್ರಿಯ ಬೆಂಬಲವನ್ನು ಪ್ರತಿಬಿಂಬಿಸುತ್ತದೆ. ಇದು ಜಾಗತಿಕ ಹೂಡಿಕೆದಾರರಿಗೆ ಮತ್ತು ಉದ್ಯಮದ ಪಾಲುದಾರರಿಗೆ ಭಾರತವು ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರದಲ್ಲಿ ಕೇವಲ ಆಶಯದಿಂದ ಸುಸ್ಥಿರವಾಗೂ ಬೃಹತ್ ಪ್ರಮಾಣದ ಅನುಷ್ಠಾನದತ್ತ ಮುನ್ನುಗ್ಗುತ್ತಿದೆ ಎಂಬ ಸ್ಪಷ್ಟ ಸಂದೇಶವನ್ನು ರವಾನಿಸುತ್ತದೆ. 2030ರ ವೇಳೆಗೆ ಭಾರತವು 400 ಶತಕೋಟಿ ಡಾಲರ್ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮಾರುಕಟ್ಟೆ ಮತ್ತು 103 ಶತಕೋಟಿ ಡಾಲರ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮಾರುಕಟ್ಟೆಯನ್ನು ಗುರಿಯಾಗಿಸಿಕೊಂಡಿರುವ ಈ ಸಂದರ್ಭದಲ್ಲಿ, ಈ ಮೈಲಿಗಲ್ಲು ಹೆಚ್ಚಿನ ಪ್ರಾಮುಖ್ಯತೆಯನ್ನು ಪಡೆದಿದೆ.

Date	3rd April
Publication	Sanje express
Quote By	Ashok Chandak

ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಅನುಷ್ಠಾನದ ಪಯಣದಲ್ಲಿ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಉದ್ಘಾಟನೆ ಮೈಲಿಗಲ್ಲು: ಐಇಎಸ್‌ಎ

ಅಂತರಗಂಗೆ ಸುದ್ದಿ

ಬೆಂಗಳೂರು, ಏ.3- ಗೌರವಾನ್ವಿತ ಪ್ರಧಾನಮಂತ್ರಿ ನರೇಂದ್ರ ಮೋದಿ ಅವರು ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಓಎಸ್‌ಎಟಿ (OSAT) ಘಟಕವನ್ನು ಉದ್ಘಾಟಿಸಿರುವುದನ್ನು ಭಾರತೀಯ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಅಸೋಸಿಯೇಷನ್ (IESA) ಸ್ವಾಗತಿಸಿದೆ. ಇದು ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರದಲ್ಲಿ ಭಾರತವು ಕೇವಲ ಉದ್ದೇಶವನ್ನು ಹೊಂದಿರುವುದಲ್ಲದೆ, ಅದನ್ನು ಯಶಸ್ವಿ ಅನುಷ್ಠಾನಕ್ಕೆ ತರುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಸ್ಪಷ್ಟ ನಿದರ್ಶನ ಎಂದು ಐಇಎಸ್‌ಎ ಬಣ್ಣಿಸಿದೆ.

ಈ ಉದ್ಘಾಟನೆ ಮತ್ತು ಮಲ್ಟಿ-ಚಿಪ್ ಇಂಟಿಲಿಜೆಂಟ್ ಮಾಡ್ಯೂಲ್‌ನ (MCM) ವಾಣಿಜ್ಯ ಬಿಡುಗಡೆಯು ಸುಧಾರಿತ ಪ್ಯಾಕೇಜಿಂಗ್, ಸಿಸ್ಟಮ್ ಇಂಟಿಗ್ರೇಷನ್ ಮತ್ತು ಸ್ಕೇಲಬಲ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಉತ್ಪಾದನೆಯಲ್ಲಿ ಭಾರತದ ಬೆಳೆಯುತ್ತಿರುವ ಶಕ್ತಿಯನ್ನು ಎತ್ತಿ ತೋರಿಸುತ್ತದೆ. ಭಾರತವು ಸ್ಥಿತಿಸ್ಥಾಪಕ ಮತ್ತು ಜಾಗತಿಕವಾಗಿ ಸ್ಪರ್ಧಾತ್ಮಕವಾದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು ನಿರ್ಮಿಸುತ್ತಿರುವುದಕ್ಕೆ ಇದು ಸಾಕ್ಷಿಯಾಗಿದೆ.

ಸನಂದ್‌ನಲ್ಲಿರುವ ಕೇನೆಸ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಘಟಕವು ಸುಮಾರು ರೂ.3,300 ಕೋಟಿ ಹೂಡಿಕೆಯೊಂದಿಗೆ ನಿರ್ಮಾಣವಾಗಿದ್ದು, ವಿನ್ಯಾಸವನ್ನು ಮೀರಿ ಸುಧಾರಿತ ಆಸೆಂಬ್ಲಿ, ಪರೀಕ್ಷೆ ಮತ್ತು ಪ್ಯಾಕೇಜಿಂಗ್ ಕಡೆಗೆ ಇಟ್ಟ ನಿರ್ಣಾಯಕ ಹೆಜ್ಜೆಯಾಗಿದೆ. ದಿನಕ್ಕೆ ಸುಮಾರು 60 ಲಕ್ಷ ಚಿಪ್‌ಗಳನ್ನು ತಯಾರಿಸುವ ಸಾಮರ್ಥ್ಯ ಹೊಂದಿರುವ ಈ ಸೌಲಭ್ಯವು ದೇಶೀಯ ಉತ್ಪಾದನಾ ಸಾಮರ್ಥ್ಯವನ್ನು ಗಣನೀಯವಾಗಿ ಹೆಚ್ಚಿಸುವುದಲ್ಲದೆ, ಸ್ಥಳೀಯ ಆರ್ಥಿಕ ಅಭಿವೃದ್ಧಿ ಮತ್ತು ಪೂರಕ ಕೈಗಾರಿಕೆಗಳನ್ನು ಬಲಪಡಿಸಲಿದೆ.

ಐಇಎಸ್‌ಎದ ಮೌಲ್ಯಯುತ ಸದಸ್ಯರಾಗಿರುವ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಈ ಸಾಧನೆಯು ವಿನ್ಯಾಸ ಮತ್ತು ಎಂಜಿನಿಯರಿಂಗ್‌ನಿಂದ ಪ್ಯಾಕೇಜಿಂಗ್ ಮತ್ತು ಉತ್ಪನ್ನಗಳ ವಾಣಿಜ್ಯೀಕರಣದವರೆಗೆ ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯ ಆಳ ಮತ್ತು ಪ್ರಾಥಮ್ಯವನ್ನು ಎತ್ತಿ ತೋರಿಸುತ್ತದೆ. ಮಲ್ಟಿ-ಚಿಪ್ ಮಾಡ್ಯೂಲ್‌ನ ಯಶಸ್ವಿ ಬಿಡುಗಡೆಯು ಭಾರತವು ಈಗ ಕೇವಲ ವಿನ್ಯಾಸ ಮಾಡುವುದು ಮಾತ್ರವಲ್ಲದೆ, ಆತ್ಮಾಧುನಿಕ ಸೆಮಿಕಂಡಕ್ಟರ್ ಉತ್ಪನ್ನಗಳನ್ನು ದೊಡ್ಡ ಪ್ರಮಾಣದಲ್ಲಿ ಉತ್ಪಾದಿಸುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಪ್ರಬಲ ಸಂಕೇತವಾಗಿದೆ.

ಒಂದೇ ತಿಂಗಳ ಅವಧಿಯಲ್ಲಿ ಎರಡು ಸೆಮಿಕಂಡಕ್ಟರ್ ಘಟಕಗಳ ಉದ್ಘಾಟನೆ ಮತ್ತು ಈ ವರ್ಷ ಇನ್ನೂ ಹಲವು ಯೋಜನೆಗಳು ಕಾರ್ಯಗತಗೊಳ್ಳಲು ಸಿದ್ಧವಾಗಿರುವುದು, ಸದೃಢವಾದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು ನಿರ್ಮಿಸುವಲ್ಲಿ ಭಾರತಕ್ಕಿರುವ ಅಜಲ ಬದ್ಧತೆಯನ್ನು ಪುನರುಚ್ಚರಿಸುತ್ತದೆ.

Date	4th April
Publication	Kalabandu
Quote By	Ashok Chandak

ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಅನುಷ್ಠಾನದ ಪಯಣದಲ್ಲಿ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಉದ್ಘಾಟನೆಯನ್ನು ಒಂದು ಮೈಲಿಗಲ್ಲು ಎಂದು ಐಇಎಸ್‌ಎ ಶ್ಲಾಘಿಸಿದೆ

ಬೆಂಗಳೂರು: ಗೌರವಾನ್ವಿತ ಪ್ರಧಾನಮಂತ್ರಿ ನರೇಂದ್ರ ಮೋದಿ ಅವರು ಕೇನೆಸ್ ಸೆಮಿಕಾನ್‌ನ ಓಎಸ್‌ಎಟಿ (OSAT) ಘಟಕವನ್ನು ಉದ್ಘಾಟಿಸಿರುವುದನ್ನು ಭಾರತೀಯ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಅಸೋಸಿಯೇಷನ್ (IESA) ಸ್ವಾಗತಿಸಿದೆ. ಇದು ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರದಲ್ಲಿ ಭಾರತವು ಕೇವಲ ಉದ್ದೇಶವನ್ನು ಹೊಂದಿರುವುದಲ್ಲದೆ, ಅದನ್ನು ಯಶಸ್ವಿ ಅನುಷ್ಠಾನಕ್ಕೆ ತರುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಸ್ಪಷ್ಟ ನಿದರ್ಶನ ಎಂದು ಐಇಎಸ್‌ಎ ಬಣ್ಣಿಸಿದೆ.

ಈ ಉದ್ಘಾಟನೆ ಮತ್ತು ಮಲ್ಟಿ-ಚಿಪ್ ಇಂಟೆಲಿಜೆಂಟ್ ಮಾಡ್ಯೂಲ್‌ನ (MCM) ವಾಣಿಜ್ಯ ಬಿಡುಗಡೆಯು ಸುಧಾರಿತ ಪ್ಯಾಕೇಜಿಂಗ್, ಸಿಸ್ಟಮ್ ಇಂಟಿಗ್ರೇಷನ್ ಮತ್ತು ಸ್ಕೇಲೆಬಲ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಉತ್ಪಾದನೆಯಲ್ಲಿ ಭಾರತದ ಬೆಳೆಯುತ್ತಿರುವ ಶಕ್ತಿಯನ್ನು ಎತ್ತಿ ತೋರಿಸುತ್ತದೆ. ಭಾರತವು ಸ್ಥಿತಿಸ್ಥಾಪಕ ಮತ್ತು ಜಾಗತಿಕವಾಗಿ ಸ್ಪರ್ಧಾತ್ಮಕವಾದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು ನಿರ್ಮಿಸುತ್ತಿರುವುದಕ್ಕೆ ಇದು ಸಾಕ್ಷಿಯಾಗಿದೆ.

ಸನಂದ್‌ನಲ್ಲಿರುವ ಕೇನೆಸ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಘಟಕವು ಸುಮಾರು 3,300 ಕೋಟಿ ಹೂಡಿಕೆಯೊಂದಿಗೆ ನಿರ್ಮಾಣವಾಗಿದ್ದು, ವಿನ್ಯಾಸವನ್ನು ಮೀರಿ ಸುಧಾರಿತ ಅಸೆಂಬ್ಲಿ, ಪರಿಕೆ ಮತ್ತು ಪ್ಯಾಕೇಜಿಂಗ್ (ATMP) ಕಡೆಗೆ ಇಟ್ಟು ನಿರ್ಣಾಯಕ ಹೆಜ್ಜೆಯಾಗಿದೆ. ದಿನಕ್ಕೆ ಸುಮಾರು 60 ಲಕ್ಷ ಚಿಪ್‌ಗಳನ್ನು ತಯಾರಿಸುವ ಸಾಮರ್ಥ್ಯ ಹೊಂದಿರುವ ಈ ಸೌಲಭ್ಯವು ದೇಶೀಯ ಉತ್ಪಾದನಾ ಸಾಮರ್ಥ್ಯವನ್ನು ಗಣನೀಯವಾಗಿ ಹೆಚ್ಚಿಸುವುದಲ್ಲದೆ, ಸ್ಥಳೀಯ ಆರ್ಥಿಕ ಅಭಿವೃದ್ಧಿ ಮತ್ತು ಪೂರಕ ಕೈಗಾರಿಕೆಗಳನ್ನು ಬಲಪಡಿಸಲಿದೆ.

ಐಇಎಸ್‌ಎದ ಮೌಲ್ಯಯುತ ಸದಸ್ಯರಾಗಿರುವ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್‌ನ ಈ ಸಾಧನೆಯು ವಿನ್ಯಾಸ ಮತ್ತು ಎಂಜಿನಿಯರಿಂಗ್‌ನಿಂದ ಪ್ಯಾಕೇಜಿಂಗ್ ಮತ್ತು ಉತ್ಪನ್ನಗಳ ವಾಣಿಜ್ಯೀಕರಣದವರೆಗೆ ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯ ಆಳ ಮತ್ತು ಪ್ರೌಢಿಮೆಯನ್ನು ಎತ್ತಿ ತೋರಿಸುತ್ತದೆ.

ಮಲ್ಟಿ-ಚಿಪ್ ಮಾಡ್ಯೂಲ್‌ನ ಯಶಸ್ವಿ ಬಿಡುಗಡೆಯು ಭಾರತವು ಈಗ ಕೇವಲ ವಿನ್ಯಾಸ ಮಾಡುವುದು ಮಾತ್ರವಲ್ಲದೆ, ಅತ್ಯಾಧುನಿಕ ಸೆಮಿಕಂಡಕ್ಟರ್ ಉತ್ಪನ್ನಗಳನ್ನು ದೊಡ್ಡ ಪ್ರಮಾಣದಲ್ಲಿ ಉತ್ಪಾದಿಸುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಪ್ರಬಲ ಸಂಕೇತವಾಗಿದೆ.

ಒಂದೇ ತಿಂಗಳ ಅವಧಿಯಲ್ಲಿ ಎರಡು ಸೆಮಿಕಂಡಕ್ಟರ್ ಘಟಕಗಳ ಉದ್ಘಾಟನೆ ಮತ್ತು ಈ ವರ್ಷ ಇನ್ನೂ ಹಲವು ಯೋಜನೆಗಳು ಕಾರ್ಯಗತಗೊಳ್ಳಲು ಸಿದ್ಧವಾಗಿರುವುದು, ಸದೃಢವಾದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು ನಿರ್ಮಿಸುವಲ್ಲಿ ಭಾರತಕ್ಕಿರುವ ಅಚಲ ಬದ್ಧತೆಯನ್ನು ಪುನರುಚ್ಚರಿಸುತ್ತದೆ. ಈ ವೇಗದ ಅನುಷ್ಠಾನವು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಮಾಹಿತಿ ತಂತ್ರಜ್ಞಾನ ಸಚಿವಾಲಯ (MeitY), ಇಂಡಿಯಾ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮಿಷನ್ (ISM) ನಾಯಕತ್ವದ ಪರಿಣಾಮಕಾರಿ ಸಮನ್ವಯ ಮತ್ತು ಗುಜರಾತ್ ಸರ್ಕಾರದಂತಹ ರಾಜ್ಯ ಸರ್ಕಾರಗಳ ಸಕ್ರಿಯ ಬೆಂಬಲವನ್ನು ಪ್ರತಿಬಿಂಬಿಸುತ್ತದೆ. ಇದು ಜಾಗತಿಕ-ಕ ಹೂಡಿಕೆದಾರರಿಗೆ ಮತ್ತು ಉದ್ಯಮದ ಪಾಲುದಾರರಿಗೆ ಭಾರತವು ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರದಲ್ಲಿ ಕೇವಲ ಆಶಯದಿಂದ ಸುಸ್ಥಿರ ಹಾಗೂ ಬೃಹತ್ ಪ್ರಮಾಣದ ಅನುಷ್ಠಾನದತ್ತ ಮುನ್ನುಗ್ಗುತ್ತಿದೆ ಎಂಬ ಸ್ಪಷ್ಟ ಸಂದೇಶವನ್ನು ರವಾನಿಸುತ್ತದೆ.

2030ರ ವೇಳೆಗೆ ಭಾರತವು 400 ಶತಕೋಟಿ ಡಾಲರ್ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮಾರುಕಟ್ಟೆ ಮತ್ತು 103 ಶತಕೋಟಿ ಡಾಲರ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮಾರುಕಟ್ಟೆಯನ್ನು ಗುರಿಯಾಗಿಸಿಕೊಂಡಿರುವ ಈ ಸಂದರ್ಭದಲ್ಲಿ, ಈ ಮೈಲಿಗಲ್ಲು ಹೆಚ್ಚಿನ ಪ್ರಾಮುಖ್ಯತೆಯನ್ನು ಪಡೆದಿದೆ. ಈ ಮಹತ್ವಾಕಾಂಕ್ಷಿಗಳನ್ನು ಸಾಧಿಸಲು ಮೌಲ್ಯ ಸರಪಳಿಯಾದ್ಯಂತ ನಿರಂತರ ಕಾರ್ಯಕ್ರಮತೆಯ ಅಗತ್ಯವಿದ್ದು, ಕೇನೆಸ್ ಘಟಕದಂತಹ ಬೆಳವಣಿಗೆಗಳು ಭಾರತವು ಆ ಹಾದಿಯಲ್ಲಿ ದೃಢವಾಗಿ ಸಾಗುತ್ತಿರುವುದನ್ನು ತೋರಿಸುತ್ತವೆ.

Date	4th April
Publication	Suvarna Times of Karnataka
Quote By	Ashok Chandak

ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಅನುಷ್ಠಾನದ ಪಯಣದಲ್ಲಿ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಉದ್ಘಾಟನೆ

ಬೆಂಗಳೂರು: ಗೌರವಾನ್ವಿತ ಪ್ರಧಾನಮಂತ್ರಿ ನರೇಂದ್ರ ಮೋದಿ ಅವರು ಕೇನೆಸ್ ಸೆಮಿಕಾನ್‌ನ ಓಎಸ್‌ಎಟಿ ಘಟಕವನ್ನು ಉದ್ಘಾಟಿಸಿರುವುದನ್ನು ಭಾರತೀಯ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಅಸೋಸಿಯೇಷನ್ ಸ್ವಾಗತಿಸಿದೆ. ಇದು ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರದಲ್ಲಿ ಭಾರತವು ಕೇವಲ ಉದ್ದೇಶವನ್ನು ಹೊಂದಿರುವುದಲ್ಲದೆ, ಅದನ್ನು ಯಶಸ್ವಿ ಅನುಷ್ಠಾನಕ್ಕೆ ತರುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಸ್ಪಷ್ಟ ನಿದರ್ಶನ ಎಂದು ಐಇಎಸ್‌ಎ ಬಣ್ಣಿಸಿದೆ. ಈ ಉದ್ಘಾಟನೆ ಮತ್ತು ಮಲ್ಟಿ-ಚಿಪ್ ಇಂಟಿಲಿಜೆಂಟ್ ಮ್ಯಾಡ್ಯೂಲ್ ನ ವಾಣಿಜ್ಯ ಬಿಡುಗಡೆಯು ಸುಧಾರಿತ ಪ್ಯಾಕೇಜಿಂಗ್, ಸಿಸ್ಟಮ್ ಇಂಟಿಗ್ರೇಷನ್ ಮತ್ತು ಸ್ಕೇಲೆಬಲ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಉತ್ಪಾದನೆಯಲ್ಲಿ ಭಾರತದ ಬೆಳೆಯುತ್ತಿರುವ ಶಕ್ತಿಯನ್ನು ಎತ್ತಿ ತೋರಿಸುತ್ತದೆ. ಭಾರತವು ಸ್ಥಿತಿಸ್ಥಾಪಕ ಮತ್ತು ಜಾಗತಿಕವಾಗಿ ಸ್ಪರ್ಧಾತ್ಮಕವಾದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು

ನಿರ್ಮಿಸುತ್ತಿರುವುದಕ್ಕೆ ಇದು ಸಾಕ್ಷಿಯಾಗಿದೆ.

ಸನಂದ್‌ನಲ್ಲಿರುವ ಕೇನೆಸ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಘಟಕವು ಸುಮಾರು ₹3,300 ಕೋಟಿ ಹೂಡಿಕೆಯೊಂದಿಗೆ ನಿರ್ಮಾಣವಾಗಿದ್ದು, ವಿನ್ಯಾಸವನ್ನು ಮೀರಿ ಸುಧಾರಿತ ಆಸೆಂಬ್ಲಿ, ಪರಿಕ್ಷೆ ಮತ್ತು ಪ್ಯಾಕೇಜಿಂಗ್ ಕಡೆಗೆ ಇಟ್ಟ ನಿರ್ಣಾಯಕ ಹೆಜ್ಜೆಯಾಗಿದೆ.

ದಿನಕ್ಕೆ ಸುಮಾರು 60 ಲಕ್ಷ ಚಿಪ್‌ಗಳನ್ನು ತಯಾರಿಸುವ ಸಾಮರ್ಥ್ಯ ಹೊಂದಿರುವ ಈ ಸೌಲಭ್ಯವು ದೇಶೀಯ ಉತ್ಪಾದನಾ ಸಾಮರ್ಥ್ಯವನ್ನು ಗಣನೀಯವಾಗಿ ಹೆಚ್ಚಿಸುವುದಲ್ಲದೆ, ಸ್ಥಳೀಯ ಆರ್ಥಿಕ ಅಭಿವೃದ್ಧಿ ಮತ್ತು ಪೂರಕ ಕೈಗಾರಿಕೆಗಳನ್ನು ಬಲಪಡಿಸಲಿದೆ.

ಐಇಎಸ್‌ಎದ ಮೌಲ್ಯಯುತ ಸದಸ್ಯರಾಗಿರುವ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್‌ನ ಈ ಸಾಧನೆಯು ವಿನ್ಯಾಸ ಮತ್ತು

ಎಂಜಿನಿಯರಿಂಗ್‌ನಿಂದ ಪ್ಯಾಕೇಜಿಂಗ್ ಮತ್ತು ಉತ್ಪನ್ನಗಳ ವಾಣಿಜ್ಯೀಕರಣದವರೆಗೆ ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯ ಆಳ ಮತ್ತು ಪ್ರೌಢತೆಯನ್ನು ಎತ್ತಿ ತೋರಿಸುತ್ತದೆ. ಮಲ್ಟಿ-ಚಿಪ್ ಮ್ಯಾಡ್ಯೂಲ್‌ನ ಯಶಸ್ವಿ ಬಿಡುಗಡೆಯು ಭಾರತವು ಈಗ ಕೇವಲ ವಿನ್ಯಾಸ ಮಾಡುವುದು ಮಾತ್ರವಲ್ಲದೆ, ಆತ್ಮಾಭಿನವಿಕ ಸೆಮಿಕಂಡಕ್ಟರ್ ಉತ್ಪನ್ನಗಳನ್ನು ದೊಡ್ಡ ಪ್ರಮಾಣದಲ್ಲಿ ಉತ್ಪಾದಿಸುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಪ್ರಬಲ ಸಂಕೇತವಾಗಿದೆ. ಒಂದೇ ತಿಂಗಳ ಅವಧಿಯಲ್ಲಿ ಎರಡು ಸೆಮಿಕಂಡಕ್ಟರ್ ಘಟಕಗಳ ಉದ್ಘಾಟನೆ ಮತ್ತು ಈ ವರ್ಷ ಇನ್ನೂ ಹಲವು ಯೋಜನೆಗಳು ಕಾರ್ಯಗತಗೊಳ್ಳಲು ಸಿದ್ಧವಾಗಿರುವುದು, ಸದೃಢವಾದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು ನಿರ್ಮಿಸುವಲ್ಲಿ ಭಾರತಕ್ಕಿರುವ ಅಚಲ ಬದ್ಧತೆಯನ್ನು ಪುನರುಚ್ಚರಿಸುತ್ತದೆ.

Date	4th April
Publication	Sanjemitra
Quote By	Ashok Chandak

ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಅನುಷ್ಠಾನದ ಪಯಣದಲ್ಲಿ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್ ಉದ್ಘಾಟನೆಯನ್ನು ಒಂದು ಮೈಲಿಗಲ್ಲು ಎಂದು ಐಇಎಸ್‌ಎ (IESA) ಶ್ಲಾಘಿಸಿದೆ

ಬೆಂಗಳೂರು: ಗೌರವಾನ್ವಿತ ಪ್ರಧಾನಮಂತ್ರಿ ನರೇಂದ್ರ ಮೋದಿ ಅವರು ಕೇನೆಸ್ ಸೆಮಿಕಾನ್‌ನ ಓಎಸ್‌ಎಟಿ (OSAT) ಘಟಕವನ್ನು ಉದ್ಘಾಟಿಸಿರುವುದನ್ನು ಭಾರತೀಯ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಅಸೋಸಿಯೇಷನ್ (IESA) ಶ್ಲಾಘಿಸಿದೆ. ಇದು ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರದಲ್ಲಿ ಭಾರತವು ಕೇವಲ ಉದ್ದೇಶವನ್ನು ಹೊಂದಿರುವುದಲ್ಲದೆ, ಅದನ್ನು ಯಶಸ್ವಿ ಅನುಷ್ಠಾನಕ್ಕೆ ತರುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಸ್ಪಷ್ಟ ನಿರ್ದರ್ಶನ ಎಂದು ಐಇಎಸ್‌ಎ ಬಣ್ಣಿಸಿದೆ.

ಈ ಉದ್ಘಾಟನೆ ಮತ್ತು ಮಲ್ಟಿ-ಚಿಪ್ ಇಂಟಿಗ್ರೇಟೆಡ್ ಮಾಡ್ಯೂಲ್‌ನ (MCM) ವಾಣಿಜ್ಯ ಬಿಡುಗಡೆಯು ಸುಧಾರಿತ ಪ್ಯಾಕೇಜಿಂಗ್, ಸಿಸ್ಟಮ್ ಇಂಟಿಗ್ರೇಷನ್ ಮತ್ತು ಸ್ಕೇಲೆಬಲ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಉತ್ಪಾದನೆಯಲ್ಲಿ ಭಾರತದ ಬೆಳೆಯುತ್ತಿರುವ ಶಕ್ತಿಯನ್ನು ಎತ್ತಿ ತೋರಿಸುತ್ತದೆ. ಭಾರತವು ಸ್ಥಿತಿಶಾಫಕ ಮತ್ತು ಜಾಗತಿಕವಾಗಿ ಸ್ಪರ್ಧಾತ್ಮಕವಾದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು ನಿರ್ಮಿಸುತ್ತಿರುವುದಕ್ಕೆ ಇದು ಸಾಕ್ಷಿಯಾಗಿದೆ.

ಸನಂದ್‌ನಲ್ಲಿರುವ ಕೇನೆಸ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಘಟಕವು ಸುಮಾರು 3,300 ಕೋಟಿ ಹೂಡಿಕೆಯೊಂದಿಗೆ ನಿರ್ಮಾಣವಾಗಿದ್ದು, ವಿನ್ಯಾಸವನ್ನು ಮೀರಿ ಸುಧಾರಿತ ಆಸೆಂಪ್ಲಿ, ಪರೀಕ್ಷೆ ಮತ್ತು ಪ್ಯಾಕೇಜಿಂಗ್ (ATMP) ಕಡೆಗೆ ಇಟ್ಟ ನಿರ್ಣಾಯಕ ಹೆಜ್ಜೆಯಾಗಿದೆ. ದಿನಕ್ಕೆ ಸುಮಾರು 60 ಲಕ್ಷ ಚಿಪ್‌ಗಳನ್ನು ತಯಾರಿಸುವ ಸಾಮರ್ಥ್ಯ ಹೊಂದಿರುವ ಈ ಸೌಲಭ್ಯವು ದೇಶೀಯ ಉತ್ಪಾದನಾ ಸಾಮರ್ಥ್ಯವನ್ನು ಗಣನೀಯವಾಗಿ ಹೆಚ್ಚಿಸುವುದಲ್ಲದೆ, ಸ್ಥಳೀಯ ಆರ್ಥಿಕ ಅಭಿವೃದ್ಧಿ ಮತ್ತು ಪೂರಕ ಕೈಗಾರಿಕೆಗಳನ್ನು ಬಲಪಡಿಸಲಿದೆ.

ಐಇಎಸ್‌ಎದ ಮೌಲ್ಯಯುತ ಸದಸ್ಯರಾಗಿರುವ ಕೇನೆಸ್ ಸೆಮಿಕಾನ್‌ನ ಈ ಸಾಧನೆಯು ವಿನ್ಯಾಸ ಮತ್ತು ಎಂಜಿನಿಯರಿಂಗ್‌ನಿಂದ ಪ್ಯಾಕೇಜಿಂಗ್ ಮತ್ತು ಉತ್ಪನ್ನಗಳ ವಾಣಿಜ್ಯೀಕರಣದವರೆಗೆ ಭಾರತದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯ ಆಳ ಮತ್ತು ವೈವಿಧ್ಯವನ್ನು ಎತ್ತಿ ತೋರಿಸುತ್ತದೆ.

ಮಲ್ಟಿ-ಚಿಪ್ ಮಾಡ್ಯೂಲ್‌ನ ಯಶಸ್ವಿ ಬಿಡುಗಡೆಯು ಭಾರತವು ಈಗ ಕೇವಲ ವಿನ್ಯಾಸ ಮಾಡುವುದು ಮಾತ್ರವಲ್ಲದೆ, ಅತ್ಯಾಧುನಿಕ ಸೆಮಿಕಂಡಕ್ಟರ್ ಉತ್ಪನ್ನಗಳನ್ನು ದೊಡ್ಡ ಪ್ರಮಾಣದಲ್ಲಿ ಉತ್ಪಾದಿಸುತ್ತಿದೆ ಎಂಬುದಕ್ಕೆ ಪ್ರಬಲ ಸಂಕೇತವಾಗಿದೆ.

ಒಂದೇ ತಿಂಗಳ ಅವಧಿಯಲ್ಲಿ ಎರಡು ಸೆಮಿಕಂಡಕ್ಟರ್ ಘಟಕಗಳ ಉದ್ಘಾಟನೆ ಮತ್ತು ಈ ವರ್ಷ ಇನ್ನೂ ಹಲವು ಯೋಜನೆಗಳು ಕಾರ್ಯಗತಗೊಳ್ಳಲು ಸಿದ್ಧವಾಗಿರುವುದು, ಸದೃಢವಾದ ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು ನಿರ್ಮಿಸುವಲ್ಲಿ ಭಾರತಕ್ಕಿರುವ ಅಚಲ ಬದ್ಧತೆಯನ್ನು ಪುನರುಚ್ಚರಿಸುತ್ತದೆ. ಈ ವೇಗದ ಅನುಷ್ಠಾನವು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಮಾಹಿತಿ ತಂತ್ರಜ್ಞಾನ ಸಚಿವಾಲಯ (MeitY), ಇಂಡಿಯಾ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮಿಷನ್ (ISM) ನಾಯಕತ್ವದ ಪರಿಣಾಮಕಾರಿ ಸಮನ್ವಯ ಮತ್ತು ಗುಜರಾತ್ ಸರ್ಕಾರದಂತಹ ರಾಜ್ಯ ಸರ್ಕಾರಗಳ ಸಕ್ರಿಯ ಬೆಂಬಲವನ್ನು ಪ್ರತಿಬಿಂಬಿಸುತ್ತದೆ. ಇದು ಜಾಗತಿಕ ಹೂಡಿಕೆದಾರರಿಗೆ ಮತ್ತು ಉದ್ಯಮದ ಪಾಲುದಾರರಿಗೆ ಭಾರತವು ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರದಲ್ಲಿ ಕೇವಲ ಆಶಯದಿಂದ ಸುಸ್ಥಿರ ಹಾಗೂ ಬೃಹತ್ ಪ್ರಮಾಣದ ಅನುಷ್ಠಾನದತ್ತ ಮುನ್ನುಡುತ್ತಿದೆ ಎಂಬ ಸ್ಪಷ್ಟ ಸಂದೇಶವನ್ನು ರವಾನಿಸುತ್ತದೆ.

2030ರ ವೇಳೆಗೆ ಭಾರತವು 400 ಶತಕೋಟಿ ಡಾಲರ್ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮಾರುಕಟ್ಟೆ ಮತ್ತು 103 ಶತ-ಕೋಟಿ ಡಾಲರ್ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮಾರುಕಟ್ಟೆಯನ್ನು ಗುರಿಯಾಗಿಸಿಕೊಂಡಿರುವ ಈ ಸಂದರ್ಭದಲ್ಲಿ, ಈ ಮೈಲಿಗಲ್ಲು ಹೆಚ್ಚಿನ ಪ್ರಾಮುಖ್ಯತೆಯನ್ನು ಪಡೆದಿದೆ. ಈ ಮಹತ್ವಾಕಾಂಕ್ಷಿಗಳನ್ನು ಸಾಧಿಸಲು ಮೌಲ್ಯ ಸರಪಳಿಯಾದ್ಯಂತ ನಿರಂತರ ಕಾರ್ಯಕ್ರಮತೆಯ ಅಗತ್ಯವಿದ್ದು, ಕೇನೆಸ್ ಘಟಕದಂತಹ ಬೆಳವಣಿಗೆಗಳು ಭಾರತವು ಆ ಹಾದಿಯಲ್ಲಿ ದೃಢವಾಗಿ ಸಾಗುತ್ತಿರುವುದನ್ನು ತೋರಿಸುತ್ತವೆ.

ದೇಶೀಯ ಸೆಮಿಕಂಡಕ್ಟರ್ ಸಾಮರ್ಥ್ಯಗಳನ್ನು ಬಲಪಡಿಸುವುದು ಪೂರೈಕೆ ಸರಪಳಿಯ ಸ್ಥಿತಿಶಾಫಕತ್ವ, ತಾಂತ್ರಿಕ ನಾಯಕತ್ವ ಮತ್ತು ಉತ್ತಮ ಗುಣಮಟ್ಟದ ನುರಿತ ಉದ್ಯೋಗಿಗಳ ಸೃಷ್ಟಿಗೆ ನಿರ್ಣಾಯಕವಾಗಿದೆ. ಮುಖ್ಯವಾಗಿ, ಭಾರತವು ಈಗ ಸಮಗ್ರವಾದ 'ಎಂಡ್-ಟು-ಎಂಡ್' ಸೆಮಿಕಂಡಕ್ಟರ್ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯನ್ನು ನಿರ್ಮಿಸುವ ಮೂಲಕ ಜಾಗತಿಕ ಪೂರೈಕೆ ಸರಪಳಿಯ ಬದಲಾವಣೆಗಳನ್ನು ಕಾರ್ಯತಂತ್ರದ ಲಾಭವಾಗಿ ಪರಿವರ್ತಿಸುತ್ತಿದೆ.

ಆಟೋಮೊಬೈಲ್ ಹಬ್ ಆಗಿದ್ದ ಸನಂದ್ ಈಗ ವೇಗವಾಗಿ ಬೆಳೆಯುತ್ತಿರುವ ಸೆಮಿಕಂಡಕ್ಟರ್ ಕ್ಷೇತ್ರ ಆಗಿ ರೂಪಾಂತರಗೊಳ್ಳುತ್ತಿರುವುದು 'ಮೇಕ್ ಇನ್ ಇಂಡಿಯಾ' ದೃಷ್ಟಿಕೋನದ ವೇಗವನ್ನು ಮತ್ತಷ್ಟು ಹೆಚ್ಚಿಸಿದೆ.

**IESA Hails Keynes Semicon Inauguration
Online - Bangalore**

**IESA Hails Keynes Semicon Inauguration
Online - National**

Date	31st March
Publication	Businessnewsthisweek
Quote By	https://businessnewsthisweek.com/business/iesa-hails-kaynes-semicon-inauguration-as-a-landmark-in-indias-semiconductor-execution-journey/

HOME > BUSINESS > IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey

IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey

March 31, 2020 | Neel Achary | Business | 0



The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT facility by the Hon'ble Prime Minister Narendra Modi, terming it a clear demonstration of India's shift from intent to successful execution in the semiconductor sector.

The inauguration, along with the commercial launch of the Multi-Chip Intelligent Module (MCM), underscores India's growing strength in advanced packaging, system integration, and scalable semiconductor manufacturing. It reflects tangible progress on the ground as India builds a resilient and globally competitive semiconductor ecosystem.

The Kaynes semiconductor facility in Sarand, with an investment of approximately **₹3,300 crore**, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 50 lakh chips per day, the facility will significantly boost domestic manufacturing capability while driving local economic development and strengthening ancillary industries.

As a valued member of IESA, Kaynes Semicon's achievement highlights the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialisation. The successful launch of the Multi-Chip Module is a strong indicator that India is now not only designing but also manufacturing sophisticated semiconductor products at scale.

Notably, the inauguration of two semiconductor facilities within a single month, with several more projects slated for rollout this year, reinforces India's unwavering commitment to building a robust semiconductor ecosystem. This rapid pace of execution reflects strong policy alignment and effective coordination led by the Ministry of Electronics and Information Technology (MeitY), the India Semiconductor Mission (ISM), and proactive support from state governments such as Government of Gujarat. It sends a clear signal to global investors and industry stakeholders that India is accelerating from intent to sustained, large-scale execution in the semiconductor sector.

This milestone assumes even greater significance as India targets a **\$400 billion electronics market and a \$103 billion semiconductor market by 2030**. Achieving these ambitions will require sustained execution across the value chain, and developments such as Kaynes' facility demonstrate that India is firmly on that path.

Strengthening domestic semiconductor capabilities will be critical for supply chain resilience, technological leadership, and the creation of high-quality skilled jobs. Importantly, India is now converting global supply chain shifts into a strategic advantage by building a comprehensive, end-to-end semiconductor ecosystem.

The transformation of Sarand from an automobile hub into a fast-emerging semiconductor cluster further reinforces the momentum of the Make in India vision and positions India as a credible and competitive player in the global semiconductor landscape.

Date	31st March
Publication	Hellokotpad
Quote By	https://hellokotpad.com/business/iesha-hails-kaynes-semicon-inauguration-as-a-landmark-in-indias-semiconductor-execution-journey/

IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey



IESA ACHIEVEMENT • 31 MARCH 2020 • 7:30 AM

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The Kaynes semiconductor facility in Sarand, with an investment of approximately ₹3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day, the facility will significantly boost domestic manufacturing capability while driving local economic development and strengthening ancillary industries.

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Date	31st March
Publication	Businessnewsmatters
Quote By	https://businessnewsmatters.com/business/iesa-hails-kaynes-semicon-inauguration-as-a-landmark-in-indias-semiconductor-execution-journey/

NEWS

IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey

By [admin](#)
MAR 31, 2020

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The Kaynes semiconductor facility in Sanand, with an investment of approximately ₹3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day, the facility will significantly boost domestic manufacturing capability while driving local economic development and strengthening ancillary industries.

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Date	31st March
Publication	Meidexpress24
Quote By	https://mediaexpress24.com/business/iesa-hails-kaynes-semicon-inauguration-as-a-landmark-in-indias-semiconductor-execution-journey/

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March
31,
2026



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Date	31st March
Publication	Businessnewsforprofit
Quote By	https://businessnewsforprofit.com/business/iesa-hails-kaynes-semicon-inauguration-as-a-landmark-in-indias-semiconductor-execution-journey/

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BUSINESS

IESA Hails Kaynes Semicon Inauguration as a Landmark in India's Semiconductor Execution Journey

By **Rajan**

March 31, 2024

The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's DS&I facility by the Hon'ble Prime Minister Narendra Modi, terming it a clear demonstration of India's shift from intent to successful execution in the semiconductor sector.

The inauguration, along with the commercial launch of the Multi-Chip Intelligent Module (MCM), underscores India's growing strength in advanced packaging, system integration, and scalable semiconductor manufacturing. It reflects tangible progress on the ground as India builds a resilient and globally competitive semiconductor ecosystem.

The Kaynes semiconductor facility in Saranah, with an investment of approximately **₹1,300 crore**, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day, the facility will significantly boost domestic manufacturing capability while driving local economic development and strengthening ancillary industries.

As a valued member of IESA, Kaynes Semicon's achievement highlights the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialisation. The successful launch of the Multi-Chip Module is a strong indicator that India is now not only designing but also manufacturing sophisticated semiconductor products at scale.

Notably, the inauguration of two semiconductor facilities within a single month, with several more projects slated for rollout this year, reinforces India's unwavering commitment to building a robust semiconductor ecosystem. This rapid pace of execution reflects strong policy alignment and effective coordination led by the Ministry of Electronics and Information Technology (MeitY), the India Semiconductor Mission (ISM), and proactive support from state governments such as Government of Gujarat. It sends a clear signal to global investors and industry stakeholders that India is accelerating from intent to sustained, large-scale execution in the semiconductor sector.

This milestone assumes even greater significance as India targets **a \$400 billion electronics market and a \$103 billion semiconductor market by 2030**. Achieving these ambitions will require sustained execution across the value chain, and developments such as Kaynes' facility demonstrate that India is firmly on that path.

Strengthening domestic semiconductor capabilities will be critical for supply chain resilience, technological leadership, and the creation of high-quality skilled jobs. Importantly, India is now converting global supply chain shifts into a strategic advantage by building a comprehensive, end-to-end semiconductor ecosystem.

The transformation of Saranah from an automobile hub into a fast-emerging semiconductor cluster further reinforces the momentum of the Make in India vision and positions India as a credible and competitive player in the global semiconductor landscape.

Date	31st March
Publication	CXO Today
Quote By	https://cxotoday.com/hardware/iesa-applauds-kaynes-semicon-launch-as-key-milestone-for-indias-tech-ambitions/

HARDWARE

IESA Applauds Kaynes Semicon Launch as Key Milestone for India's Tech Ambitions

CXOtoday News Desk 1 month ago



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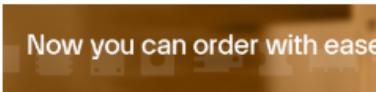
The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT facility by the Prime Minister Narendra Modi, terming it a clear demonstration of India's shift from intent to successful execution in the semiconductor sector.

The inauguration, along with the commercial launch of the Multi-Chip Intelligent Module (MCM), underscores India's growing strength in advanced packaging, system integration, and scalable semiconductor manufacturing. It reflects tangible progress on the ground as India builds a resilient and globally competitive semiconductor ecosystem.

The Kaynes semiconductor facility in Sanand, with an investment of approximately ₹3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day, the facility will significantly boost domestic manufacturing capability while driving local economic development and strengthening ancillary industries.

Kaynes Semicon's achievement highlights the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialisation. The successful launch of the Multi-Chip Module is a strong indicator that India is now not only designing but also manufacturing sophisticated semiconductor products at scale.

Date	31st March
Publication	Electronicsbuzz
Quote By	https://electronicsbuzz.in/iesa-celebrates-kaynes-semicon-inauguration-as-milestone-in-indias-semiconductor-journey/



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Home > News > Industry News > IESA Celebrates Kaynes Semicon Inauguration as Milestone in India's Semiconductor Journey

News Industry News

IESA Celebrates Kaynes Semicon Inauguration as Milestone in India's Semiconductor Journey

By **Electronics Buzz** - March 31, 2025

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The [India Electronics and Semiconductor Association \(IESA\)](#) praised the inauguration of Kaynes Semiconductors' OSAT facility by Narendra Modi, highlighting it as a strong example of India moving from intent to action in the [semiconductor](#) sector.

The launch, paired with the commercial rollout of the Multi-Chip Intelligent Module (MCM),

emphasizes India's growing capabilities in advanced packaging, system integration, and scalable semiconductor production, marking tangible progress toward a resilient, globally competitive semiconductor ecosystem.

Located in Sanand and backed by an investment of around ₹3,300 crore, the Kaynes facility moves beyond design into advanced assembly, testing, and packaging (ATMP). With a projected output of nearly 6 million chips per day, it will significantly enhance domestic manufacturing capacity, stimulate local economic growth, and strengthen supporting industries.

As a valued member of IESA, Kaynes Semicon's achievement highlights the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialisation. The successful launch of the Multi-Chip Module is a strong indicator that India is now not only designing but also manufacturing sophisticated semiconductor products at scale.

Date	31st March
Publication	Timestech
Quote By	https://timestech.in/india-electronics-and-semiconductor-association-hails-kaynes-semicon-launch-milestone/

India Electronics and Semiconductor Association Hails Kaynes Semicon Launch Milestone

By Ashok Chandak, President IESA and SEMI India

By Timestech - March 31, 2024

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The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT facility by the Hon'ble Prime Minister Narendra Modi, terming it a clear demonstration of India's shift from intent to successful execution in the semiconductor sector.

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The Kaynes semiconductor facility in Sanand, with an investment of approximately ₹3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day, the facility will significantly boost domestic manufacturing capability while driving local economic development and strengthening ancillary industries.

As a valued member of IESA, Kaynes Semicon's achievement highlights the increasing depth and maturity of India's semiconductor ecosystem—from design and engineering to packaging and product commercialisation. The successful launch of the Multi-Chip Module is a strong indicator that India is now not only designing but also manufacturing sophisticated semiconductor products at scale.

Notably, the inauguration of two semiconductor facilities within a single month, with several more projects slated for rollout this year, reinforces India's unwavering commitment to building a robust semiconductor ecosystem. This rapid pace of execution reflects strong policy alignment and effective coordination led by the Ministry of Electronics and Information Technology (MeitY), the India Semiconductor Mission (ISM), and proactive support from state governments such as Government of Gujarat. It sends a clear signal to global investors and industry stakeholders that India is accelerating from intent to sustained, large-scale execution in the semiconductor sector.

This milestone assumes even greater significance as India targets a \$400 billion electronics market and a \$103 billion semiconductor market by 2030. Achieving these ambitions will require sustained execution across the value chain, and developments such as Kaynes' facility demonstrate that India is firmly on that path.

Strengthening domestic semiconductor capabilities will be critical for supply chain resilience, technological leadership, and the creation of high-quality skilled jobs. Importantly, India is now converting global supply chain shifts into a strategic advantage by building a comprehensive, end-to-end semiconductor ecosystem.

The transformation of Sanand from an automobile hub into a fast-emerging semiconductor cluster further reinforces the momentum of the Make in India vision and positions India as a credible and competitive player in the global semiconductor landscape.

Date	31st March
Publication	BusinessToday
Quote By	https://www.businesstoday.in/technology/story/pm-modi-inaugurates-rs-3300-crore-kaynes-semiconductor-plant-in-gujarat-523321-2026-03-31#google_vignette

PM Modi inaugurates Rs 3,300 crore Kaynes semiconductor plant in Gujarat

Commercial production at the Kaynes facility has begun with Intelligent Power Modules (IPMs), which are widely used in electric vehicles, industrial systems and energy-efficient appliances.

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The Sanand unit, developed under the India Semiconductor Mission, is India's second operational semiconductor facility after Micron Technology inaugurated its unit earlier this year.

Prime Minister Narendra Modi on March 31 inaugurated the Rs 3,300 crore semiconductor facility of Kaynes Semicon at Sanand GIDC in Ahmedabad, marking a key milestone in India's efforts to build domestic chip manufacturing capabilities.

The plant, an outsourced semiconductor assembly and test (OSAT) facility, has commenced commercial operations and will focus on semiconductor assembly, packaging and testing, a critical segment in the global chip value chain.

Date	31st March
Publication	DqIndia
Quote By	https://www.dqindia.com/esdm/iesha-hails-kaynes-semicon-inauguration-as-landmark-in-indias-semiconductor-execution-journey-11439048

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IESA hails Kaynes Semicon inauguration as landmark in India's semiconductor execution journey

Kaynes semiconductor facility in Sanand, with an investment of approximately ₹3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP).

DQI Bureau
31 Mar 2024 12:42 IST



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India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT facility by Prime Minister Narendra Modi, terming it a clear demonstration of India's shift from intent to successful execution in the semiconductor sector.



Ashok Chandak, President IESA and SEMI India, said the inauguration, along with the commercial launch of the Multi-Chip Intelligent Module (MCM), underscores India's growing strength in advanced packaging, system integration, and scalable semiconductor manufacturing. It reflects tangible progress on the ground as India builds a resilient and globally competitive semiconductor ecosystem.

Kaynes semiconductor facility in Sanand, with an investment of approximately ₹3,300 crore, represents a decisive step beyond design into advanced assembly, testing, and packaging (ATMP). With an expected capacity of nearly 60 lakh chips per day, the facility will significantly boost domestic manufacturing capability while driving local economic development and strengthening ancillary industries.

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Date	31st March
Publication	Digital Terminal
Quote By	https://digitalterminal.in/association-news/iesa-highlights-kaynes-semicon-plant-as-key-step-toward-scalable-semiconductor-manufacturing-in-india

Association News

IESA Highlights Kaynes Semicon Plant as Key Step Toward Scalable Semiconductor Manufacturing in India

The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT



NDM News Network

Published on: 01 Apr 2025, 4:20 pm · 2 min read



The India Electronics and Semiconductor Association (IESA) welcomed the inauguration of Kaynes Semicon's OSAT facility by the **Hon'ble Prime Minister Narendra Modi**, terming it a clear demonstration of India's shift from intent to successful execution in the semiconductor sector.

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Date	31st March
Publication	Outlook Business
Quote By	https://www.outlookbusiness.com/deeptech/pm-modi-inaugurates-indias-second-semiconductor-plant-kaynes-semicon-begins-operations

PM Modi Inaugurates India's Second Semiconductor Plant, Kaynes Semicon Begins Operations

Prime Minister Modi inaugurates Kaynes Semicon's OSAT plant in Gujarat; the plant is India's second operational semiconductor unit under the India Semiconductor Mission

Outlook Business Desk
 Created By: Shashank Khatt
 Updated on: 31 March 2023 5:51 pm

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